

Features

This LSI has following features.

■ CPU (Arm® Cortex®-A9)

- Operating frequency: 528 MHz
- Single-precision/double-precision FPU
- Arm® NEON™

■ On-chip memory

- 4 MB

■ Main graphics and camera input functions

- Video display controller (VDC6): 1 channel
 - LCD output: Max. WXGA
 - Screen superimposition: 3 layers
 - Video input: Max. XGA
- CMOS camera input (CEU): 1 channel
- MIPI-CS12 interface: 1 channel
- Distortion compensation unit (IMR): 1 channel
- 2D graphics engine: 1 channel
- Sprite engine: 1 channel
- JPEG coding engine: 1 channel

■ Main memory interface functions

- NOR flash, SDRAM, NAND flash
- Serial flash: 1-bit/4-bit/8-bit: 1 channel, 8-bit: 1 channel (ability to run stored programs directly)
- SD/MMC host interface: 2 channels

■ Main communication functions

- USB 2.0 High Speed: 2 channels (Host/Function switchable)
- 10M/100M EtherMAC: 2 channels
- SCIF: 5 channels
- I2C: 4 channels
- SSI: 4 channels
- RSPI: 3 channels
- CAN-FD: 2 channels

■ Optional functions

- DRP (Dynamically Reconfigurable Processor)

1. Overview

1.1 Outline of Specification

Table 1.1 Features of RZ/A2M

Items	Specification
CPU	<ul style="list-style-type: none"> • Arm Cortex-A9 processor • Maximum operating frequency: 528 MHz • Instruction cache size: 32 Kbytes • Data cache size: 32 Kbytes (write-back algorithm) • TLB entries: 128 entries • Jazelle® architecture extension: Full implementation • Media processing engine with NEON™ technology
Boot modes	<ul style="list-style-type: none"> • Eight boot modes • Boot mode 0: Booting from memory (bus width: 16 bits) connected to the CS0 space Note: This only applies to 324-pin products. • Boot mode 1: Booting from a NAND flash memory with SD controller • Boot mode 2: Booting from a NAND flash memory with MMC controller (data bus width: 8 bits) • Boot mode 3: Booting from a serial flash memory (3.3 V) connected to the SPI multi I/O bus space • Boot mode 4: Booting from an Octal-SPI flash memory connected to the SPI multi I/O bus space • Boot mode 5: Booting from a HyperFlash connected to the SPI multi I/O bus space • Boot mode 6: Booting from an OctaFlash connected to the OctaFlash space • Boot mode 7: Booting from a HyperFlash connected to the HyperFlash space
Secondary cache	<ul style="list-style-type: none"> • Arm CoreLink™ Level 2 Cache Controller L2C-310 • Operating frequency: 132 MHz • Cache size: 128 Kbytes
Clock pulse generator	<ul style="list-style-type: none"> • Clock mode: Input clock can be selected from external input (EXTAL) or crystal resonator. • Input clock can be multiplied by 44 (max.) by the internal PLL circuit. • Peak values of EMI noise can be reduced by the on-chip SSCG circuit. • Five types of clocks generated: <ul style="list-style-type: none"> —CPU clock (Iϕ): Maximum 528 MHz —Image processing clock (Gϕ): Maximum 264 MHz —Internal bus clock (Bϕ): Maximum 132 MHz —Peripheral clock 1 (P1ϕ): Maximum 66 MHz —Peripheral clock 0 (P0ϕ): Maximum 33 MHz
Interrupt controller	<ul style="list-style-type: none"> • Arm CoreLink™ Generic Interrupt Controller (GIC-400) • External interrupt pins (NMI, IRQ7 to IRQ0, and TINT31 to TINT0) • On-chip peripheral interrupts: Priority level set for each module • 32 priority levels available
Bus state controller [Only for 324-pin products]	<ul style="list-style-type: none"> • Address space divided into six areas (0 to 5), each a maximum of 64 Mbytes • The following features settable for each area independently <ul style="list-style-type: none"> —Bus size (8 or 16 bits): Available sizes depend on the area. —Number of access wait cycles (different wait cycles can be specified for read and write access cycles in some areas) —Idle wait cycle insertion (between the same area access cycles or different area access cycles) —Specifying the memory to be connected to each area enables direct connection to SRAM, SRAM with byte selection, SDRAM, and burst ROM (clocked synchronous or asynchronous). The address/data multiplexed I/O (MPX) interface is also available. • Outputs a chip select signal (CS0# to CS5#) according to the target area (CS assert or negate timing can be selected by software) • SDRAM refresh <ul style="list-style-type: none"> Auto refresh or self refresh mode selectable • SDRAM burst access
Direct memory access controller	<ul style="list-style-type: none"> • Two modules, sixteen channels; external requests are available for one channel. • Can be activated by on-chip peripheral modules. • A specific DMA transfer interval can be specified to adjust the bus occupancy. • Link mode (DMA transfer under descriptor control) supported • Transfer information can be automatically reloaded.

Table 1.1 Features of RZ/A2M

Items	Specification
Multi-function timer pulse unit 3	<ul style="list-style-type: none"> • 9 channels (16 bits × 8 channels, 32 bits × 1 channel) • Maximum 28 lines of pulse inputs/outputs and 3 lines of pulse inputs • 14 types of count clocks (P1φ/1, P1φ/2, P1φ/4, P1φ/8, P1φ/16, P1φ/32, P1φ/64, P1φ/256, P1φ/1024, MTCLKA, MTCLKB, MTCLKC, MTCLKD, MTIOC1A) selectable <ul style="list-style-type: none"> —14 types of count clocks selectable (channel 0) —12 types of count clocks selectable (channel 2) —11 types of count clocks selectable (channels 1, 3, 4, 6, 7, and 8) —10 types of count clocks selectable (channel 5) • Input capture function • 39 output compare and input capture registers • Counter clear operation (Simultaneous counter clearing by Compare match or Input capture is available.) • Simultaneous writing to multiple timer counters (TCNT) • Synchronous input/output of each register due to synchronous operation of the counter. • Buffered operation • Cascade-connected operation • 43 types of interrupt sources • Automatic transfer of register data • Pulse output modes <ul style="list-style-type: none"> Toggle, PWM, complementary PWM, and reset-synchronized PWM modes • Synchronization of multiple counters • Complementary PWM output mode <ul style="list-style-type: none"> —Non-overlapping waveforms output for 3-phase inverter control —Automatic dead time setting —0% to 100% PWM duty value specifiable —A/D converter start request delaying function —Interrupt skipping at crest or trough • Reset-synchronized PWM mode <ul style="list-style-type: none"> Three-phase PWM waveforms in positive and negative phases can be output with a required duty value. • Phase counting mode: 16-bit mode (channels 1 and 2) / 32-bit mode (channels 1 and 2) • Counter function of dead time compensation • Conversion start trigger of A/D converter can be generated. • Conversion start trigger of A/D converter can be skipped. • Digital filter functions for the input capture and external count clock pin.
Port output enable 3	<ul style="list-style-type: none"> • Control of the high-impedance state of the MTU3a waveform output pins • Activation with four input pins • Activation on detection of short-circuited outputs (detection of simultaneous PWM output to the active level) • Activation by register write • Additional programming of output control target pins is possible.
General PWM timer	<ul style="list-style-type: none"> • 32 bits × 8 channels • Counting up or down (sawtooth wave), counting up and down (triangular wave) selectable for all channels. • Independent selectable for each channel. • 2 input/output pins per channel • 2 output compare/input capture registers per channel • For the 2 output compare/input capture registers of each channel, 4 registers are provided as buffer registers and are capable of operating as comparison registers when buffering is not in use. • In output compare operation, buffer switching can be at peaks or troughs, enabling the generation of laterally asymmetrically PWM waveforms. • Registers for setting up frame intervals on each channel (with capability for generating interrupts on overflow or underflow) • Generation of dead times in PWM operation • Synchronous start / stop / clear of counters on arbitrary channels. • Starting, stopping, and clearing up/down counters in response to a maximum of eight events • Starting, stopping, and clearing up/down counters in response to input level comparison • Starting, stopping, and clearing up/down counters in response to a maximum of four external triggers • Output pin invalidation functions due to dead time error or detection of short circuit between output pins. • Generation of triggers for A/D converter conversion • Digital filter functions for the input capture and external trigger pins

Table 1.1 Features of RZ/A2M

Items	Specification
Port output enable for GPT	<ul style="list-style-type: none"> • Output prohibition control of the GPT waveform output pin • Activation with up to four input pins • Activation by dead time error detection or output short detection • Activation by register write
OS timer	<ul style="list-style-type: none"> • Three-channel 32-bit counters • Two operating modes: <ul style="list-style-type: none"> —Interval timer mode —Free-running comparison mode • DMA transfer request or interrupt request can be issued when a compare match occurs.
Watchdog timer	<ul style="list-style-type: none"> • On-chip one-channel watchdog timer • A counter overflow can reset the LSI. • CPU parity error can reset the LSI.
Realtime clock	<ul style="list-style-type: none"> • Internal clock, Two types of count mode, alarm function • Interrupts can be generated at intervals of 1/64 s by the on-chip 32.768-kHz oscillator.
Serial communications interface with FIFO	<ul style="list-style-type: none"> • Five channels • Clock synchronous mode or asynchronous mode selectable • Simultaneous transmission and reception (full-duplex communication) supported • Dedicated baud rate generator • Separate 16-byte FIFO registers for transmission and reception • Modem control function (channels 0, 1, and 2 in asynchronous mode)
Serial communications interface	<ul style="list-style-type: none"> • Two channels • Clock synchronous mode, asynchronous mode, or smart card interface mode is selectable. • Simultaneous transmission and reception (full-duplex communication) supported • Dedicated baud rate generator • LSB first/MSB first selectable • Modem control function • Encoding and decoding of IrDA communications waveforms in accord with version 1.0 of the IrDA standard (on channel 0)
Renesas serial peripheral interface	<ul style="list-style-type: none"> • Three channels • SPI operation • Master mode and slave mode selectable • Programmable bit length, clock polarity, and clock phase can be selected. • Consecutive transfers • MSB first/LSB first selectable • Maximum transfer rate: 33.00 Mbps
SPI multi I/O bus controller	<ul style="list-style-type: none"> • One channel • Up to two serial flash memories with multiple I/O bus sizes (single/quad) can be connected. • Connectable with one Octal-SPI flash memory. • Connectable with one HyperFlash™ memory. • External address space read mode (built-in read cache) • SPI operating mode • Maximum frequency: 132 MHz (QSPI0_SPCLK)
HyperBus controller	<ul style="list-style-type: none"> • Two channels • Support HyperBus interface • One HyperFlash and HyperRAM can be connected per channel. • Maximum frequency: 132 MHz (HM_CK, HM_CK#)
Octa memory controller	<ul style="list-style-type: none"> • Two channels • Support Macronix Serial Multi I/O (MXSMIO®) Octa Peripheral Interface (OPI) interface. • One OctaFlash and OctaRAM can be connected per channel. • Support memory-map read/write feature with independent Flash/RAM address space. • OctaFlash supports STR (Single Transfer Rate) mode and DTR (Double Transfer Rate) mode. • SPI operation • Support Read-While-Write (RWW) function • Maximum frequency: 132 MHz (OM_SCLK)
I ² C bus interface	<ul style="list-style-type: none"> • Four channels • Master mode and slave mode supported • Support for 7-bit and 10-bit slave address formats • Support for multi-master operation • Timeout detection

Table 1.1 Features of RZ/A2M

Items	Specification
Serial sound interface	<ul style="list-style-type: none"> • Four-channel bidirectional serial transfer • Duplex communication (channels 0, 1, and 3) • Support of I²S, Monaural, and TDM audio formats • Support of master and slave functions • Generation of programmable word clock and bit clock • Multi-channel formats • Support of 8, 16, 18, 20, 22, 24, and 32-bit data formats • Support of 32-stage FIFO for transmission and reception • Support of LR-clock continue function in which the LR-clock signal is not stopped.
CANFD interface	<ul style="list-style-type: none"> • Two channels • ISO11898-1 (2003) compliant • CAN-FD ISO 11898-1 (2015) compliant • Message buffer: <ul style="list-style-type: none"> —Up to 64 × 2-channel receive message buffers: shared among all channels. —16 transmit message buffers per channel
Renesas SPDIF interface	<ul style="list-style-type: none"> • Support of IEC60958 standard (stereo and consumer use modes only) • Sampling frequencies of 32 kHz, 44.1 kHz, and 48 kHz • Audio word sizes of 16 to 24 bits per sample • Biphasic mark encoding • Double buffered data • Parity encoded serial data
Ethernet MAC controller	<ul style="list-style-type: none"> • 176-pin products: 1 channel when the media independent interface (MII) is in use, 2 channels when the reduced media independent interface (RMII) is in use • 256-, 272-, or 324-pin products: 2 channels whether the MII or RMII is in use • Conforms with the Ethernet / IEEE802.3 MAC (Media Access Control) layer standard • Supports transfer at 10 and 100 Mbps • Supports full-duplex and half-duplex mode • Supports Media Independent Interface (MII) compliant with the IEEE802.3u standard and Reduced Media Independent Interface (RMII) • Magic Packet™* detection and Wake-On-LAN (WOL) signal output • Built-in PTP controller (EPTPC) for Ethernet controller that uses Time Precision Time Protocol (PTP) defined by IEEE 1588-2008 (Version 2.0) to synchronize time between devices. • E-DMAC (Direct Memory Access Controller for Ethernet controller) function <p>Note: * Magic Packet is a trademark of Advanced Micro Devices, Inc.</p>
A/D converter	<ul style="list-style-type: none"> • 12-bit resolution • Eight input channels • Minimum conversion time: 1 μs per channel • A/D conversion request by the external trigger or timer trigger
NAND flash controller	<ul style="list-style-type: none"> • Direct-connected memory interface with NAND-type flash memory • ONFI 1.0 (mode 1 to 2) • ECC: 2, 4, 8, 16, 24, and 32 bits • Supports flash memory requiring Large block (2048+64) • Supports flash memory requiring 5-byte addresses (2 Gbits and more) • Interrupt request • Two types of DMA mode
USB 2.0 host/function module	<ul style="list-style-type: none"> • Two channels • USB 2.0-compliant host/function module • 480-Mbps, 12-Mbps, and 1.5-Mbps transfer rates provided (host mode) • 480-Mbps and 12-Mbps transfer rates provided (function mode) • On-chip 1-Kbyte RAM as communication buffers (host mode) • On-chip 8-Kbyte RAM as communication buffers (function mode)

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Items	Specification
Video display controller 6	<ul style="list-style-type: none"> • Video input interface: BT601, BT656 format (NTSC/PAL) input: Input clock: 27 MHz/54 MHz Digital pin input (channel 0): YCbCr422, YCbCr444, RGB888, RGB666, RGB565 Digital pin input size: Maximum input video image size to be set*: 1920 pixels × 1080 lines (horizontal × vertical) Note: * Depends on the AC characteristics of the connected device. Examples of input video image size: XGA (1024 × 768) SVGA (800 × 600), WVGA (800 × 480), VGA (640 × 480), WQVGA (480 × 240), QVGA (320 × 240, 240 × 320) • Input video control Horizontal noise reduction (NR), brightness adjustment and contrast adjustment using matrix operation • Scaling control Vertical and horizontal scaling up or down of input video possible at a desired ratio (scaling up of graphics also possible) Scaling up ratio: 1 to 8; scaling down ratio: 1/8 to 1 Interpolation: Hold or linear selectable 2D IP conversion: 2D IP conversion through separately setting the initial phases for the top and bottom fields • Video recording Output pixel format: YCbCr444, YCbCr422, RGB888, RGB565 Output field rate: 1/1, 1/2, 1/4, 1/8 Rotation: Horizontal mirroring and 90/180/270 degree rotation for YCbCr422 and RGB565 Maximum video image size to be stored: ×1 size of input video image • Output video control Black stretch: Black area stretched according to Y signal state Enhancer capability: LTI (transient improvement) and sharpness (contour emphasis) for Y signal • Three graphics layers (one of them also for input video) Available input pixel formats 1 bit/pixel: CLUT1 4 bits/pixel: CLUT4 8 bits/pixel: CLUT8 16 bits/pixel: YCbCr422 (graphics layers 0), RGB565, ARGB1555, RGBA5551, ARGB4444 32 bits/pixel: ARGB8888, RGBA8888, RGB888, YCbCr444 (graphics layers 0) • Superimposition Alpha blending in a rectangular area: Input video, layer 1, and layer 2 blended according to the transparency percentage α (fade-in and fade-out function available) Chroma key function: Mixing based on transparency percentage α using the specified RGB and CLUT value Pixel-base alpha blending: Alpha blending for each pixel based on transparency percentage α • Panel output control Panel output correction: Brightness adjustment and contrast adjustment, gamma correction, panel dithering TCON: Various timing output for LCD panel driving provided by a total of seven vertical and horizontal panel driver signals Panel output pixel format: RGB888, RGB666, RGB565, serial RGB Output video image size: Maximum output video image size to be set*: 1999 pixels × 2035 lines (horizontal × vertical) Note: * Depends on the AC characteristics of the display panel. Examples of output video image size: XGA (1024 × 768) SVGA (800 × 600), WVGA (800 × 480), VGA (640 × 480), WQVGA (480 × 240), QVGA (320 × 240, 240 × 320)

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Items	Specification
LVDS output interface	<ul style="list-style-type: none"> Four pairs of differential output conforming to the TIA/EIA-644 standard (three pairs for data and one pair for the clock) When the LVDS output interface is not used, the LVDS pins can be used as CMOS input/output. The LVDS PLL generates clocks of various frequencies. LVDS Power-down function
Image renderer (IMR-LS2)	<ul style="list-style-type: none"> One channel Refers to the video captured data as two-dimensional texture data and draws a shape by performing texture mapping for an arbitrary shape divided into triangular objects. Display list system Drawing functions <ul style="list-style-type: none"> Texture mapping, bilinear filtering, automatic coordinate generation (and relative coordinate input) Instruction system <ul style="list-style-type: none"> Draw instruction: TRI for drawing a triangle Control instructions: TRAP, INT, NOP, SYNCM, SYNCW, WTL, and WTS Drawing space <ul style="list-style-type: none"> Destination coordinates: $0 \leq X \leq 2,047$, $0 \leq Y \leq 2,047$ Source coordinates: $0 \leq u \leq 1,439$, $0 \leq v \leq 1,023$
2D drawing engine (DRW)	<ul style="list-style-type: none"> Support almost any object geometry, rather than being bound to only a few specific geometries such as lines, triangles, or circles. The edges of every object can be independently blurred or anti-aliased. Color Formats <ul style="list-style-type: none"> Frame buffer formats <ul style="list-style-type: none"> 8-bit: a (8) 16-bit: RGB (565), aRGB (4444), aRGB (1555) 32-bit: aRGB (8888). Texture formats <ul style="list-style-type: none"> 1-bit: CLUT (1)/I (1) 2-bit: CLUT (2)/I (2) 4-bit: CLUT (4)/I (4) 8-bit: a (8), CLUT (8)/I (8), aCLUT (44) 16-bit: aRGB (4444), aRGB (1555), RGB (565) 24-bit: RGB (888) (run length encoded (RLE) unit) 32-bit: aRGB (8888). CLUT formats use a 256-entry color lookup table.
Sprite engine (SPEA)	<ul style="list-style-type: none"> RLE Unit <ul style="list-style-type: none"> Supports Targa RLE data packet formats Sprite Unit <ul style="list-style-type: none"> Two channels Up to 16 separate sprites processed by each channel
JPEG codec unit	<ul style="list-style-type: none"> Compression and decompression method conforming to the JPEG baseline standard within the range described in this document. Operational precision: Conforming to JPEG Part 2, ISO-IEC10918-2 Pixel format: <ul style="list-style-type: none"> Compression: YCbCr422 Decompression: YCbCr444, YCbCr422, YCbCr411, YCbCr420 Output pixel format to the buffer: YCbCr422, ARGB8888, RGB565 Four quantization tables provided Four Huffman tables provided (two tables for AC coefficients and two tables for DC coefficients) Markers supported: SOI, SOF0, SOS, DQT, DHT, DRI, RSTm, and EOI Image data rate: Max. 132 Mbytes/s (at 66-MHz operation)

Table 1.1 Features of RZ/A2M

Items	Specification
Capture engine unit	<ul style="list-style-type: none"> Examples of input video image size : <ul style="list-style-type: none"> 5 megapixels (2,560 × 1,920) 3 megapixels (2,048 × 1,536) 2 megapixels (1,632 × 1,224) UXGA (1,600 × 1,200) SXGA (1) (1,280 × 1,024) SXGA (2) (1,280 × 960) WXGA (1,280 × 768) XGA (1,024 × 768) SVGA (800 × 600) WVGA (800 × 480) VGA (640 × 480) WQVGA (480 × 240) QVGA (320 × 240, 240 × 320) Note: Depends on the AC characteristics of the connected device, frame rate of the connected device, and transfer speed to the destination RAM. Input format: 8- or 16-bit binary data Memory output format: YCbCr422, YCbCr420 Note: The captured data cannot be displayed via the video display controller 6 because the Y data and CbCr data are split when written to memory.
MIPI CSI-2 interface [Only for 256-, 272-, or 324-pin products]	<ul style="list-style-type: none"> Up to 1.0-Gbps transfer rate of MIPI CSI-2 ECC 1-bit error correction and 2-bit or more error detection of a packet header CRC error detection of a payload data part Generation of VD (vertical sync), HD (horizontal sync), and FLD (field) signals Lane swapping
Video input module	<ul style="list-style-type: none"> Input formats <ul style="list-style-type: none"> MIPI CSI2 interface: YCbCr422, RGB888, RAW8 Up to 2048 × 2048 pixels capture area Memory output data formats <ul style="list-style-type: none"> YCbCr422, RGB565, ARGB1555, RGB888, ARGB8888
SD/MMC host interface	<ul style="list-style-type: none"> 176-pin products: 1 channel 256-, 272-, or 324-pin products: 2 channels SD memory I/O card interface (1-/4-bit SD bus) SD, SDHC, and SDXC SD memory card access supported Default, high-speed, UHS-I/SDR50, DDR50, and SDR104 transfer modes supported Error check function: CRC7 (command), CRC16 (data) Interrupt request: 2 Card detection function, write protect supported MMC interface (1-/4-/8-bit MMC bus) Note: Channel 1 only supports a 1- or 4-bit MMC bus. e-MMC device access supported High-speed, HS200 transfer modes supported
On-chip RAM	<ul style="list-style-type: none"> 4-Mbyte large capacity memory for video display/recording and work (128 Kbytes are used for data retention) 128-Kbyte memory for data retention (16 Kbytes × 2, 32 Kbytes × 1, 64 Kbytes × 1)
General I/O ports	<ul style="list-style-type: none"> 176-pin products: 47 I/Os, 8 inputs with open-drain outputs, 14 inputs (input only), and 1 output (output only) 256-pin products: 92 I/Os, 8 inputs with open-drain outputs, 14 inputs (input only), and 1 output (output only) 272-pin products: 92 I/Os, 8 inputs with open-drain outputs, 14 inputs (input only), and 1 output (output only) 324-pin products: 128 I/Os, 8 inputs with open-drain outputs, 14 inputs (input only), and 1 output (output only) Input or output can be selected for each bit.
Power-down modes	<ul style="list-style-type: none"> Four power-down modes provided to reduce the power consumption in this LSI <ul style="list-style-type: none"> —Sleep mode —Software standby mode —Deep standby mode —Module standby mode
Debugger interface	<ul style="list-style-type: none"> Arm CoreSight™ architecture JTAG-standard pin assignment

Table 1.1 Features of RZ/A2M

Items	Specification
Trusted Secure IP [option]	<ul style="list-style-type: none"> Security algorithm Common key encryption: AES (compliant with NIST FIPS PUB 197), 3DES, ARC4 Non-common key encryption: RSA Other features TRNG (true-random number generator) Hash value generation: SHA1, SHA224, SHA256, GHASH Support of unique ID
OTP	<ul style="list-style-type: none"> A nonvolatile memory that can be written only once Security setting, authentication setting and the OTP boot setting are possible.
Dynamic reconfigurable processor (DRP) [option]	<ul style="list-style-type: none"> Dynamically reconfigurable intellectual property module 6 tiles 32 I/O ports
Power supply voltage	<ul style="list-style-type: none"> Vcc: 1.14 to 1.26 V, PVcc: 3.0 to 3.6 V, PVcc_HO: 1.7 to 1.9 V PVcc_SPI/PVcc_SD0/PVcc_SD1: 1.7 to 1.9 V/3.0 to 3.6 V
Temperature range	-40 to +85°C
Quality level	Industrial usage, etc.
Package	<ul style="list-style-type: none"> PLBG0176GA-B 176-pin BGA, 13-mm square, 0.8-mm pitch JEITA Package Code: P-LFBGA176-13×13-0.80 RENESAS Code: PLBG0176GA-B PLBG0256KA-A 256-pin BGA, 11-mm square, 0.5-mm pitch JEITA Package Code: P-LFBGA256-11×11-0.50 RENESAS Code: PLBG0256KA-A PRBG0272GA-A 272-pin BGA, 17-mm square, 0.80-mm pitch JEITA Package Code: P-LFBGA272-17×17-0.80 RENESAS Code: PRBG0272GA-A PRBG0324GA-A 324-pin BGA, 19-mm square, 0.8-mm pitch JEITA Package Code: P-FBGA324-19×19-0.80 RENESAS Code: PRBG0324GA-A

1.2 Block Diagram

This LSI has two main buses: the north main bus where peripheral modules are connected and the south main bus where on-chip RAM and external ROM and RAM are connected. Figure 1.1 is a schematic diagram of the internal buses.

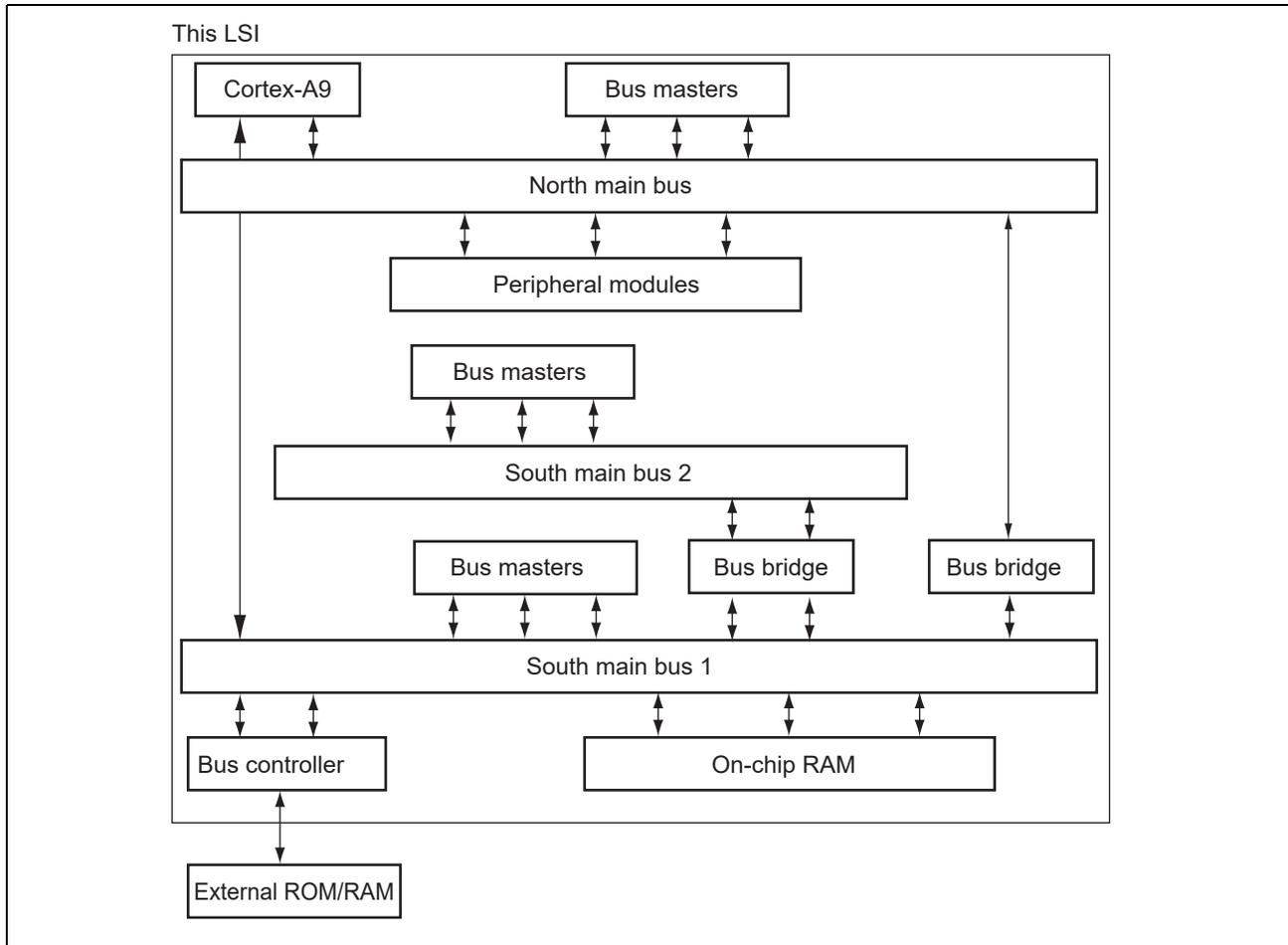


Figure 1.1 Schematic Diagram of LSI Internal Bus

1.3 Product Lineup

Table 1.2 Product Lineup

Group	Part Number	DRP Function	Trusted Secure IP	Package	
RZ/A2M	R7S921040VCBG	No DRP	No Trusted Secure IP	PLBG0176GA-B	
	R7S921041VCBG			PLBG0256KA-A	
	R7S921042VCBG			PRBG0272GA-A	
	R7S921043VCBG			PRBG0324GA-A	
	R7S921045VCBG			Available	PLBG0176GA-B
	R7S921046VCBG			PLBG0256KA-A	
	R7S921047VCBG			PRBG0272GA-A	
	R7S921048VCBG	PRBG0324GA-A			
	R7S921051VCBG	Available	No Trusted Secure IP	PLBG0256KA-A	
	R7S921052VCBG			PRBG0272GA-A	
	R7S921053VCBG			PRBG0324GA-A	
	R7S921056VCBG	Available	Available	PLBG0256KA-A	
	R7S921057VCBG			PRBG0272GA-A	
	R7S921058VCBG			PRBG0324GA-A	

Note: Usable pins of the modules listed below depend on the type of package in which the given product comes. For details, see section 2.1.2, List of Pins.

- Interrupt controller
- Direct memory access controller
- Multi-function timer pulse unit 3
- General PWM timer
- HyperBus controller
- Serial sound interface
- CANFD interface
- Renesas SPDIF interface
- NAND flash controller
- Video display controller 6

2. Pin

2.1 Pin Functions

2.1.1 Pin Function of Functional Blocks

Table 2.1 List of Pin Functions

Classification	Symbol	I/O	Name	Function
Power supply	Vcc	I	Power supply	Power supply pins. All the Vcc pins must be connected to the system power supply. This LSI does not operate correctly if there is a pin left open.
	Vss	I	Ground	Ground pins. All the Vss pins must be connected to the system power supply (0 V). This LSI does not operate correctly if there is a pin left open.
	PVcc	I	Power supply for I/O circuits	Power supply for I/O pins. All the PVcc pins must be connected to the system power supply. This LSI does not operate correctly if there is a pin left open.
	PVcc_SPI, PVcc_HO, PVcc_SD0, PVcc_SD1	I	Power supply for I/O circuits	Power supply for I/O pins. All the PVcc_SPI, PVcc_HO, PVcc_SD0, PVcc_SD1 pins must be connected to the system power supply. This LSI does not operate correctly if there is a pin left open.
	PLLvcc	I	Power supply for PLL	Power supply for the on-chip PLL oscillator.
Clock	EXTAL	I	External clock	Connected to a crystal resonator. An external clock signal may also be input to the EXTAL pin.
	XTAL	O	Crystal	Connected to a crystal resonator.
	CKIO	O	System clock output	Supplies the system clock to external devices.
	AUDIO_CLK	I	External clock for audio	Input pin of external clock for audio. A clock input to the divider is selected from an oscillation clock input on this pin or pins AUDIO_X1 and AUDIO_X2.
	AUDIO_X1 AUDIO_X2	I O	Crystal resonator/ external clock for audio	Pins connected to a crystal resonator for audio. An external clock can be input on pin AUDIO_X1. A clock input to the divider is selected from an oscillation clock input on these pins or the AUDIO_CLK pin.
	AUDIO_XOUT	O	AUDIO_X1 clock output	Output for the on-chip oscillator on AUDIO_X1 or the external clock signal.
	Operating mode control	MD_BOOT2, MD_BOOT1, MD_BOOT0	I	Mode set
MD_CLK		I	Clock mode set	Sets the clock operating mode. Do not change the signal levels on this pin while the RES# pin is asserted or until the mode is fixed, after the negation.
MD_CLKS		I	SSCG clock mode set	Switches the SSCG circuit on or off. Do not change the signal levels on this pin while the RES# pin is asserted or until the mode is fixed, after the negation.
BSCANP		I	Boundary scan set	Boundary scan setting pin. This pin is set to the high level for a boundary scan and to the low level for normal operation.
System control	RES#	I	Power-on reset	This LSI enters the power-on reset state when this signal goes low.
	WDTOVF# / PERROUT#	O	Watchdog timer overflow / CPU Parity error	Outputs an overflow signal from the watchdog timer. Outputs the CPU parity error.

Table 2.1 List of Pin Functions

Classification	Symbol	I/O	Name	Function
Interrupts	NMI	I	Non-maskable interrupt	Non-maskable interrupt request pin. It is handled as an FIQ exception. Fix it high when not in use.
	IRQ7 to IRQ0	I	Interrupt requests 7 to 0	Maskable interrupt request pins. Level-input or edge-input detection can be selected. When the edge-input detection is selected, the rising edge, falling edge, or both edges can also be selected.
Address bus	A25 to A0	O	Address bus	Outputs addresses
Data bus	D15 to D0	I/O	Data bus	Bidirectional data bus
Bus control	CS5# to CS0#	O	Chip select 5 to 0	Chip-select signals for external memory or devices.
	RD#	O	Read	Indicates that data is read from an external device.
	RD/WR#	O	Read/write	Read/write signal
	BS#	O	Bus start	Bus-cycle start signal
	AH#	O	Address hold	Address hold timing signal for the device that uses the address/data-multiplexed bus.
	WAIT#	I	Wait	Inserts a wait cycle into the bus cycles during access to the external space.
	WE0#	O	Byte select	Indicates a write access to bits 7 to 0 of data of external memory or device.
	WE1#	O	Byte select	Indicates a write access to bits 15 to 8 of data of external memory or device.
	DQML	O	Byte select	Selects bits D7 to D0 when SDRAM is connected.
	DQMU	O	Byte select	Selects bits D15 to D8 when SDRAM is connected.
	RAS#	O	RAS	Connected to the RAS# pin when SDRAM is connected.
	CAS#	O	CAS	Connected to the CAS# pin when SDRAM is connected.
	CKE	O	CK enable	Connected to the CKE pin when SDRAM is connected.
Direct memory access controller	DREQ0	I	DMA-transfer request	Input pin to receive external requests for DMA transfer.
	DACK0	O	DMA-transfer request accept	Output pin for signals indicating acceptance of external requests from external devices.
	TEND0	O	DMA-transfer end output	Output pin for DMA transfer end.

Table 2.1 List of Pin Functions

Classification	Symbol	I/O	Name	Function
Multi-function timer pulse unit 3	MTCLKA, MTCLKB, MTCLKC, MTCLKD	I	Timer clock input	Input pins for external clock signals or for phase counting mode clock signals.
	MTIOC0A, MTIOC0B, MTIOC0C, MTIOC0D	I/O	Input capture/output compare (channel 0)	TGRA_0 to TGRD_0 input capture input/output compare output/PWM output pins.
	MTIOC1A, MTIOC1B	I/O	Input capture/output compare (channel 1)	TGRA_1 and TGRB_1 input capture input/output compare output/PWM output pins.
	MTIOC2A, MTIOC2B	I/O	Input capture/output compare (channel 2)	TGRA_2 and TGRB_2 input capture input/output compare output/PWM output pins.
	MTIOC3A, MTIOC3B, MTIOC3C, MTIOC3D	I/O	Input capture/output compare (channel 3)	TGRA_3 to TGRD_3 input capture input/output compare output/PWM output pins.
	MTIOC4A, MTIOC4B, MTIOC4C, MTIOC4D	I/O	Input capture/output compare (channel 4)	TGRA_4 to TGRD_4 input capture input/output compare output/PWM output pins.
	MTIC5U, MTIC5V, MTIC5W	I/O	Input capture/output compare (channel 5)	TGRU_5, TGRV_5, and TGRW_5 input capture input/dead time compensation input pins.
	MTIOC6A, MTIOC6B, MTIOC6C, MTIOC6D	I/O	Input capture/output compare (channel 6)	TGRA_6 and TGRB_6 input capture input/output compare output/PWM output pins.
	MTIOC7A, MTIOC7B, MTIOC7C, MTIOC7D	I/O	Input capture/output compare (channel 7)	TGRA_7 to TGRD_7 input capture input/output compare output/PWM output pins.
MTIOC8A, MTIOC8B, MTIOC8C, MTIOC8D	I/O	Input capture/output compare (channel 8)	TGRA_8 to TGRD_8 input capture input/output compare output pins.	
Port output enable 3	POE0#, POE4#, POE8#, POE10#	I	High impedance request	Input pins for request signals to place the MTU3a waveform output pins in the high impedance state.
General purpose PWM timer	GTETRGA to GTETRGD	I	External trigger	External trigger input pins.
	GTIOC0A to GTIOC7A, GTIOC0B to GTIOC7B	I/O	Timer I/O	Input capture, output compare, or PWM output pins.
Realtime clock	RTC_X1	I	Crystal resonator for realtime clock/external clock	Connected to 32.768-kHz crystal resonator The RTC_X1 pin can also be used to input an external clock.
	RTC_X2	O		
	EXTAL	I	Crystal resonator for internal clock/external clock	Connected to a crystal resonator.
	XTAL	O		
Serial communication interface with FIFO	TxD4 to TxD0	O	Transmit data	Data output pins.
	RxD4 to RxD0	I	Receive data	Data input pins.
	SCK4 to SCK0	I/O	Serial clock	Clock input/output pins.
	RTS2#, RTS1#, RTS0#	O	Transmit request	Modem control pins.
	CTS2#, CTS1#, CTS0#	I/O	Transmit enable	Modem control pins.
Serial communication interface	SCI_SCK1, SCI_SCK0	I/O	Serial clock	Clock input/output pins.
	SCI_TXD1, SCI_TXD0	O	Transmit data	Data output pins.
	SCI_RXD1, SCI_RXD0	I	Receive data	Data input pins.
	SCI_CTS1# / RTS1#, SCI_CTS0# / RTS0#	I/O	Transmit and receive start control	I/O pins for controlling the start of transmission and reception.
I ² C bus interface	RIIC3SCL to RIIC0SCL	I/O	Serial clock pin	Serial clock I/O pins.
	RIIC3SDA to RIIC0SDA	I/O	Serial data pin	Serial data I/O pins.
Serial sound interface	SSITxD3, SSITxD1, SSITxD0	O	Data output	Serial data output pin.
	SSIRxD3, SSIRxD1, SSIRxD0	I	Data input	Serial data input pin.
	SSIDATA2	I/O	Data I/O	Serial data I/O pins.
	SSIBCK3 to SSISBCK0	I/O	bit clock I/O	I/O pins for bit clocks.
	SSILRCK3 to SSILRCK0	I/O	LR clock I/O	I/O pins for LR clock / frame sync.

Table 2.1 List of Pin Functions

Classification	Symbol	I/O	Name	Function
CANFD interface	CAN_CLK	I	Clock source for CAN communication	Clock source for CAN communication.
	CAN1TX, CAN0TX	O	CAN bus transmit data	Output pins for transmit data on the CAN bus.
	CAN1RX, CAN0RX	I	CAN bus receive data	Input pins for receive data on the CAN bus.
	CAN0RX_DATARATE_EN, CAN1RX_DATARATE_EN	O	CAN Bus receive data phase	This pin indicates the receive data phase of the CAN bus. This pin is set to "1" in the data (high-speed bit rate) area.
	CAN0TX_DATARATE_EN, CAN1TX_DATARATE_EN	O	CAN bus transmit data phase	This pin indicates the transmit data phase of the CAN bus. This pin is set to "1" in the data (high-speed bit rate) area.
Renesas SPDIF interface	SPDIF_OUT	O	Data output	Transmit data output pin.
	SPDIF_IN	I	Data input	Receive data input pin.
Renesas serial peripheral interface	MOSI2 to MOSI0	I/O	Data	Data I/O pins.
	MISO2 to MISO0	I/O	Data	Data I/O pins.
	RSPCK2 to RSPCK0	I/O	Clock	Clock I/O pins.
	SSL20, SSL10, SSL00	I/O	Slave select	Slave select I/O pins.
SPI multi I/O bus controller	QSPI0_SPCLK, QSPI1_SPCLK	O	Clock	Clock output pins.
	QSPI0_SSL	O	Slave select	Slave select output pins.
	QSPI1_SSL	I/O	Slave select or Data strobe	When serial flash memory is connected: This pin serves as a slave select output pin. When Octal-SPI flash or HyperFlash memory is connected: This pin serves as a data strobe input pin.
	QSPI0_IO3 to QSPI0_IO0, QSPI1_IO3 to QSPI1_IO0	I/O	Data	Data I/O pins.
	RPC_RESET#	O	Reset	Reset output pin.
	RPC_WP#	O	Write protect	Write protect output pin.
	RPC_INT#	I	Interrupt	Interrupt input pin.
HyperBus controller	HM_CK	O	Clock	Differential clock output pin.
	HM_CK#	O	Clock	Differential clock output pin.
	HM_CS0#	O	Chip select 0	Chip select signal for the external memory.
	HM_CS1#	O	Chip select 1	Chip select signal for the external memory.
	HM_RWDS	I/O	Read Write Data Strobe	Read: data strobe pin. Write: data Mask pin.
	HM_DQ7 to HM_DQ0	I/O	Data	Data I/O pin.
	HM_RESET#	O	Reset output	Reset signal for the external memory.
	HM_RSTO#	I	Reset input	Reset signal from the external memory.
	HM_INT#	I	Interrupt input	Interrupt signal from the external memory.

Table 2.1 List of Pin Functions

Classification	Symbol	I/O	Name	Function
Octa memory controller	OM_SCLK	O	Clock	clock output pin.
	OM_CS0#	O	Chip select 0	Chip select signal for the external memory.
	OM_CS1#	O	Chip select 1	Chip select signal for the external memory.
	OM_DQS	I/O	Data strobe	Read: data strobe pin. Write: data Mask pin.
	OM_SIO7 to OM_SIO0	I/O	Data	Data I/O pins.
	OM_RESET#	O	Reset output	Reset signal for the external memory.
	OM_ECS#	I	ECC error detection	ECC error detection pin from the external memory.
Ethernet controller	ET1_TXCLK, ET0_TXCLK	I	Transmit clock	MII clock pin for transmission.
	ET1_TXEN, ET0_TXCLK	O	Transmit enable	MII transmit data enable pin
	ET0_TXD3 to ET0_TXD0, ET1_TXD3 to ET1_TXD0	O	Transmit data	MII transmit data pins.
	ET1_COL, ET0_COL	I	Collision detection	MII collision detection pin.
	ET1_TXER, ET0_TXER	O	Transmit error	MII transmit error output pin.
	ET1_RXCLK, ET0_RXCLK	I	Receive clock	MII receive clock pin
	ET1_RXDV, ET0_RXDV	I	Receive enable	MII receive data enable pin
	ET1_RXD3 to ET1_RXD0, ET0_RXD3 to ET0_RXD0	I	Receive data	MII receive data pins.
	ET1_RXER, ET0_RXER	I	Receive error	MII receive error input pin.
	ET1_CRS, ET0_CRS	I	Carrier detection	MII carrier detection pin.
	REF50CK0, REF50CK1	I	Reference clock	RMII reference clock pin.
	RMII0_CRS_DV, RMII1_CRS_DV	I	Carrier detection and Receive enable	RMII carrier detection and Receive enable pin.
	RMII0_TXD1, RMII0_TXD0, RMII1_TXD1, RMII1_TXD0	O	Transmit data	RMII transmit data pin.
	RMII0_TXD_EN, RMII1_TXD_EN	O	Transmit enable	RMII transmit enable pin.
	RMII0_RXER, RMII1_RXER	I	Receive error	RMII receive error input pin.
	RMII0_RXD1, RMII0_RXD0, RMII1_RXD1, RMII1_RXD0	I	Receive data	RMII receive data pin.
	ET1_MDC, ET0_MDC	O	Management data clock	Clock pin for information transfer via MDIO.
	ET1_MDIO, ET0_MDIO	I/O	Management data I/O	Bidirectional pin for exchange of management data.
	ET1_LINKSTA, ET0_LINKSTA	I	Status	Link status pin from the PHY-LSI.
	ET1_EXOUT, ET0_EXOUT	O	General purpose output	General purpose output pin.
	ET1_WOL, ET0_WOL	O	Wake-On-LAN	Indicate the LSI receive a Magic Packet.
ET0_SCLKIN, ET1_SCLKIN	I	SCLKA clock	Clock signal supplied to the statistical time correction algorithm unit.	

Table 2.1 List of Pin Functions

Classification	Symbol	I/O	Name	Function
NAND flash controller	NFALE	O	Flash memory address latch enable	Asserted for address output and negated for data I/O.
	NFRE#	O	Flash memory read enable	Reads data at falling edge.
	NFCE#	O	Flash memory chip enable	Enables the flash memory connected to this LSI.
	NFCLE	O	Flash memory command latch enable	Asserted at command output.
	NFRB#	I	Flash memory ready/busy	High level indicates ready state and low level indicates busy state.
	NFWE#	O	Flash memory write enable	Flash memory latches commands, addresses, and data at falling edge.
	NFDATA[7:0]	I/O	Flash memory data	Data I/O pins.
USB 2.0 host/function module	DP1, DP0	I/O	USB 2.0 host/function module D+ data	D+ data pins for USB 2.0 host/function module bus.
	DM1, DM0	I/O	USB 2.0 host/function module D- data	D- data pins for USB 2.0 host/function module bus.
	VBUSIN1, VBUSIN0	I	VBUS input	A pin for monitoring connection of the USB cable. Step down the VBUS voltage to 3.3 V. Connect this pin to the Vbus pin of the USB bus so that it can detect connection and disconnection of the Vbus pin.
	VBUSEN1, VBUSEN0	O	VBUS output	VBUS power supply enable pin.
	OVRCUR1, OVRCUR0	I	Overcurrent input	Overcurrent input pin.
	OTG_EXICEN1, OTG_EXICEN0	O	OTG Power supply IC control	OTG Power supply IC control pin.
	OTG_ID1, OTG_ID0	I	OTG Power supply IC ID	OTG Power supply IC ID pin.
	CC1_Rd1, CC1_Ra1, CC2_Rd1, CC2_Ra1, CC1_Rd0, CC1_Ra0, CC2_Rd0, CC2_Ra0	I	CC input	These pins are used to monitor the state of the resistance on the CC pins of the USB Type-C connector. Check the state of the resistance of the USB Type-C connector and input the result of checking through the CC pins of the RZ/A2M.
	RREF1, RREF0	I	Reference input	Connected to USBVs via 2.2kΩ ± 1% resistance.
	USB_X1	I	Crystal resonator for USB 2.0 host/function module	Connected to a crystal resonator for USB 2.0 host/function module.
	USB_X2	O		
	USBAPVcc1, USBAPVcc0	I	Power supply for transceiver analog pins	Power supply for pins.
	USBDPVcc1, USBDPVcc0	I	Power supply for transceiver digital pins	Power supply for pins.
	USBVss	I	Ground for transceiver pins	Ground for pins.
Video display controller 6	LCD0_DATA23 to LCD0_DATA0	O	Output data	Data output pins for panel.
	LCD0_TCON6 to LCD0_TCON0	O	Panel timing adjustment output	Output pins for panel timing adjustment.
	LCD0_CLK	O	Panel clock	Panel clock output pins.
	LCD0_EXTCLK	I	Panel clock source	Panel clock source input pins.
	DV0_DATA23 to DV0_DATA0	I	Input data	Data input pins for graphics data.
	DV0_VSYNC	I	VSYNC input	VSYNC input pins.
	DV0_HSYNC	I	HSYNC input	HSYNC input pins.
	DV0_CLK	I	Input clock	Clock input signal pins for graphics data.

Table 2.1 List of Pin Functions

Classification	Symbol	I/O	Name	Function
LVDS output interface	TXCLKOUTP, TXCLKOUTM	O	Output clock	LVDS differential clock output pins.
	TXOUT2P to TXOUT0P, TXOUT2M to TXOUT0M	O	Output data	LVDS differential data output pins.
	LVDSAPVcc	I	LVDS analog power supply	Power supply for LVDS output.
	LVDSPLLVcc	I	LVDS PLL power supply	Power supply for LVDS PLL.
Capture engine unit	VIO_D15 to VIO_D0	I	Input data	Graphics data input pins.
	VIO_CLK	I	Input clock	Graphics data clock input pin.
	VIO_VD	I	VSYNC input	VSYNC input pin.
	VIO_HD	I	HSYNC input	HSYNC input pin.
	VIO_FLD	I	FIELD input	Input pin for field information
MIPI CSI-2 interface	CSI_DATA0P	I	Input data	Positive data receive pin for CSI Lane 0 differential input.
	CSI_DATA0N	I	Input data	Negative data receive pin for CSI Lane 0 differential input.
	CSI_DATA1P	I	Input data	Positive data receive pin for CSI Lane 1 differential input.
	CSI_DATA1N	I	Input data	Negative data receive pin for CSI Lane 1 differential input.
	CSI_CLKP	I	Input clock	Positive receive pin for CSI clock Lane input.
	CSI_CLKN	I	Input clock	Negative receive pin for CSI clock Lane input.
	MIPIAVcc18	I	MIPI analog power supply	Power supply for the MIPI analog circuits.
SD/MMC host interface	SD0_CLK, SD1_CLK	O	SD/MMC clock	Output pins for SD/MMC clock.
	SD0_CMD, SD1_CMD	I/O	SD/MMC command	SD/MMC command output and response input signals.
	SD0_DAT7 to SD0_DAT0, SD1_DAT3 to SD1_DAT0	I/O	SD/MMC data	SD/MMC data bus signals.
	SD0_CD, SD1_CD	I	SD/MMC card detection	SD/MMC card detection.
	SD0_WP, SD1_WP	I	SD/MMC write protection	SD/MMC write protection signals.
	SD0_RST#	O	SD/MMC reset	SD/MMC reset signal.
A/D converter	AN007 to AN000	I	Analog input pins	Analog input pins.
	ADTRG#	I	A/D conversion trigger input	External trigger input pin for starting A/D conversion.
	AVcc	I	Analog power supply and reference voltage	Analog power supply and reference voltage pin for A/D converter.
	AVss	I	Analog ground	Ground pin for A/D converter.
General I/O ports	P0_0 to PK_5	I/O	General port	General purpose I/O port pins 176-pin products: 47 pins 256-pin products: 92 pins 272-pin products: 92 pins 324-pin products: 128 pins
	PD_0 to PD_7	I/O	General port	8 general input port pins with open-drain output.
	P5_0 to P5_7, PL_0 to PL_4, JP0_0	I	General port	14 general input port pins
	JP0_1	O	General port	1 general output port pin

Table 2.1 List of Pin Functions

Classification	Symbol	I/O	Name	Function
Debugger interface	TCK/SWDCLK	I	Test clock	Test-clock input pin. Also used as the input clock pin for serial wire debugging
	TMS/SWDIO	I/O	Test mode select	Test-mode select signal input pin. Also used as the I/O data pin for serial wire debugging
	TDI	I	Test data input	Serial input pin for instructions and data.
	TDO/SWO	O	Test data output	Serial output pin for instructions and data.
	TRST#	I	Test reset	Initialization-signal input pin.
	TRACEDATA3 to TRACEDATA0	O	Data output	Trace data output pins.
	TRACECLK	O	Clock output	Trace clock output pin.
	TRACECTL	O	Enable output	Trace enable output pin.
Dynamic Reconfigurable Processor (DRP)*	DRP31 to DRP00	I/O	DRP I/O pins	32 DRP input/output pins

Note: * Only in products with a DRP

2.1.2 List of Pins

Table 2.2 List of Pins (324-Pin BGA)

Ball Number	Port Function/ Dedicated Function		Mode Function		Function 1		Function 2		Function 3		Function 4		Function 5		Function 6		Function 7		Simplified Circuit Diagram Figure 2.1	
	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O		
A1	Vcc																			
A2	QSPI1_IO3	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
A3	QSPI1_SPCLK	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
A4	RPC_WP#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
A5	QSPI0_IO3	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
A6	PVcc_SPI																			
A7	Vss																			
A8	PVcc																			
A9	PF_4	I(s)/ O	-	-	RxD2	I(s)	DV0_DATA19	I(s)	LCD0_DATA4	O	MTIOC6A	I(s)/ O	SSIBCK0	I(s)/ O	IRQ1	I(s)	-	-	-	(1)
A10	PE_6	I(s)/ O	-	-	ET0_MDIO	I(s)/ O	VIO_D2	I(s)	SSIRxD0	I(s)	MTIOC0D	I(s)/ O	CC2_Rd1	I(s)	-	-	-	-	-	(1)
A11	PL_2	I(s)	MD_BOOT2	I(s)	-	-	-	-	-	-	-	-	IRQ6	I(s)	-	-	-	-	-	(5)
A12	PE_5	I(s)/ O	-	-	ET0_MDC	O	VIO_D3	I(s)	SSITxD0	O	MTIOC0C	I(s)/ O	CC1_Rd1	I(s)	-	-	-	-	-	(1)
A13	P8_4	I(s)/ O	-	-	A4	O	DRP20*	I(s)/ O	DV0_DATA13	I(s)	SSL00	I(s)/ O	SSIRxD3	I(s)	-	-	-	-	-	(1)
A14	P8_6	I(s)/ O	-	-	A6	O	DRP18*	I(s)/ O	DV0_DATA11	I(s)	MOSI0	I(s)/ O	SSILRCK3	I(s)/ O	-	-	-	-	-	(1)
A15	PE_4	I(s)/ O	-	-	ET0_CR_S	I(s)	VIO_D4	I(s)	SSILRCK0	I(s)/ O	MTIOC0B	I(s)/ O	-	-	-	-	-	RMII0_CR_S_DV	I(s)	(1)
A16	P9_1	I(s)/ O	-	-	A9	O	DRP15*	I(s)/ O	DV0_DATA8	I(s)	RxD4	I(s)	SSILRCK2	I(s)/ O	-	-	-	-	-	(1)
A17	PVcc																			
A18	Vss																			
A19	PE_1	I(s)/ O	-	-	ET0_RXD0	I(s)	VIO_D7	I(s)	RxD2	I(s)	POE8#	I(s)	VBUSIN1	I(s)	IRQ1	I(s)	RMII0_RXD0	I(s)	-	(1)
A20	PA_4	I(s)/ O	-	-	A20	O	DV0_DATA9	I(s)	LCD0_DATA14	O	SCI_TXD0	I(s)/ O	MTIOC0C	I(s)/ O	-	-	-	-	-	(1)
A21	CKIO	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(11)
A22	Vss																			
B1	PK_1	I(s)/ O	-	-	ET1_TXD0	O	NFDATA4	I(s)/ O	CC1_Ra0	I(s)	CAN_CLK	I(s)	SSIDATA2	I(s)/ O	-	-	-	RMII1_TXD0	O	(1)
B2	Vcc																			
B3	QSPI1_IO1	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
B4	QSPI1_IO0	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
B5	RPC_RESET#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
B6	QSPI0_IO1	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
B7	QSPI0_SPCLK	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
B8	PF_5	I(s)/ O	-	-	TxD2	O	DV0_DATA20	I(s)	LCD0_DATA3	O	MTIOC6B	I(s)/ O	SSILRCK0	I(s)/ O	-	-	-	-	-	(1)
B9	P6_3	I(s)/ O	-	-	ET0_TXD1	O	VIO_HD	I(s)	TxD3	O	POE0#	I(s)	-	-	-	-	-	RMII0_TXD1	O	(1)
B10	PH_0	I(s)/ O	-	-	AUDIO_CLK	I(s)	VIO_D1	I(s)	GTIOC4A	I(s)/ O	MTIOC1A	I(s)/ O	CC1_Rd0	I(s)	IRQ3	I(s)	-	-	-	(1)
B11	PL_3	I(s)	MD_BOOT1	I(s)	-	-	-	-	-	-	-	-	IRQ7	I(s)	-	-	-	-	-	(5)
B12	PL_1	I(s)	MD_CLK	I(s)	-	-	-	-	-	-	-	-	IRQ5	I(s)	-	-	-	-	-	(5)
B13	P8_3	I(s)/ O	-	-	A3	O	DRP21*	I(s)/ O	DV0_DATA14	I(s)	MTIOC6A	I(s)/ O	GTIOC3A	I(s)/ O	-	-	-	-	-	(1)
B14	PF_2	I(s)/ O	-	-	TxD3	O	DV0_DATA17	I(s)	LCD0_DATA6	O	MTIOC7C	I(s)/ O	MISO1	I(s)/ O	-	-	-	-	-	(1)
B15	P8_7	I(s)/ O	-	-	A7	O	DRP17*	I(s)/ O	DV0_DATA10	I(s)	RSPCK0	I(s)/ O	SSIBCK3	I(s)/ O	-	-	-	-	-	(1)
B16	PE_3	I(s)/ O	-	-	ET0_RXER	I(s)	VIO_D5	I(s)	SSIBCK0	I(s)/ O	MTIOC0A	I(s)/ O	-	-	-	-	-	RMII0_RXER	I(s)	(1)
B17	PA_0	I(s)/ O	-	-	A16	O	DV0_DATA13	I(s)	LCD0_DATA10	O	SCI_TXD1	I(s)/ O	MTIOC8C	I(s)/ O	-	-	-	-	-	(1)
B18	PA_3	I(s)/ O	-	-	A19	O	DV0_DATA10	I(s)	LCD0_DATA13	O	SCI_CTS0#/ RTS0#	I(s)/ O	MTIOC0D	I(s)/ O	-	-	-	-	-	(1)
B19	PA_5	I(s)/ O	-	-	A21	O	DV0_DATA8	I(s)	LCD0_DATA15	O	SCI_RXD0	I(s)/ O	MTIOC0B	I(s)/ O	IRQ5	I(s)	-	-	-	(1)

Table 2.2 List of Pins (324-Pin BGA)

Ball Number	Port Function/ Dedicated Function		Mode Function		Function 1		Function 2		Function 3		Function 4		Function 5		Function 6		Function 7		Simplified Circuit Diagram Figure 2.1
	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	
B20	PA_6	I(s)/ O	-	-	A22	O	DV0_ DATA7	I(s)	LCD0_ DATA16	O	SCI_ SCK0	I(s)/ O	MTIOC0A	I(s)/ O	-	-	-	-	(1)
B21	Vss																		
B22	PVcc																		
C1	PH_2	I(s)/ O	-	-	CTS2#	I(s)/ O	DV0_ DATA22	I(s)	LCD0_ DATA1	O	MTIOC6D	I(s)/ O	SSIRxD0	I(s)	-	-	-	-	(1)
C2	P8_2	I(s)/ O	-	-	A2	O	DRP22*	I(s)/ O	DV0_ DATA15	I(s)	GTIOC5A	I(s)/ O	IRQ2	I(s)	-	-	-	-	(1)
C3	Vcc																		
C4	QSPI1_SSL	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
C5	RPC_INT#	I	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
C6	QSPI0_SSL	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
C7	QSPI0_IO0	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
C8	P6_1	I(s)/ O	-	-	ET0_TXEN	O	VIO_CLK	I(s)	SCK3	I(s)/ O	MTIOC2A	I(s)/ O	-	-	-	-	RMIIO_ TXD_EN	O	(1)
C9	P6_2	I(s)/ O	-	-	ET0_TXD0	O	VIO_VD	I(s)	RxD3	I(s)	MTIOC2B	I(s)/ O	OTG_ EXICEN1	O	IRQ0	I(s)	RMIIO_ TXD0	O	(1)
C10	PH_1	I(s)/ O	-	-	AUDIO_ XOUT	O	VIO_D0	I(s)	GTIOC4B	I(s)/ O	MTIOC1B	I(s)/ O	CC2_Rd0	I(s)	IRQ2	I(s)	-	-	(1)
C11	PL_4	I(s)	MD_ BOOT0	I(s)	-	-	-	-	-	-	-	-	IRQ0	I(s)	-	-	-	-	(5)
C12	PL_0	I(s)	MD_ CLKS	I(s)	-	-	-	-	-	-	-	-	IRQ4	I(s)	-	-	-	-	(5)
C13	P8_5	I(s)/ O	-	-	A5	O	DRP19*	I(s)/ O	DV0_ DATA12	I(s)	MIS00	I(s)/ O	SSITxD3	O	-	-	-	-	(1)
C14	PF_1	I(s)/ O	-	-	RxD3	I(s)	DV0_ DATA16	I(s)	LCD0_ DATA7	O	MTIOC7B	I(s)/ O	MOS11	I(s)/ O	IRQ4	I(s)	-	-	(1)
C15	P9_0	I(s)/ O	-	-	A8	O	DRP16*	I(s)/ O	DV0_ DATA9	I(s)	TxD4	O	SSIDATA2	I(s)/ O	-	-	-	-	(1)
C16	PE_2	I(s)/ O	-	-	ET0_RXD1	I(s)	VIO_D6	I(s)	TxD2	O	POE10#	I(s)	-	-	-	-	RMIIO_ RXD1	I(s)	(1)
C17	PA_2	I(s)/ O	-	-	A18	O	DV0_ DATA11	I(s)	LCD0_ DATA12	O	SCI_ SCK1	I(s)/ O	MTIOC8A	I(s)/ O	-	-	-	-	(1)
C18	PG_0	I(s)/ O	-	-	ET0_TXCLK	I(s)	VIO_D8	I(s)	RSPCK0	I(s)/ O	MTIOC3A	I(s)/ O	HM_ RST0#	I(s)	-	-	-	-	(1)
C19	PB_0	I(s)/ O	-	-	A24	O	DV0_ DATA5	I(s)	LCD0_ DATA18	O	SSITxD1	O	POE8#	I(s)	-	-	-	-	(1)
C20	Vss																		
C21	PD_7	I(s)/ O(o)	-	-	RIIC3SDA	I(s)/ O(o)	IRQ7	I(s)	-	-	-	-	-	-	-	-	-	-	(4)
C22	PD_3	I(s)/ O(o)	-	-	RIIC1SDA	I(s)/ O(o)	IRQ3	I(s)	MTCLKD	I(s)	GTETRGD	I(s)	-	-	-	-	-	-	(4)
D1	PVcc																		
D2	BSCANP	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(12)
D3	P8_1	I(s)/ O	-	-	A1	O	DRP23*	I(s)/ O	DV0_ DATA16	I(s)	GTIOC5B	I(s)/ O	IRQ3	I(s)	-	-	-	-	(1)
D4	Vcc																		
D5	QSPI1_IO2	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
D6	Vss																		
D7	QSPI0_IO2	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
D8	PK_0	I(s)/ O	-	-	ET1_TXEN	O	NFDATA3	I(s)/ O	CC1_Rd0	I(s)	MTIOC1B	I(s)/ O	SSIBCK2	I(s)/ O	-	-	RMIIO_ TXD_EN	O	(1)
D9	PF_6	I(s)/ O	-	-	RTS2#	I(s)/ O	DV0_ DATA21	I(s)	LCD0_ DATA2	O	MTIOC6C	I(s)/ O	SSITxD0	O	-	-	-	-	(1)
D10	PE_0	I(s)/ O	-	-	ET0_RXCLK	I(s)	VIO_FLD	I(s)	SCK2	I(s)/ O	POE4#	I(s)	-	-	-	-	REF50CK0	I(s)	(1)
D11	PF_3	I(s)/ O	-	-	SCK2	I(s)/ O	DV0_ DATA18	I(s)	LCD0_ DATA5	O	MTIOC7D	I(s)/ O	SSL10	I(s)/ O	-	-	-	-	(1)
D12	PVcc																		
D13	Vss																		
D14	PF_0	I(s)/ O	-	-	SCK3	I(s)/ O	DV0_ DATA15	I(s)	LCD0_ DATA8	O	MTIOC7A	I(s)/ O	RSPCK1	I(s)/ O	-	-	-	-	(1)
D15	P8_0	I(s)/ O	-	-	A0	O	DV0_ DATA14	I(s)	LCD0_ DATA9	O	SCI_ CTS1#/ RTS1#	I(s)/ O	MTIOC8D	I(s)/ O	-	-	-	-	(1)
D16	PA_1	I(s)/ O	-	-	A17	O	DV0_ DATA12	I(s)	LCD0_ DATA11	O	SCI_ RXD1	I(s)/ O	MTIOC8B	I(s)/ O	IRQ6	I(s)	-	-	(1)
D17	PA_7	I(s)/ O	-	-	A23	O	DV0_ DATA6	I(s)	LCD0_ DATA17	O	SSIRxD1	I(s)	POE10#	I(s)	-	-	-	-	(1)

Table 2.2 List of Pins (324-Pin BGA)

Ball Number	Port Function/ Dedicated Function		Mode Function		Function 1		Function 2		Function 3		Function 4		Function 5		Function 6		Function 7		Simplified Circuit Diagram Figure 2.1
	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	
D18	PVcc																		
D19	Vss																		
D20	PD_6	I(s)/ O(o)	-	-	RIIC3SCL	I(s)/ O(o)	IRQ6	I(s)	-	-	-	-	-	-	-	-	-	-	(4)
D21	PD_4	I(s)/ O(o)	-	-	RIIC2SCL	I(s)/ O(o)	IRQ4	I(s)	-	-	-	-	-	-	-	-	-	-	(4)
D22	PD_1	I(s)/ O(o)	-	-	RIIC0SDA	I(s)/ O(o)	IRQ1	I(s)	MTCLKB	I(s)	GTETRGB	I(s)	-	-	-	-	-	-	(4)
E1	Vss																		
E2	PH_3	I(s)/ O	-	-	HM_RSTO#	I(s)	RTS2#	I(s)/ O	GTIOC6A	I(s)/ O	MTIOC2A	I(s)/ O	SD0_CD	I(s)	IRQ3	I(s)	-	-	(1)
E3	PK_3	I(s)/ O	-	-	ET1_RXCLK	I(s)	NFDATA6	I(s)/ O	CC2_Rd0	I(s)	CAN0RX DATARATE_ EN	O	MOSI0	I(s)/ O	-	-	REF50CK1	I(s)	(1)
E4	PK_2	I(s)/ O	-	-	ET1_TXD1	O	NFDATA5	I(s)/ O	VBUSEN1	O	CAN0RX	I(s)	RSPCK0	I(s)/ O	IRQ5	I(s)	RMII1_TXD1	O	(1)
E19	PD_5	I(s)/ O(o)	-	-	RIIC2SDA	I(s)/ O(o)	IRQ5	I(s)	-	-	-	-	-	-	-	-	-	-	(4)
E20	PD_2	I(s)/ O(o)	-	-	RIIC1SCL	I(s)/ O(o)	IRQ2	I(s)	MTCLKC	I(s)	GTETRGC	I(s)	-	-	-	-	-	-	(4)
E21	TCK/ SWDCLK	I	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(7)
E22	JP0_0	I(s)	-	-	TDI	I	-	-	-	-	-	-	-	-	-	-	-	-	(6)
F1	PVcc_HO																		
F2	HM_CS0#/ OM_CS0#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
F3	HM_CK/ OM_SCLK	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
F4	PF_7	I(s)/ O	-	-	GTETRGD	I(s)	DV0_ DATA23	I(s)	LCD0_ DATA0	O	MTCLKD	I(s)	IRQ1	I(s)	-	-	-	-	(1)
F19	PD_0	I(s)/ O(o)	-	-	RIIC0SCL	I(s)/ O(o)	IRQ0	I(s)	MTCLKA	I(s)	GTETRGA	I(s)	-	-	-	-	-	-	(4)
F20	TRST#	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(10)
F21	TMS/SWDIO	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(9)
F22	PB_1	I(s)/ O	-	-	A25	O	DV0_ DATA4	I(s)	LCD0_ DATA19	O	SSILRCK1	I(s)/ O	POE4#	I(s)	-	-	-	-	(1)
G1	HM_DQ1/ OM_SIO1	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
G2	HM_RWDS/ OM_DQS	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
G3	HM_CS1#/ OM_CS1#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
G4	HM_CK#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
G19	JP0_1	O	-	-	TDO/SWO	O	-	-	-	-	-	-	-	-	-	-	-	-	(8)
G20	PB_2	I(s)/ O	-	-	BS#	O	DV0_ DATA3	I(s)	LCD0_ DATA20	O	SSIBCK1	I(s)/ O	POE0#	I(s)	-	-	-	-	(1)
G21	PB_3	I(s)/ O	-	-	CS0#	O	DV0_ DATA2	I(s)	LCD0_ DATA21	O	SSIDATA2	I(s)/ O	CTS0#	I(s)/ O	-	-	-	-	(1)
G22	P9_2	I(s)/ O	-	-	A10	O	DRP14*	I(s)/ O	DV0_ DATA7	I(s)	SCK4	I(s)/ O	SSIBCK2	I(s)/ O	-	-	-	-	(1)
H1	HM_DQ4/ OM_SIO4	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
H2	HM_DQ2/ OM_SIO2	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
H3	HM_DQ3/ OM_SIO3	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
H4	HM_DQ0/ OM_SIO0	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
H19	PB_4	I(s)/ O	-	-	CS1#	O	DV0_ DATA1	I(s)	LCD0_ DATA22	O	SSILRCK2	I(s)/ O	RTS0#	I(s)/ O	-	-	-	-	(1)
H20	P9_3	I(s)/ O	-	-	A11	O	DRP13*	I(s)/ O	DV0_ DATA6	I(s)	-	-	SSIRxD0	I(s)	-	-	-	-	(1)
H21	PB_5	I(s)/ O	-	-	WAIT#	I(s)	DV0_ DATA0	I(s)	LCD0_ DATA23	O	SSIBCK2	I(s)/ O	TxD0	O	-	-	-	-	(1)
H22	P9_5	I(s)/ O	-	-	A13	O	DRP11*	I(s)/ O	DV0_ DATA4	I(s)	-	-	SSILRCK0	I(s)/ O	-	-	-	-	(1)
J1	HM_RESET#/ OM_RESET#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
J2	HM_DQ6/ OM_SIO6	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)

Table 2.2 List of Pins (324-Pin BGA)

Ball Number	Port Function/ Dedicated Function		Mode Function		Function 1		Function 2		Function 3		Function 4		Function 5		Function 6		Function 7		Simplified Circuit Diagram Figure 2.1
	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	
J3	HM_DQ7/ OM_SIO7	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
J4	HM_DQ5/ OM_SIO5	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
J9	Vcc																		
J10	Vss																		
J11	Vss																		
J12	Vss																		
J13	Vss																		
J14	Vcc																		
J19	P9_4	I(s)/ O	-	-	A12	O	DRP12*	I(s)/ O	DV0_ DATA5	I(s)	-	-	SSITxD0	O	-	-	-	-	(1)
J20	P7_7	I(s)/ O	-	-	RD#	O	DV0_ HSYNC	I(s)	LCD0_ TCON0	O	GTIOC3B	I(s)/ O	RxD0	I(s)	-	-	-	-	(1)
J21	P7_6	I(s)/ O	-	-	AH#	O	DV0_ VSYNC	I(s)	LCD0_ TCON1	O	GTIOC3A	I(s)/ O	SCK0	I(s)/ O	-	-	-	-	(1)
J22	P9_6	I(s)/ O	-	-	A14	O	DRP10*	I(s)/ O	DV0_ DATA3	I(s)	-	-	SSIBCK0	I(s)/ O	-	-	-	-	(1)
K1	Vss																		
K2	PJ_6	I(s)/ O	-	-	GTETRGC	I(s)	NFCE#	O	LCD0_ CLK	O	MTCLKC	I(s)	IRQ0	I(s)	-	-	-	-	(1)
K3	PH_4	I(s)/ O	-	-	HM_INT#/ OM_ECS#	I(s)	CTS2#	I(s)/ O	GTIOC6B	I(s)/ O	MTIOC2B	I(s)/ O	SD0_WP	I(s)	IRQ2	I(s)	-	-	(1)
K4	PJ_0	I(s)/ O	-	-	TRACECLK	O	SPDIF_ OUT	O	-	-	SCK1	I(s)/ O	SSIRxD3	I(s)	-	-	-	-	(1)
K9	Vcc																		
K10	Vss																		
K11	Vss																		
K12	Vss																		
K13	Vss																		
K14	Vcc																		
K19	P9_7	I(s)/ O	-	-	A15	O	DRP09*	I(s)/ O	DV0_ DATA2	I(s)	-	-	SD1_WP	I(s)	-	-	-	-	(1)
K20	PG_1	I(s)/ O	-	-	ET0_TXD2	O	VIO_D9	I(s)	MOSI0	I(s)/ O	MTIOC3C	I(s)/ O	HM_INT#/ OM_ECS#	I(s)	-	-	-	-	(1)
K21	P7_5	I(s)/ O	-	-	CKE	O	DRP08*	I(s)/ O	DV0_ DATA1	I(s)	CTS1#	I(s)/ O	OVRCUR1	I(s)	-	-	-	-	(1)
K22	PG_2	I(s)/ O	-	-	ET0_TXD3	O	VIO_D10	I(s)	MISO0	I(s)/ O	MTIOC3B	I(s)/ O	GTIOC0A	I(s)/ O	IRQ4	I(s)	-	-	(1)
L1	PVcc																		
L2	P0_1	I(s)/ O	-	-	D1	I/O	DRP25*	I(s)/ O	DV0_ DATA18	I(s)	MTIOC6C	I(s)/ O	GTIOC4A	I(s)/ O	-	-	-	-	(2)
L3	P0_0	I(s)/ O	-	-	D0	I/O	DRP24*	I(s)/ O	DV0_ DATA17	I(s)	MTIOC6B	I(s)/ O	GTIOC3B	I(s)/ O	-	-	-	-	(2)
L4	PJ_7	I(s)/ O	-	-	GTETRGB	I(s)	NFDATA0	I(s)/ O	LCD0_ EXTCLK	I(s)	MTCLKB	I(s)	-	-	-	-	-	-	(1)
L9	Vcc																		
L10	Vss																		
L11	Vss																		
L12	Vss																		
L13	Vss																		
L14	Vcc																		
L19	P7_1	I(s)/ O	-	-	RD/WR#	O	DRP05*	I(s)/ O	DV0_ VSYNC	I(s)	RxD1	I(s)	CC1_Ra1	I(s)	-	-	-	-	(1)
L20	P7_4	I(s)/ O	-	-	CAS#	O	DRP07*	I(s)/ O	DV0_ DATA0	I(s)	RTS1#	I(s)/ O	CC2_Ra1	I(s)	-	-	-	-	(1)
L21	P7_3	I(s)/ O	-	-	RAS#	O	DRP06*	I(s)/ O	DV0_ HSYNC	I(s)	TxD1	O	CC2_Rd1	I(s)	-	-	-	-	(1)
L22	P7_2	I(s)/ O	-	-	CS4#	O	DV0_CLK	I(s)	LCD0_ TCON2	O	TEND0	O	CC2_Ra0	I(s)	-	-	-	-	(1)
M1	P0_2	I(s)/ O	-	-	D2	I/O	DRP26*	I(s)/ O	DV0_ DATA19	I(s)	MTIOC6D	I(s)/ O	GTIOC4B	I(s)/ O	-	-	-	-	(2)
M2	P0_5	I(s)/ O	-	-	D5	I/O	DRP29*	I(s)/ O	DV0_ DATA22	I(s)	MTIOC7C	I(s)/ O	GTIOC7A	I(s)/ O	-	-	-	-	(2)
M3	P0_4	I(s)/ O	-	-	D4	I/O	DRP28*	I(s)/ O	DV0_ DATA21	I(s)	MTIOC7B	I(s)/ O	GTIOC6B	I(s)/ O	-	-	-	-	(2)
M4	P0_3	I(s)/ O	-	-	D3	I/O	DRP27*	I(s)/ O	DV0_ DATA20	I(s)	MTIOC7A	I(s)/ O	GTIOC6A	I(s)/ O	-	-	-	-	(2)

Table 2.2 List of Pins (324-Pin BGA)

Ball Number	Port Function/ Dedicated Function		Mode Function		Function 1		Function 2		Function 3		Function 4		Function 5		Function 6		Function 7		Simplified Circuit Diagram Figure 2.1	
	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O		
M9	Vcc																			
M10	Vss																			
M11	Vss																			
M12	Vss																			
M13	Vss																			
M14	Vcc																			
M19	P6_6	I(s)/O	-	-	CS2#	O	DRP02*	I(s)/O	LCD0_TCON4	O	DREQ0	I(s)	CC1_Ra0	I(s)	-	-	-	-	(1)	
M20	P6_0	I(s)/O	-	-	ADTRG#	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	(1)	
M21	P7_0	I(s)/O	-	-	WE1#/DQMU	O	DRP04*	I(s)/O	DV0_CLK	I(s)	SCK1	I(s)/O	CC1_Rd1	I(s)	-	-	-	-	(1)	
M22	PVcc																			
N1	PJ_3	I(s)/O	-	-	TRACE DATA1	O	NFDATA0	I(s)/O	-	-	RTS1#	I(s)/O	SSILRCK3	I(s)/O	-	-	-	-	(1)	
N2	PJ_1	I(s)/O	-	-	TRACECTL	O	SPDIF_IN	I(s)	-	-	RxD1	I(s)	VBUSIN0	I(s)	IRQ0	I(s)	-	-	(1)	
N3	P0_6	I(s)/O	-	-	D6	I/O	DRP30*	I(s)/O	DV0_DATA23	I(s)	MTIOC7D	I(s)/O	GTIOC7B	I(s)/O	-	-	-	-	(2)	
N4	PJ_2	I(s)/O	-	-	TRACE DATA0	O	NFCE#	O	-	-	TxD1	O	SSITxD3	O	-	-	-	-	(1)	
N9	Vcc																			
N10	Vss																			
N11	Vss																			
N12	Vss																			
N13	Vss																			
N14	Vcc																			
N19	P6_5	I(s)/O	-	-	CS3#	O	DRP01*	I(s)/O	LCD0_TCON5	O	AUDIO_XOUT	O	CC1_Rd0	I(s)	-	-	-	-	(1)	
N20	PG_3	I(s)/O	-	-	ET0_COL	I(s)	VIO_D11	I(s)	SSL00	I(s)/O	MTIOC3D	I(s)/O	GTIOC0B	I(s)/O	-	-	-	-	(1)	
N21	P6_4	I(s)/O	-	-	CS5#	O	DRP00*	I(s)/O	LCD0_TCON6	O	AUDIO_CLK	I(s)	SD1_CD	I(s)	-	-	-	-	(1)	
N22	Vss																			
P1	PH_6	I(s)/O	-	-	HM_INT#/OM_ECS#	I(s)	NFDATA3	I(s)/O	ET1_WOL	O	MTIC5V	I(s)	IRQ4	I(s)	-	-	-	-	(1)	
P2	PH_5	I(s)/O	-	-	HM_RSTO#	I(s)	NFDATA2	I(s)/O	ET1_EXOUT/ET1_SCLKIN	I(s)/O	MTIC5U	I(s)	IRQ5	I(s)	-	-	-	-	(1)	
P3	PK_5	I(s)/O	-	-	GTETRGA	I(s)	NFDATA1	I(s)/O	WDTOVF#/PERROUT#	O	MTCLKA	I(s)	-	-	-	-	-	-	(1)	
P4	PVcc																			
P9	Vcc																			
P10	Vss																			
P11	Vss																			
P12	Vss																			
P13	Vss																			
P14	Vcc																			
P19	SD0_DAT7	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	
P20	SD0_RST#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	
P21	P6_7	I(s)/O	-	-	WE0#/DQML	O	DRP03*	I(s)/O	LCD0_TCON3	O	DACK0	O	CC2_Rd0	I(s)	-	-	-	-	(1)	
P22	PVcc_SD0																			
R1	PVcc																			
R2	PJ_4	I(s)/O	-	-	TRACE DATA2	O	NFDATA1	I(s)/O	-	-	CTS1#	I(s)/O	SSIBCK3	I(s)/O	-	-	-	-	(1)	
R3	PJ_5	I(s)/O	-	-	TRACE DATA3	O	NFDATA2	I(s)/O	OVRCUR0	I(s)	MTIOC1A	I(s)/O	SSILRCK2	I(s)/O	IRQ4	I(s)	-	-	(1)	
R4	Vss																			
R19	SD0_DAT2	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	
R20	SD0_DAT5	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	
R21	SD0_DAT4	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	
R22	SD0_DAT6	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	
T1	AUDIO_X1	I	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(13)	
T2	AUDIO_X2	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(13)	

Table 2.2 List of Pins (324-Pin BGA)

Ball Number	Port Function/ Dedicated Function		Mode Function		Function 1		Function 2		Function 3		Function 4		Function 5		Function 6		Function 7		Simplified Circuit Diagram Figure 2.1
	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	
T3	P3_5	I(s)/ O	-	-	ET1_RXD1	I(s)	NFCLE	O	CC2_Ra0	I(s)	CAN0TX Datarate_En	O	SSL00	I(s)/ O	-	-	RMII1_ RXD1	I(s)	(1)
T4	P3_2	I(s)/ O	-	-	ET1_CRS	I(s)	NFRE#	O	CC1_Ra1	I(s)	CAN1RX Datarate_En	O	MOSI2	I(s)/ O	-	-	RMII1_ CRS_DV	I(s)	(1)
T19	SD0_DAT0	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
T20	SD0_DAT1	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
T21	SD0_DAT3	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
T22	Vss																		
U1	Vss																		
U2	PK_4	I(s)/ O	-	-	ET1_RXD0	I(s)	NFDATA7	I(s)/ O	OVRCUR1	I(s)	CAN0TX	O	MISO0	I(s)/ O	IRQ6	I(s)	RMII1_ RXD0	I(s)	(1)
U3	P3_1	I(s)/ O	-	-	ET1_RXER	I(s)	NFALE	O	VBUSEN0	I(s)	CAN1RX	I(s)	RSPCK2	I(s)/ O	IRQ6	I(s)	RMII1_ RXER	I(s)	(1)
U4	MIPIAVcc18																		
U19	SD1_DAT0	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
U20	SD1_DAT2	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
U21	SD0_CMD	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
U22	SD0_CLK	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
V1	CSI_CLKP	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
V2	CSI_CLKN	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
V3	PG_4	I(s)/ O	-	-	ET0_TXER	O	VIO_D15	I(s)	RSPCK1	I(s)/ O	MTIOC4A	I(s)/ O	GTIOC1A	I(s)/ O	-	-	-	-	(1)
V4	Vss																		
V19	P5_4	I(s)	-	-	AN004	I(a)	IRQ0	I(s)	SD1_CD	I(s)	-	-	-	-	-	-	-	-	(3)
V20	SD1_DAT1	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
V21	SD1_DAT3	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
V22	PVcc_SD1																		
W1	CSI_DATA0 P	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
W2	CSI_DATA0 N	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
W3	Vss																		
W4	PG_6	I(s)/ O	-	-	ET0_RXD2	I(s)	VIO_D13	I(s)	MISO1	I(s)/ O	MTIOC4C	I(s)/ O	GTIOC2A	I(s)/ O	IRQ5	I(s)	-	-	(1)
W5	P1_0	I(s)/ O	-	-	D7	I/O	DRP31*	I(s)/ O	IRQ0	I(s)	CAN_CLK	I(s)	VBUSEN0	O	-	-	-	-	(2)
W6	P1_2	I(s)/ O	-	-	D9	I/O	MTIOC8B	I(s)/ O	IRQ2	I(s)	CAN0RX Datarate_En	O	VBUSEN1	O	-	-	-	-	(2)
W7	P2_0	I(s)/ O	-	-	D12	I/O	GTIOC6A	I(s)/ O	IRQ5	I(s)	CAN1RX	I(s)	OTG_ EXICEN0	O	-	-	-	-	(2)
W8	PC_2	I(s)/ O	-	-	OTG_ EXICEN0	O	NFDATA7	I(s)/ O	ET1_TXD3	O	MISO2	I(s)/ O	LCD0_ TC0N5	O	-	-	-	-	(1)
W9	P4_3	I(s)/ O	-	-	RTS0#	I(s)/ O	TXOUT1M	O	SCI_CTS1#/ RTS1#	I(s)/ O	SSILRCK1	I(s)/ O	MTIOC8D	I(s)/ O	IRQ3	I(s)	-	-	(1)
W10	LVDSAPVcc																		
W11	Vss																		
W12	LVDSPLLc																		
W13	USBDPVcc0																		
W14	USBVss																		
W15	Vss																		
W16	PVcc																		
W17	Vss																		
W18	PLLVcc																		
W19	P5_2	I(s)	-	-	AN002	I(a)	IRQ6	I(s)	VBUSIN0	I(s)	-	-	-	-	-	-	-	-	(3)
W20	P5_6	I(s)	-	-	AN006	I(a)	IRQ2	I(s)	-	-	-	-	-	-	-	-	-	-	(3)
W21	SD1_CMD	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
W22	Vss																		
Y1	CSI_DATA1 P	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
Y2	CSI_DATA1 N	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	

Table 2.2 List of Pins (324-Pin BGA)

Ball Number	Port Function/ Dedicated Function		Mode Function		Function 1		Function 2		Function 3		Function 4		Function 5		Function 6		Function 7		Simplified Circuit Diagram Figure 2.1	
	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O		
Y3	Vss																			
Y4	P3_3	I(s)/ O	-	-	ET1_MDC	O	NFWE#	O	OTG_EXICEN0	O	CAN1TX	O	MISO2	I(s)/ O	IRQ7	I(s)	-	-	(1)	
Y5	P1_4	I(s)/ O	-	-	D11	I/O	MTIOC8D	I(s)/ O	IRQ4	I(s)	CAN0TX_DATARATE_EN	O	VBUSIN0	I(s)	-	-	-	-	(2)	
Y6	PC_0	I(s)/ O	-	-	VBUSIN1	I(s)	NFDATA5	I(s)/ O	ET1_TXCLK	I(s)	RSPCK2	I(s)/ O	IRQ2	I(s)	-	-	-	-	(1)	
Y7	P2_2	I(s)/ O	-	-	D14	I/O	GTIOC7A	I(s)/ O	IRQ7	I(s)	CAN1TX	O	VBUSIN1	I(s)	-	-	-	-	(2)	
Y8	P4_2	I(s)/ O	-	-	TxD0	O	TXOUT1P	O	SCI_TXD1	I(s)/ O	SSITxD1	O	MTIOC8C	I(s)/ O	IRQ2	I(s)	-	-	(1)	
Y9	P4_6	I(s)/ O	-	-	ET0_EXOUT/ ET0_SCLKIN	I(s)/ O	TXCLK_OUTP	O	SCI_TXD0	I(s)/ O	TxD4	O	DACK0	O	-	-	-	-	(1)	
Y10	NMI	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(10)	
Y11	Vss																			
Y12	USBVss																			
Y13	USBVss																			
Y14	USBVss																			
Y15	USBVss																			
Y16	USBDPVcc1																			
Y17	PC_7	I(s)/ O	-	-	OVRCUR0	I(s)	NFRB#	I(s)	ET1_RXD3	I(s)	SD1_WP	I(s)	LCD0_TCON0	O	IRQ6	I(s)	-	-	(1)	
Y18	PC_6	I(s)/ O	-	-	VBUSEN0	O	NFWE#	O	ET1_RXD2	I(s)	SD1_CD	I(s)	LCD0_TCON1	O	IRQ7	I(s)	-	-	(1)	
Y19	P5_0	I(s)	-	-	AN000	I(a)	IRQ4	I(s)	SD0_CD	I(s)	SD1_CD	I(s)	-	-	-	-	-	-	(3)	
Y20	P5_1	I(s)	-	-	AN001	I(a)	IRQ5	I(s)	SD0_WP	I(s)	SD1_WP	I(s)	-	-	-	-	-	-	(3)	
Y21	P5_7	I(s)	-	-	AN007	I(a)	IRQ3	I(s)	-	-	-	-	-	-	-	-	-	-	(3)	
Y22	SD1_CLK	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	
AA1	MIPIAVcc18																			
AA2	Vss																			
AA3	P1_1	I(s)/ O	-	-	D8	I/O	MTIOC8A	I(s)/ O	IRQ1	I(s)	CAN0RX	I(s)	OVRCUR0	I(s)	-	-	-	-	(2)	
AA4	P3_4	I(s)/ O	-	-	ET1_MDIO	I(s)/ O	NFRB#	I(s)	CC2_Ra1	I(s)	CAN1TX_DATARATE_EN	O	SSL20	I(s)/ O	-	-	-	-	(1)	
AA5	P3_0	I(s)/ O	-	-	OTG_EXICEN1	O	NFDATA4	I(s)/ O	ET1_LINKSTA	I(s)	MTIC5W	I(s)	IRQ3	I(s)	-	-	-	-	(1)	
AA6	PC_1	I(s)/ O	-	-	VBUSIN0	I(s)	NFDATA6	I(s)/ O	ET1_TXD2	O	MOSI2	I(s)/ O	LCD0_TCON6	O	-	-	-	-	(1)	
AA7	P4_0	I(s)/ O	-	-	SCK0	I(s)/ O	TXOUT0P	O	SCI_SCK1	I(s)/ O	SSIBCK1	I(s)/ O	MTIOC8A	I(s)/ O	IRQ0	I(s)	-	-	(1)	
AA8	P4_4	I(s)/ O	-	-	CTS0#	I(s)/ O	TXOUT2P	O	SCI_CTS0#/ RTS0#	I(s)/ O	WDT0VF#/ PERR0UT#	O	OTG_EXICEN0	O	-	-	-	-	(1)	
AA9	P4_7	I(s)/ O	-	-	ET0_WOL	O	TXCLK_OUTM	O	SCI_SCK0	I(s)/ O	SCK4	I(s)/ O	TEND0	O	-	-	-	-	(1)	
AA10	USB_X2	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(13)	
AA11	DP0	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-		
AA12	USBAPVcc0																			
AA13	RREF0	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-		
AA14	USBVss																			
AA15	DP1	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-		
AA16	PVcc																			
AA17	PC_5	I(s)/ O	-	-	VBUSEN1	O	NFRE#	O	ET1_RXDV	I(s)	SPDIF_OUT	O	LCD0_TCON2	O	IRQ0	I(s)	-	-	(1)	
AA18	XTAL	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(13)	
AA19	PC_4	I(s)/ O	-	-	OTG_ID1	I(s)	NFALE	O	ET1_TXER	O	SPDIF_IN	I(s)	LCD0_TCON3	O	IRQ1	I(s)	-	-	(1)	
AA20	RTC_X2	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(14)	
AA21	P5_3	I(s)	-	-	AN003	I(a)	IRQ7	I(s)	OTG_ID0	I(s)	-	-	-	-	-	-	-	(3)		
AA22	P5_5	I(s)	-	-	AN005	I(a)	IRQ1	I(s)	SD1_WP	I(s)	-	-	-	-	-	-	-	(3)		
AB1	Vss																			
AB2	PG_5	I(s)/ O	-	-	ET0_RXDV	I(s)	VIO_D14	I(s)	MOSI1	I(s)/ O	MTIOC4B	I(s)/ O	GTIOC1B	I(s)/ O	-	-	-	-	(1)	
AB3	PG_7	I(s)/ O	-	-	ET0_RXD3	I(s)	VIO_D12	I(s)	SSL10	I(s)/ O	MTIOC4D	I(s)/ O	GTIOC2B	I(s)/ O	-	-	-	-	(1)	

Table 2.2 List of Pins (324-Pin BGA)

Ball Number	Port Function/ Dedicated Function		Mode Function		Function 1		Function 2		Function 3		Function 4		Function 5		Function 6		Function 7		Simplified Circuit Diagram Figure 2.1
	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	
AB4	P1_3	I(s)/ O	-	-	D10	I/O	MTIOC8C	I(s)/ O	IRQ3	I(s)	CAN0TX	O	OTG_ID1	I(s)	-	-	-	-	(2)
AB5	P2_1	I(s)/ O	-	-	D13	I/O	GTIOC6B	I(s)/ O	IRQ6	I(s)	CAN1RX DATARATE_ EN	O	OTG_ID0	I(s)	-	-	-	-	(2)
AB6	P2_3	I(s)/ O	-	-	D15	I/O	GTIOC7B	I(s)/ O	WDTOVF#/ PERROUT#	O	CAN1TX DATARATE_ EN	O	OTG_ EXICEN1	O	-	-	-	-	(2)
AB7	P4_1	I(s)/ O	-	-	RxD0	I(s)	TXOUT0M	O	SCI_RXD1	I(s)/ O	SSIRxD1	I(s)	MTIOC8B	I(s)/ O	IRQ1	I(s)	-	-	(1)
AB8	P4_5	I(s)/ O	-	-	ET0_ LINKSTA	I(s)	TXOUT2M	O	SCI_RXD0	I(s)/ O	RxD4	I(s)	DREQ0	I(s)	-	-	-	-	(1)
AB9	RES#	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(12)
AB10	USB_X1	I	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(13)
AB11	DM0	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
AB12	USBA PVcc1																		
AB13	RREF1	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
AB14	USBVss																		
AB15	DM1	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
AB16	PVcc																		
AB17	PC_3	I(s)/ O	-	-	OTG_ID0	I(s)	NFCLE	O	ET1_COL	I(s)	SSL20	I(s)/ O	LCD0_ TCON4	O	-	-	-	-	(1)
AB18	EXTAL	I	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(13)
AB19	Vss																		
AB20	RTC_X1	I	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(14)
AB21	AVcc																		
AB22	AVss																		

[Legend]

(s): Schmitt

(a): Analog

(o): Open drain

Note: * Only in products with a DRP

Table 2.3 List of Pins (272-Pin BGA)

Ball Number	Port Function/ Dedicated Function		Mode Function		Function 1		Function 2		Function 3		Function 4		Function 5		Function 6		Function 7		Simplified Circuit Diagram Figure 2.1	
	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O		
A1	Vcc																			
A2	QSPI1_IO3	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
A3	QSPI1_IO1	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
A4	QSPI1_SPCLK	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
A5	QSPI0_SSL	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
A6	QSPI0_IO0	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
A7	Vss																			
A8	PVcc																			
A9	P6_3	I(s)/ O	-	-	ET0_TXD1	O	VIO_HD	I(s)	TxD3	O	POE0#	I(s)	-	-	-	-	-	RMII0_TXD1	O	(1)
A10	PE_6	I(s)/ O	-	-	ET0_MDIO	I(s)/ O	VIO_D2	I(s)	SSIRxD0	I(s)	MTIOC0D	I(s)/ O	CC2_Rd1	I(s)	-	-	-	-	-	(1)
A11	PL_4	I(s)	MD_BOOT0	I(s)	-	-	-	-	-	-	-	-	IRQ0	I(s)	-	-	-	-	-	(5)
A12	PL_2	I(s)	MD_BOOT2	I(s)	-	-	-	-	-	-	-	-	IRQ6	I(s)	-	-	-	-	-	(5)
A13	PL_1	I(s)	MD_CLK	I(s)	-	-	-	-	-	-	-	-	IRQ5	I(s)	-	-	-	-	-	(5)
A14	PF_1	I(s)/ O	-	-	RxD3	I(s)	DV0_DATA16	I(s)	LCD0_DATA7	O	MTIOC7B	I(s)/ O	MOSI1	I(s)/ O	IRQ4	I(s)	-	-	-	(1)
A15	PE_2	I(s)/ O	-	-	ET0_RXD1	I(s)	VIO_D6	I(s)	TxD2	O	POE10#	I(s)	-	-	-	-	-	RMII0_RXD1	I(s)	(1)
A16	PA_3	I(s)/ O	-	-	-	-	DV0_DATA10	I(s)	LCD0_DATA13	O	SCI_CTS0#/ RTS0#	I(s)/ O	MTIOC0D	I(s)/ O	-	-	-	-	-	(1)
A17	PA_6	I(s)/ O	-	-	-	-	DV0_DATA7	I(s)	LCD0_DATA16	O	SCI_SCK0	I(s)/ O	MTIOC0A	I(s)/ O	-	-	-	-	-	(1)
A18	Vss																			
A19	CKIO	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(11)
A20	Vss																			
B1	Vss																			
B2	Vcc																			
B3	QSPI1_IO2	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
B4	RPC_INT#	I	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
B5	RPC_RESET#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
B6	QSPI0_IO3	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
B7	QSPI0_SPCLK	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
B8	P6_1	I(s)/ O	-	-	ET0_TXEN	O	VIO_CLK	I(s)	SCK3	I(s)/ O	MTIOC2A	I(s)/ O	-	-	-	-	-	RMII0_TXD_EN	O	(1)
B9	PF_5	I(s)/ O	-	-	TxD2	O	DV0_DATA20	I(s)	LCD0_DATA3	O	MTIOC6B	I(s)/ O	SSILRCK0	I(s)/ O	-	-	-	-	-	(1)
B10	PH_1	I(s)/ O	-	-	AUDIO_XOUT	O	VIO_D0	I(s)	GTIOC4B	I(s)/ O	MTIOC1B	I(s)/ O	CC2_Rd0	I(s)	IRQ2	I(s)	-	-	-	(1)
B11	PF_3	I(s)/ O	-	-	SCK2	I(s)/ O	DV0_DATA18	I(s)	LCD0_DATA5	O	MTIOC7D	I(s)/ O	SSL10	I(s)/ O	-	-	-	-	-	(1)
B12	PL_0	I(s)	MD_CLKS	I(s)	-	-	-	-	-	-	-	-	IRQ4	I(s)	-	-	-	-	-	(5)
B13	PE_5	I(s)/ O	-	-	ET0_MDC	O	VIO_D3	I(s)	SSITxD0	O	MTIOC0C	I(s)/ O	CC1_Rd1	I(s)	-	-	-	-	-	(1)
B14	P8_0	I(s)/ O	-	-	-	-	DV0_DATA14	I(s)	LCD0_DATA9	O	SCI_CTS1#/ RTS1#	I(s)/ O	MTIOC8D	I(s)/ O	-	-	-	-	-	(1)
B15	PE_3	I(s)/ O	-	-	ET0_RXER	I(s)	VIO_D5	I(s)	SSIBCK0	I(s)/ O	MTIOC0A	I(s)/ O	-	-	-	-	-	RMII0_RXER	I(s)	(1)
B16	PA_2	I(s)/ O	-	-	-	-	DV0_DATA11	I(s)	LCD0_DATA12	O	SCI_SCK1	I(s)/ O	MTIOC8A	I(s)/ O	-	-	-	-	-	(1)
B17	PA_4	I(s)/ O	-	-	-	-	DV0_DATA9	I(s)	LCD0_DATA14	O	SCI_TXD0	I(s)/ O	MTIOC0C	I(s)/ O	-	-	-	-	-	(1)
B18	PB_0	I(s)/ O	-	-	-	-	DV0_DATA5	I(s)	LCD0_DATA18	O	SSITxD1	O	POE8#	I(s)	-	-	-	-	-	(1)
B19	Vss																			
B20	PD_6	I(s)/ O(o)	-	-	RIIC3SCL	I(s)/ O(o)	IRQ6	I(s)	-	-	-	-	-	-	-	-	-	-	-	(4)
C1	PH_2	I(s)/ O	-	-	CTS2#	I(s)/ O	DV0_DATA22	I(s)	LCD0_DATA1	O	MTIOC6D	I(s)/ O	SSIRxD0	I(s)	-	-	-	-	-	(1)
C2	PK_1	I(s)/ O	-	-	ET1_TXD0	O	NFDATA4	I(s)/ O	CC1_Ra0	I(s)	CAN_CLK	I(s)	SSIDATA2	I(s)/ O	-	-	-	RMII1_TXD0	O	(1)

Table 2.3 List of Pins (272-Pin BGA)

Ball Number	Port Function/ Dedicated Function		Mode Function		Function 1		Function 2		Function 3		Function 4		Function 5		Function 6		Function 7		Simplified Circuit Diagram Figure 2.1	
	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O		
C3	Vcc																			
C4	QSPI1_SSL	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
C5	RPC_WP#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
C6	QSPI0_IO1	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
C7	QSPI0_IO2	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
C8	PF_6	I(s)/ O	-	-	RTS2#	I(s)/ O	DV0_DATA21	I(s)	LCD0_DATA2	O	MTIOC6C	I(s)/ O	SSITXD0	O	-	-	-	-	-	(1)
C9	PE_0	I(s)/ O	-	-	ET0_RXCLK	I(s)	VIO_FLD	I(s)	SCK2	I(s)/ O	POE4#	I(s)	-	-	-	-	REF50CK0	I(s)	-	(1)
C10	PF_4	I(s)/ O	-	-	RxD2	I(s)	DV0_DATA19	I(s)	LCD0_DATA4	O	MTIOC6A	I(s)/ O	SSIBCK0	I(s)/ O	IRQ1	I(s)	-	-	-	(1)
C11	PL_3	I(s)	MD_BOOT1	I(s)	-	-	-	-	-	-	-	-	IRQ7	I(s)	-	-	-	-	-	(5)
C12	PF_2	I(s)/ O	-	-	TxD3	O	DV0_DATA17	I(s)	LCD0_DATA6	O	MTIOC7C	I(s)/ O	MISO1	I(s)/ O	-	-	-	-	-	(1)
C13	PE_4	I(s)/ O	-	-	ET0_CRS	I(s)	VIO_D4	I(s)	SSLRCK0	I(s)/ O	MTIOC0B	I(s)/ O	-	-	-	-	RMII0_CRS_DV	I(s)	-	(1)
C14	PA_0	I(s)/ O	-	-	-	-	DV0_DATA13	I(s)	LCD0_DATA10	O	SCI_TXD1	I(s)/ O	MTIOC8C	I(s)/ O	-	-	-	-	-	(1)
C15	PE_1	I(s)/ O	-	-	ET0_RXD0	I(s)	VIO_D7	I(s)	RxD2	I(s)	POE8#	I(s)	VBUSIN1	I(s)	IRQ1	I(s)	RMII0_RXD0	I(s)	-	(1)
C16	PA_5	I(s)/ O	-	-	-	-	DV0_DATA8	I(s)	LCD0_DATA15	O	SCI_RXD0	I(s)/ O	MTIOC0B	I(s)/ O	IRQ5	I(s)	-	-	-	(1)
C17	PG_0	I(s)/ O	-	-	ET0_TXCLK	I(s)	VIO_D8	I(s)	RSPCK0	I(s)/ O	MTIOC3A	I(s)/ O	HM_RSTO#	I(s)	-	-	-	-	-	(1)
C18	Vss																			
C19	PD_7	I(s)/ O(o)	-	-	RIIC3SDA	I(s)/ O(o)	IRQ7	I(s)	-	-	-	-	-	-	-	-	-	-	-	(4)
C20	PD_5	I(s)/ O(o)	-	-	RIIC2SDA	I(s)/ O(o)	IRQ5	I(s)	-	-	-	-	-	-	-	-	-	-	-	(4)
D1	PH_3	I(s)/ O	-	-	HM_RSTO#	I(s)	RTS2#	I(s)/ O	GTIOC6A	I(s)/ O	MTIOC2A	I(s)/ O	SD0_CD	I(s)	IRQ3	I(s)	-	-	-	(1)
D2	PK_3	I(s)/ O	-	-	ET1_RXCLK	I(s)	NFDATA6	I(s)/ O	CC2_Rd0	I(s)	CAN0RX_DATARATE_EN	O	MOSI0	I(s)/ O	-	-	REF50CK1	I(s)	-	(1)
D3	PK_2	I(s)/ O	-	-	ET1_TXD1	O	NFDATA5	I(s)/ O	VBUSIN1	O	CAN0RX	I(s)	RSPCK0	I(s)/ O	IRQ5	I(s)	RMII1_TXD1	O	-	(1)
D4	Vcc																			
D5	QSPI1_IO0	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
D6	Vss																			
D7	PVcc_SPI																			
D8	PK_0	I(s)/ O	-	-	ET1_TXEN	O	NFDATA3	I(s)/ O	CC1_Rd0	I(s)	MTIOC1B	I(s)/ O	SSIBCK2	I(s)/ O	-	-	RMII1_TXD_EN	O	-	(1)
D9	P6_2	I(s)/ O	-	-	ET0_TXD0	O	VIO_VD	I(s)	RxD3	I(s)	MTIOC2B	I(s)/ O	OTG_EXICEN1	O	IRQ0	I(s)	RMII0_TXD0	O	-	(1)
D10	PH_0	I(s)/ O	-	-	AUDIO_CLK	I(s)	VIO_D1	I(s)	GTIOC4A	I(s)/ O	MTIOC1A	I(s)/ O	CC1_Rd0	I(s)	IRQ3	I(s)	-	-	-	(1)
D11	PVcc																			
D12	Vss																			
D13	PF_0	I(s)/ O	-	-	SCK3	I(s)/ O	DV0_DATA15	I(s)	LCD0_DATA8	O	MTIOC7A	I(s)/ O	RSPCK1	I(s)/ O	-	-	-	-	-	(1)
D14	PA_1	I(s)/ O	-	-	-	-	DV0_DATA12	I(s)	LCD0_DATA11	O	SCI_RXD1	I(s)/ O	MTIOC8B	I(s)/ O	IRQ6	I(s)	-	-	-	(1)
D15	PA_7	I(s)/ O	-	-	-	-	DV0_DATA6	I(s)	LCD0_DATA17	O	SSIRxD1	I(s)	POE10#	I(s)	-	-	-	-	-	(1)
D16	PVcc																			
D17	Vss																			
D18	PD_4	I(s)/ O(o)	-	-	RIIC2SCL	I(s)/ O(o)	IRQ4	I(s)	-	-	-	-	-	-	-	-	-	-	-	(4)
D19	PD_3	I(s)/ O(o)	-	-	RIIC1SDA	I(s)/ O(o)	IRQ3	I(s)	MTCLKD	I(s)	GTETRGD	I(s)	-	-	-	-	-	-	-	(4)
D20	PD_1	I(s)/ O(o)	-	-	RIIC0SDA	I(s)/ O(o)	IRQ1	I(s)	MTCLKB	I(s)	GTETRGB	I(s)	-	-	-	-	-	-	-	(4)
E1	Vss																			
E2	BSCANP	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(12)

Table 2.3 List of Pins (272-Pin BGA)

Ball Number	Port Function/ Dedicated Function		Mode Function		Function 1		Function 2		Function 3		Function 4		Function 5		Function 6		Function 7		Simplified Circuit Diagram Figure 2.1
	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	
E3	PF_7	I(s)/ O	-	-	GTETRGD	I(s)	DV0_DATA23	I(s)	LCD0_DATA0	O	MTCLKD	I(s)	IRQ1	I(s)	-	-	-	-	(1)
E4	PVcc																		
E17	PVcc																		
E18	PD_2	I(s)/ O(o)	-	-	RIIC0SCL	I(s)/ O(o)	IRQ2	I(s)	MTCLKC	I(s)	GTETRC	I(s)	-	-	-	-	-	-	(4)
E19	TCK/ SWDCLK	I	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(7)
E20	JP0_0	I	-	-	TDI	I	-	-	-	-	-	-	-	-	-	-	-	-	(6)
F1	HM_RWDS/ OM_DQS	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
F2	HM_CK#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
F3	HM_CK/ OM_SCLK	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
F4	Vss																		
F17	TMS/SWDIO	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(9)
F18	PD_0	I(s)/ O(o)	-	-	RIIC0SCL	I(s)/ O(o)	IRQ0	I(s)	MTCLKA	I(s)	GTETRG	I(s)	-	-	-	-	-	-	(4)
F19	TRST#	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(10)
F20	JP0_1	O	-	-	TDO/SWO	O	-	-	-	-	-	-	-	-	-	-	-	-	(8)
G1	HM_DQ2/ OM_SIO2	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
G2	HM_DQ1/ OM_SIO1	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
G3	HM_CS0#/ OM_CS0#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
G4	PVcc_HO																		
G17	Vss																		
G18	PB_1	I(s)/ O	-	-	-	-	DV0_DATA4	I(s)	LCD0_DATA19	O	SSILRCK1	I(s)/ O	POE4#	I(s)	-	-	-	-	(1)
G19	PB_2	I(s)/ O	-	-	-	-	DV0_DATA3	I(s)	LCD0_DATA20	O	SSIBCK1	I(s)/ O	POE0#	I(s)	-	-	-	-	(1)
G20	PB_3	I(s)/ O	-	-	-	-	DV0_DATA2	I(s)	LCD0_DATA21	O	SSIDATA2	I(s)/ O	CTS0#	I(s)/ O	-	-	-	-	(1)
H1	HM_DQ3/ OM_SIO3	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
H2	HM_DQ6/ OM_SIO6	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
H3	HM_DQ4/ OM_SIO4	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
H4	HM_CS1#/ OM_CS1#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
H17	PVcc																		
H18	PB_5	I(s)/ O	-	-	-	-	DV0_DATA0	I(s)	LCD0_DATA23	O	SSIBCK2	I(s)/ O	TxD0	O	-	-	-	-	(1)
H19	PB_4	I(s)/ O	-	-	-	-	DV0_DATA1	I(s)	LCD0_DATA22	O	SSILRCK2	I(s)/ O	RTS0#	I(s)/ O	-	-	-	-	(1)
H20	P7_7	I(s)/ O	-	-	-	-	DV0_HSYNC	I(s)	LCD0_TCON0	O	GTIOC3B	I(s)/ O	RxD0	I(s)	-	-	-	-	(1)
J1	HM_RESET#/ OM_RESET#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
J2	HM_DQ7/ OM_SIO7	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
J3	HM_DQ5/ OM_SIO5	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
J4	HM_DQ0/ OM_SIO0	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
J9	Vcc																		
J10	Vss																		
J11	Vss																		
J12	Vcc																		
J17	P7_6	I(s)/ O	-	-	-	-	DV0_VSYNC	I(s)	LCD0_TCON1	O	GTIOC3A	I(s)/ O	SCK0	I(s)/ O	-	-	-	-	(1)
J18	PG_2	I(s)/ O	-	-	ET0_TXD3	O	VIO_D10	I(s)	MISO0	I(s)/ O	MTIOC3B	I(s)/ O	GTIOC0A	I(s)/ O	IRQ4	I(s)	-	-	(1)

Table 2.3 List of Pins (272-Pin BGA)

Ball Number	Port Function/ Dedicated Function		Mode Function		Function 1		Function 2		Function 3		Function 4		Function 5		Function 6		Function 7		Simplified Circuit Diagram Figure 2.1
	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	
J19	PG_1	I(s)/ O	-	-	ET0_TXD2	O	VIO_D9	I(s)	MOSIO	I(s)/ O	MTIOC3C	I(s)/ O	HM_INT#/ OM_ECS#	I(s)	-	-	-	-	(1)
J20	P7_2	I(s)/ O	-	-	-	-	DV0_CLK	I(s)	LCD0_TCON 2	O	TEND0	O	CC2_Ra0	I(s)	-	-	-	-	(1)
K1	PJ_7	I(s)/ O	-	-	GTETRGB	I(s)	NFDATA0	I(s)/ O	LCD0_EXTCLK	I(s)	MTCLKB	I(s)	-	-	-	-	-	-	(1)
K2	PJ_6	I(s)/ O	-	-	GTETRGC	I(s)	NFCE#	O	LCD0_CLK	O	MTCLKC	I(s)	IRQ0	I(s)	-	-	-	-	(1)
K3	PH_4	I(s)/ O	-	-	HM_INT#/ OM_ECS#	I(s)	CTS2#	I(s)/ O	GTIOC6B	I(s)/ O	MTIOC2B	I(s)/ O	SD0_WP	I(s)	IRQ2	I(s)	-	-	(1)
K4	PJ_0	I(s)/ O	-	-	TRACECLK	O	SPDIF_OUT	O	-	-	SCK1	I(s)/ O	SSIRxD3	I(s)	-	-	-	-	(1)
K9	Vcc																		
K10	Vss																		
K11	Vss																		
K12	Vcc																		
K17	PVcc																		
K18	PG_3	I(s)/ O	-	-	ET0_COL	I(s)	VIO_D11	I(s)	SSL00	I(s)/ O	MTIOC3D	I(s)/ O	GTIOC0B	I(s)/ O	-	-	-	-	(1)
K19	P6_7	I(s)/ O	-	-	-	-	DRP03*	I(s)/ O	LCD0_TCON 3	O	DACK0	O	CC2_Rd0	I(s)	-	-	-	-	(1)
K20	PVcc																		
L1	PJ_1	I(s)/ O	-	-	TRACECTL	O	SPDIF_IN	I(s)	-	-	RxD1	I(s)	VBUSIN0	I(s)	IRQ0	I(s)	-	-	(1)
L2	PJ_3	I(s)/ O	-	-	TRACE DATA1	O	NFDATA0	I(s)/ O	-	-	RTS1#	I(s)/ O	SSLRCK3	I(s)/ O	-	-	-	-	(1)
L3	PH_5	I(s)/ O	-	-	HM_RSTO#	I(s)	NFDATA2	I(s)/ O	ET1_EXOUT/ ET1_SCLKIN	I(s)/ O	MTIC5U	I(s)	IRQ5	I(s)	-	-	-	-	(1)
L4	PVcc																		
L9	Vcc																		
L10	Vss																		
L11	Vss																		
L12	Vcc																		
L17	Vss																		
L18	P6_0	I(s)/ O	-	-	ADTRG#	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	(1)
L19	P6_5	I(s)/ O	-	-	-	-	DRP01*	I(s)/ O	LCD0_TCON5	O	AUDIO_XOUT	O	CC1_Rd0	I(s)	-	-	-	-	(1)
L20	Vss																		
M1	PH_6	I(s)/ O	-	-	HM_INT#/ OM_ECS#	I(s)	NFDATA3	I(s)/ O	ET1_WOL	O	MTIC5V	I(s)	IRQ4	I(s)	-	-	-	-	(1)
M2	PJ_2	I(s)/ O	-	-	TRACE DATA0	O	NFCE#	O	-	-	TxD1	O	SSITxD3	O	-	-	-	-	(1)
M3	PK_5	I(s)/ O	-	-	GTETRGA	I(s)	NFDATA1	I(s)/ O	WDTOVF#/ PERROUT#	O	MTCLKA	I(s)	-	-	-	-	-	-	(1)
M4	Vss																		
M9	Vcc																		
M10	Vss																		
M11	Vss																		
M12	Vcc																		
M17	PVcc_SD0																		
M18	P6_4	I(s)/ O	-	-	-	-	DRP00*	I(s)/ O	LCD0_TCON6	O	AUDIO_CLK	I(s)	SD1_CD	I(s)	-	-	-	-	(1)
M19	P6_6	I(s)/ O	-	-	-	-	DRP02*	I(s)/ O	LCD0_TCON4	O	DREQ0	I(s)	CC1_Ra0	I(s)	-	-	-	-	(1)
M20	SD0_RST#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
N1	PVcc																		
N2	PJ_5	I(s)/ O	-	-	TRACE DATA3	O	NFDATA2	I(s)/ O	OVRCUR0	I(s)	MTIOC1A	I(s)/ O	SSLRCK2	I(s)/ O	IRQ4	I(s)	-	-	(1)
N3	PJ_4	I(s)/ O	-	-	TRACE DATA2	O	NFDATA1	I(s)/ O	-	-	CTS1#	I(s)/ O	SSIBCK3	I(s)/ O	-	-	-	-	(1)
N4	PVcc																		
N17	SD0_DAT0	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)

Table 2.3 List of Pins (272-Pin BGA)

Ball Number	Port Function/ Dedicated Function		Mode Function		Function 1		Function 2		Function 3		Function 4		Function 5		Function 6		Function 7		Simplified Circuit Diagram Figure 2.1
	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	
N18	SD0_DAT5	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
N19	SD0_DAT7	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
N20	SD0_DAT6	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
P1	AUDIO_X1	I	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(13)
P2	AUDIO_X2	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(13)
P3	P3_5	I(s)/ O	-	-	ET1_RXD1	I(s)	NFCLE	O	CC2_Ra0	I(s)	CAN0TX DATARATE_ EN	O	SSL00	I(s)/ O	-	-	RMII1_RXD1	I(s)	(1)
P4	PK_4	I(s)/ O	-	-	ET1_RXD0	I(s)	NFDATA7	I(s)/ O	OVRCUR1	I(s)	CAN0TX	O	MISO0	I(s)/ O	IRQ6	I(s)	RMII1_RXD0	I(s)	(1)
P17	PVcc_SD1																		
P18	SD0_DAT2	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
P19	SD0_DAT3	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
P20	SD0_DAT4	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
R1	Vss																		
R2	P3_1	I(s)/ O	-	-	ET1_RXER	I(s)	NFALE	O	VBUSEN0	I(s)	CAN1RX	I(s)	RSPCK2	I(s)/ O	IRQ6	I(s)	RMII1_RXER	I(s)	(1)
R3	PG_4	I(s)/ O	-	-	ET0_TXER	O	VIO_D15	I(s)	RSPCK1	I(s)/ O	MTIOC4A	I(s)/ O	GTIOC1A	I(s)/ O	-	-	-	-	(1)
R4	MIPIAVcc18																		
R17	Vss																		
R18	SD0_CMD	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
R19	SD0_DAT1	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
R20	SD0_CLK	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
T1	CSI_CLKP	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
T2	CSI_CLKN	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
T3	P3_2	I(s)/ O	-	-	ET1_CRS	I(s)	NFRE#	O	CC1_Ra1	I(s)	CAN1RX DATARATE_ EN	O	MOSI2	I(s)/ O	-	-	RMII1_CRS_DV	I(s)	(1)
T4	Vss																		
T17	AVss																		
T18	SD1_DAT0	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
T19	SD1_CLK	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
T20	Vss																		
U1	CSI_DATA0P	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
U2	CSI_DATA0N	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
U3	Vss																		
U4	PG_6	I(s)/ O	-	-	ET0_RXD2	I(s)	VIO_D13	I(s)	MISO1	I(s)/ O	MTIOC4C	I(s)/ O	GTIOC2A	I(s)/ O	IRQ5	I(s)	-	-	(1)
U5	PC_0	I(s)/ O	-	-	VBUSIN1	I(s)	NFDATA5	I(s)/ O	ET1_TXCLK	I(s)	RSPCK2	I(s)/ O	IRQ2	I(s)	-	-	-	-	(1)
U6	P3_3	I(s)/ O	-	-	ET1_MDC	O	NFWE#	O	OTG_EXICE N0	O	CAN1TX	O	MISO2	I(s)/ O	IRQ7	I(s)	-	-	(1)
U7	P4_6	I(s)/ O	-	-	ET0_EXOUT/ ET0_SCLKIN	I(s)/ O	TXCLKOUTP	O	SCI_TXD0	I(s)/ O	TxD4	O	DACK0	O	-	-	-	-	(1)
U8	LVDSPLLVcc																		
U9	LVDSAPVcc																		
U10	USBDPVcc0																		
U11	RREF0																		
U12	RREF1																		
U13	Vss																		
U14	PLLvcc																		
U15	PVcc																		
U16	PC_6	I(s)/ O	-	-	VBUSEN0	O	NFWE#	O	ET1_RXD2	I(s)	SD1_CD	I(s)	LCD0_ TCON1	O	IRQ7	I(s)	-	-	(1)
U17	AVcc																		
U18	SD1_CMD	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
U19	SD1_DAT1	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
U20	SD1_DAT2	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)

Table 2.3 List of Pins (272-Pin BGA)

Ball Number	Port Function/ Dedicated Function	Mode Function		Function 1		Function 2		Function 3		Function 4		Function 5		Function 6		Function 7		Simplified Circuit Diagram Figure 2.1	
		Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O		
V1	CSI_DATA1P	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
V2	CSI_DATA1N	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
V3	Vss																		
V4	P3_4	I(s)/ O	-	-	ET1_MDIO	I(s)/ O	NFRB#	I(s)	CC2_Ra1	I(s)	CAN1TX_ Datarate_ EN	O	SSL20	I(s)/ O	-	-	-	-	(1)
V5	PC_2	I(s)/ O	-	-	OTG_ EXICEN0	O	NFDATA7	I(s)/ O	ET1_TXD3	O	MISO2	I(s)/ O	LCD0_ TCON5	O	-	-	-	-	(1)
V6	P4_2	I(s)/ O	-	-	TxD0	O	TXOUT1P	O	SCI_TXD1	I(s)/ O	SSITxD1	O	MTIOC8C	I(s)/ O	IRQ2	I(s)	-	-	(1)
V7	P4_7	I(s)/ O	-	-	ET0_WOL	O	TXCLKOUTM	O	SCI_SCK0	I(s)/ O	SCK4	I(s)/ O	TEND0	O	-	-	-	-	(1)
V8	Vss																		
V9	Vss																		
V10	USBVss																		
V11	USBVss																		
V12	USBVss																		
V13	Vss																		
V14	PC_3	I(s)/ O	-	-	OTG_ID0	I(s)	NFCLE	O	ET1_COL	I(s)	SSL20	I(s)/ O	LCD0_ TCON4	O	-	-	-	-	(1)
V15	PC_5	I(s)/ O	-	-	VBUSEN1	O	NFRE#	O	ET1_RXDV	I(s)	SPDIF_OUT	O	LCD0_ TCON2	O	IRQ0	I(s)	-	-	(1)
V16	PC_7	I(s)/ O	-	-	OVRCUR0	I(s)	NFRB#	I(s)	ET1_RXD3	I(s)	SD1_WP	I(s)	LCD0_ TCON0	O	IRQ6	I(s)	-	-	(1)
V17	P5_0	I(s)	-	-	AN000	I(a)	IRQ4	I(s)	SD0_CD	I(s)	SD1_CD	I(s)	-	-	-	-	-	-	(3)
V18	P5_6	I(s)	-	-	AN006	I(a)	IRQ2	I(s)	-	-	-	-	-	-	-	-	-	-	(3)
V19	P5_7	I(s)	-	-	AN007	I(a)	IRQ3	I(s)	-	-	-	-	-	-	-	-	-	-	(3)
V20	SD1_DAT3	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
W1	MIPiAVcc18																		
W2	Vss																		
W3	PG_5	I(s)/ O	-	-	ET0_RXDV	I(s)	VIO_D14	I(s)	MOSI1	I(s)/ O	MTIOC4B	I(s)/ O	GTIOC1B	I(s)/ O	-	-	-	-	(1)
W4	P3_0	I(s)/ O	-	-	OTG_ EXICEN1	O	NFDATA4	I(s)/ O	ET1_ LINKSTA	I(s)	MTIC5W	I(s)	IRQ3	I(s)	-	-	-	-	(1)
W5	P4_1	I(s)/ O	-	-	RxD0	I(s)	TXOUT0M	O	SCI_RXD1	I(s)/ O	SSIRxD1	I(s)	MTIOC8B	I(s)/ O	IRQ1	I(s)	-	-	(1)
W6	P4_3	I(s)/ O	-	-	RTS0#	I(s)/ O	TXOUT1M	O	SCI_CTS1#/ RTS1#	I(s)/ O	SSLRCK1	I(s)/ O	MTIOC8D	I(s)/ O	IRQ3	I(s)	-	-	(1)
W7	NMI	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(10)
W8	USB_X2	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(13)
W9	USBVss																		
W10	DP0	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
W11	USBAPVcc0																		
W12	USBAPVcc1																		
W13	DM1	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
W14	USBDPVcc1																		
W15	PC_4	I(s)/ O	-	-	OTG_ID1	I(s)	NFALE	O	ET1_TXER	O	SPDIF_IN	I(s)	LCD0_ TCON3	O	IRQ1	I(s)	-	-	(1)
W16	XTAL	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(13)
W17	RTC_X2	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(14)
W18	P5_4	I(s)	-	-	AN004	I(a)	IRQ0	I(s)	SD1_CD	I(s)	-	-	-	-	-	-	-	-	(3)
W19	P5_3	I(s)	-	-	AN003	I(a)	IRQ7	I(s)	OTG_ID0	I(s)	-	-	-	-	-	-	-	-	(3)
W20	P5_5	I(s)	-	-	AN005	I(a)	IRQ1	I(s)	SD1_WP	I(s)	-	-	-	-	-	-	-	-	(3)
Y1	Vss																		
Y2	PG_7	I(s)/ O	-	-	ET0_RXD3	I(s)	VIO_D12	I(s)	SSL10	I(s)/ O	MTIOC4D	I(s)/ O	GTIOC2B	I(s)/ O	-	-	-	-	(1)
Y3	PC_1	I(s)/ O	-	-	VBUSIN0	I(s)	NFDATA6	I(s)/ O	ET1_TXD2	O	MOSI2	I(s)/ O	LCD0_ TCON6	O	-	-	-	-	(1)
Y4	P4_0	I(s)/ O	-	-	SCK0	I(s)/ O	TXOUT0P	O	SCI_SCK1	I(s)/ O	SSIBCK1	I(s)/ O	MTIOC8A	I(s)/ O	IRQ0	I(s)	-	-	(1)

Table 2.3 List of Pins (272-Pin BGA)

Ball Number	Port Function/ Dedicated Function		Mode Function		Function 1		Function 2		Function 3		Function 4		Function 5		Function 6		Function 7		Simplified Circuit Diagram Figure 2.1
	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	
Y5	P4_4	I(s)/ O	-	-	CTS0#	I(s)/ O	TXOUT2P	O	SCL_CTS0#/ RTS0#	I(s)/ O	WDTOVF#/ PERROUT#	O	OTG_ EXICEN0	O	-	-	-	-	(1)
Y6	P4_5	I(s)/ O	-	-	ET0_ LINKSTA	I(s)	TXOUT2M	O	SCL_RXD0	I(s)/ O	RxD4	I(s)	DREQ0	I(s)	-	-	-	-	(1)
Y7	RES#	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(12)
Y8	USB_X1	I	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(13)
Y9	USBVss																		
Y10	DM0	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
Y11	USBVss																		
Y12	USBVss																		
Y13	DP1	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
Y14	USBVss																		
Y15	EXTAL	I	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(13)
Y16	Vss																		
Y17	RTC_X1	I	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(14)
Y18	P5_2	I(s)	-	-	AN002	I(a)	IRQ6	I(s)	VBUSIN0	I(s)	-	-	-	-	-	-	-	-	(3)
Y19	P5_1	I(s)	-	-	AN001	I(a)	IRQ5	I(s)	SD0_WP	I(s)	SD1_WP	I(s)	-	-	-	-	-	-	(3)
Y20	Vss																		

[Legend]

(s): Schmitt

(a): Analog

(o): Open drain

Note: * Only in products with a DRP

Table 2.4 List of Pins (256-Pin BGA)

Ball Number	Port Function/ Dedicated Function		Mode Function		Function 1		Function 2		Function 3		Function 4		Function 5		Function 6		Function 7		Simplified Circuit Diagram Figure 2.1	
	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O		
A1	Vcc																			
A2	QSPI1_SSL	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
A3	QSPI1_IO3	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
A4	QSPI1_SPCLK	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
A5	RPC_RESET#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
A6	PVcc_SPI																			
A7	Vss																			
A8	QSPI0_SPCLK	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
A9	P6_1	I(s)/ O	-	-	ET0_TXEN	O	VIO_CLK	I(s)	SCK3	I(s)/ O	MTIOC2A	I(s)/ O	-	-	-	-	-	RMII0_TXD_EN	O	(1)
A10	P6_3	I(s)/ O	-	-	ET0_TXD1	O	VIO_HD	I(s)	TxD3	O	POE0#	I(s)	-	-	-	-	-	RMII0_TXD1	O	(1)
A11	PE_6	I(s)/ O	-	-	ET0_MDIO	I(s)/ O	VIO_D2	I(s)	SSIRxD0	I(s)	MTIOC0D	I(s)/ O	CC2_Rd1	I(s)	-	-	-	-	-	(1)
A12	PL_4	I(s)	MD_BOOT0	I(s)	-	-	-	-	-	-	-	-	IRQ0	I(s)	-	-	-	-	-	(5)
A13	PL_0	I(s)	MD_CLKS	I(s)	-	-	-	-	-	-	-	-	IRQ4	I(s)	-	-	-	-	-	(5)
A14	PE_5	I(s)/ O	-	-	ET0_MDC	O	VIO_D3	I(s)	SSITxD0	O	MTIOC0C	I(s)/ O	CC1_Rd1	I(s)	-	-	-	-	-	(1)
A15	PE_4	I(s)/ O	-	-	ET0_CRS	I(s)	VIO_D4	I(s)	SSILRCK0	I(s)/ O	MTIOC0B	I(s)/ O	-	-	-	-	-	RMII0_CRS_DV	I(s)	(1)
A16	PE_3	I(s)/ O	-	-	ET0_RXER	I(s)	VIO_D5	I(s)	SSIBCK0	I(s)/ O	MTIOC0A	I(s)/ O	-	-	-	-	-	RMII0_RXER	I(s)	(1)
A17	PA_2	I(s)/ O	-	-	-	-	DV0_DATA11	I(s)	LCD0_DATA12	O	SCI_SCK1	I(s)/ O	MTIOC8A	I(s)/ O	-	-	-	-	-	(1)
A18	PE_1	I(s)/ O	-	-	ET0_RXD0	I(s)	VIO_D7	I(s)	RxD2	I(s)	POE8#	I(s)	VBUSIN1	I(s)	IRQ1	I(s)	RMII0_RXD0	I(s)	(1)	
A19	PA_6	I(s)/ O	-	-	-	-	DV0_DATA7	I(s)	LCD0_DATA16	O	SCI_SCK0	I(s)/ O	MTIOC0A	I(s)/ O	-	-	-	-	-	(1)
A20	CKIO	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(11)
A21	Vss																			
B1	PK_1	I(s)/ O	-	-	ET1_TXD0	O	NFDATA4	I(s)/ O	CC1_Ra0	I(s)	CAN_CLK	I(s)	SSIDATA2	I(s)/ O	-	-	-	RMII1_TXD0	O	(1)
B2	Vcc																			
B3	QSPI1_IO0	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
B4	QSPI1_IO1	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
B5	RPC_INT#	I	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
B6	QSPI0_SSL	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
B7	QSPI0_IO3	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
B8	QSPI0_IO1	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
B9	PF_5	I(s)/ O	-	-	TxD2	O	DV0_DATA20	I(s)	LCD0_DATA3	O	MTIOC6B	I(s)/ O	SSILRCK0	I(s)/ O	-	-	-	-	-	(1)
B10	PF_4	I(s)/ O	-	-	RxD2	I(s)	DV0_DATA19	I(s)	LCD0_DATA4	O	MTIOC6A	I(s)/ O	SSIBCK0	I(s)/ O	IRQ1	I(s)	-	-	-	(1)
B11	PH_1	I(s)/ O	-	-	AUDIO_XOUT	O	VIO_D0	I(s)	GTIOC4B	I(s)/ O	MTIOC1B	I(s)/ O	CC2_Rd0	I(s)	IRQ2	I(s)	-	-	-	(1)
B12	PL_1	I(s)	MD_CLK	I(s)	-	-	-	-	-	-	-	-	IRQ5	I(s)	-	-	-	-	-	(5)
B13	PL_2	I(s)	MD_BOOT2	I(s)	-	-	-	-	-	-	-	-	IRQ6	I(s)	-	-	-	-	-	(5)
B14	P8_0	I(s)/ O	-	-	-	-	DV0_DATA14	I(s)	LCD0_DATA9	O	SCI_CTS1#/RTS1#	I(s)/ O	MTIOC8D	I(s)/ O	-	-	-	-	-	(1)
B15	PF_1	I(s)/ O	-	-	RxD3	I(s)	DV0_DATA16	I(s)	LCD0_DATA7	O	MTIOC7B	I(s)/ O	MOSI1	I(s)/ O	IRQ4	I(s)	-	-	-	(1)
B16	PA_0	I(s)/ O	-	-	-	-	DV0_DATA13	I(s)	LCD0_DATA10	O	SCI_TXD1	I(s)/ O	MTIOC8C	I(s)/ O	-	-	-	-	-	(1)
B17	PA_7	I(s)/ O	-	-	-	-	DV0_DATA6	I(s)	LCD0_DATA17	O	SSIRxD1	I(s)	POE10#	I(s)	-	-	-	-	-	(1)
B18	PA_4	I(s)/ O	-	-	-	-	DV0_DATA9	I(s)	LCD0_DATA14	O	SCI_TXD0	I(s)/ O	MTIOC0C	I(s)/ O	-	-	-	-	-	(1)
B19	PB_0	I(s)/ O	-	-	-	-	DV0_DATA5	I(s)	LCD0_DATA18	O	SSITxD1	O	POE8#	I(s)	-	-	-	-	-	(1)
B20	Vss																			
B21	PD_3	I(s)/ O(o)	-	-	RIIC1SDA	I(s)/ O(o)	IRQ3	I(s)	MTCLKD	I(s)	GTETRGD	I(s)	-	-	-	-	-	-	-	(4)
C1	PK_3	I(s)/ O	-	-	ET1_RXCLK	I(s)	NFDATA6	I(s)/ O	CC2_Rd0	I(s)	CAN0RX_DATARATE_EN	O	MOSI0	I(s)/ O	-	-	-	REF50CK1	I(s)	(1)

Table 2.4 List of Pins (256-Pin BGA)

Ball Number	Port Function/ Dedicated Function		Mode Function		Function 1		Function 2		Function 3		Function 4		Function 5		Function 6		Function 7		Simplified Circuit Diagram Figure 2.1	
	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O		
C2	PH_2	I(s)/ O	-	-	CTS2#	I(s)/ O	DV0_DATA22	I(s)	LCD0_DATA1	O	MTIOC6D	I(s)/ O	SSIRxD0	I(s)	-	-	-	-	(1)	
C20	PD_7	I(s)/ O(o)	-	-	RIIC3SDA	I(s)/ O(o)	IRQ7	I(s)	-	-	-	-	-	-	-	-	-	-	(4)	
C21	PD_1	I(s)/ O(o)	-	-	RIIC0SDA	I(s)/ O(o)	IRQ1	I(s)	MTCLKB	I(s)	GTETRGB	I(s)	-	-	-	-	-	-	(4)	
D1	HM_CK/ OM_SCLK	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	
D2	BSCANP	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(12)	
D4	Vcc																			
D5	QSPI1_I02	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	
D6	RPC_WP#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	
D7	QSPI0_I02	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	
D8	PK_0	I(s)/ O	-	-	ET1_TXEN	O	NFDATA3	I(s)/ O	CC1_Rd0	I(s)	MTIOC1B	I(s)/ O	SSIBCK2	I(s)/ O	-	-	-	RMII1_TXD_EN	O	(1)
D9	P6_2	I(s)/ O	-	-	ET0_TXD0	O	VIO_VD	I(s)	RxD3	I(s)	MTIOC2B	I(s)/ O	OTG_EXICEN1	O	IRQ0	I(s)	RMII0_TXD0	O	(1)	
D10	PH_0	I(s)/ O	-	-	AUDIO_CLK	I(s)	VIO_D1	I(s)	GTIOC4A	I(s)/ O	MTIOC1A	I(s)/ O	CC1_Rd0	I(s)	IRQ3	I(s)	-	-	(1)	
D11	PF_3	I(s)/ O	-	-	SCK2	I(s)/ O	DV0_DATA18	I(s)	LCD0_DATA5	O	MTIOC7D	I(s)/ O	SSL10	I(s)/ O	-	-	-	-	(1)	
D12	PF_2	I(s)/ O	-	-	TxD3	O	DV0_DATA17	I(s)	LCD0_DATA6	O	MTIOC7C	I(s)/ O	MISO1	I(s)/ O	-	-	-	-	(1)	
D13	PF_0	I(s)/ O	-	-	SCK3	I(s)/ O	DV0_DATA15	I(s)	LCD0_DATA8	O	MTIOC7A	I(s)/ O	RSPCK1	I(s)/ O	-	-	-	-	(1)	
D14	PE_2	I(s)/ O	-	-	ET0_RXD1	I(s)	VIO_D6	I(s)	TxD2	O	POE10#	I(s)	-	-	-	-	RMII0_RXD1	I(s)	(1)	
D15	PA_1	I(s)/ O	-	-	-	-	DV0_DATA12	I(s)	LCD0_DATA11	O	SCI_RXD1	I(s)/ O	MTIOC8B	I(s)/ O	IRQ6	I(s)	-	-	(1)	
D16	PG_0	I(s)/ O	-	-	ET0_TXCLK	I(s)	VIO_D8	I(s)	RSPCK0	I(s)/ O	MTIOC3A	I(s)/ O	HM_RSTO#	I(s)	-	-	-	-	(1)	
D17	PA_5	I(s)/ O	-	-	-	-	DV0_DATA8	I(s)	LCD0_DATA15	O	SCI_RXD0	I(s)/ O	MTIOC0B	I(s)/ O	IRQ5	I(s)	-	-	(1)	
D18	Vss																			
D20	PD_5	I(s)/ O(o)	-	-	RIIC2SDA	I(s)/ O(o)	IRQ5	I(s)	-	-	-	-	-	-	-	-	-	-	(4)	
D21	JP0_0	I	-	-	TDI	I	-	-	-	-	-	-	-	-	-	-	-	-	(6)	
E1	HM_CK#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	
E2	HM_CS0#/ OM_CS0#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	
E4	PK_2	I(s)/ O	-	-	ET1_TXD1	O	NFDATA5	I(s)/ O	VBUSEN1	O	CAN0RX	I(s)	RSPCK0	I(s)/ O	IRQ5	I(s)	RMII1_TXD1	O	(1)	
E5	Vcc																			
E6	Vss																			
E7	PVcc																			
E8	QSPI0_I00	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	
E9	PF_6	I(s)/ O	-	-	RTS2#	I(s)/ O	DV0_DATA21	I(s)	LCD0_DATA2	O	MTIOC6C	I(s)/ O	SSITxD0	O	-	-	-	-	(1)	
E10	PE_0	I(s)/ O	-	-	ET0_RXCLK	I(s)	VIO_FLD	I(s)	SCK2	I(s)/ O	POE4#	I(s)	-	-	-	-	REF50CK0	I(s)	(1)	
E11	PL_3	I(s)	MD_BOOT1	I(s)	-	-	-	-	-	-	-	-	-	-	IRQ7	I(s)	-	-	(5)	
E12	Vcc																			
E13	Vss																			
E14	PVcc																			
E15	PA_3	I(s)/ O	-	-	-	-	DV0_DATA10	I(s)	LCD0_DATA13	O	SCI_CTS0#/ RTS0#	I(s)/ O	MTIOC0D	I(s)/ O	-	-	-	-	(1)	
E16	Vcc																			
E17	Vss																			
E18	TCK/ SWDCLK	I	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(7)	
E20	PD_0	I(s)/ O(o)	-	-	RIIC0SCL	I(s)/ O(o)	IRQ0	I(s)	MTCLKA	I(s)	GTETRGA	I(s)	-	-	-	-	-	-	(4)	
E21	TRST#	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(10)	
F1	HM_DQ1/ OM_SIO1	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	
F2	HM_RWDS/ OM_DQS	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	

Table 2.4 List of Pins (256-Pin BGA)

Ball Number	Port Function/ Dedicated Function		Mode Function		Function 1		Function 2		Function 3		Function 4		Function 5		Function 6		Function 7		Simplified Circuit Diagram Figure 2.1
	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	
F4	PF_7	I(s)/ O	-	-	GTETRGD	I(s)	DV0_DATA23	I(s)	LCD0_DATA0	O	MTCLKD	I(s)	IRQ1	I(s)	-	-	-	-	(1)
F5	Vss																		
F17	PD_6	I(s)/ O(o)	-	-	RIIC3SCL	I(s)/ O(o)	IRQ6	I(s)	-	-	-	-	-	-	-	-	-	-	(4)
F18	PD_2	I(s)/ O(o)	-	-	RIIC1SCL	I(s)/ O(o)	IRQ2	I(s)	MTCLKC	I(s)	GTETRC	I(s)	-	-	-	-	-	-	(4)
F20	JP0_1	O	-	-	TDO/SWO	O	-	-	-	-	-	-	-	-	-	-	-	-	(8)
F21	PB_1	I(s)/ O	-	-	-	-	DV0_DATA4	I(s)	LCD0_DATA19	O	SSILRCK1	I(s)/ O	POE4#	I(s)	-	-	-	-	(1)
G1	PVcc_HO																		
G2	HM_DQ2/ OM_SIO2	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
G4	HM_DQ4/ OM_SIO4	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
G5	PVcc																		
G17	PD_4	I(s)/ O(o)	-	-	RIIC2SCL	I(s)/ O(o)	IRQ4	I(s)	-	-	-	-	-	-	-	-	-	-	(4)
G18	TMS/SWDIO	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(9)
G20	PB_3	I(s)/ O	-	-	-	-	DV0_DATA2	I(s)	LCD0_DATA21	O	SSIDATA2	I(s)/ O	CTS0#	I(s)/ O	-	-	-	-	(1)
G21	PB_5	I(s)/ O	-	-	-	-	DV0_DATA0	I(s)	LCD0_DATA23	O	SSIBCK2	I(s)/ O	TxD0	O	-	-	-	-	(1)
H1	Vss																		
H2	HM_DQ6/ OM_SIO6	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
H4	HM_CS1#/ OM_CS1#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
H5	PH_3	I(s)/ O	-	-	HM_RSTO#	I(s)	RTS2#	I(s)/ O	GTIOC6A	I(s)/ O	MTIOC2A	I(s)/ O	SD0_CD	I(s)	IRQ3	I(s)	-	-	(1)
H17	PB_2	I(s)/ O	-	-	-	-	DV0_DATA3	I(s)	LCD0_DATA20	O	SSIBCK1	I(s)/ O	POE0#	I(s)	-	-	-	-	(1)
H18	PB_4	I(s)/ O	-	-	-	-	DV0_DATA1	I(s)	LCD0_DATA22	O	SSILRCK2	I(s)/ O	RTS0#	I(s)/ O	-	-	-	-	(1)
H20	P7_7	I(s)/ O	-	-	-	-	DV0_HSYNC	I(s)	LCD0_TCON 0	O	GTIOC3B	I(s)/ O	RxD0	I(s)	-	-	-	-	(1)
H21	PG_2	I(s)/ O	-	-	ET0_TXD3	O	VIO_D10	I(s)	MISO0	I(s)/ O	MTIOC3B	I(s)/ O	GTIOC0A	I(s)/ O	IRQ4	I(s)	-	-	(1)
J1	HM_RESET#/ OM_RESET#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
J2	PH_4	I(s)/ O	-	-	HM_INT#/ OM_ECS#	I(s)	CTS2#	I(s)/ O	GTIOC6B	I(s)/ O	MTIOC2B	I(s)/ O	SD0_WP	I(s)	IRQ2	I(s)	-	-	(1)
J4	HM_DQ3/ OM_SIO3	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
J5	HM_DQ0/ OM_SIO0	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
J17	PG_1	I(s)/ O	-	-	ET0_TXD2	O	VIO_D9	I(s)	MOSI0	I(s)/ O	MTIOC3C	I(s)/ O	HM_INT#/ OM_ECS#	I(s)	-	-	-	-	(1)
J18	P7_6	I(s)/ O	-	-	-	-	DV0_VSYNC	I(s)	LCD0_TCON 1	O	GTIOC3A	I(s)/ O	SCK0	I(s)/ O	-	-	-	-	(1)
J20	P7_2	I(s)/ O	-	-	-	-	DV0_CLK	I(s)	LCD0_TCON 2	O	TEND0	O	CC2_Ra0	I(s)	-	-	-	-	(1)
J21	P6_0	I(s)/ O	-	-	ADTRG#	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	(1)
K1	PJ_6	I(s)/ O	-	-	GTETRC	I(s)	NFCE#	O	LCD0_CLK	O	MTCLKC	I(s)	IRQ0	I(s)	-	-	-	-	(1)
K2	PJ_1	I(s)/ O	-	-	TRACECTL	O	SPDIF_IN	I(s)	-	-	RxD1	I(s)	VBUSIN0	I(s)	IRQ0	I(s)	-	-	(1)
K4	HM_DQ7/ OM_SIO7	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
K5	HM_DQ5/ OM_SIO5	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
K17	PVcc																		
K18	PG_3	I(s)/ O	-	-	ET0_COL	I(s)	VIO_D11	I(s)	SSL00	I(s)/ O	MTIOC3D	I(s)/ O	GTIOC0B	I(s)/ O	-	-	-	-	(1)
K20	P6_5	I(s)/ O	-	-	-	-	DRP01*	I(s)/ O	LCD0_TCON 5	O	AUDIO_XOU T	O	CC1_Rd0	I(s)	-	-	-	-	(1)
K21	P6_4	I(s)/ O	-	-	-	-	DRP00*	I(s)/ O	LCD0_TCON 6	O	AUDIO_CLK	I(s)	SD1_CD	I(s)	-	-	-	-	(1)
L1	PH_5	I(s)/ O	-	-	HM_RSTO#	I(s)	NFDATA2	I(s)/ O	ET1_EXOUT/ ET1_SCLKIN	I(s)/ O	MTIC5U	I(s)	IRQ5	I(s)	-	-	-	-	(1)

Table 2.4 List of Pins (256-Pin BGA)

Ball Number	Port Function/ Dedicated Function		Mode Function		Function 1		Function 2		Function 3		Function 4		Function 5		Function 6		Function 7		Simplified Circuit Diagram Figure 2.1
	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	
L2	PJ_3	I(s)/ O	-	-	TRACE DATA1	O	NFDATA0	I(s)/ O	-	-	RTS1#	I(s)/ O	SSLRCK3	I(s)/ O	-	-	-	-	(1)
L4	PJ_0	I(s)/ O	-	-	TRACECLK	O	SPDIF_OUT	O	-	-	SCK1	I(s)/ O	SSIRxD3	I(s)	-	-	-	-	(1)
L5	Vcc																		
L17	Vss																		
L18	P6_7	I(s)/ O	-	-	-	-	DRP03*	I(s)/ O	LCD0_TCON 3	O	DACK0	O	CC2_Rd0	I(s)	-	-	-	-	(1)
L20	P6_6	I(s)/ O	-	-	-	-	DRP02*	I(s)/ O	LCD0_TCON 4	O	DREQ0	I(s)	CC1_Ra0	I(s)	-	-	-	-	(1)
L21	SD0_DAT6	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
M1	PH_6	I(s)/ O	-	-	HM_INT#/ OM_ECS#	I(s)	NFDATA3	I(s)/ O	ET1_WOL	O	MTIC5V	I(s)	IRQ4	I(s)	-	-	-	-	(1)
M2	PJ_7	I(s)/ O	-	-	GTETRGB	I(s)	NFDATA0	I(s)/ O	LCD0_ EXTCLK	I(s)	MTCLKB	I(s)	-	-	-	-	-	-	(1)
M4	PJ_2	I(s)/ O	-	-	TRACE DATA0	O	NFCE#	O	-	-	TxD1	O	SSITxD3	O	-	-	-	-	(1)
M5	Vss																		
M17	Vcc																		
M18	SD0_RST#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
M20	SD0_DAT7	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
M21	PVcc_SD0																		
N1	P3_5	I(s)/ O	-	-	ET1_RXD1	I(s)	NFCLE	O	CC2_Ra0	I(s)	CAN0TX_ DATARATE_ EN	O	SSL00	I(s)/ O	-	-	RMII1_RXD1	I(s)	(1)
N2	PJ_5	I(s)/ O	-	-	TRACE DATA3	O	NFDATA2	I(s)/ O	OVRCUR0	I(s)	MTIOC1A	I(s)/ O	SSLRCK2	I(s)/ O	IRQ4	I(s)	-	-	(1)
N4	PJ_4	I(s)/ O	-	-	TRACE DATA2	O	NFDATA1	I(s)/ O	-	-	CTS1#	I(s)/ O	SSIBCK3	I(s)/ O	-	-	-	-	(1)
N5	PK_5	I(s)/ O	-	-	GTETRGA	I(s)	NFDATA1	I(s)/ O	WDTOVF#/ PERROUT#	O	MTCLKA	I(s)	-	-	-	-	-	-	(1)
N17	SD0_DAT0	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
N18	SD0_DAT5	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
N20	SD0_DAT4	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
N21	Vss																		
P1	AUDIO_X1	I	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(13)
P2	AUDIO_X2	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(13)
P4	PK_4	I(s)/ O	-	-	ET1_RXD0	I(s)	NFDATA7	I(s)/ O	OVRCUR1	I(s)	CAN0TX	O	MISO0	I(s)/ O	IRQ6	I(s)	RMII1_RXD0	I(s)	(1)
P5	PVcc																		
P17	SD0_CLK	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
P18	SD0_DAT2	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
P20	SD0_DAT3	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
P21	SD0_DAT1	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
R1	PG_4	I(s)/ O	-	-	ET0_TXER	O	VIO_D15	I(s)	RSPCK1	I(s)/ O	MTIOC4A	I(s)/ O	GTIOC1A	I(s)/ O	-	-	-	-	(1)
R2	P3_1	I(s)/ O	-	-	ET1_RXER	I(s)	NFALE	O	VBUSEN0	I(s)	CAN1RX	I(s)	RSPCK2	I(s)/ O	IRQ6	I(s)	RMII1_RXER	I(s)	(1)
R4	P3_2	I(s)/ O	-	-	ET1_CRS	I(s)	NFRE#	O	CC1_Ra1	I(s)	CAN1RX_ DATARATE_ EN	O	MOSI2	I(s)/ O	-	-	RMII1_ CRS_DV	I(s)	(1)
R5	Vss																		
R17	SD1_DAT2	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
R18	SD1_DAT0	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
R20	SD1_DAT3	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
R21	SD0_CMD	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
T1	Vss																		
T2	Vss																		
T4	MIPIAVcc18																		
T5	Vcc																		
T17	SD1_CLK	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
T18	SD1_CMD	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
T20	SD1_DAT1	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
T21	PVcc_SD1																		

Table 2.4 List of Pins (256-Pin BGA)

Ball Number	Port Function/ Dedicated Function		Mode Function		Function 1		Function 2		Function 3		Function 4		Function 5		Function 6		Function 7		Simplified Circuit Diagram Figure 2.1
	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	
U1	CSI_DATA0P	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
U2	CSI_DATA0N	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
U4	Vss																		
U5	PVcc																		
U6	Vss																		
U7	LVDSAPVcc																		
U8	P4_3	I(s)/ O	-	-	RTS0#	I(s)/ O	TXOUT1M	O	SCI_CTS1#/ RTS1#	I(s)/ O	SSLIRCK1	I(s)/ O	MTIOC8D	I(s)/ O	IRQ3	I(s)	-	-	(1)
U9	P4_7	I(s)/ O	-	-	ET0_WOL	O	TXCLKOUTM	O	SCI_SCK0	I(s)/ O	SCK4	I(s)/ O	TEND0	O	-	-	-	-	(1)
U10	USBVss																		
U11	RREF0		-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
U12	RREF1		-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
U13	USBVss																		
U14	Vss																		
U15	PLLVcc																		
U16	PVcc																		
U17	Vss																		
U18	P5_4	I(s)	-	-	AN004	I(a)	IRQ0	I(s)	SD1_CD	I(s)	-	-	-	-	-	-	-	-	(3)
U20	P5_5	I(s)	-	-	AN005	I(a)	IRQ1	I(s)	SD1_WP	I(s)	-	-	-	-	-	-	-	-	(3)
U21	Vss																		
V1	CSI_CLKP	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
V2	CSI_CLKN	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
V4	PG_6	I(s)/ O	-	-	ET0_RXD2	I(s)	VIO_D13	I(s)	MISO1	I(s)/ O	MTIOC4C	I(s)/ O	GTIOC2A	I(s)/ O	IRQ5	I(s)	-	-	(1)
V5	P3_3	I(s)/ O	-	-	ET1_MDC	O	NFWE#	O	OTG_EXICEN0	O	CAN1TX	O	MISO2	I(s)/ O	IRQ7	I(s)	-	-	(1)
V6	PC_2	I(s)/ O	-	-	OTG_EXICE N0	O	NFDATA7	I(s)/ O	ET1_TXD3	O	MISO2	I(s)/ O	LCD0_TCON 5	O	-	-	-	-	(1)
V7	Vss																		
V8	P4_2	I(s)/ O	-	-	TxD0	O	TXOUT1P	O	SCI_TXD1	I(s)/ O	SSITxD1	O	MTIOC8C	I(s)/ O	IRQ2	I(s)	-	-	(1)
V9	P4_6	I(s)/ O	-	-	ET0_EXOUT/ ET0_SCLKIN	I(s)/ O	TXCLKOUTP	O	SCI_TXD0	I(s)/ O	TxD4	O	DACK0	O	-	-	-	-	(1)
V10	Vss																		
V11	USBAPVcc0																		
V12	USBAPVcc1																		
V13	USBVss																		
V14	PC_4	I(s)/ O	-	-	OTG_ID1	I(s)	NFALE	O	ET1_TXER	O	SPDIF_IN	I(s)	LCD0_TCON 3	O	IRQ1	I(s)	-	-	(1)
V15	PC_6	I(s)/ O	-	-	VBUSEN0	O	NFWE#	O	ET1_RXD2	I(s)	SD1_CD	I(s)	LCD0_TCON 1	O	IRQ7	I(s)	-	-	(1)
V16	PC_3	I(s)/ O	-	-	OTG_ID0	I(s)	NFCLE	O	ET1_COL	I(s)	SSL20	I(s)/ O	LCD0_TCON 4	O	-	-	-	-	(1)
V17	PVcc																		
V18	P5_0	I(s)	-	-	AN000	I(a)	IRQ4	I(s)	SD0_CD	I(s)	SD1_CD	I(s)	-	-	-	-	-	-	(3)
V20	P5_6	I(s)	-	-	AN006	I(a)	IRQ2	I(s)	-	-	-	-	-	-	-	-	-	-	(3)
V21	P5_7	I(s)	-	-	AN007	I(a)	IRQ3	I(s)	-	-	-	-	-	-	-	-	-	-	(3)
W1	CSI_DATA1P	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
W2	CSI_DATA1N	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
W20	P5_2	I(s)	-	-	AN002	I(a)	IRQ6	I(s)	VBUSIN0	I(s)	-	-	-	-	-	-	-	-	(3)
W21	P5_3	I(s)	-	-	AN003	I(a)	IRQ7	I(s)	OTG_ID0	I(s)	-	-	-	-	-	-	-	-	(3)
Y1	Vss																		
Y2	Vss																		
Y3	PG_7	I(s)/ O	-	-	ET0_RXD3	I(s)	VIO_D12	I(s)	SSL10	I(s)/ O	MTIOC4D	I(s)/ O	GTIOC2B	I(s)/ O	-	-	-	-	(1)
Y4	PC_0	I(s)/ O	-	-	VBUSIN1	I(s)	NFDATA5	I(s)/ O	ET1_TXCLK	I(s)	RSPCK2	I(s)/ O	IRQ2	I(s)	-	-	-	-	(1)
Y5	PC_1	I(s)/ O	-	-	VBUSIN0	I(s)	NFDATA6	I(s)/ O	ET1_TXD2	O	MOSI2	I(s)/ O	LCD0_TCON 6	O	-	-	-	-	(1)
Y6	P4_0	I(s)/ O	-	-	SCK0	I(s)/ O	TXOUT0P	O	SCI_SCK1	I(s)/ O	SSIBCK1	I(s)/ O	MTIOC8A	I(s)/ O	IRQ0	I(s)	-	-	(1)

Table 2.4 List of Pins (256-Pin BGA)

Ball Number	Port Function/ Dedicated Function		Mode Function		Function 1		Function 2		Function 3		Function 4		Function 5		Function 6		Function 7		Simplified Circuit Diagram Figure 2.1
	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	
Y7	P4_4	I(s)/ O	-	-	CTS0#	I(s)/ O	TXOUT2P	O	SCI_CTS0#/ RTS0#	I(s)/ O	WDTOVF#/ PERROUT#	O	OTG_ EXICEN0	O	-	-	-	-	(1)
Y8	LVDSPLLvcc																		
Y9	NMI	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(10)
Y10	USB_X2	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(13)
Y11	USBDPVcc0																		
Y12	DP0	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
Y13	USBVss																		
Y14	DP1	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
Y15	USBDPVcc1																		
Y16	Vss																		
Y17	XTAL	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(13)
Y18	RTC_X2	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(14)
Y19	AVcc																		
Y20	PVcc																		
Y21	P5_1	I(s)	-	-	AN001	I(a)	IRQ5	I(s)	SD0_WP	I(s)	SD1_WP	I(s)	-	-	-	-	-	-	(3)
AA1	Vss																		
AA2	PG_5	I(s)/ O	-	-	ET0_RXDV	I(s)	VIO_D14	I(s)	MOSI1	I(s)/ O	MTIOC4B	I(s)/ O	GTIOC1B	I(s)/ O	-	-	-	-	(1)
AA3	P3_4	I(s)/ O	-	-	ET1_MDIO	I(s)/ O	NFRB#	I(s)	CC2_Ra1	I(s)	CAN1TX_ Datarate_ EN	O	SSL20	I(s)/ O	-	-	-	-	(1)
AA4	P3_0	I(s)/ O	-	-	OTG_ EXICEN1	O	NFDATA4	I(s)/ O	ET1_ LINKSTA	I(s)	MTIC5W	I(s)	IRQ3	I(s)	-	-	-	-	(1)
AA5	Vss																		
AA6	P4_1	I(s)/ O	-	-	RxD0	I(s)	TXOUT0M	O	SCI_RXD1	I(s)/ O	SSIrxD1	I(s)	MTIOC8B	I(s)/ O	IRQ1	I(s)	-	-	(1)
AA7	P4_5	I(s)/ O	-	-	ET0_ LINKSTA	I(s)	TXOUT2M	O	SCI_RXD0	I(s)/ O	RxD4	I(s)	DREQ0	I(s)	-	-	-	-	(1)
AA8	Vss																		
AA9	RES#	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(12)
AA10	USB_X1	I	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(13)
AA11	USBVss																		
AA12	DM0	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
AA13	USBVss																		
AA14	DM1	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
AA15	USBVss																		
AA16	PC_5	I(s)/ O	-	-	VBUSEN1	O	NFRE#	O	ET1_RXDV	I(s)	SPDIF_OUT	O	LCD0_TCON 2	O	IRQ0	I(s)	-	-	(1)
AA17	PC_7	I(s)/ O	-	-	OVRCUR0	I(s)	NFRB#	I(s)	ET1_RXD3	I(s)	SD1_WP	I(s)	LCD0_TCON 0	O	IRQ6	I(s)	-	-	(1)
AA18	EXTAL	I	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(13)
AA19	RTC_X1	I	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(14)
AA20	AVss																		
AA21	PVcc																		

[Legend]

(s): Schmitt

(a): Analog

(o): Open drain

Note: * Only in products with a DRP

Table 2.5 List of Pins (176-Pin BGA)

Ball Number	Port Function/ Dedicated Function		Mode Function		Function 1		Function 2		Function 3		Function 4		Function 5		Function 6		Function 7		Simplified Circuit Diagram Figure 2.1	
	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O		
A1	Vss																			
A2	PK_3	I(s)/ O	-	-	-	-	NFDATA6	I(s)/ O	CC2_Rd0	I(s)	CAN0RX_ DATARATE_ EN	O	MOSI0	I(s)/ O	-	-	REF50CK1	I(s)	(1)	
A3	QSPI1_ SPCLK	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
A4	RPC_WP#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
A5	PVcc_SPI																			
A6	Vss																			
A7	QSPI0_IO3	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
A8	P6_1	I(s)/ O	-	-	ET0_TXEN	O	VIO_CLK	I(s)	SCK3	I(s)/ O	MTIOC2A	I(s)/ O	-	-	-	-	RMII0_ TXD_EN	O	(1)	
A9	P6_2	I(s)/ O	-	-	ET0_TXD0	O	VIO_VD	I(s)	RxD3	I(s)	MTIOC2B	I(s)/ O	OTG_ EXICEN1	O	IRQ0	I(s)	RMII0_TXD0	O	(1)	
A10	PH_1	I(s)/ O	-	-	AUDIO_XOUT	O	VIO_D0	I(s)	GTIOC4B	I(s)/ O	MTIOC1B	I(s)/ O	CC2_Rd0	I(s)	IRQ2	I(s)	-	-	(1)	
A11	PE_6	I(s)/ O	-	-	ET0_MDIO	I(s)/ O	VIO_D2	I(s)	SSIRxD0	I(s)	MTIOC0D	I(s)/ O	CC2_Rd1	I(s)	-	-	-	-	(1)	
A12	PL_2	I(s)	MD_BOOT2	I(s)	-	-	-	-	-	-	-	-	IRQ6	I(s)	-	-	-	-	(5)	
A13	PE_3	I(s)/ O	-	-	ET0_RXER	I(s)	VIO_D5	I(s)	SSIBCK0	I(s)/ O	MTIOC0A	I(s)/ O	-	-	-	-	RMII0_RXER	I(s)	(1)	
A14	CKIO	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(11)	
A15	Vss																			
B1	BSCANP	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(12)
B2	PH_3	I(s)/ O	-	-	HM_RSTO#	I(s)	RTS2#	I(s)/ O	GTIOC6A	I(s)/ O	MTIOC2A	I(s)/ O	SD0_CD	I(s)	IRQ3	I(s)	-	-	-	(1)
B3	QSPI1_SSL	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
B4	QSPI1_IO1	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
B5	RPC_RESET #	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
B6	QSPI0_IO2	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
B7	QSPI0_IO1	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
B8	PK_0	I(s)/ O	-	-	-	-	NFDATA3	I(s)/ O	CC1_Rd0	I(s)	MTIOC1B	I(s)/ O	SSIBCK2	I(s)/ O	-	-	RMII1_ TXD_EN	O	(1)	
B9	P6_3	I(s)/ O	-	-	ET0_TXD1	O	VIO_HD	I(s)	TxD3	O	POE0#	I(s)	-	-	-	-	RMII0_TXD1	O	(1)	
B10	PL_4	I(s)	MD_BOOT0	I(s)	-	-	-	-	-	-	-	-	IRQ0	I(s)	-	-	-	-	(5)	
B11	PL_0	I(s)	MD_CLKS	I(s)	-	-	-	-	-	-	-	-	IRQ4	I(s)	-	-	-	-	(5)	
B12	PE_5	I(s)/ O	-	-	ET0_MDC	O	VIO_D3	I(s)	SSITxD0	O	MTIOC0C	I(s)/ O	CC1_Rd1	I(s)	-	-	-	-	(1)	
B13	PE_1	I(s)/ O	-	-	ET0_RXD0	I(s)	VIO_D7	I(s)	RxD2	I(s)	POE8#	I(s)	VBUSIN1	I(s)	IRQ1	I(s)	RMII0_RXD0	I(s)	(1)	
B14	Vss																			
B15	PD_7	I(s)/ O(o)	-	-	RIIC3SDA	I(s)/ O(o)	IRQ7	I(s)	-	-	-	-	-	-	-	-	-	-	(4)	
C1	HM_CK/OM_ SCLK	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
C2	PK_1	I(s)/ O	-	-	-	-	NFDATA4	I(s)/ O	CC1_Ra0	I(s)	CAN_CLK	I(s)	SSIDATA2	I(s)/ O	-	-	RMII1_TXD0	O	(1)	
C3	QSPI1_IO3	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
C4	QSPI1_IO2	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
C5	RPC_INT#	I	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
C6	QSPI0_SSL	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
C7	QSPI0_ SPCLK	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
C8	PE_0	I(s)/ O	-	-	ET0_RXCLK	I(s)	VIO_FLD	I(s)	SCK2	I(s)/ O	POE4#	I(s)	-	-	-	-	REF50CK0	I(s)	(1)	
C9	PH_0	I(s)/ O	-	-	AUDIO_CLK	I(s)	VIO_D1	I(s)	GTIOC4A	I(s)/ O	MTIOC1A	I(s)/ O	CC1_Rd0	I(s)	IRQ3	I(s)	-	-	(1)	
C10	PL_1	I(s)	MD_CLK	I(s)	-	-	-	-	-	-	-	-	IRQ5	I(s)	-	-	-	-	(5)	
C11	PE_4	I(s)/ O	-	-	ET0_CRS	I(s)	VIO_D4	I(s)	SSILRCK0	I(s)/ O	MTIOC0B	I(s)/ O	-	-	-	-	RMII0_ CRS_DV	I(s)	(1)	
C12	PG_0	I(s)/ O	-	-	ET0_TXCLK	I(s)	VIO_D8	I(s)	RSPCK0	I(s)/ O	MTIOC3A	I(s)/ O	HM_RSTO#	I(s)	-	-	-	-	(1)	
C13	Vss																			
C14	PD_5	I(s)/ O(o)	-	-	RIIC2SDA	I(s)/ O(o)	IRQ5	I(s)	-	-	-	-	-	-	-	-	-	-	(4)	

Table 2.5 List of Pins (176-Pin BGA)

Ball Number	Port Function/ Dedicated Function		Mode Function		Function 1		Function 2		Function 3		Function 4		Function 5		Function 6		Function 7		Simplified Circuit Diagram Figure 2.1
	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	
C15	PD_3	I(s)/ O(o)	-	-	RIIC1SDA	I(s)/ O(o)	IRQ3	I(s)	MTCLKD	I(s)	GTETRGD	I(s)	-	-	-	-	-	-	(4)
D1	HM_CK#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
D2	HM_CS0#/ OM_CS0#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
D3	PK_2	I(s)/ O	-	-	-	-	NFDATA5	I(s)/ O	VBUSEN1	O	CAN0RX	I(s)	RSPCK0	I(s)/ O	IRQ5	I(s)	RMI1_TXD1	O	(1)
D4	Vss																		
D5	Vcc																		
D6	QSPI1_IO0	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
D7	QSPI0_IO0	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
D8	PVcc																		
D9	PL_3	I(s)	MD_BOOT1	I(s)	-	-	-	-	-	-	-	-	IRQ7	I(s)	-	-	-	-	(5)
D10	PE_2	I(s)/ O	-	-	ET0_RXD1	I(s)	VIO_D6	I(s)	TxD2	O	POE10#	I(s)	-	-	-	-	RMI0_RXD1	I(s)	(1)
D11	PVcc																		
D12	Vss																		
D13	PD_6	I(s)/ O(o)	-	-	RIIC3SCL	I(s)/ O(o)	IRQ6	I(s)	-	-	-	-	-	-	-	-	-	-	(4)
D14	PD_4	I(s)/ O(o)	-	-	RIIC2SCL	I(s)/ O(o)	IRQ4	I(s)	-	-	-	-	-	-	-	-	-	-	(4)
D15	PD_1	I(s)/ O(o)	-	-	RIIC0SDA	I(s)/ O(o)	IRQ1	I(s)	MTCLKB	I(s)	GTETRGB	I(s)	-	-	-	-	-	-	(4)
E1	Vss																		
E2	HM_DQ0/ OM_SIO0	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
E3	HM_RWDS/ OM_DQS	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
E4	PVcc																		
E12	PD_2	I(s)/ O(o)	-	-	RIIC1SCL	I(s)/ O(o)	IRQ2	I(s)	MTCLKC	I(s)	GTETRGC	I(s)	-	-	-	-	-	-	(4)
E13	PD_0	I(s)/ O(o)	-	-	RIIC0SCL	I(s)/ O(o)	IRQ0	I(s)	MTCLKA	I(s)	GTETRGA	I(s)	-	-	-	-	-	-	(4)
E14	TCK/ SWDCLK	I	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(7)
E15	JP0_0	I(s)	-	-	TDI	I	-	-	-	-	-	-	-	-	-	-	-	-	(6)
F1	PVcc_HO																		
F2	HM_DQ2/ OM_SIO2	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
F3	HM_DQ1/ OM_SIO1	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
F4	HM_CS1#/ OM_CS1#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
F12	TMS/SWDIO	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(9)
F13	JP0_1	O	-	-	TDO/SWO	O	-	-	-	-	-	-	-	-	-	-	-	-	(8)
F14	TRST#	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(10)
F15	P6_0	I(s)/ O	-	-	ADTRG#	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	(1)
G1	HM_DQ4/ OM_SIO4	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
G2	HM_DQ7/ OM_SIO7	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
G3	HM_DQ5/ OM_SIO5	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
G4	HM_DQ3/ OM_SIO3	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
G12	Vcc																		
G13	PG_3	I(s)/ O	-	-	ET0_COL	I(s)	VIO_D11	I(s)	SSL00	I(s)/ O	MTIOC3D	I(s)/ O	GTIOC0B	I(s)/ O	-	-	-	-	(1)
G14	PG_2	I(s)/ O	-	-	ET0_TXD3	O	VIO_D10	I(s)	MISO0	I(s)/ O	MTIOC3B	I(s)/ O	GTIOC0A	I(s)/ O	IRQ4	I(s)	-	-	(1)
G15	PVcc																		
H1	HM_DQ6/ OM_SIO6	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
H2	HM_RESET#/ OM_RESET#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)
H3	PH_4	I(s)/ O	-	-	HM_INT#/ OM_ECS#	I(s)	CTS2#	I(s)/ O	GTIOC6B	I(s)/ O	MTIOC2B	I(s)/ O	SD0_WP	I(s)	IRQ2	I(s)	-	-	(1)

Table 2.5 List of Pins (176-Pin BGA)

Ball Number	Port Function/ Dedicated Function		Mode Function		Function 1		Function 2		Function 3		Function 4		Function 5		Function 6		Function 7		Simplified Circuit Diagram Figure 2.1	
	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O		
H4	Vcc																			
H12	PG_1	I(s)/ O	-	-	ET0_TXD2	O	VIO_D9	I(s)	MOSI0	I(s)/ O	MTIOC3C	I(s)/ O	HM_INT#/ OM_ECS#	I(s)	-	-	-	-	(1)	
H13	SD0_DAT5	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	
H14	SD0_RST#	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	
H15	Vss																			
J1	PJ_0	I(s)/ O	-	-	TRACECLK	O	SPDIF_ OUT	O	-	-	SCK1	I(s)/ O	SSIRxD3	I(s)	-	-	-	-	(1)	
J2	PJ_1	I(s)/ O	-	-	TRACECTL	O	SPDIF_ IN	I(s)	-	-	RxD1	I(s)	VBUSIN0	I(s)	IRQ0	I(s)	-	-	(1)	
J3	PJ_2	I(s)/ O	-	-	TRACE DATA0	O	NFCE#	O	-	-	TxD1	O	SSITxD3	O	-	-	-	-	(1)	
J4	Vss																			
J12	SD0_DAT7	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	
J13	SD0_DAT2	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	
J14	SD0_DAT4	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	
J15	PVcc_SD0																			
K1	PJ_5	I(s)/ O	-	-	TRACE DATA3	O	NFDATA2	I(s)/ O	OVRCUR0	I(s)	MTIOC1A	I(s)/ O	SSLRCK2	I(s)/ O	IRQ4	I(s)	-	-	(1)	
K2	PJ_3	I(s)/ O	-	-	TRACE DATA1	O	NFDATA0	I(s)/ O	-	-	RTS1#	I(s)/ O	SSLRCK3	I(s)/ O	-	-	-	-	(1)	
K3	PJ_4	I(s)/ O	-	-	TRACE DATA2	O	NFDATA1	I(s)/ O	-	-	CTS1#	I(s)/ O	SSIBCK3	I(s)/ O	-	-	-	-	(1)	
K4	PVcc																			
K12	SD0_CLK	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	
K13	SD0_DAT3	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	
K14	SD0_DAT0	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	
K15	SD0_DAT6	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	
L1	PK_4	I(s)/ O	-	-	-	-	NFDATA7	I(s)/ O	OVRCUR1	I(s)	CAN0TX	O	MISO0	I(s)/ O	IRQ6	I(s)	RMII1_RXD0	I(s)	(1)	
L2	P3_5	I(s)/ O	-	-	-	-	NFCLE	O	CC2_Ra0	I(s)	CAN0TX_ DATARATE_ EN	O	SSL00	I(s)/ O	-	-	RMII1_RXD1	I(s)	(1)	
L3	Vss																			
L4	Vcc																			
L12	PVcc																			
L13	Vss																			
L14	SD0_DAT1	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	
L15	SD0_CMD	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(15)	
M1	AUDIO_X1	I	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(13)	
M2	AUDIO_X2	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(13)	
M3	P3_2	I(s)/ O	-	-	-	-	NFRE#	O	CC1_Ra1	I(s)	CAN1RX_ DATARATE_ EN	O	MOSI2	I(s)/ O	-	-	RMII1_ CRS_DV	I(s)	(1)	
M4	Vss																			
M5	P3_3	I(s)/ O	-	-	ET1_MDC	O	NFRE#	O	OTG_ EXICEN0	O	CAN1TX	O	MISO2	I(s)/ O	IRQ7	I(s)	-	-	(1)	
M6	LVDSAPVcc																			
M7	LVDSPLLvcc																			
M8	NMI	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(10)	
M9	USBVss																			
M10	PVcc																			
M11	Vcc																			
M12	P5_0	I(s)	-	-	AN000	I(a)	IRQ4	I(s)	SD0_CD	I(s)	SD1_CD	I(s)	-	-	-	-	-	-	(3)	
M13	P5_4	I(s)	-	-	AN004	I(a)	IRQ0	I(s)	SD1_CD	I(s)	-	-	-	-	-	-	-	-	(3)	
M14	P5_7	I(s)	-	-	AN007	I(a)	IRQ3	I(s)	-	-	-	-	-	-	-	-	-	-	(3)	
M15	P5_5	I(s)	-	-	AN005	I(a)	IRQ1	I(s)	SD1_WP	I(s)	-	-	-	-	-	-	-	-	(3)	
N1	P3_1	I(s)/ O	-	-	-	-	NFALE	O	VBUSEN0	I(s)	CAN1RX	I(s)	RSPCK2	I(s)/ O	IRQ6	I(s)	RMII1_ RXER	I(s)	(1)	
N2	PG_4	I(s)/ O	-	-	ET0_TXER	O	VIO_D15	I(s)	RSPCK1	I(s)/ O	MTIOC4A	I(s)/ O	GTIOC1A	I(s)/ O	-	-	-	-	(1)	
N3	Vss																			
N4	PG_7	I(s)/ O	-	-	ET0_RXD3	I(s)	VIO_D12	I(s)	SSL10	I(s)/ O	MTIOC4D	I(s)/ O	GTIOC2B	I(s)/ O	-	-	-	-	(1)	

Table 2.5 List of Pins (176-Pin BGA)

Ball Number	Port Function/ Dedicated Function		Mode Function		Function 1		Function 2		Function 3		Function 4		Function 5		Function 6		Function 7		Simplified Circuit Diagram Figure 2.1
	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	Symbol	I/O	
N5	P4_2	I(s)/O	-	-	TxD0	O	TXOUT1P	O	SCI_TXD1	I(s)/O	SSITxD1	O	MTIOC8C	I(s)/O	IRQ2	I(s)	-	-	(1)
N6	P4_3	I(s)/O	-	-	RTS0#	I(s)/O	TXOUT1M	O	SCI_CTS1#/RTS1#	I(s)/O	SSLRCK1	I(s)/O	MTIOC8D	I(s)/O	IRQ3	I(s)	-	-	(1)
N7	P4_6	I(s)/O	-	-	ET0_EXOUT/ ET0_SCLKIN	I(s)/O	TXCLK OUTP	O	SCI_TXD0	I(s)/O	TxD4	O	DACK0	O	-	-	-	-	(1)
N8	RES#	I(s)	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(12)
N9	RREF0	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-
N10	Vss																		
N11	PLLVcc																		
N12	Vcc																		
N13	P5_2	I(s)	-	-	AN002	I(a)	IRQ6	I(s)	VBUSIN0	I(s)	-	-	-	-	-	-	-	-	(3)
N14	P5_3	I(s)	-	-	AN003	I(a)	IRQ7	I(s)	OTG_ID0	I(s)	-	-	-	-	-	-	-	-	(3)
N15	P5_6	I(s)	-	-	AN006	I(a)	IRQ2	I(s)	-	-	-	-	-	-	-	-	-	-	(3)
P1	PVcc																		
P2	Vss																		
P3	PG_6	I(s)/O	-	-	ET0_RXD2	I(s)	VIO_D13	I(s)	MISO1	I(s)/O	MTIOC4C	I(s)/O	GTIOC2A	I(s)/O	IRQ5	I(s)	-	-	(1)
P4	P4_0	I(s)/O	-	-	SCK0	I(s)/O	TXOUT0P	O	SCI_SCK1	I(s)/O	SSIBCK1	I(s)/O	MTIOC8A	I(s)/O	IRQ0	I(s)	-	-	(1)
P5	P4_4	I(s)/O	-	-	CTS0#	I(s)/O	TXOUT2P	O	SCI_CTS0#/RTS0#	I(s)/O	WDTOVF#/PERROUT#	O	OTG_EXICEN0	O	-	-	-	-	(1)
P6	P4_7	I(s)/O	-	-	ET0_WOL	O	TXCLK OUTM	O	SCI_SCK0	I(s)/O	SCK4	I(s)/O	TEND0	O	-	-	-	-	(1)
P7	USB_X2	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(13)
P8	USBDPVcc0																		
P9	USBAPVcc0																		
P10	USBVss																		
P11	XTAL	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(13)
P12	RTC_X2	O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(14)
P13	AVcc																		
P14	Vcc																		
P15	P5_1	I(s)	-	-	AN001	I(a)	IRQ5	I(s)	SD0_WP	I(s)	SD1_WP	I(s)	-	-	-	-	-	-	(3)
R1	Vss																		
R2	PG_5	I(s)/O	-	-	ET0_RXDV	I(s)	VIO_D14	I(s)	MOSI1	I(s)/O	MTIOC4B	I(s)/O	GTIOC1B	I(s)/O	-	-	-	-	(1)
R3	P3_4	I(s)/O	-	-	ET1_MDIO	I(s)/O	NFRB#	I(s)	CC2_Ra1	I(s)	CAN1TX DATARATE EN	O	SSL20	I(s)/O	-	-	-	-	(1)
R4	P4_1	I(s)/O	-	-	RxD0	I(s)	TXOUT0M	O	SCI_RXD1	I(s)/O	SSIRxD1	I(s)	MTIOC8B	I(s)/O	IRQ1	I(s)	-	-	(1)
R5	P4_5	I(s)/O	-	-	ET0_LINKSTA	I(s)	TXOUT2M	O	SCI_RXD0	I(s)/O	RxD4	I(s)	DREQ0	I(s)	-	-	-	-	(1)
R6	Vss																		
R7	USB_X1	I	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(13)
R8	DP0	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
R9	DM0	I/O	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	
R10	USBVss																		
R11	EXTAL	I	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(13)
R12	Vss																		
R13	RTC_X1	I	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	-	(14)
R14	AVss																		
R15	Vcc																		

[Legend]

- (s): Schmitt
(a): Analog
(o): Open drain

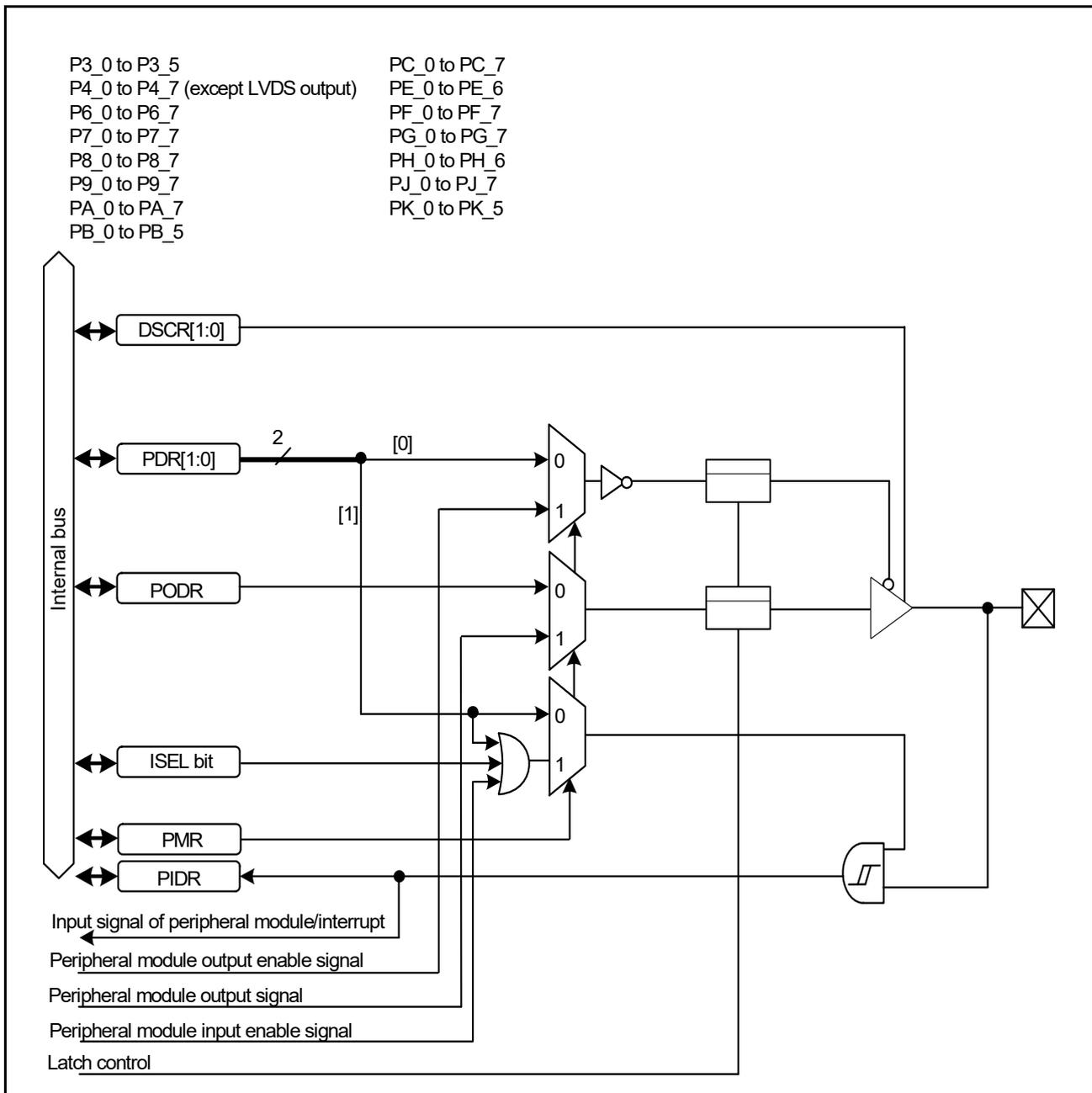


Figure 2.1 (1) Input/Output Buffer with Schmitt AND Input and Latch

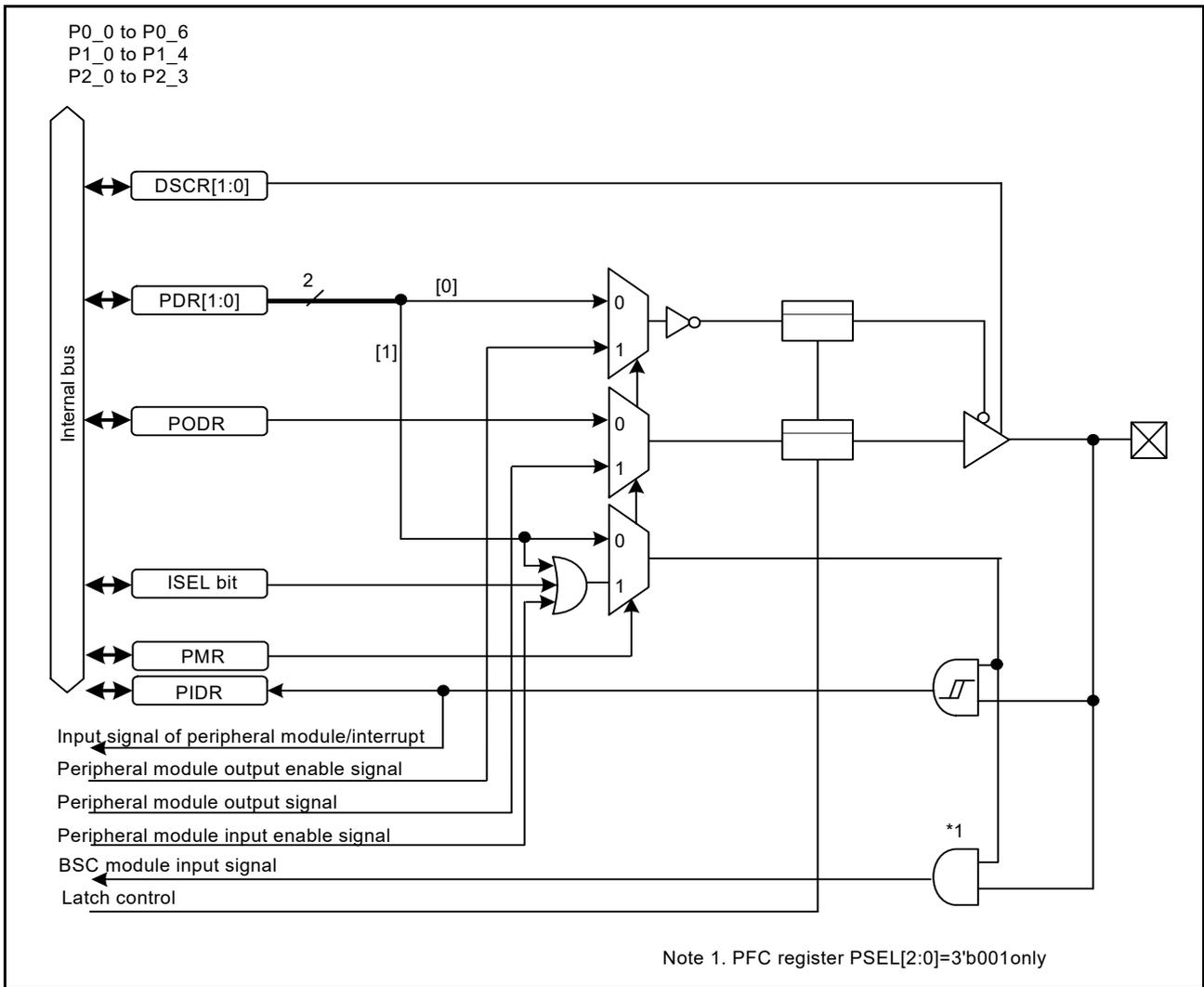


Figure 2.1 (2) Input/Output Buffer with TTL AND Input, Schmitt AND Input, and Latch

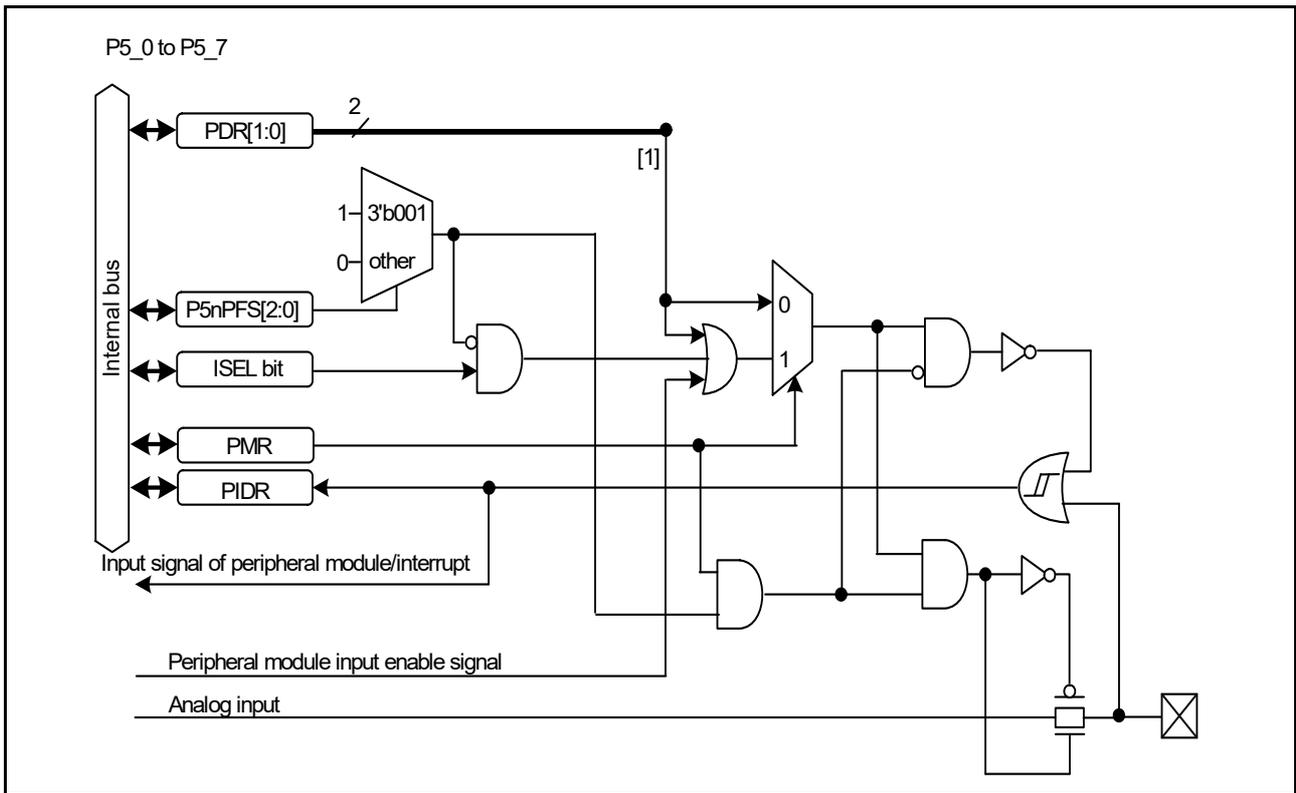
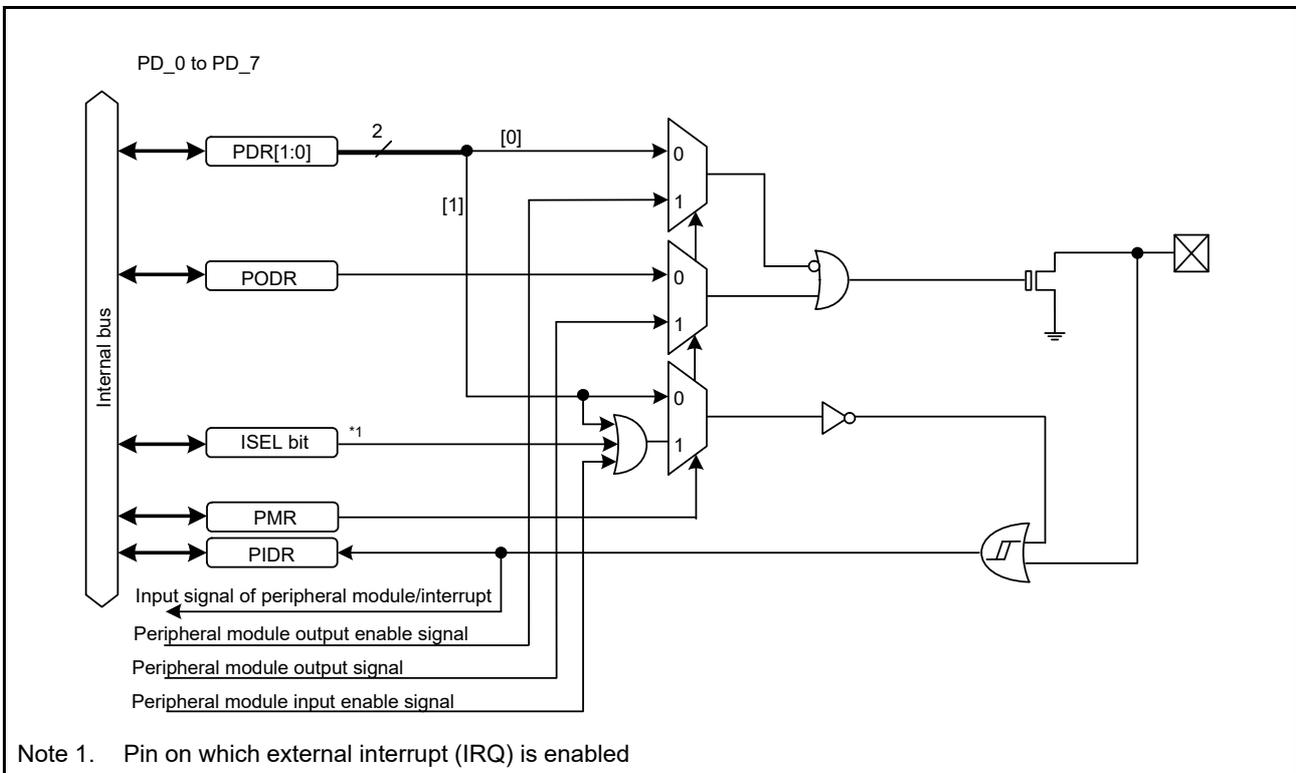


Figure 2.1 (3) Input Buffer Multiplexed with Schmitt OR Input and A/D Input



Note 1. Pin on which external interrupt (IRQ) is enabled

Figure 2.1 (4) Bidirectional Buffer with Schmitt OR Input and Open-Drive Output

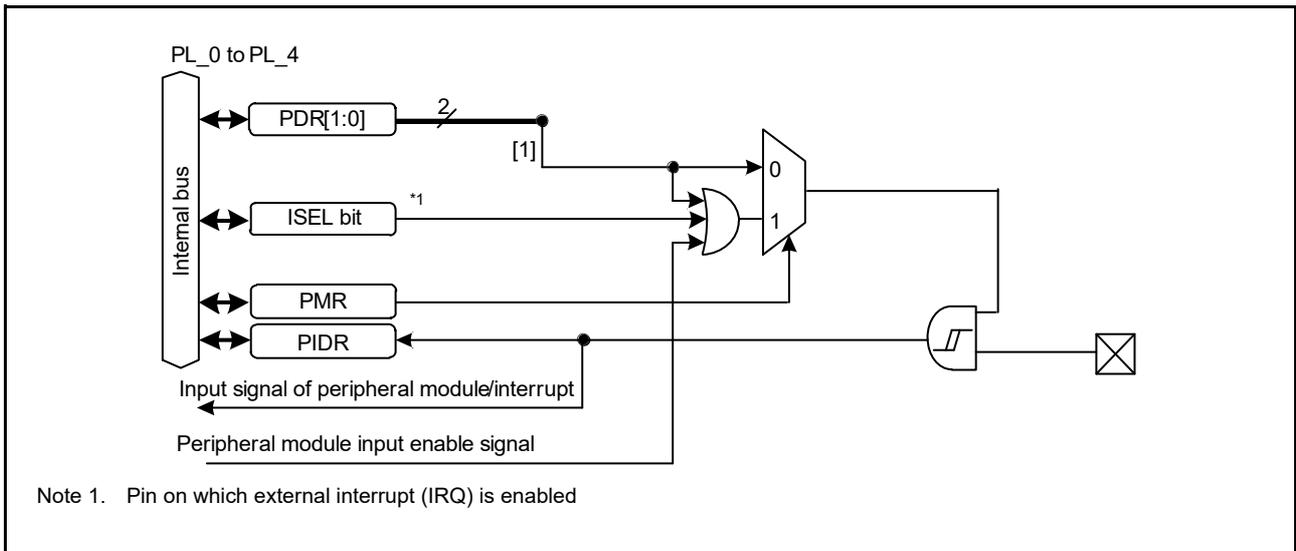


Figure 2.1 (5) Schmitt AND Input Buffer

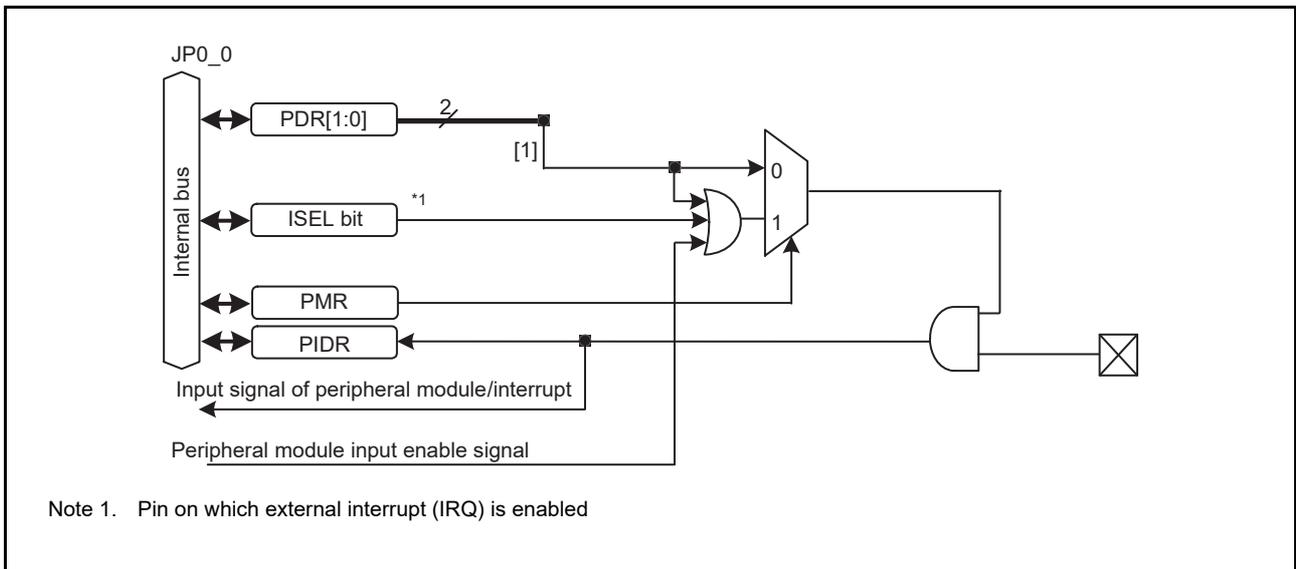


Figure 2.1 (6) TTL AND Input Buffer

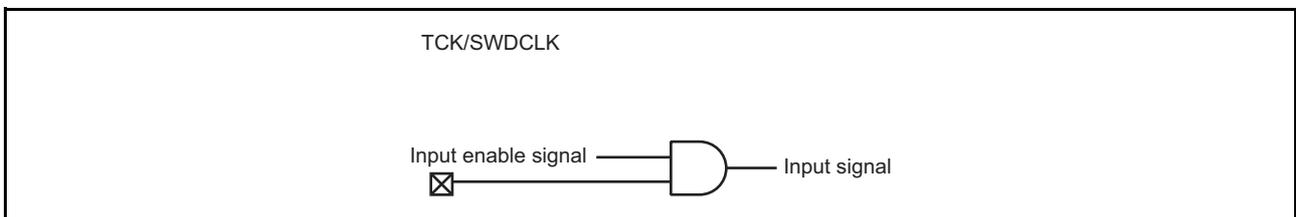


Figure 2.1 (7) TTL AND Input Buffer

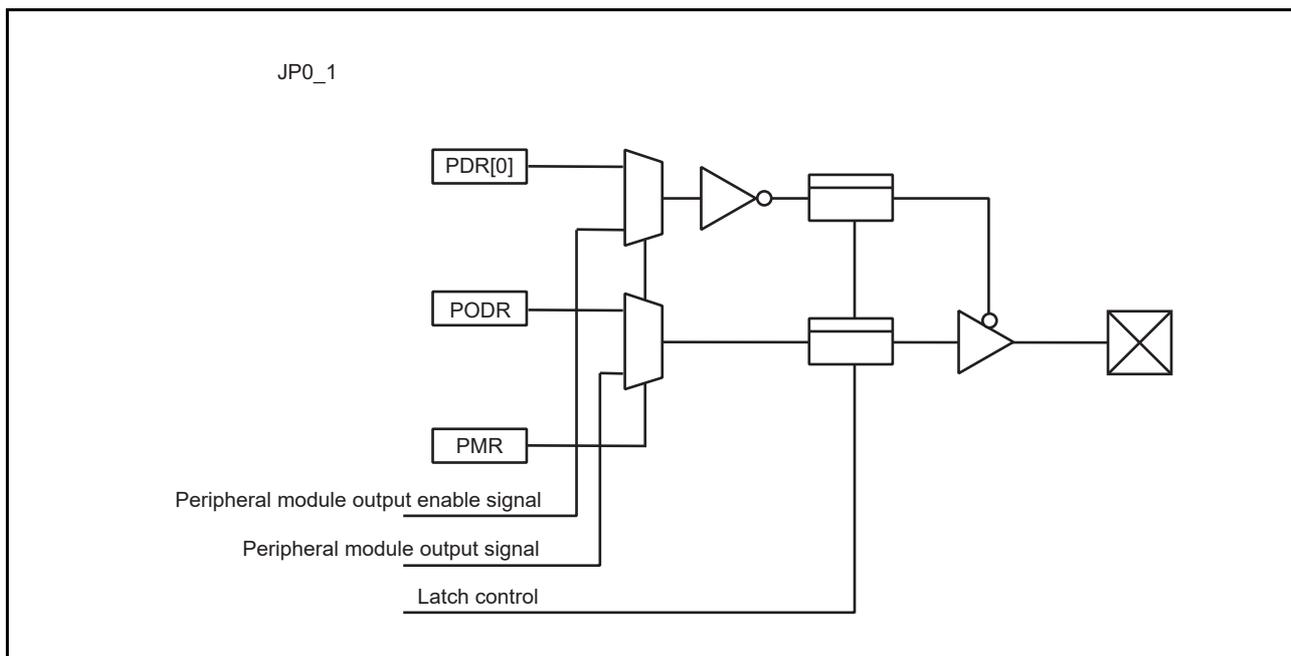


Figure 2.1 (8) Output Buffer with Latch and Enable Signal

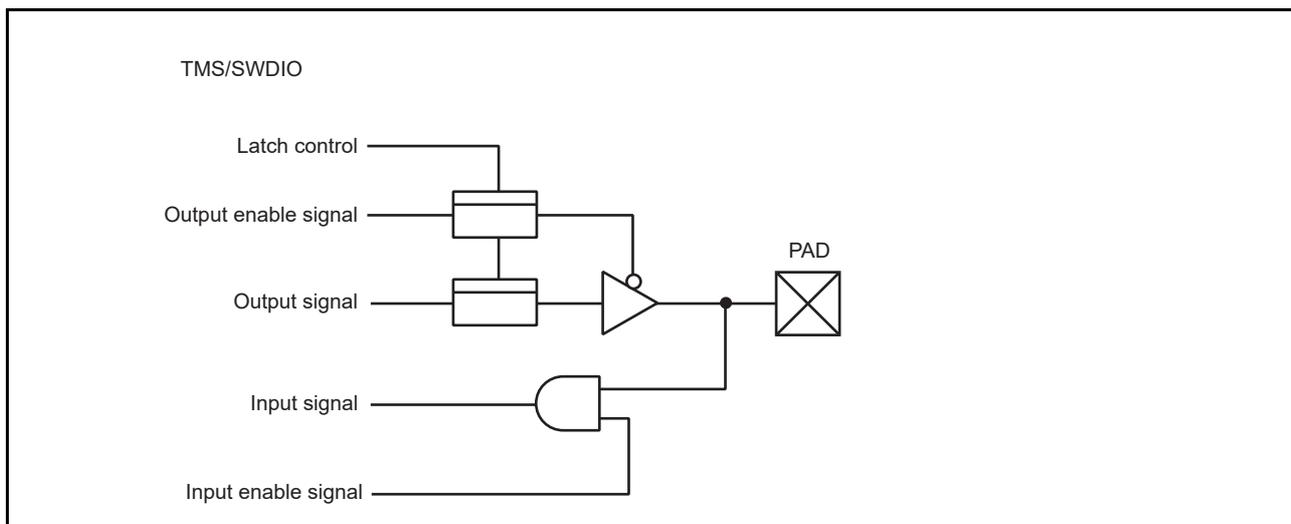


Figure 2.1 (9) Bidirectional Buffer with TTL AND Input and Latch

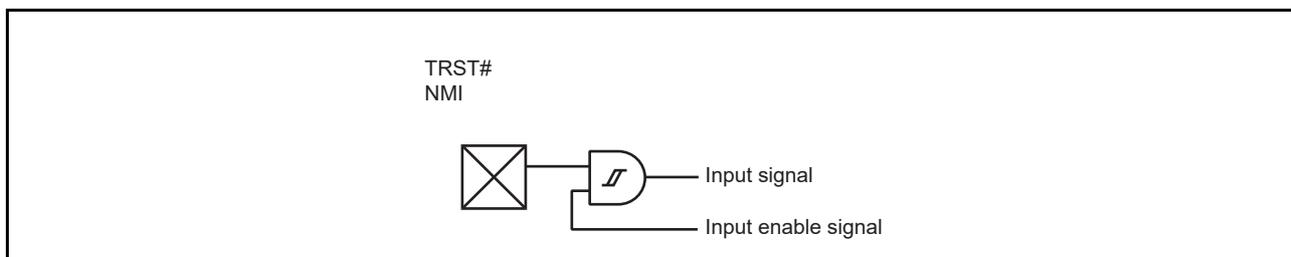


Figure 2.1 (10) Schmitt AND Input Buffer

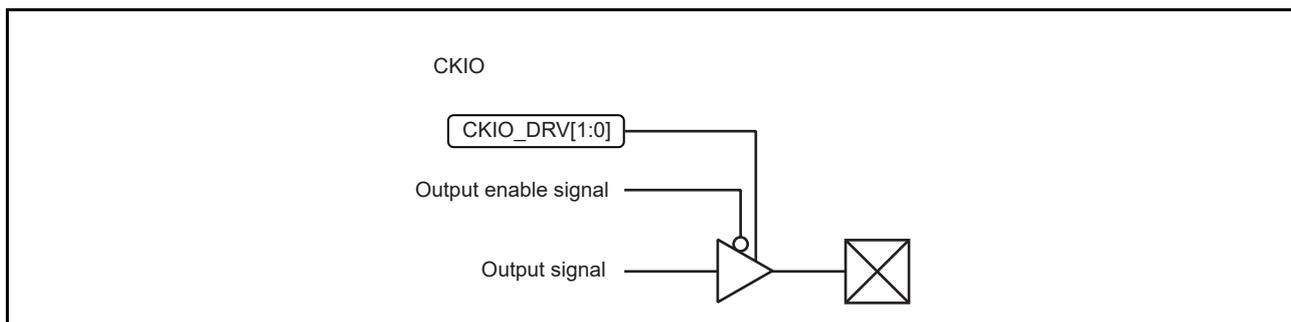


Figure 2.1 (11) Output Buffer with Enable Signal and Controllable Driving Ability

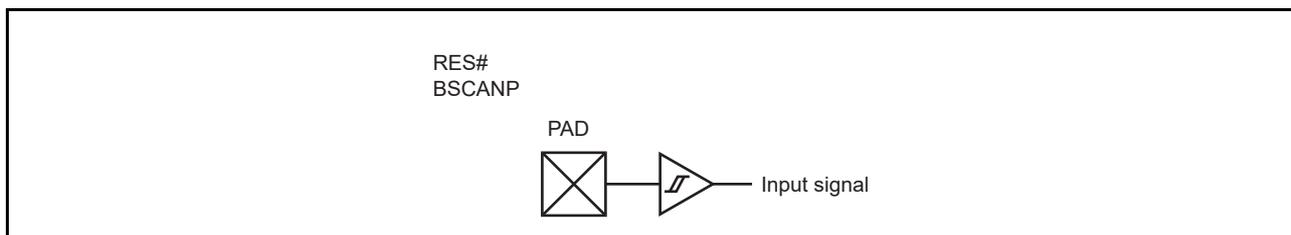


Figure 2.1 (12) Schmitt Input Buffer

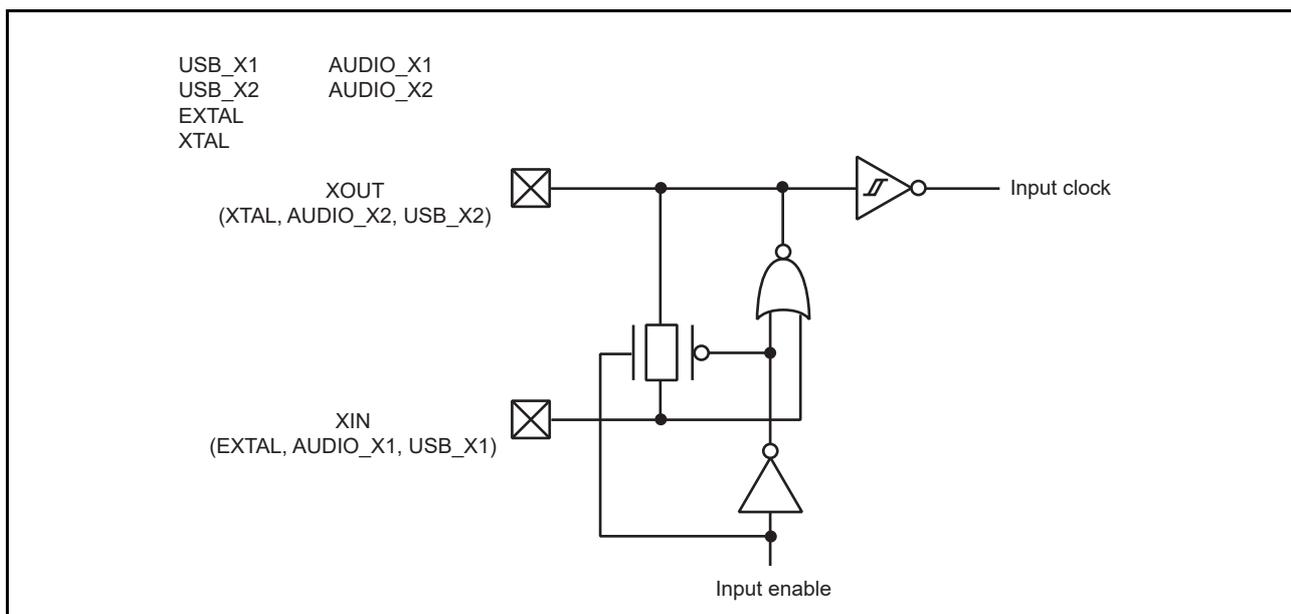


Figure 2.1 (13) Oscillation Buffer (1)

2.2 Pin Assignment

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22					
A	Vcc	QSPI1_IO3	QSPI1_SPCLK	RPC_WP#	QSPI0_IO3	PVcc_SPI	Vss	PVcc	PF_4	PE_6	PL_2	PE_5	P8_4	P8_6	PE_4	P9_1	PVcc	Vss	PE_1	PA_4	CKIO	Vss	A				
B	PK_1	Vcc	QSPI1_IO1	QSPI1_IO0	RPC_RESET#	QSPI0_IO1	QSPI0_SPCLK	PF_5	P6_3	PH_0	PL_3	PL_1	P8_3	PF_2	P8_7	PE_3	PA_0	PA_3	PA_5	PA_6	Vss	PVcc	B				
C	PH_2	P8_2	Vcc	QSPI1_SSL	RPC_INT#	QSPI0_SSL	QSPI0_IO0	P6_1	P6_2	PH_1	PL_4	PL_0	P8_5	PF_1	P9_0	PE_2	PA_2	PG_0	PB_0	Vss	PD_7	PD_3	C				
D	PVcc	BSCANP	P8_1	Vcc	QSPI1_IO2	Vss	QSPI0_IO2	PK_0	PF_6	PE_0	PF_3	PVcc	Vss	PF_0	P8_0	PA_1	PA_7	PVcc	Vss	PD_6	PD_4	PD_1	D				
E	Vss	PH_3	PK_3	PK_2															PD_5	PD_2	TCK/SWDCLK	JP0_0	E				
F	PVcc_HO	HM_CS0#/OM_CS0#	HM_CK/OM_SCLK	PF_7															PD_0	TRST#	TMS/SWDIO	PB_1	F				
G	HM_DQ1/OM_SIO1	HM_RWDS/OM_DQS	HM_CS1#/OM_CS1#	HM_CK#															JP0_1	PB_2	PB_3	P9_2	G				
H	HM_DQ4/OM_SIO4	HM_DQ2/OM_SIO2	HM_DQ3/OM_SIO3	HM_DQ0/OM_SIO0															PB_4	P9_3	PB_5	P9_5	H				
J	HM_RESET#/OM_RESET#	HM_DQ6/OM_SIO6	HM_DQ7/OM_SIO7	HM_DQ5/OM_SIO5	Vcc						Vss	Vss	Vss	Vss	Vss	Vcc							P9_4	P7_7	P7_6	P9_6	J
K	Vss	PJ_6	PH_4	PJ_0	Vcc						Vss	Vss	Vss	Vss	Vcc							P9_7	PG_1	P7_5	PG_2	K	
L	PVcc	P0_1	P0_0	PJ_7	Vcc						Vss	Vss	Vss	Vss	Vcc							P7_1	P7_4	P7_3	P7_2	L	
M	P0_2	P0_5	P0_4	P0_3	Vcc						Vss	Vss	Vss	Vss	Vcc							P6_6	P6_0	P7_0	PVcc	M	
N	PJ_3	PJ_1	P0_6	PJ_2	Vcc						Vss	Vss	Vss	Vss	Vcc							P6_5	PG_3	P6_4	Vss	N	
P	PH_6	PH_5	PK_5	PVcc	Vcc						Vss	Vss	Vss	Vss	Vcc							SD0_DAT7	SD0_RST#	P6_7	PVcc_SD0	P	
R	PVcc	PJ_4	PJ_5	Vss																			SD0_DAT2	SD0_DAT5	SD0_DAT4	SD0_DAT6	R
T	AUDIO_X1	AUDIO_X2	P3_5	P3_2																			SD0_DAT0	SD0_DAT1	SD0_DAT3	Vss	T
U	Vss	PK_4	P3_1	MIPI_AVcc18																			SD1_DAT0	SD1_DAT2	SD0_CMD	SD0_CLK	U
V	CSI_CLKP	CSI_CLKN	PG_4	Vss																			P5_4	SD1_DAT1	SD1_DAT3	PVcc_SD1	V
W	CSI_DATA0P	CSI_DATA0N	Vss	PG_6	P1_0	P1_2	P2_0	PC_2	P4_3	LVDS_APVcc	Vss	LVDS_PLLVcc	USB_DPVcc0	USBVss	Vss	PVcc	Vss	PLLVcc	P5_2	P5_6	SD1_CMD	Vss	W				
Y	CSI_DATA1P	CSI_DATA1N	Vss	P3_3	P1_4	PC_0	P2_2	P4_2	P4_6	NMI	Vss	USBVss	USBVss	USBVss	USBVss	USB_DPVcc1	PC_7	PC_6	P5_0	P5_1	P5_7	SD1_CLK	Y				
AA	MIPI_AVcc18	Vss	P1_1	P3_4	P3_0	PC_1	P4_0	P4_4	P4_7	USB_X2	DP0	USB_APVcc0	RREF0	USBVss	DP1	PVcc	PC_5	XTAL	PC_4	RTC_X2	P5_3	P5_5	AA				
AB	Vss	PG_5	PG_7	P1_3	P2_1	P2_3	P4_1	P4_5	RES#	USB_X1	DM0	USB_APVcc1	RREF1	USBVss	DM1	PVcc	PC_3	EXTAL	Vss	RTC_X1	AVcc	AVss	AB				
	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21	22					

Figure 2.2 Pin Assignment of the 324-Pin BGA (Top Perspective View)

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20						
A	Vcc	QSPI1_IO3	QSPI1_IO1	QSPI1_SPCLK	QSPI0_SSL	QSPI0_IO0	Vss	PVcc	P6_3	PE_6	PL_4	PL_2	PL_1	PF_1	PE_2	PA_3	PA_6	Vss	CKIO	Vss	A					
B	Vss	Vcc	QSPI1_IO2	RPC_INT#	RPC_RESET#	QSPI0_IO3	QSPI0_SPCLK	P6_1	PF_5	PH_1	PF_3	PL_0	PE_5	P8_0	PE_3	PA_2	PA_4	PB_0	Vss	PD_6	B					
C	PH_2	PK_1	Vcc	QSPI1_SSL	RPC_WP#	QSPI0_IO1	QSPI0_IO2	PF_6	PE_0	PF_4	PL_3	PF_2	PE_4	PA_0	PE_1	PA_5	PG_0	Vss	PD_7	PD_5	C					
D	PH_3	PK_3	PK_2	Vcc	QSPI1_IO0	Vss	PVcc_SPI	PK_0	P6_2	PH_0	PVcc	Vss	PF_0	PA_1	PA_7	PVcc	Vss	PD_4	PD_3	PD_1	D					
E	Vss	BSCANP	PF_7	PVcc													PVcc	PD_2	TCK/SWDCLK	JP0_0	E					
F	HM_RWDS/OM_DQS	HM_CK#	HM_CK/OM_SCLK	Vss													TMS/SWDIO	PD_0	TRST#	JP0_1	F					
G	HM_DQ2/OM_SIO2	HM_DQ1/OM_SIO1	HM_CS0#/OM_CS0#	PVcc_HO													Vss	PB_1	PB_2	PB_3	G					
H	HM_DQ3/OM_SIO3	HM_DQ6/OM_SIO6	HM_DQ4/OM_SIO4	HM_CS1#/OM_CS1#													PVcc	PB_5	PB_4	P7_7	H					
J	HM_RES ET#/OM_RESET#	HM_DQ7/OM_SIO7	HM_DQ5/OM_SIO5	HM_DQ0/OM_SIO0	Vcc				Vss	Vss	Vcc											P7_6	PG_2	PG_1	P7_2	J
K	PJ_7	PJ_6	PH_4	PJ_0	Vcc				Vss	Vss	Vcc											PVcc	PG_3	P6_7	PVcc	K
L	PJ_1	PJ_3	PH_5	PVcc	Vcc				Vss	Vss	Vcc											Vss	P6_0	P6_5	Vss	L
M	PH_6	PJ_2	PK_5	Vss	Vcc				Vss	Vss	Vcc											PVcc_SD0	P6_4	P6_6	SD0_RST#	M
N	PVcc	PJ_5	PJ_4	PVcc													SD0_DAT0	SD0_DAT5	SD0_DAT7	SD0_DAT6	N					
P	AUDIO_X1	AUDIO_X2	P3_5	PK_4													PVcc_SD1	SD0_DAT2	SD0_DAT3	SD0_DAT4	P					
R	Vss	P3_1	PG_4	MIPI_AVcc18													Vss	SD0_CMD	SD0_DAT1	SD0_CLK	R					
T	CSI_CLKP	CSI_CLKN	P3_2	Vss													AVss	SD1_DAT0	SD1_CLK	Vss	T					
U	CSI_DATA0P	CSI_DATA0N	Vss	PG_6	PC_0	P3_3	P4_6	LVDS_PLLVcc	LVDS_APVcc	USB_DPVcc0	RREF0	RREF1	Vss	PLLVcc	PVcc	PC_6	AVcc	SD1_CMD	SD1_DAT1	SD1_DAT2	U					
V	CSI_DATA1P	CSI_DATA1N	Vss	P3_4	PC_2	P4_2	P4_7	Vss	Vss	USBVss	USBVss	USBVss	Vss	PC_3	PC_5	PC_7	P5_0	P5_6	P5_7	SD1_DAT3	V					
W	MIPI_AVcc18	Vss	PG_5	P3_0	P4_1	P4_3	NMI	USB_X2	USBVss	DP0	USB_APVcc0	USB_APVcc1	DM1	USB_DPVcc1	PC_4	XTAL	RTC_X2	P5_4	P5_3	P5_5	W					
Y	Vss	PG_7	PC_1	P4_0	P4_4	P4_5	RES#	USB_X1	USBVss	DM0	USBVss	USBVss	DP1	USBVss	EXTAL	Vss	RTC_X1	P5_2	P5_1	Vss	Y					
	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20						

Figure 2.3 Pin Assignment of the 272-Pin BGA (Top Perspective View)

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21				
A	Vcc	QSPI1_SSL	QSPI1_IO3	QSPI1_SPCLK	RPC_RESET#	PVcc_SPI	Vss	QSPI0_SPCLK	P6_1	P6_3	PE_6	PL_4	PL_0	PE_5	PE_4	PE_3	PA_2	PE_1	PA_6	CKIO	Vss	A			
B	PK_1	Vcc	QSPI1_IO0	QSPI1_IO1	RPC_INT#	QSPI0_SSL	QSPI0_IO3	QSPI0_IO1	PF_5	PF_4	PH_1	PL_1	PL_2	P8_0	PF_1	PA_0	PA_7	PA_4	PB_0	Vss	PD_3	B			
C	PK_3	PH_2																			PD_7	PD_1	C		
D	HM_CK/OM_SCLK	BSCANP	Vcc	QSPI1_IO2	RPC_WP#	QSPI0_IO2	PK_0	P6_2	PH_0	PF_3	PF_2	PF_0	PE_2	PA_1	PG_0	PA_5	Vss						PD_5	JP0_0	D
E	HM_CK#	HM_CS0#/OM_CS0#	PK_2	Vcc	Vss	PVcc	QSPI0_IO0	PF_6	PE_0	PL_3	Vcc	Vss	PVcc	PA_3	Vcc	Vss	TCK/SWDCLK					PD_0	TRST#	E	
F	HM_DQ1/OM_SIO1	HM_RWDS/OM_DQS	PF_7	Vss													PD_6	PD_2	JP0_1	PB_1	F				
G	PVcc_HO	HM_DQ2/OM_SIO2	HM_DQ4/OM_SIO4	PVcc													PD_4	TMS/SWDIO	PB_3	PB_5	G				
H	Vss	HM_DQ6/OM_SIO6	HM_CS1#/OM_CS1#	PH_3													PB_2	PB_4	P7_7	PG_2	H				
J	HM_RESET#/OM_RESET#	PH_4	HM_DQ3/OM_SIO3	HM_DQ0/OM_SIO0													PG_1	P7_6	P7_2	P6_0	J				
K	PJ_6	PJ_1	HM_DQ7/OM_SIO7	HM_DQ5/OM_SIO5													PVcc	PG_3	P6_5	P6_4	K				
L	PH_5	PJ_3	PJ_0	Vcc													Vss	P6_7	P6_6	SD0_DAT6	L				
M	PH_6	PJ_7	PJ_2	Vss													Vcc	SD0_RST#	SD0_DAT7	PVcc_SD0	M				
N	P3_5	PJ_5	PJ_4	PK_5													SD0_DAT0	SD0_DAT5	SD0_DAT4	Vss	N				
P	AUDIO_X1	AUDIO_X2	PK_4	PVcc													SD0_CLK	SD0_DAT2	SD0_DAT3	SD0_DAT1	P				
R	PG_4	P3_1	P3_2	Vss													SD1_DAT2	SD1_DAT0	SD1_DAT3	SD0_CMD	R				
T	Vss	Vss	MIPIA_Vcc18	Vcc													SD1_CLK	SD1_CMD	SD1_DAT1	PVcc_SD1	T				
U	CSI_DATA0P	CSI_DATA0N	Vss	PVcc	Vss	LVDS_APVcc	P4_3	P4_7	USBVss	RREF0	RREF1	USBVss	Vss	PLLvcc	PVcc	Vss	P5_4					P5_5	Vss	U	
V	CSI_CLKP	CSI_CLKN	PG_6	P3_3	PC_2	Vss	P4_2	P4_6	Vss	USB_APVcc0	USB_APVcc1	USBVss	PC_4	PC_6	PC_3	PVcc	P5_0					P5_6	P5_7	V	
W	CSI_DATA1P	CSI_DATA1N																			P5_2	P5_3	W		
Y	Vss	Vss	PG_7	PC_0	PC_1	P4_0	P4_4	LVDS_PLLVcc	NMI	USB_X2	USB_DPVcc0	DP0	USBVss	DP1	USB_DPVcc1	Vss	XTAL	RTC_X2	AVcc	PVcc	P5_1	Y			
AA	Vss	PG_5	P3_4	P3_0	Vss	P4_1	P4_5	Vss	RES#	USB_X1	USBVss	DM0	USBVss	DM1	USBVss	PC_5	PC_7	EXTAL	RTC_X1	AVss	PVcc	AA			
	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21				

Figure 2.4 Pin Assignment of the 256-Pin BGA (Top Perspective View)

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15		
A	Vss	PK_3	QSPI1_SPCLK	RPC_WP#	PVcc_SPI	Vss	QSPI0_IO3	P6_1	P6_2	PH_1	PE_6	PL_2	PE_3	CKIO	Vss	A	
B	BSCANP	PH_3	QSPI1_SSL	QSPI1_IO1	RPC_RESET#	QSPI0_IO2	QSPI0_IO1	PK_0	P6_3	PL_4	PL_0	PE_5	PE_1	Vss	PD_7	B	
C	HM_CK/ OM_SCLK	PK_1	QSPI1_IO3	QSPI1_IO2	RPC_INT#	QSPI0_SSL	QSPI0_SPCLK	PE_0	PH_0	PL_1	PE_4	PG_0	Vss	PD_5	PD_3	C	
D	HM_CK#	HM_CS0#/ OM_CS0#	PK_2	Vss	Vcc	QSPI1_IO0	QSPI0_IO0	PVcc	PL_3	PE_2	PVcc	Vss	PD_6	PD_4	PD_1	D	
E	Vss	HM_DQ0/ OM_SIO0	HM_RWDS/ OM_DQS	PVcc									PD_2	PD_0	TCK/ SWDCLK	JP0_0	E
F	PVcc_HO	HM_DQ2/ OM_SIO2	HM_DQ1/ OM_SIO1	HM_CS1#/ OM_CS1#									TMS/ SWDIO	JP0_1	TRST#	P6_0	F
G	HM_DQ4/ OM_SIO4	HM_DQ7/ OM_SIO7	HM_DQ5/ OM_SIO5	HM_DQ3/ OM_SIO3									Vcc	PG_3	PG_2	PVcc	G
H	HM_DQ6/ OM_SIO6	HM_RES ET#/OM RESET#	PH_4	Vcc									PG_1	SD0_DAT5	SD0_RST#	Vss	H
J	PJ_0	PJ_1	PJ_2	Vss									SD0_DAT7	SD0_DAT2	SD0_DAT4	PVcc_SD0	J
K	PJ_5	PJ_3	PJ_4	PVcc									SD0_CLK	SD0_DAT3	SD0_DAT0	SD0_DAT6	K
L	PK_4	P3_5	Vss	Vcc									PVcc	Vss	SD0_DAT1	SD0_CMD	L
M	AUDIO_X1	AUDIO_X2	P3_2	Vss	P3_3	LVDS APVcc	LVDS PLLvcc	NMI	USBVss	PVcc	Vcc	P5_0	P5_4	P5_7	P5_5	M	
N	P3_1	PG_4	Vss	PG_7	P4_2	P4_3	P4_6	RES#	RREF0	Vss	PLLvcc	Vcc	P5_2	P5_3	P5_6	N	
P	PVcc	Vss	PG_6	P4_0	P4_4	P4_7	USB_X2	USB DPVcc0	USB APVcc0	USBVss	XTAL	RTC_X2	AVcc	Vcc	P5_1	P	
R	Vss	PG_5	P3_4	P4_1	P4_5	Vss	USB_X1	DP0	DM0	USBVss	EXTAL	Vss	RTC_X1	AVss	Vcc	R	
	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15		

Figure 2.5 Pin Assignment of the 176-Pin BGA (Top Perspective View)

3. Electrical Characteristics

3.1 Absolute Maximum Ratings

Table 3.1 Absolute Maximum Ratings

Item	Symbol	Value	Unit	
Power supply voltage (I/O)	PVcc	-0.3 to 4.2	V	
Power supply voltage (1.8-/3.3-V switchable I/O)	PVcc_SPI PVcc_SD0 PVcc_SD1	-0.3 to 4.2	V	
Power supply voltage (1.8-V I/O)	PVcc_HO	-0.3 to 4.2	V	
Power supply voltage (Internal)	Vcc	-0.3 to 1.6	V	
PLL power supply voltage	PLLVcc	-0.3 to 1.6	V	
Analog power supply voltage	AVcc	-0.3 to 4.2	V	
USB transceiver analog power supply voltage (I/O)	USBAPVcc1 USBAPVcc0	-0.3 to 4.2	V	
USB transceiver digital power supply voltage (I/O)	USBDPVcc1 USBDPVcc0	-0.3 to 4.2	V	
LVDS analog power supply voltage	LVDSAPVcc	-0.3 to 4.2	V	
LVDS PLL power supply voltage	LVDSPLLVcc	-0.3 to 1.6	V	
MIPI analog power supply voltage	MIPIAVcc18	-0.3 to 2.6	V	
Input voltage	1.8-V I/O input pins	V_{in}	-0.3 to 1.8-V power supply (PVcc_HO, MIPIAVcc18) + 0.3	V
	1.8-/3.3-V switchable I/O input pins	V_{in}	-0.3 to 1.8-/3.3-V power supply (PVcc_SPI, PVcc_SD0, PVcc_SD1) + 0.3	V
	Other input pins	V_{in}	-0.3 to 3.3-V power supply (PVcc, AVcc, USBAPVcc1, USBAPVcc0, USBDPVcc1, USBDPVcc0, LVDSAPVcc) + 0.3	V
Operating temperature	Ambient temperature	T_a	-40 to +85	°C
	Junction temperature	T_j	-40 to +125	
Storage temperature	T_{stg}	-55 to +125	°C	

Caution: Permanent damage to the LSI may result if absolute maximum ratings are exceeded

3.2 Power-On/Power-Off Sequence

The 1.2-V power supply (Vcc, PLLVcc, and LVDSPLLVcc), 1.8-V power supply (PVcc_HO and MIPIAVcc18), 1.8-/3.3-V switchable power supply (PVcc_SPI, PVcc_SD0, PVcc_SD1), and 3.3-V power supply (PVcc, AVcc, USBAPVcc1, USBAPVcc0, USBDPVcc1, USBDPVcc0, and LVDSAPVcc) can be turned on and off in any order.

When turning on the power, be sure to drive both the TRST# and RES# pins low; otherwise, the output pins and input/output pins output undefined levels, resulting in system malfunction.

When turning off the power, drive the TRST# and RES# pins low if the undefined output may cause a problem.

3.3 DC Characteristics

- Conditions used to obtain DC characteristics (2) in Table 3.2 other than current consumption
 $V_{cc} = 1.14$ to 1.26 V, $PV_{cc} = USBDPV_{cc0} = USBDPV_{cc1} = AV_{cc} = 3.0$ to 3.6 V,
 $PV_{cc_SPI} = 3.0$ to 3.6 V/ 1.7 to 1.9 V, $PV_{cc_SD0} = 3.0$ to 3.6 V/ 1.7 to 1.9 V,
 $PV_{cc_SD1} = 3.0$ to 3.6 V/ 1.7 to 1.9 V, $PLL_{Vcc} = 1.14$ to 1.26 V,
 $USBAPV_{cc0} = USBAPV_{cc1} = 3.0$ to 3.6 V, $LVDSAPV_{cc} = 3.0$ to 3.6 V,
 $LVDSPLL_{Vcc} = 1.14$ to 1.26 V, $PV_{cc_HO} = MIPIAV_{cc18} = 1.7$ to 1.9 V,
 $V_{ss} = AV_{ss} = USBV_{ss} = 0$ V
 $T_a = -40$ to $+85^\circ\text{C}$, $T_j = -40$ to $+125^\circ\text{C}$
- Conditions used to obtain DC characteristics (2) in Table 3.2 for current consumption
 $V_{cc} = 1.20$ V, $PV_{cc} = USBDPV_{cc0} = USBDPV_{cc1} = AV_{cc} = 3.3$ V,
 $PV_{cc_SPI} = 3.3$ V/ 1.8 V, $PV_{cc_SD0} = 3.3$ V/ 1.8 V, $PV_{cc_SD1} = 3.3$ V/ 1.8 V,
 $PLL_{Vcc} = 1.20$ V, $USBAPV_{cc0} = USBAPV_{cc1} = 3.3$ V, $LVDSAPV_{cc} = 3.3$ V,
 $LVDSPLL_{Vcc} = 1.20$ V, $PV_{cc_HO} = MIPIAV_{cc18} = 1.8$ V,
 $V_{ss} = AV_{ss} = USBV_{ss} = 0$ V
 $T_a = -40$ to $+85^\circ\text{C}$, $T_j = -40$ to $+125^\circ\text{C}$
 $I_\phi = 528.0$ MHz, $G_\phi = 264.00$ MHz, $B_\phi = 132.00$ MHz, $P1_\phi = 66.00$ MHz, $P0_\phi = 33.00$ MHz

Table 3.2 DC Characteristics (1) [Common Items]

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions	
Power supply voltage	PV_{cc}	3.0	3.3	3.6	V		
	PV_{cc_SPI}	1.7	1.8	1.9	V	1.8-V power supply selection	
	PV_{cc_SD0} PV_{cc_SD1}	3.0	3.3	3.6	V	3.3-V power supply selection	
	PV_{cc_HO}	1.7	1.8	1.9	V		
	V_{cc}	1.14	1.20	1.26	V		
PLL power supply voltage	PLL_{Vcc}	1.14	1.20	1.26	V		
Analog power supply voltage	AV_{cc}	3.0	3.3	3.6	V		
USB power supply voltage	$USBAPV_{cc1}$ $USBAPV_{cc0}$ $USBDPV_{cc1}$ $USBDPV_{cc0}$	3.0	3.3	3.6	V		
LVDS analog power supply voltage	$LVDSAPV_{cc}$	3.0	3.3	3.6	V		
LVDS PLL power supply voltage	$LVDSPLL_{Vcc}$	1.14	1.20	1.26	V		
MIPI analog power supply voltage	$MIPIAV_{cc18}$	1.7	1.8	1.9	V		
Input leakage current	All input pins (except MIPI CSI-2 interface Related Pins*1) MIPI CSI-2 interface Related Pins*1	I_{in}	—	—	1.0	μA	$V_{in} = 0.5$ to $PV_{cc} - 0.5$ V
					10	μA	$V_{in} = 0.5$ to $MIPIAV_{cc18} - 0.5$ V
Three-state leakage current	All input/output pins, all output pins (except PD_0 to PD_7) (off state) PD_0 to PD_7	I_{STI}	—	—	1.0	μA	$V_{in} = 0.5$ to $PV_{cc} - 0.5$ V
					10	μA	
Input capacitance	USB 2.0 Host/Function Module-Related Pins*2	C_{in}	—	—	20	pF	
	All input/output pins and all input pins other than above				10	pF	

Note 1. CSI_DATA0P, CSI_DATA0N, CSI_DATA1P, CSI_DATA1N, CSI_CLKP, CSI_CLKN pins

Note 2. DP1, DP0, DM1, DM0 pins

Table 3.2 DC Characteristics (2) [Current Consumption]

Item	Power Supply	Symbol	Typ.	Max.	Unit	Test Conditions
Current consumption in normal operation	Vcc	Icc	—	994	mA	When the DRP is not in use.
			—	400	mA	When the DRP is in use, these values are added to that of the above columns, respectively.
	PLLvcc	PLLicc	—	21.8	mA	
	LVDSPLLvcc	LVDSPLLicc	—	2.1	mA	
	MIPIAVcc18	MIPIAicc18	—	10	mA	During MIPI transfer
	PVcc_HO	PIcc_HO	15*1	—	mA	PVcc_HO = 1.8 V HM_CK, HM_CK# / OM_SCLK = 132 MHz
	PVcc_SPI	PIcc_SPI	15*1	—	mA	PVcc_SPI = 3.3 V QSPIO_SPCLK, QSPI1_SPCLK = 66 MHz
			15*1	—	mA	PVcc_SPI = 1.8 V QSPIO_SPCLK, QSPI1_SPCLK = 132 MHz
	PVcc_SD0	PIcc_SD0	15*1	—	mA	PVcc_SD0 = 3.3 V SD0_CLK = 33 MHz
			11*1	—	mA	PVcc_SD0 = 1.8 V SD0_CLK = 132 MHz
	PVcc_SD1	PIcc_SD1	15*1	—	mA	PVcc_SD1 = 3.3 V SD1_CLK = 33 MHz
			11*1	—	mA	PVcc_SD1 = 1.8 V SD1_CLK = 132 MHz
	PVcc	PIcc	100*1	—	mA	
	USBDPVcc0 + USBDPVcc1	UDPIcc	52*1	—	mA	In USB high-speed operation (1ch)
			93*1	—	mA	In USB high-speed operation (2ch)
			19*1	—	mA	In USB full-speed operation (1ch)
			29*1	—	mA	In USB full-speed operation (2ch)
	USBAPVcc0 + USBAPVcc1	UAPIcc	—	11	mA	When 1-ch is in use
			—	18	mA	When 2-ch is in use
	LVDSAPVcc	LVDSAPIcc	—	30	mA	During LVDS transfer
	AVcc	AIcc	—	1	mA	During A/D conversion
Current consumption in sleep mode	Vcc	I _{sleep}	—	850	mA	
	For the other power supply, the current consumption is the same as in normal operation.					
Current consumption in software standby mode	Vcc + PLLVcc + LVDSPLLvcc	I _{sstby}	30	500	mA	
	MIPIAVcc18 + PVcc_SPI + PVcc_HO + PVcc_SD0 + PVcc_SD1	PI _{sstby18_33}	0.4	3.4	μA	
	PVcc + AVcc + USBAPVcc1 + USBAPVcc0 + USBDPVcc1 + USBDPVcc0 + LVDSAPVcc	PI _{sstby}	3	20	μA	When the USB host/function is not in use
			4.5	5	mA	When the USB host/function is in use

Item	Power Supply	Symbol	Typ.	Max.	Unit	Test Conditions
Current consumption in deep standby mode	Vcc + PLLVcc + LVDSPLLvcc	I _{dstby}	16	155	μA	RAM 0 Kbytes retained
			22	170	μA	RAM 16 Kbytes retained
			28	185	μA	RAM 32 Kbytes retained
			40	215	μA	RAM 64 Kbytes retained
			64	275	μA	RAM 128 Kbytes retained
	MIPIAVcc18 + PVcc_SPI + PVcc_HO + PVcc_SD0 + PVcc_SD1	PI _{dstby18_33}	0.4	2.1	μA	
	PVcc + AVcc + USBAPVcc1 + USBAPVcc0 + USBDPVcc1 + USBDPVcc0 + LVDSAPVcc	PI _{dstby}	2.4	7	μA	RTC is not operating
			7.7	12.5	μA	RTC_X1 selected
			1.3	—	mA	EXTAL 12 MHz selected, small gain
			1.5	—	mA	EXTAL 24 MHz selected, small gain

Note 1. Reference value. The actual operating current greatly depends on the system (such as slow rising/falling edges caused by IO load and toggle frequency). Be sure to determine the value using the actual system.

Table 3.2 DC Characteristics (3) [Except 1.8-/3.3-V Switchable I/O Interface, I²C Bus Interface, and USB 2.0 Host/Function Module-Related Pins]

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions	
Input high voltage*1	V _{IH}	2.2	—	PVcc + 0.3	V		
Input low voltage*1	V _{IL}	-0.3	—	0.8	V		
Schmitt trigger input characteristics	VT ⁺	PVcc × 0.665	—	PVcc + 0.3	V		
	VT ⁻	-0.3	—	0.8	V		
	VT ⁺ - VT ⁻	0.2	—	—	V		
Output high voltage	V _{OH}	PVcc - 0.5	—	—	V	I _{OH} = -8.0 mA*2, -2.0 mA*3	
Output low voltage	V _{OL}	—	—	0.4	V	I _{OL} = 8.0 mA*2, 2.0 mA*3	
RAM standby voltage	Software standby mode (large-capacity on-chip RAM)	V _{RAMS}	0.85	—	—	V	Measured with Vcc as parameter
	Deep standby mode (only the on-chip RAM for data retention)	V _{RAMD}	1.14	—	—	V	

Note 1. Except for Schmitt trigger function

Note 2. This is the value when high driving ability is set with a pin for which high driving ability is selectable.

Note 3. This is the value when normal driving ability is set with a pin for which high driving ability is selectable or the value of the pin to which normal driving ability is fixed.

Table 3.2 DC Characteristics (4) [1.8-/3.3-V Switchable I/O Interface*]

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Input high voltage	V_{IH}	1.27	—	$PVcc_* + 0.3$	V	PVcc_SPI with 1.8-V power supply selection
				2		PVcc_SD0 and PVcc_SD1 with 1.8-V power supply selection
Input low voltage	V_{IL}	-0.3	—	$PVcc_* \times 0.625$	V	3.3-V power supply selection
				0.58		1.8-V power supply selection
Output high voltage	V_{OH}	1.4	—	—	V	1.8-V power supply selection, $I_{OH} = -2.0$ mA
				$PVcc_* \times 0.75$		3.3-V power supply selection, $I_{OH} = -2.0$ mA
Output low voltage	V_{OL}	—	—	0.45	V	1.8-V power supply selection, $I_{OL} = 2.0$ mA
				$PVcc_* \times 0.125$		3.3-V power supply selection, $I_{OL} = 2.0$ mA

Note: PVcc_SPI, PVcc_SD0, PVcc_SD1

Table 3.2 DC Characteristics (5) [1.8-V I/O Interface*]

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Input high voltage	V_{IH}	1.27	—	$PVcc_* + 0.3$	V	
Input low voltage	V_{IL}	-0.3	—	0.58	V	
Output high voltage	V_{OH}	1.4	—	—	V	$I_{OH} = -2.0$ mA
Output low voltage	V_{OL}	—	—	0.45	V	$I_{OL} = 2.0$ mA

Note: PVcc_HO

Table 3.2 DC Characteristics (6) [I²C Bus Interface-Related Pins*]

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Input high voltage	V_{IH}	$PVcc \times 0.7$	—	$PVcc + 0.3$	V	
Input low voltage	V_{IL}	-0.3	—	$PVcc \times 0.3$	V	
Schmitt trigger input characteristics	$V_{IH} - V_{IL}$	$PVcc \times 0.05$	—	—	V	
Output low voltage	V_{OL}	—	—	0.4	V	$I_{OL} = 3.0$ mA (RIICnFER.FMPE = 0)
		—	—	0.4	V	$I_{OL} = 20.0$ mA (RIICnFER.FMPE = 1)

Note: The PD_0 to PD_7 pins are open-drain pins.

Table 3.2 DC Characteristics (7) [USB 2.0 Host/Function Module-Related Pins*]

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Reference resistance	R_{REF}	2.2 k Ω \pm 1%				

Note: RREF0, RREF1 pins.

Table 3.2 DC Characteristics (8) [USB 2.0 Host/Function Module-Related Pins* (Low-Speed, Full-Speed, and High-Speed Common Items)]

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
DP pull-up resistance (when function is selected)	R_{pu}	0.900	—	1.575	k Ω	In idle mode
		1.425	—	3.090	k Ω	In transmit/receive mode
DP and DM pull-down resistance (when host is selected)	R_{pd}	14.25	—	24.80	k Ω	

Note: DP1, DP0, DM1, and DM0 pins

Table 3.2 DC Characteristics (9) [USB 2.0 Host/Function Module-Related Pins* (Low-Speed and Full-Speed)]

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Input high voltage	V_{IH}	2.0	—	—	V	
Input low voltage	V_{IL}	—	—	0.8	V	
Differential input sensitivity	V_{DI}	0.2	—	—	V	$ (DP) - (DM) $
Differential common mode range	V_{CM}	0.8	—	2.5	V	
Output high voltage	V_{OH}	2.8	—	3.6	V	$I_{OH} = -200 \mu A$
Output low voltage	V_{OL}	0.0	—	0.3	V	$I_{OL} = 2 \text{ mA}$
Output signal crossover voltage	V_{CRS}	1.3	—	2.0	V	$C_L = 50 \text{ pF}$ (full-speed) $C_L = 200 \text{ to } 600 \text{ pF}$ (low-speed)

Note: DP1, DP0, DM1, and DM0 pins

Table 3.2 DC Characteristics (10) [USB 2.0 Host/Function Module-Related Pins* (High-Speed)]

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Squelch detection threshold voltage (differential voltage)	V_{HSSQ}	100	—	150	mV	
Common mode voltage range	V_{HSCM}	-50	—	500	mV	
Idle state	V_{HSOI}	-10.0	—	10.0	mV	
Output high voltage	V_{HSOH}	360	—	440	mV	
Output low voltage	V_{HSOL}	-10.0	—	10.0	mV	
Chirp J output voltage (difference)	V_{CHIRPJ}	700	—	1100	mV	
Chirp K output voltage (difference)	V_{CHIRPK}	-900	—	-500	mV	

Note: DP1, DP0, DM1, and DM0 pins

Table 3.2 DC Characteristics (11) [LVDS-Related Pins*]

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Differential Output Voltage	VOD	250	350	450	mV	$R_L = 100\Omega$
Difference VOD between 'H' and 'L'	ΔVOD	—	—	50	mV	$R_L = 100\Omega$
Offset (Common Mode) Voltage	VOS	1.125	1.25	1.375	V	$R_L = 100\Omega$
Difference VOS between 'H' and 'L'	ΔVOS	—	—	50	mV	$R_L = 100\Omega$

Note: TXCLKOUTP, TXCLKOUTM, TXOUT2P to TXOUT0P, and TXOUT2M to TXOUT0M pins

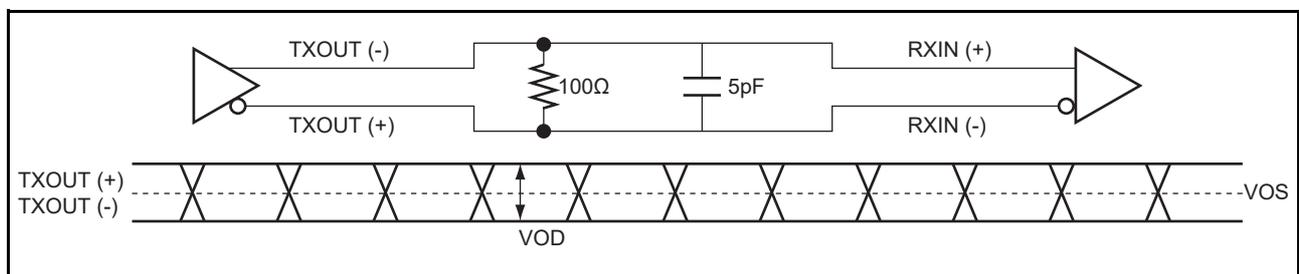


Figure 3.1 LVDS output waveform

Table 3.2 DC Characteristics (12) [MIPI CSI-2 interface-Related Pins*]

Item	Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Input signal voltage range	V_{PIN}	-50	—	1350	mV	
Ground shift	V_{GNDSH}	-50	—	50	mV	
transient pin voltage level	$V_{PIN(absmax)}$	-0.15	—	1.45	V	
Differential input high threshold	V_{IDTH}	—	—	70	mV	HS Receiver
Differential input low threshold	V_{IDTL}	-70	—	—	mV	HS Receiver
Single-ended input high voltage	V_{IHHS}	—	—	460	mV	HS Receiver
Single-ended input low voltage	V_{ILHS}	-40	—	—	mV	HS Receiver
Input common mode voltage	$V_{CMRX(DC)}$	70	—	330	mV	HS Receiver
Differential input impedance	Z_{ID}	80	—	125	Ω	HS Receiver
Input high voltage	V_{IH}	880	—	—	mV	LP Receiver
Input low voltage	V_{IL}	—	—	550	mV	LP Receiver
Input hysteresis	V_{HYST}	—	50	—	mV	LP Receiver, Reference value

Note: CSI_DATA0P, CSI_DATA0N, CSI_DATA1P, CSI_DATA1N, CSI_CLKP, CSI_CLKN pins

Table 3.3 Permissible Output Currents

Item		Symbol	Min.	Typ.	Max.	Unit	
Permissible output low current (per pin)	PD_0 to PD_7	High-speed mode	IOL	—	—	20	mA
		Normal mode				6	mA
	The CKIO, SD0_CLK, and SD1_CLK output pins, and output pins driven by the PVcc_SPI, or PVcc_HO power supply pin	High drive				12	mA
		Normal drive				8	mA
		SD0_CMD, SD0_DAT7 to SD0_DAT0, SD1_CMD, SD1_DAT3 to SD1_DAT0				6	mA
		Output pins other than above	High drive*1			8	mA
	Normal drive*2			2	mA		
Permissible output high current (per pin)	The CKIO, SD0_CLK, and SD1_CLK output pins, and output pins driven by the PVcc_SPI, or PVcc_HO power supply pin	High drive	- IOH	—	—	12	mA
		Normal drive				8	mA
	SD0_CMD, SD0_DAT7 to SD0_DAT0, SD1_CMD, SD1_DAT3 to SD1_DAT0	High drive*1				8	mA
		Normal drive*2				2	mA
		SD0_CMD, SD0_DAT7 to SD0_DAT0, SD1_CMD, SD1_DAT3 to SD1_DAT0				6	mA
		Output pins other than above	High drive*1			8	mA
	Normal drive*2			2	mA		
Permissible output current (total)		Σ IO	—	—	150	mA	

Caution: To protect the LSI's reliability, the output current values should not exceed the values in Table 3.3.

Note 1. This is the value when high driving ability is set with a pin for which high driving ability is selectable.

Note 2. This is the value when normal driving ability is set with a pin for which high driving ability is selectable or the value of the pin to which normal driving ability is fixed.

3.4 AC Characteristics

Signals input to this LSI are basically handled as signals in synchronization with a clock. The setup and hold times for input pins must be followed.

Conditions for AC characteristics: $V_{cc} = 1.14$ to 1.26 V, $PV_{cc} = USBDPV_{cc0} = USBDPV_{cc1} = AV_{cc} = 3.0$ to 3.6 V, $PV_{cc_SPI} = 3.0$ to 3.6 V/ 1.7 to 1.9 V, $PV_{cc_SD0} = 3.0$ to 3.6 V/ 1.7 to 1.9 V, $PV_{cc_SD1} = 3.0$ to 3.6 V/ 1.7 to 1.9 V, $PLL_{Vcc} = 1.14$ to 1.26 V, $USBAPV_{cc0} = USBAPV_{cc1} = 3.0$ to 3.6 V, $LVDSAPV_{cc} = 3.0$ to 3.6 V, $LVDSPLL_{Vcc} = 1.14$ to 1.26 V, $PV_{cc_HO} = MIPIAV_{cc18} = 1.7$ to 1.9 V, $V_{ss} = AV_{ss} = USBV_{ss} = 0$ V, $T_a = -40$ to $+85^{\circ}\text{C}$, $T_j = -40$ to $+125^{\circ}\text{C}$

Table 3.4 Operating Frequency

Item	Symbol	Min.	Max.	Unit	Remarks
Operating frequency	CPU clock ($I\phi$)	f	55	528	MHz
	Image processing clock ($G\phi$)		55	264	MHz
	Internal bus clock ($B\phi$)		27.5	132	MHz
	Peripheral clock 1 ($P1\phi$)		27.5	66	MHz
	Peripheral clock 0 ($P0\phi$)		27.5	33	MHz

3.4.1 Clock Timing

Table 3.5 Clock Timing

Item	Symbol	Min.	Max.	Unit	Figure
EXTAL clock input frequency (when the clock is supplied to USB 2.0 host/function module)	f_{EX}	12MHz \pm 100ppm 24MHz \pm 100ppm			Figure 3.2
EXTAL clock input frequency (when the clock isn't supplied to USB 2.0 host/function module)		10 20	12 24	MHz	
EXTAL clock input cycle time (when the clock isn't supplied to USB 2.0 host/function module)	t_{EXcyc}	83.34 41.67	100 50	ns	
AUDIO_X1 clock input frequency (crystal resonator connected)	f_{EX}	10.00	50.00	MHz	
AUDIO_X1 clock input cycle time (crystal resonator connected)	t_{EXcyc}	20.00	100.00	ns	
AUDIO_X1, AUDIO_CLK clock input frequency (external clock input)	f_{EX}	1.00	50.00	MHz	
AUDIO_X1, AUDIO_CLK clock input cycle time (external clock input)	t_{EXcyc}	20.00	1000.00	ns	
USB_X1 clock input frequency (when the 48-MHz clock is supplied to USB 2.0 host/function module)	f_{EX}	48MHz \pm 100ppm			
EXTAL, AUDIO_X1, AUDIO_CLK, USB_X1 clock input low pulse width	t_{EXL}	0.4	0.6	t_{EXcyc}	
EXTAL, AUDIO_X1, AUDIO_CLK, USB_X1 clock input high pulse width	t_{EXH}	0.4	0.6	t_{EXcyc}	
EXTAL, AUDIO_X1, AUDIO_CLK, USB_X1 clock input rise time	t_{EXr}	—	4	ns	
EXTAL, AUDIO_X1, AUDIO_CLK, USB_X1 clock input fall time	t_{EXf}	—	4	ns	
CKIO clock output frequency	f_{OP}	27.5*1	132*1	MHz	
CKIO clock output cycle time	t_{cyc}	7.58*1	36.36*1	ns	Figure 3.3 (1), Figure 3.3 (2)
CKIO clock output low pulse width 1	t_{CKOL1}	$t_{cyc} / 2 - t_{CKOr1}$	—	ns	Figure 3.3 (1)
CKIO clock output high pulse width 1	t_{CKOH1}	$t_{cyc} / 2 - t_{CKOf1}$	—	ns	
CKIO clock output rise time 1	t_{CKOr1}	—	3	ns	
CKIO clock output fall time 1	t_{CKOf1}	—	3	ns	
CKIO clock output low pulse width 2	t_{CKOL2}	$t_{cyc} / 2 - t_{CKOr2}$	—	ns	Figure 3.3 (2)
CKIO clock output high pulse width 2	t_{CKOH2}	$t_{cyc} / 2 - t_{CKOf2}$	—	ns	
CKIO clock output rise time 2	t_{CKOr2}	—	2	ns	
CKIO clock output fall time 2	t_{CKOf2}	—	2	ns	
CKIO clock output low pulse width 3	t_{CKOL3}	$t_{cyc} / 2 - t_{CKOr3}$	—	ns	Figure 3.3 (3)
CKIO clock output high pulse width 3	t_{CKOH3}	$t_{cyc} / 2 - t_{CKOf3}$	—	ns	
CKIO clock output rise time 3	t_{CKOr3}	—	1*2	ns	
CKIO clock output fall time 3	t_{CKOf3}	—	1*2	ns	
On-chip PLL circuit oscillation settling time	t_{POSC}	1	—	ms	Figure 3.4, Figure 3.5
On-chip oscillation circuit oscillation settling time (RTC_X1)	t_{ROSC}	—	3*3	s	Figure 3.7
On-chip oscillation circuit oscillation settling time (other than above)		—	4*3	ms	Figure 3.4, Figure 3.5, Figure 3.7
Mode hold time	t_{MDH}	200	—	ns	Figure 3.4, Figure 3.5

Note 1. The range of CKIO clock output frequency and cycle time is determined by register settings. See Table 6.4 and Table 6.5 in Section 6, Clock Pulse Generator, of the RZ/A2M Group User's Manual.

Note 2. Output load: 15 pF

Note 3. Settings for values smaller than the above specifications may be possible, as long as the values are confirmed through evaluation by the manufacturer of the oscillator.

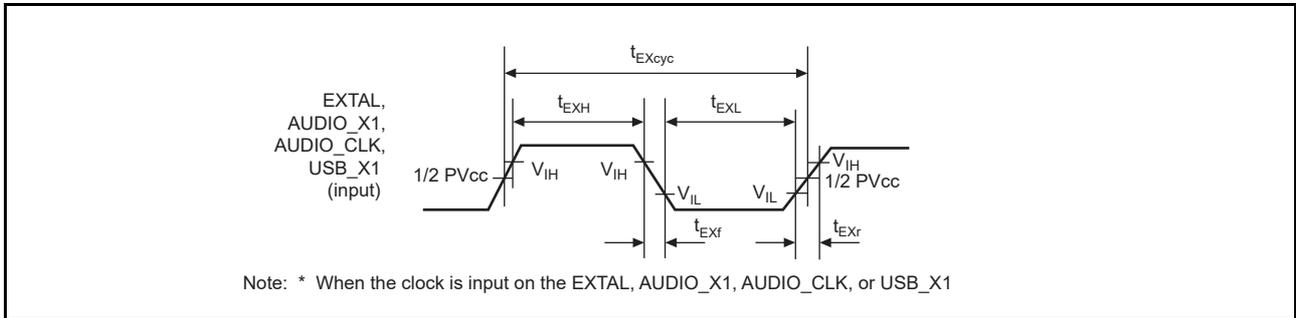


Figure 3.2 EXTAL, AUDIO_X1, AUDIO_CLK, and USB_X1 Clock Input Timing

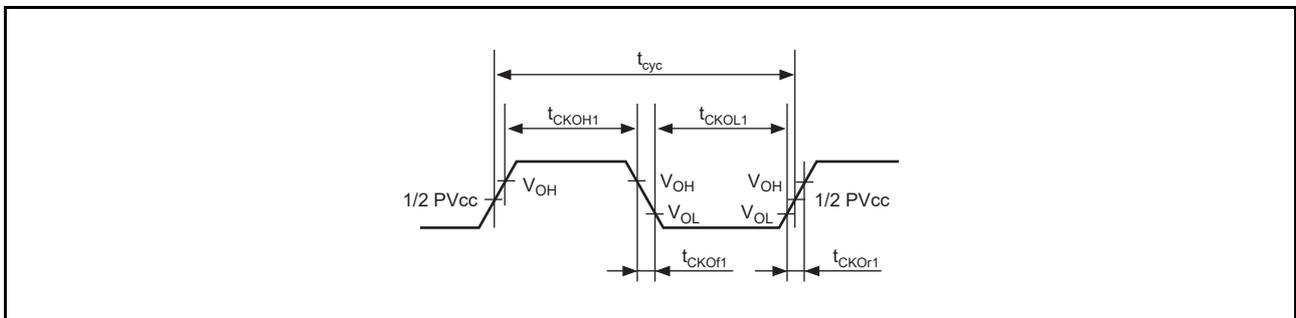


Figure 3.3 (1) CKIO Clock Output Timing 1

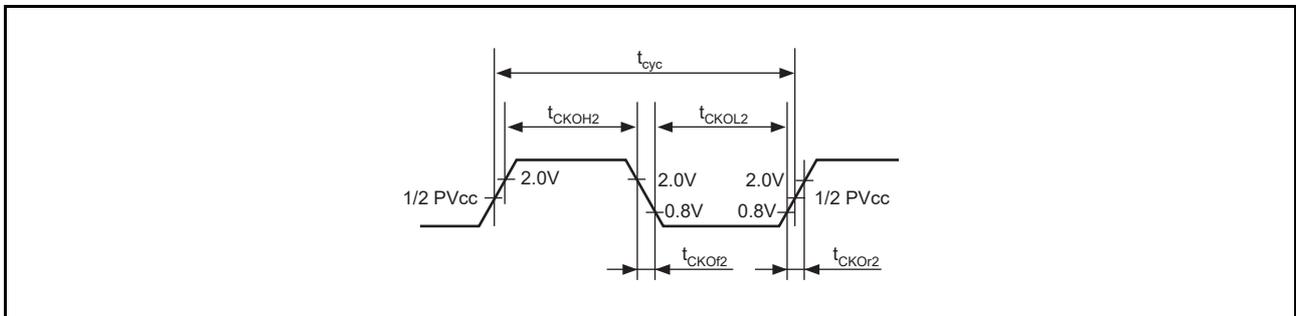


Figure 3.3 (2) CKIO Clock Output Timing 2

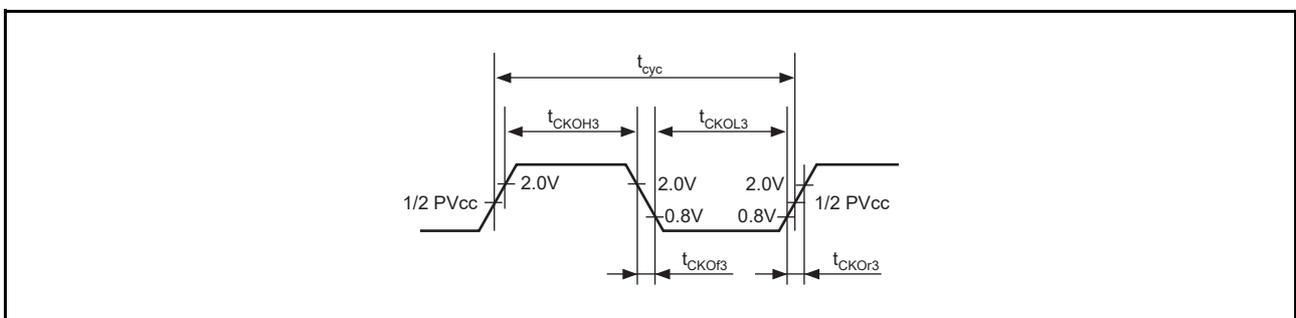


Figure 3.3 (3) CKIO Clock Output Timing 3

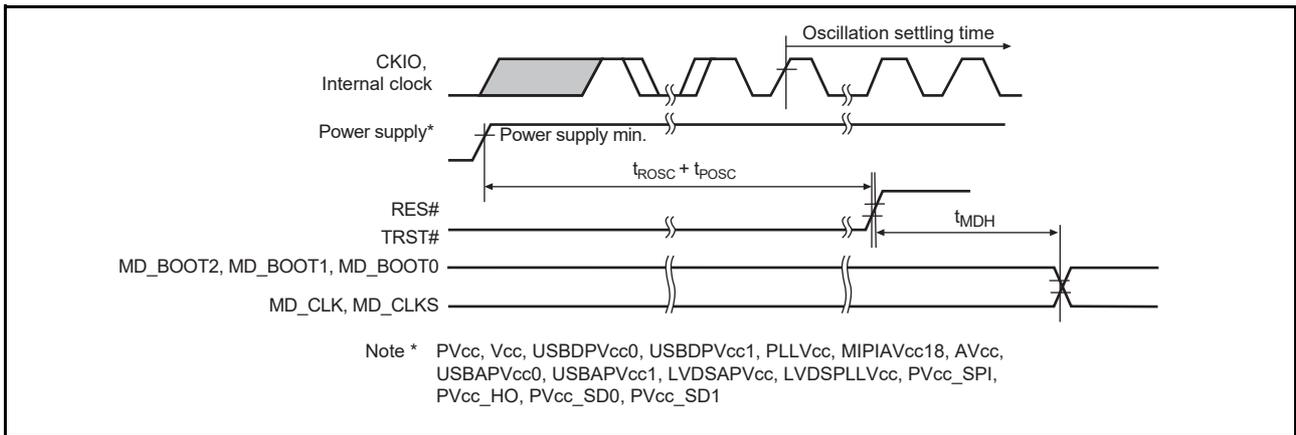


Figure 3.4 Power-On Oscillation Settling Time

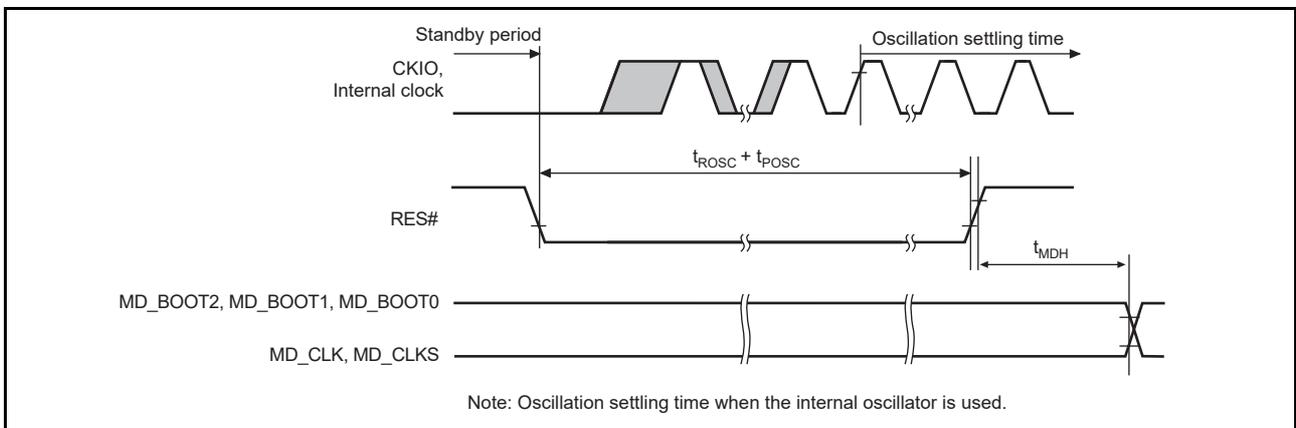


Figure 3.5 Oscillation Settling Time on Return from Standby (Return by Reset)

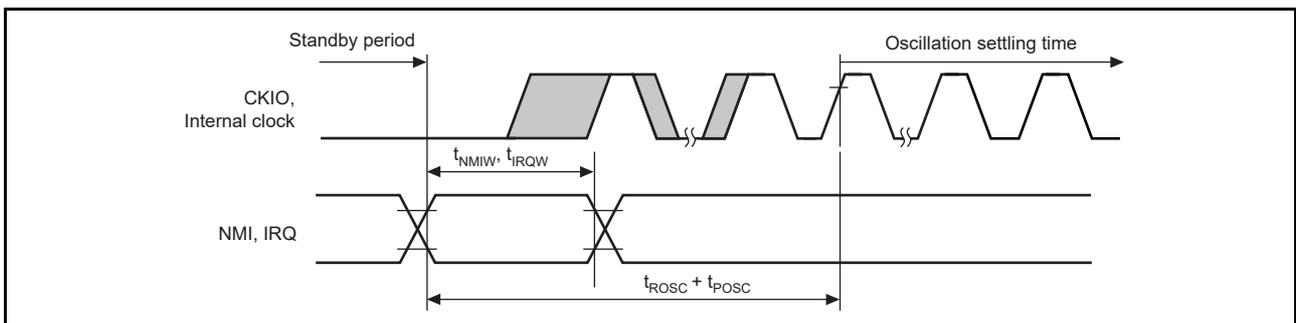


Figure 3.6 Oscillation Settling Time on Return from Standby (Return by NMI or IRQ)

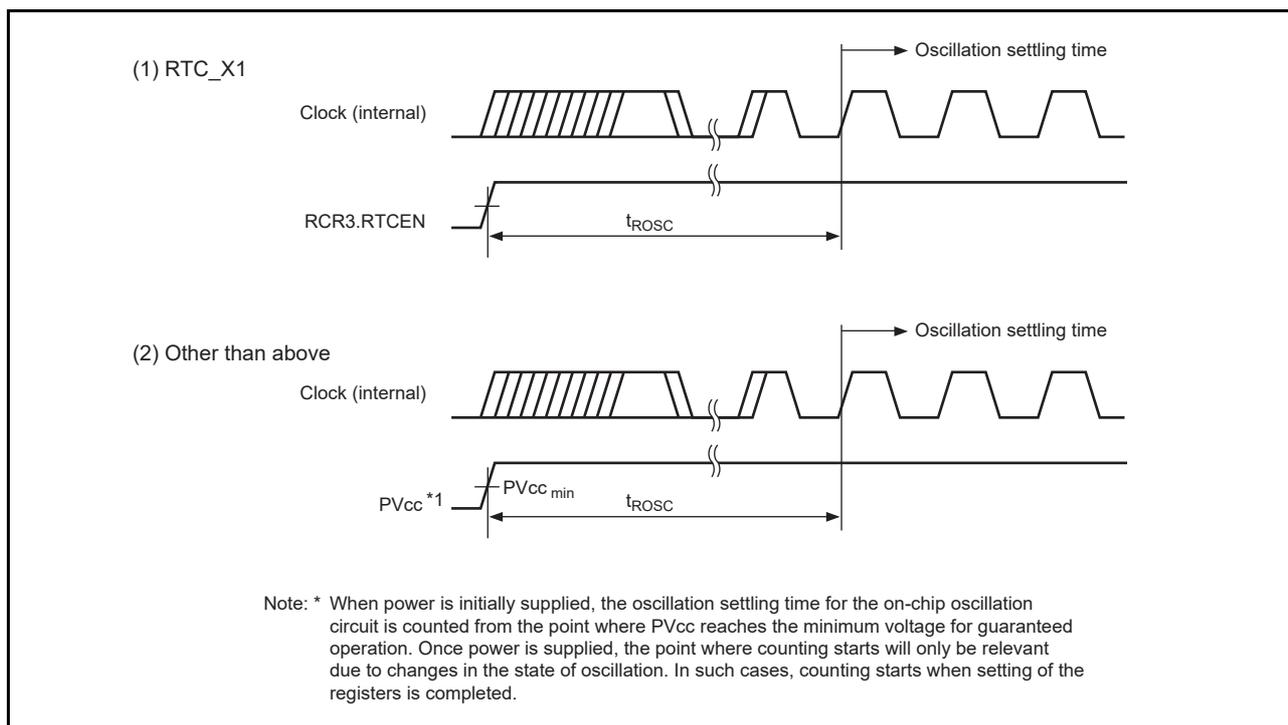


Figure 3.7 On-chip Oscillation Circuit Oscillation Settling Time

3.4.2 Control Signal Timing

Table 3.6 Control Signal Timing

Item	Symbol	Min.	Max.	Unit	Figure	
RES# pulse width	Exit from standby mode	t_{RESW}	10	—	ms	Figure 3.8 (1)
	Other than above		20	—	tcyc*2	
TRST# pulse width	t_{TRSW}	20	—	tcyc*2		
NMI pulse width	t_{NMIW}	20	—	tcyc*2	Figure 3.3 (2) , Figure 3.6	
IRQ pulse width	t_{IRQW}	20	—	tcyc*2		
TINT pulse width	t_{TINTW}	20	—	tcyc*2		
TINT input wait timing in the same group*1	t_{TINTGW}	20	—	tcyc*2	Figure 3.8 (2)	
RES# input rise time	t_{RSr}	—	500	μ s	Figure 3.8 (3)	

Note 1. This restriction applies only to the same group of pin interrupts. For details, see section 51.4.4.2, Restriction on the Input from Pins in the Same Group, in the RZ/A2M Group User's Manual.

Note 2. tcyc indicates the cycle when the setting of the CKIOSEL bits in the CKIO select register is 2'b01 (initial value).

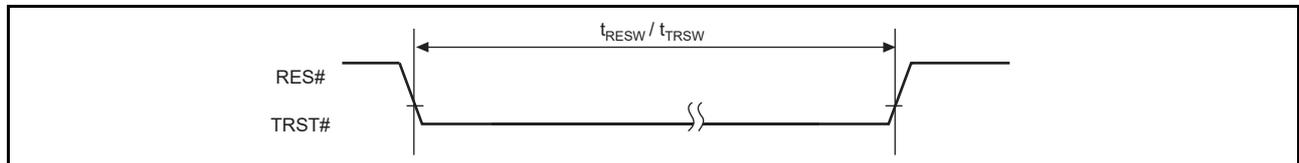


Figure 3.8 (1) Reset Input Timing 1

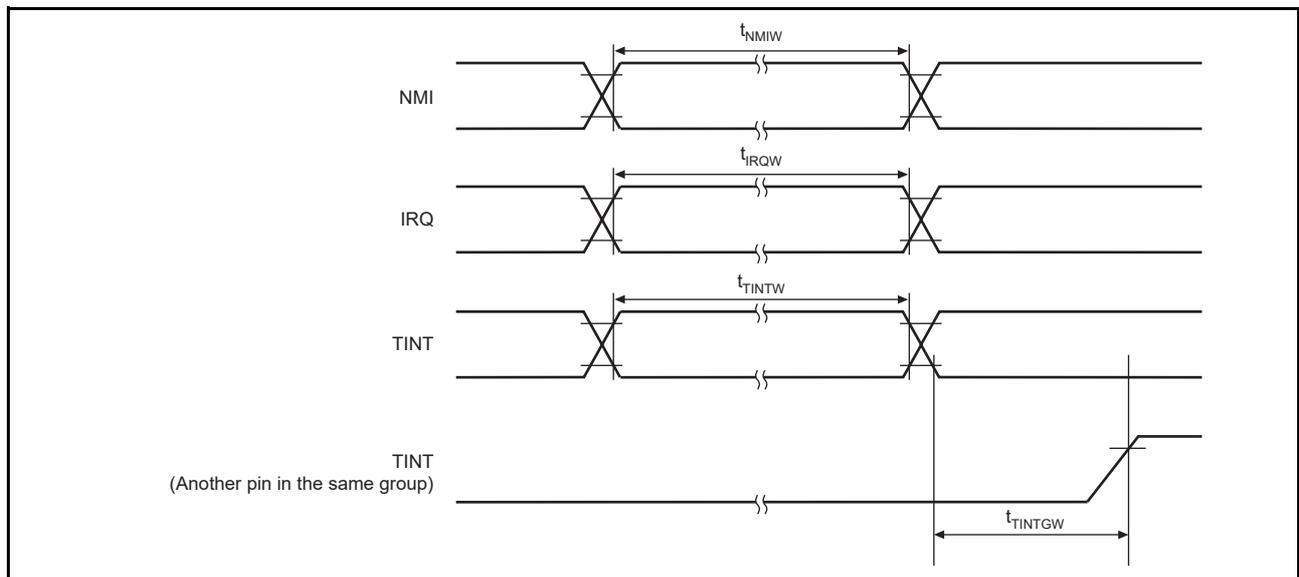


Figure 3.8 (2) Interrupt Signal Input Timing

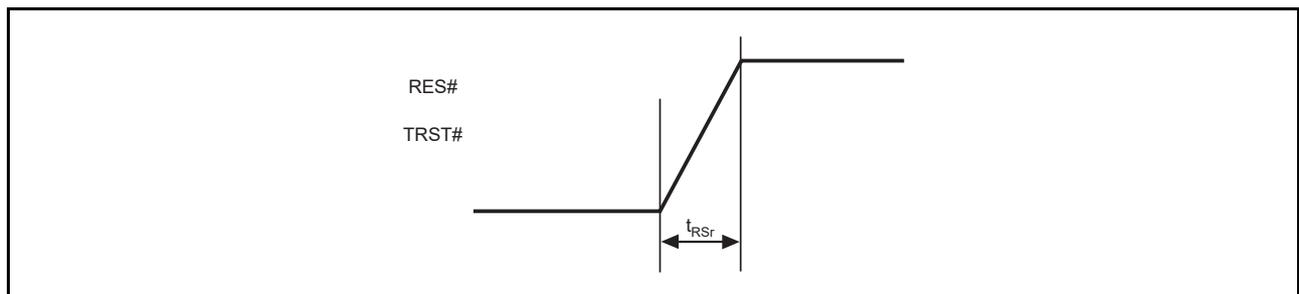


Figure 3.8 (3) Reset Input Timing 2

3.4.3 SPI Multi I/O Bus Controller, Octa Memory/HyperBus™ Controller Reset Output Timing

Table 3.7 SPI Multi I/O Bus Controller, Octa Memory/HyperBus™ Controller Reset Output Timing

Item	Symbol	Min.	Max.	Unit	Figure
Memory reset pulse width	t_{RP}	2500	—	t_{p0cyc}	Figure 3.9 to Figure 3.12
Memory reset (negate) to memory access time	t_{RH}	500	—	t_{p0cyc}	

Note: t_{p0cyc} indicates the peripheral clock 0 (P0φ) cycle.

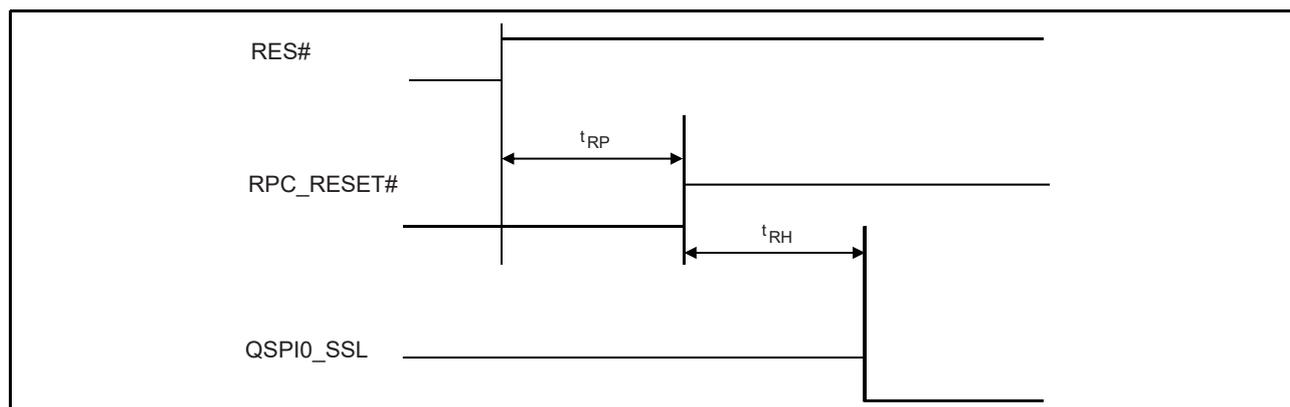


Figure 3.9 SPI Multi I/O Bus Controller Reset Output Timing after a power-on reset (Boot Modes 3, 4, and 5)

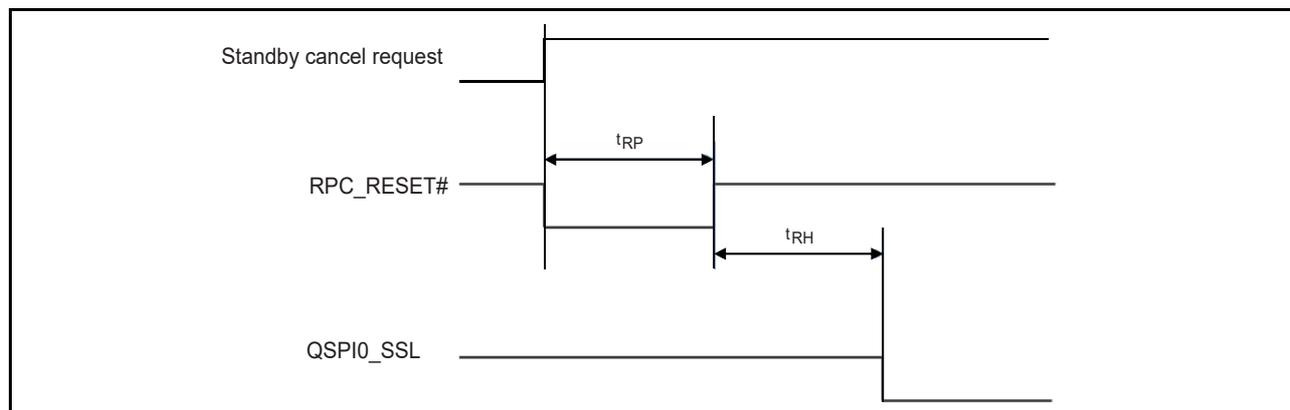


Figure 3.10 SPI Multi I/O Bus Controller Reset Output Timing after recovery from deep standby (Boot Modes 3, 4, and 5)

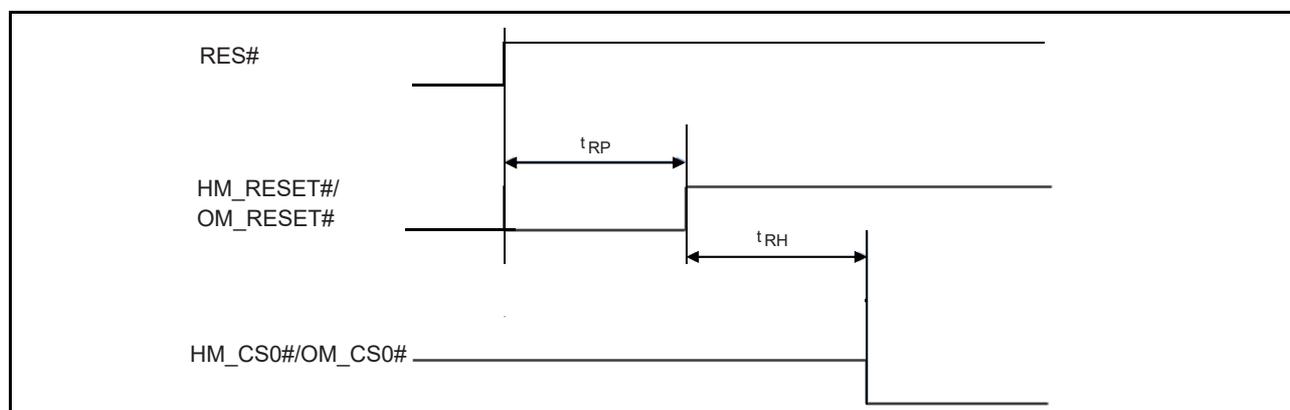


Figure 3.11 Octa Memory/HyperBus™ Controller Reset Output Timing after a power-on reset (Boot Modes 6 and 7)

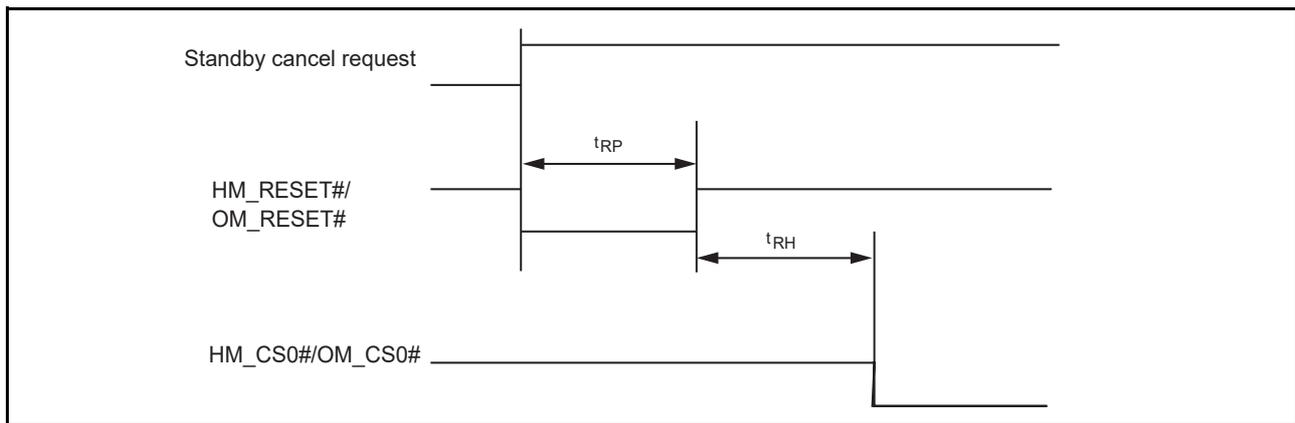


Figure 3.12 Octa Memory/HyperBus™ Controller Reset Output Timing after recovery from deep standby (Boot Modes 6 and 7)

3.4.4 Bus Timing

Table 3.8 Bus Timing

Item	Symbol	CKIO = 132 MHz ^{*1}		Unit	Figure
		Min.	Max.		
Address delay time 1	t _{AD1}	2.0	4.8	ns	Figure 3.13 to Figure 3.37
Address delay time 2	t _{AD2}	1 / 2 t _{cyc}	1 / 2 t _{cyc} + 8 * ³	ns	Figure 3.20
Address setup time	t _{AS}	0	—	ns	Figure 3.13 to Figure 3.16, Figure 3.20
Chip enable setup time	t _{cs}	0	—	ns	Figure 3.13 to Figure 3.16, Figure 3.20
Address hold time	t _{AH}	0	—	ns	Figure 3.13 to Figure 3.16
BS delay time	t _{BSD}	—	4.8	ns	Figure 3.13 to Figure 3.34
CS delay time 1	t _{CSD1}	2.0	4.8	ns	Figure 3.13 to Figure 3.37
Read write delay time 1	t _{RWD1}	2.0	4.8	ns	Figure 3.13 to Figure 3.37
Read strobe delay time	t _{RSD}	1 / 2 t _{cyc}	1 / 2 t _{cyc} + 12 * ³	ns	Figure 3.13 to Figure 3.20
Read data setup time 1	t _{RDS1}	1 / 2 t _{cyc} + 5 * ³	—	ns	Figure 3.13 to Figure 3.19
Read data setup time 2	t _{RDS2}	2.0	—	ns	Figure 3.21 to Figure 3.24, Figure 3.29 to Figure 3.31
Read data setup time 3	t _{RDS3}	1 / 2 t _{cyc} + 5 * ³	—	ns	Figure 3.20
Read data hold time 1	t _{RDH1}	0	—	ns	Figure 3.13 to Figure 3.19
Read data hold time 2	t _{RDH2}	2.5	—	ns	Figure 3.21 to Figure 3.24, Figure 3.29 to Figure 3.31
Read data hold time 3	t _{RDH3}	0	—	ns	Figure 3.20
Write enable delay time 1	t _{WED1}	1 / 2 t _{cyc}	1 / 2 t _{cyc} + 12 * ³	ns	Figure 3.13 to Figure 3.18
Write enable delay time 2	t _{WED2}	—	4.8	ns	Figure 3.19
Write data delay time 1	t _{WDD1}	—	4.8	ns	Figure 3.13 to Figure 3.19
Write data delay time 2	t _{WDD2}	—	4.8	ns	Figure 3.25 to Figure 3.28, Figure 3.32 to Figure 3.34
Write data hold time 1	t _{WDH1}	2.0	—	ns	Figure 3.13 to Figure 3.19
Write data hold time 2	t _{WDH2}	2.0	—	ns	Figure 3.25 to Figure 3.28, Figure 3.32 to Figure 3.34
Write data hold time 4	t _{WDH4}	0	—	ns	Figure 3.13 to Figure 3.17
WAIT setup time	t _{WTS}	1 / 2 t _{cyc} + 5.0 * ³	—	ns	Figure 3.14 to Figure 3.20
WAIT hold time	t _{WTH}	1 / 2 t _{cyc} + 3.5 * ³	—	ns	Figure 3.14 to Figure 3.20
RAS delay time 1	t _{RASD1}	2.0	4.8	ns	Figure 3.21 to Figure 3.37
CAS delay time 1	t _{CASD1}	2.0	4.8	ns	Figure 3.21 to Figure 3.37
DQM delay time 1	t _{DQMD1}	2.0	4.8	ns	Figure 3.21 to Figure 3.34
CKE delay time 1	t _{CKED1}	2.0	4.8	ns	Figure 3.36
AH delay time	t _{AHD}	1 / 2 t _{cyc}	1 / 2 t _{cyc} + 12 * ³	ns	Figure 3.17
Multiplexed address delay time	t _{MAD}	—	12* ³	ns	Figure 3.17
Multiplexed address hold time	t _{MAH}	1.0* ³	—	ns	Figure 3.17
Address setup time for AH	t _{AVVH}	1 / 2 t _{cyc} - 2	—	ns	Figure 3.17
DACK, TEND delay time	t _{DACD}	Refer to the direct memory access controller timing		ns	Figure 3.13 to Figure 3.34

Note 1. The maximum value (f_{max}) of CKIO (external bus clock) depends on the number of wait cycles and the system configuration of your board.

Note 2. 1/2 t_{cyc} indicated in minimum and maximum values for the item of delay, setup, and hold times represents a half cycle from the rising edge with a clock. That is, 1/2 t_{cyc} describes a reference of the falling edge with a clock.

Note 3. These values specified are for 66 MHz max operation. For CKIO = 110 to 132 MHz operation, some wait cycle insertion and input timing design are required depending on the system configuration.

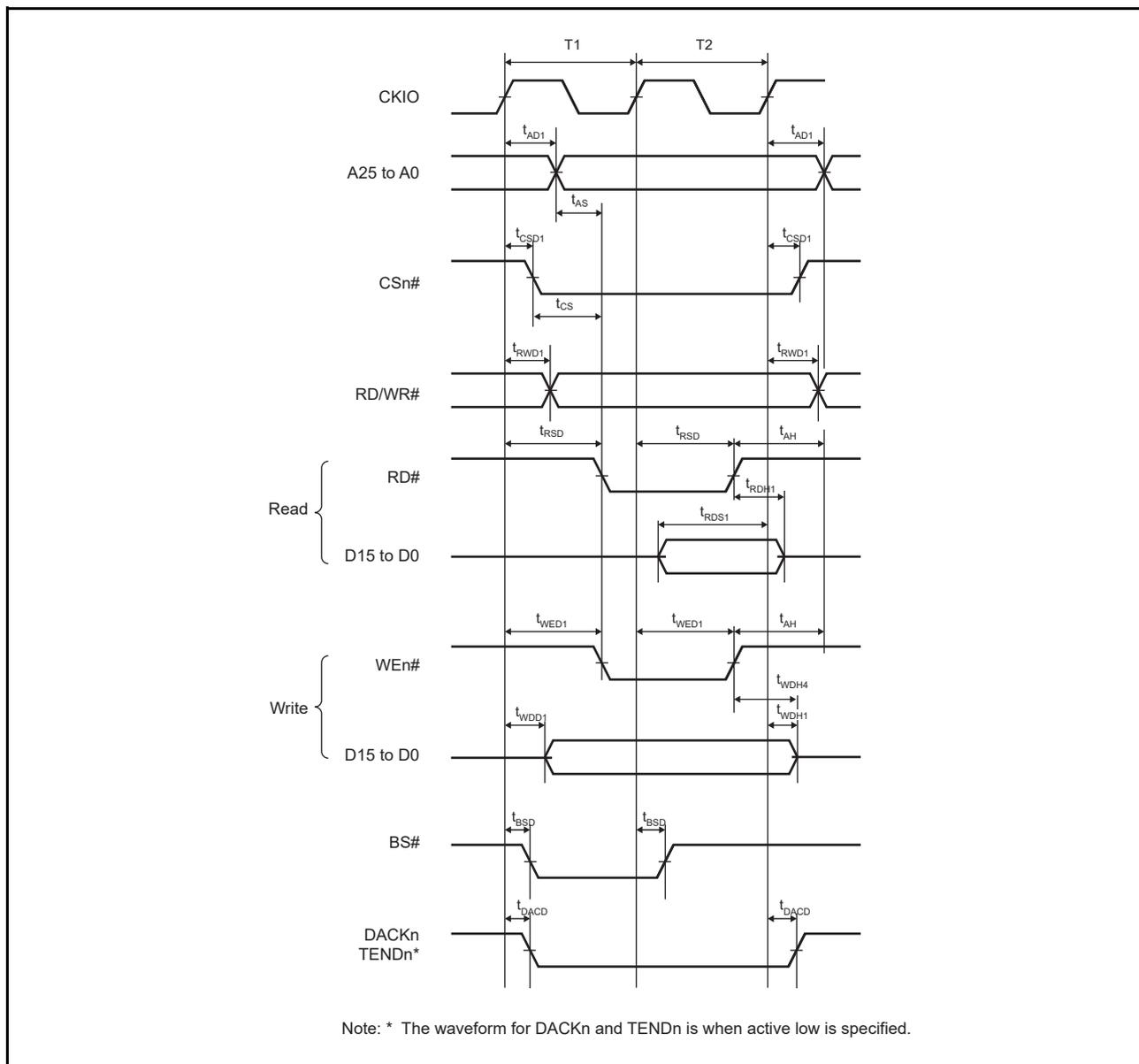


Figure 3.13 Basic Bus Timing for Normal Space (No Wait)

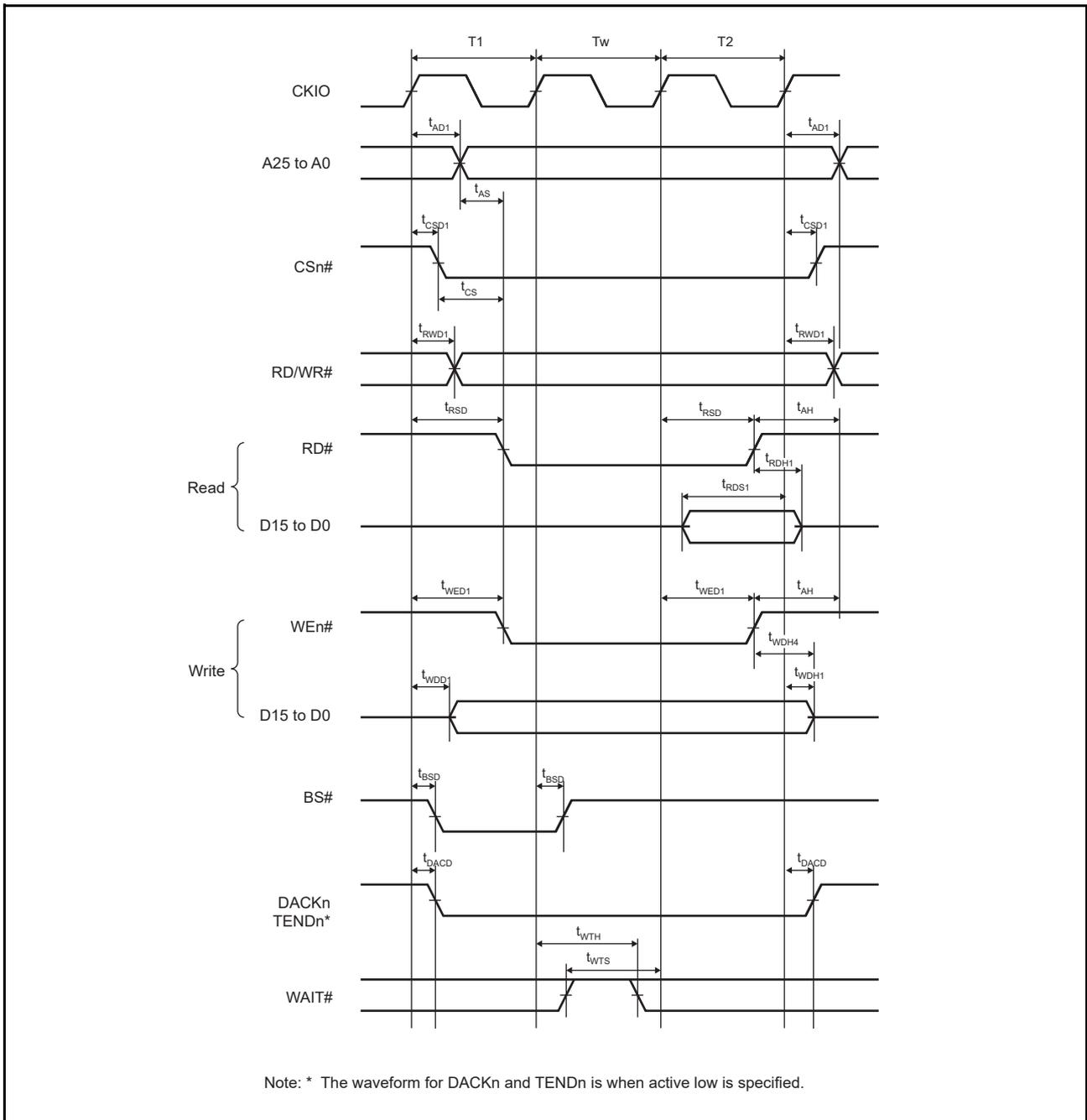


Figure 3.14 Basic Bus Timing for Normal Space (One Software Wait Cycle)

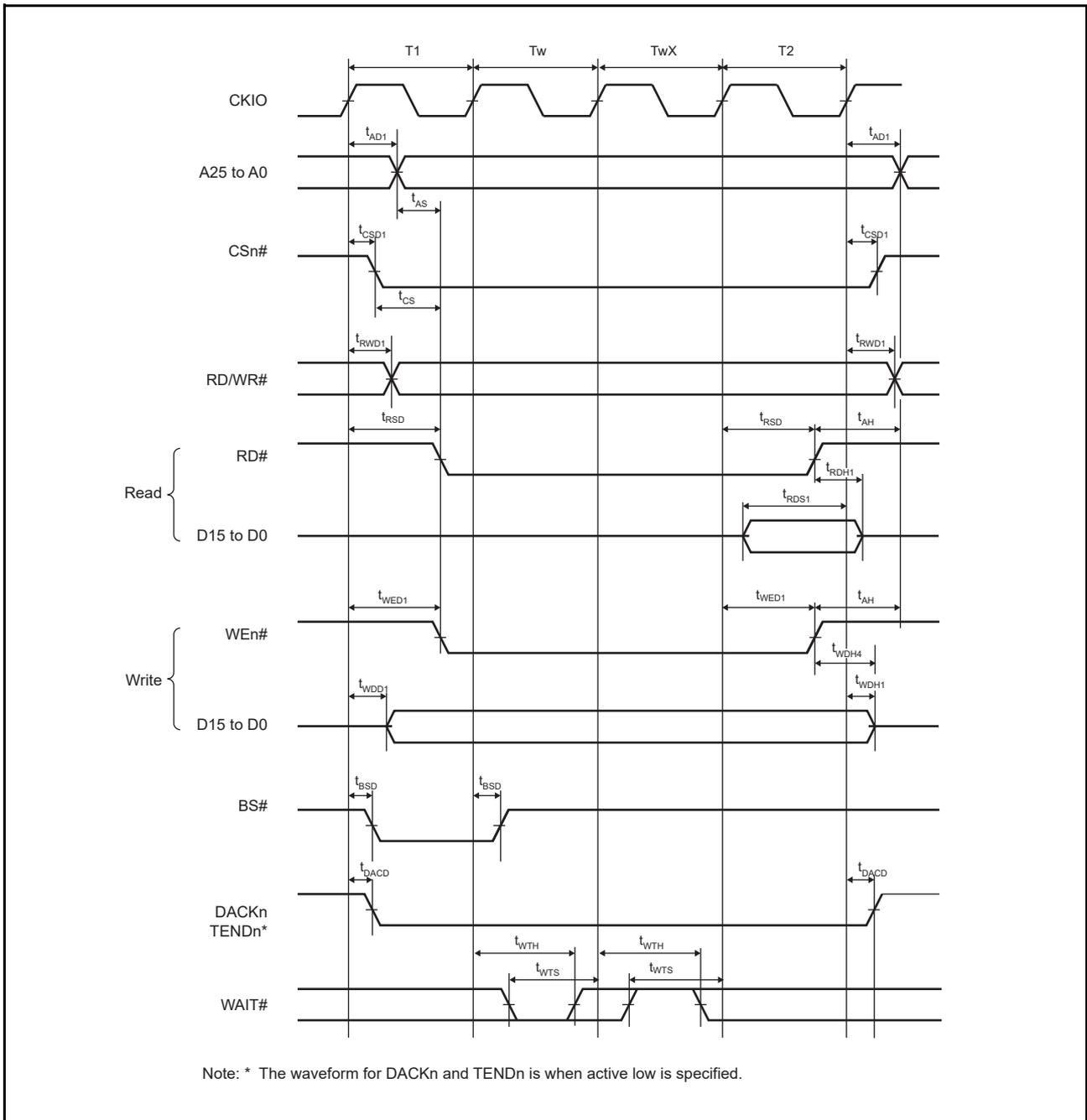


Figure 3.15 Basic Bus Timing for Normal Space (One Software Wait Cycle, One External Wait Cycle)

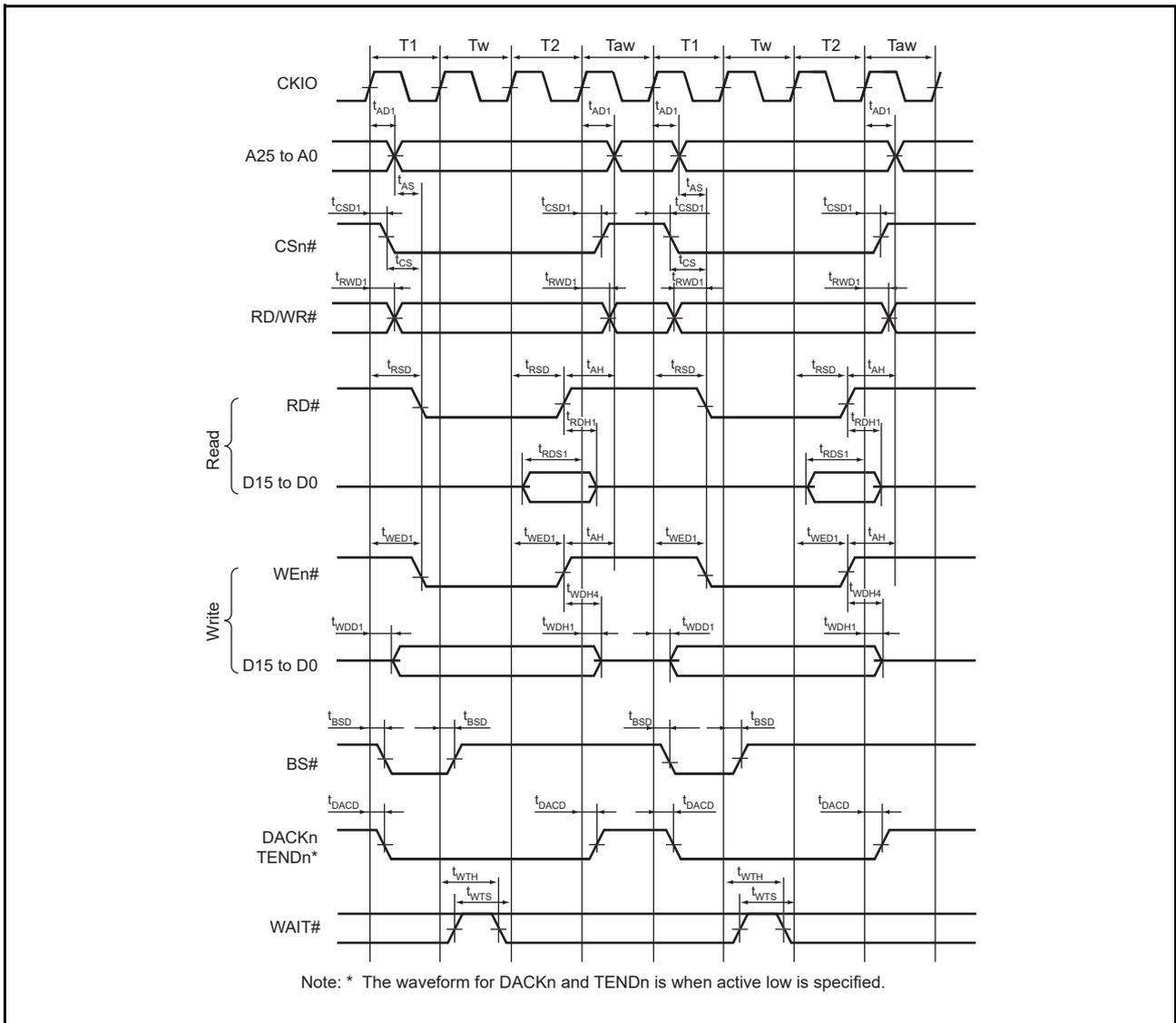


Figure 3.16 Basic Bus Timing for Normal Space (One Software Wait Cycle, External Wait Cycle Valid (WM Bit = 0), No Idle Cycle)

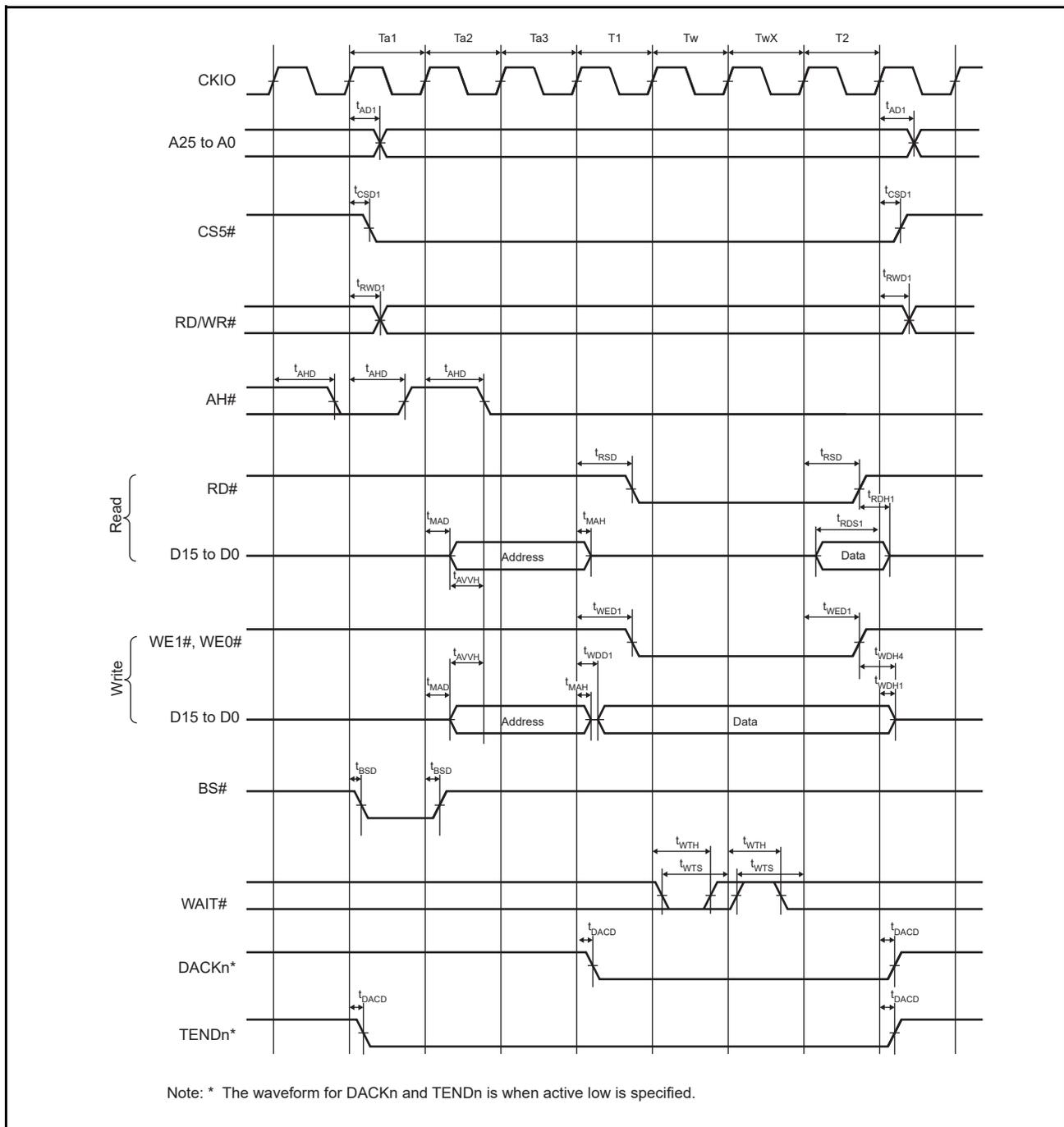


Figure 3.17 MPX-I/O Interface Bus Cycle (Three Address Cycles, One Software Wait Cycle, One External Wait Cycle)

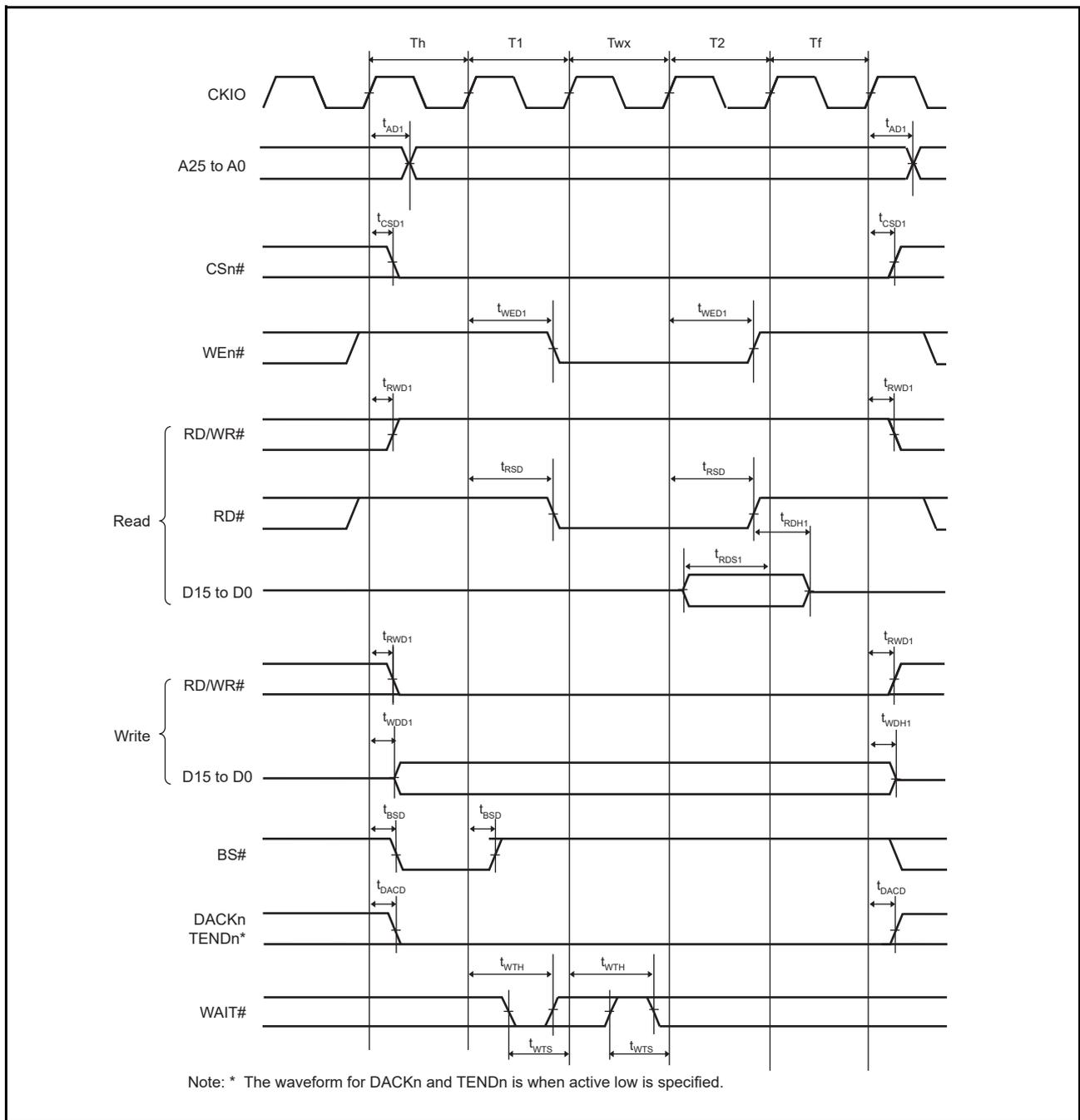


Figure 3.18 Bus Cycle of SRAM with Byte Selection (SW = 1 Cycle, HW = 1 Cycle, One Asynchronous External Wait Cycle, BAS = 0 (Write Cycle UB#/LB# Control))

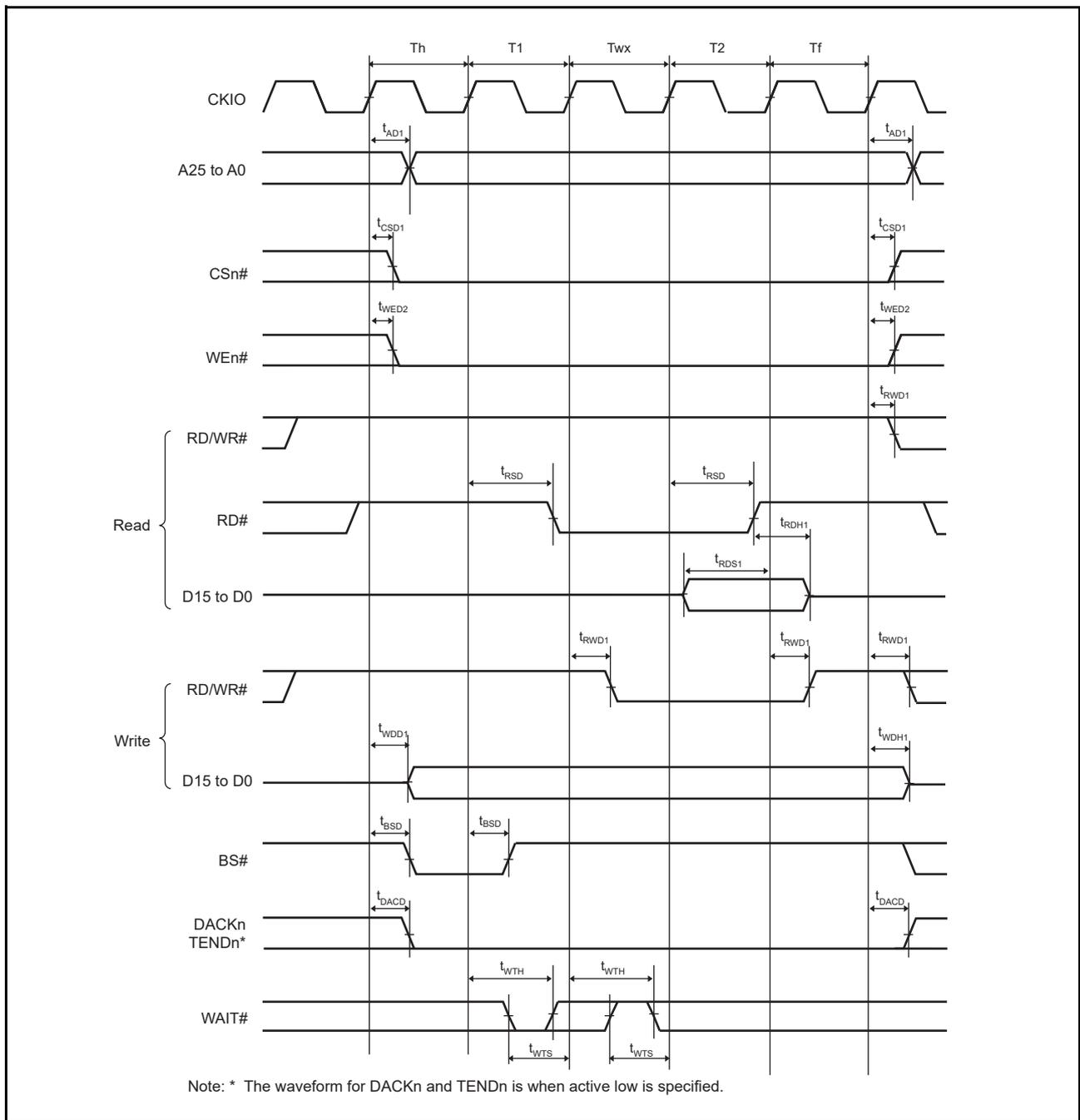


Figure 3.19 Bus Cycle of SRAM with Byte Selection (SW = 1 Cycle, HW = 1 Cycle, One Asynchronous External Wait Cycle, BAS = 1 (Write Cycle WE# Control))

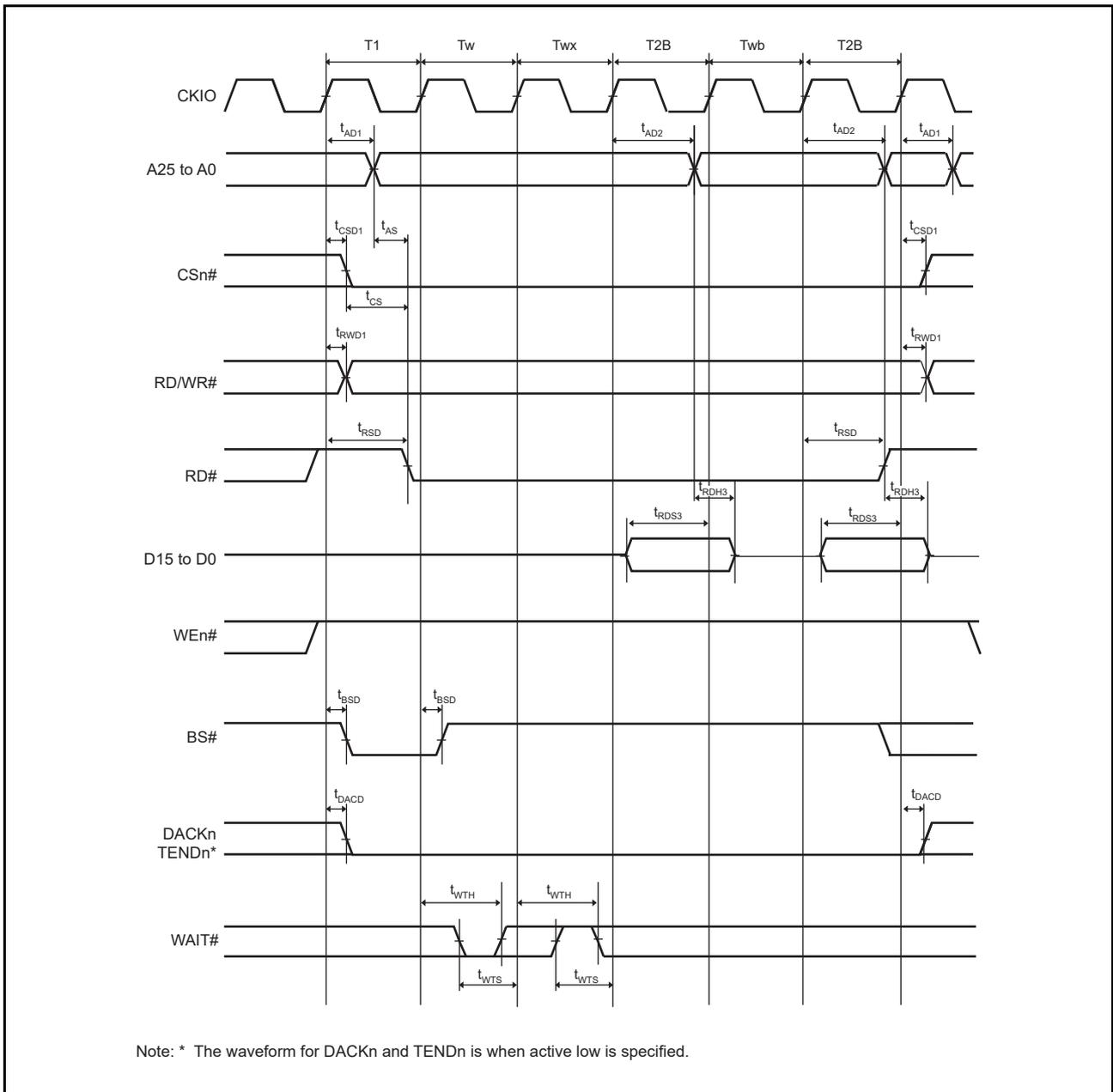


Figure 3.20 Burst ROM Read Cycle (One Software Wait Cycle, One Asynchronous External Burst Wait Cycle, Two Burst)

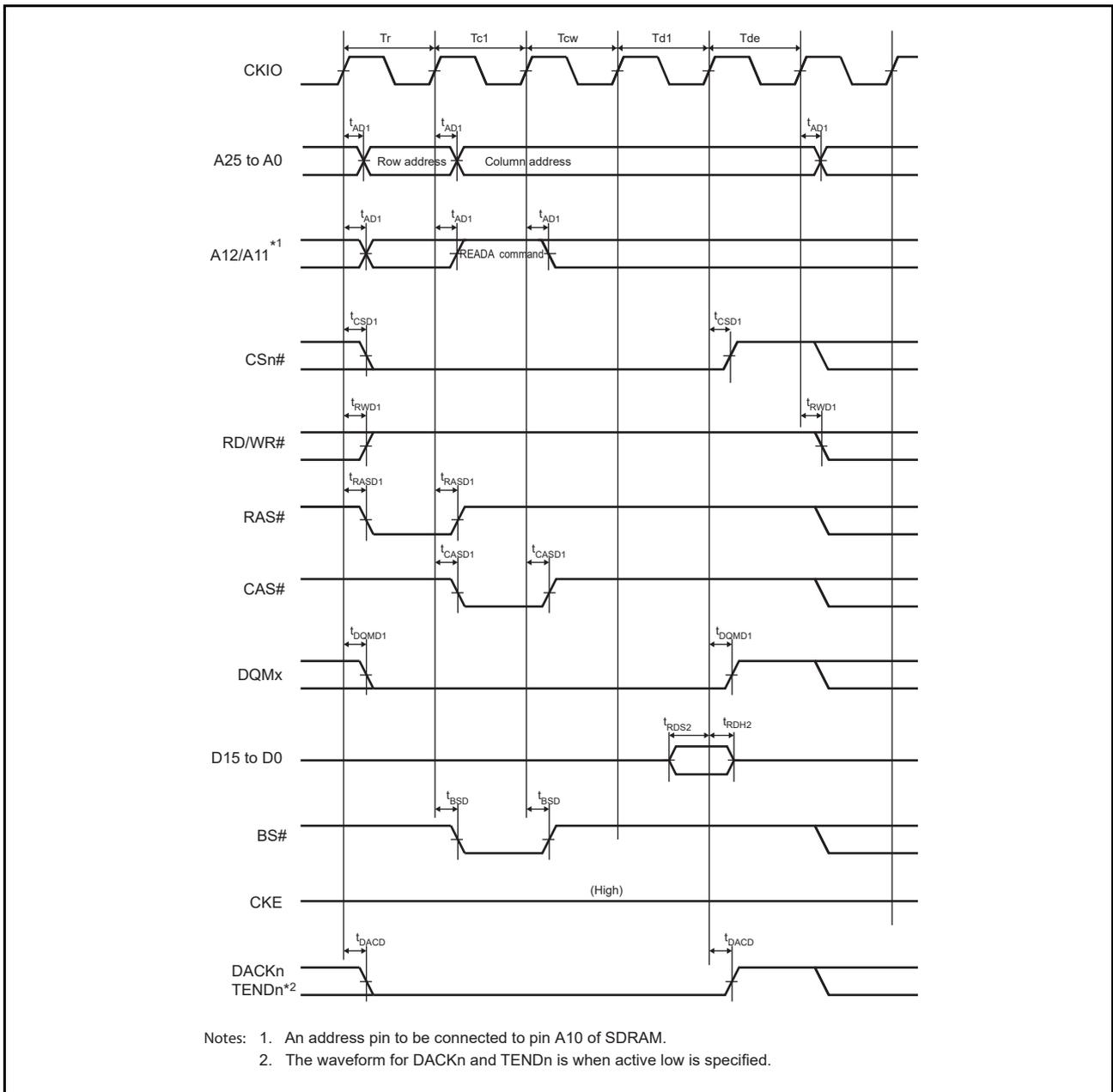


Figure 3.21 Synchronous DRAM Single Read Bus Cycle (Auto Precharge, CAS Latency 2, WTRCD = 0 Cycle, WTRP = 0 Cycle)

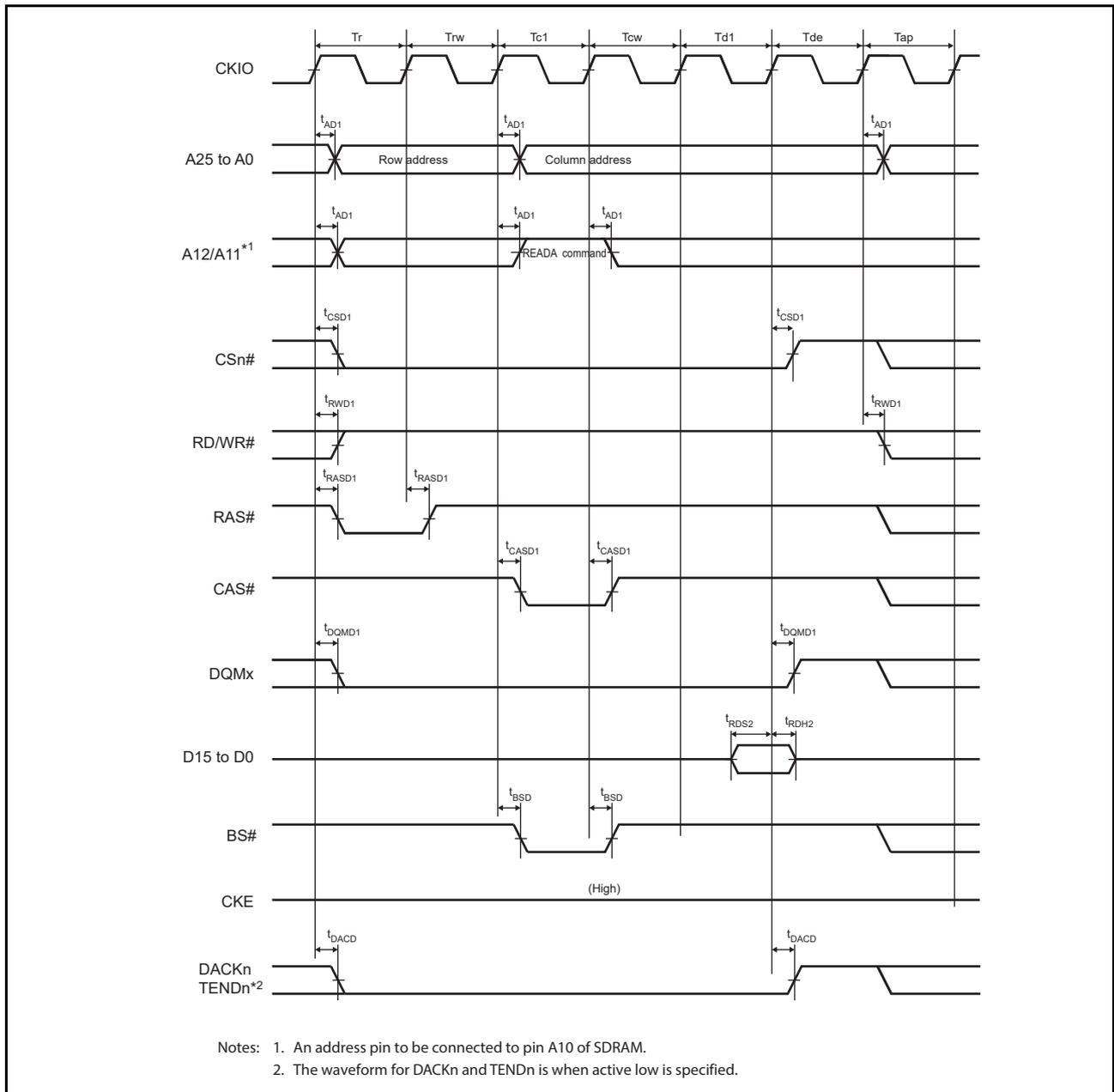


Figure 3.22 Synchronous DRAM Single Read Bus Cycle (Auto Precharge, CAS Latency 2, WTRCD = 1 Cycle, WTRP = 1 Cycle)

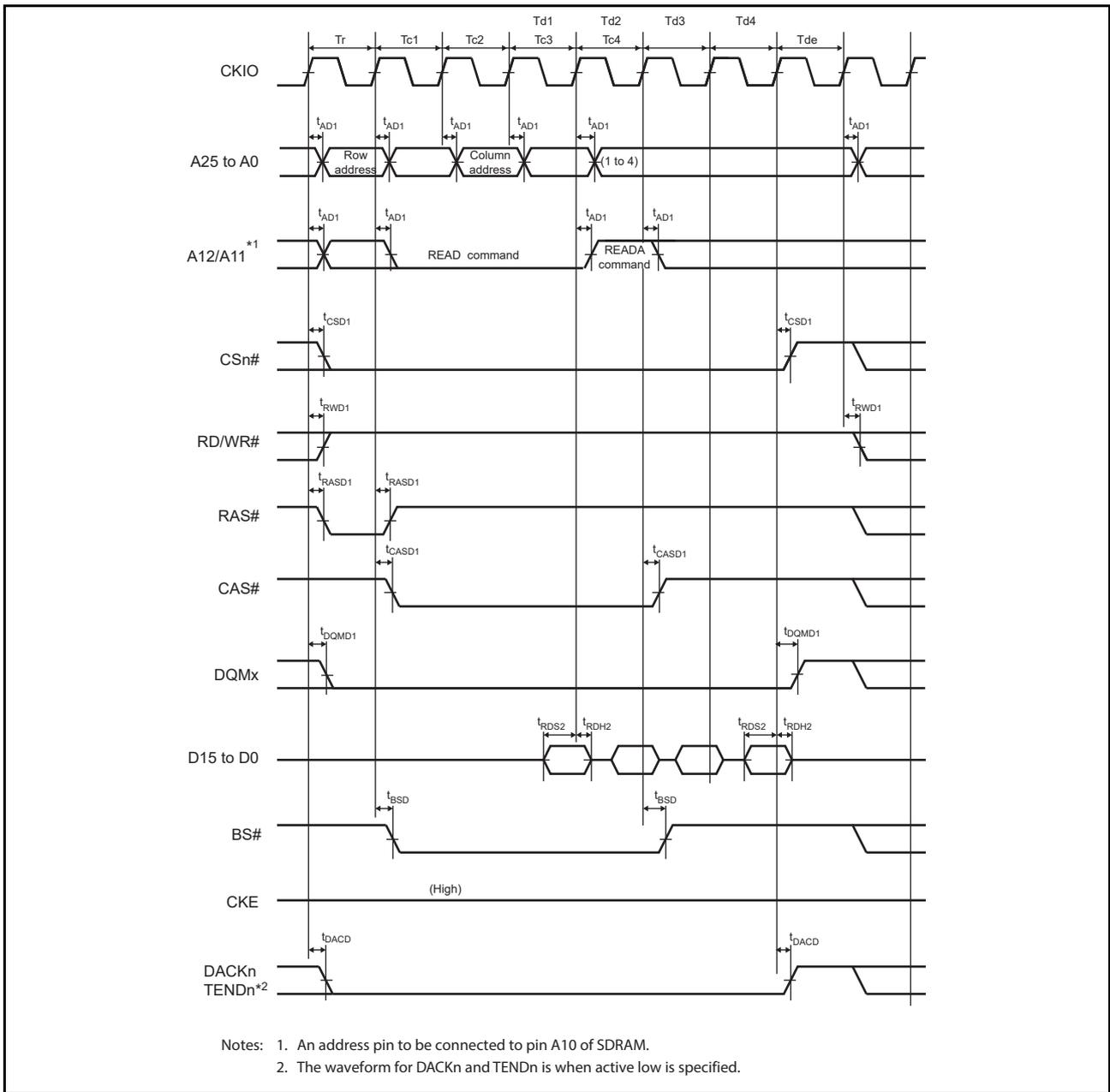


Figure 3.23 Synchronous DRAM Burst Read Bus Cycle (Four Read Cycles) (Auto Precharge, CAS Latency 2, WTRCD = 0 Cycle, WTRP = 1 Cycle)

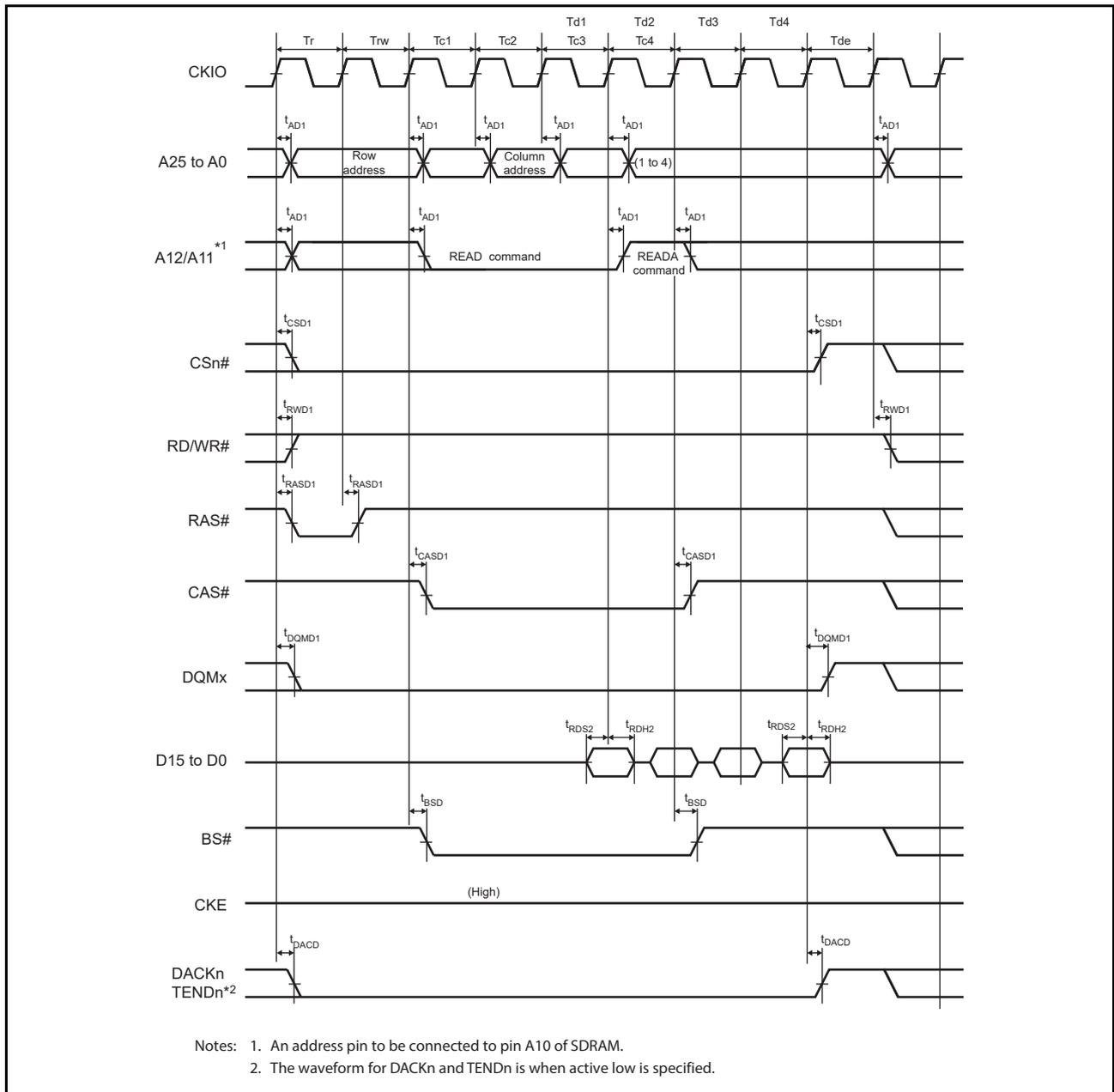


Figure 3.24 Synchronous DRAM Burst Read Bus Cycle (Four Read Cycles) (Auto Precharge, CAS Latency 2, WTRCD = 1 Cycle, WTRP = 0 Cycle)

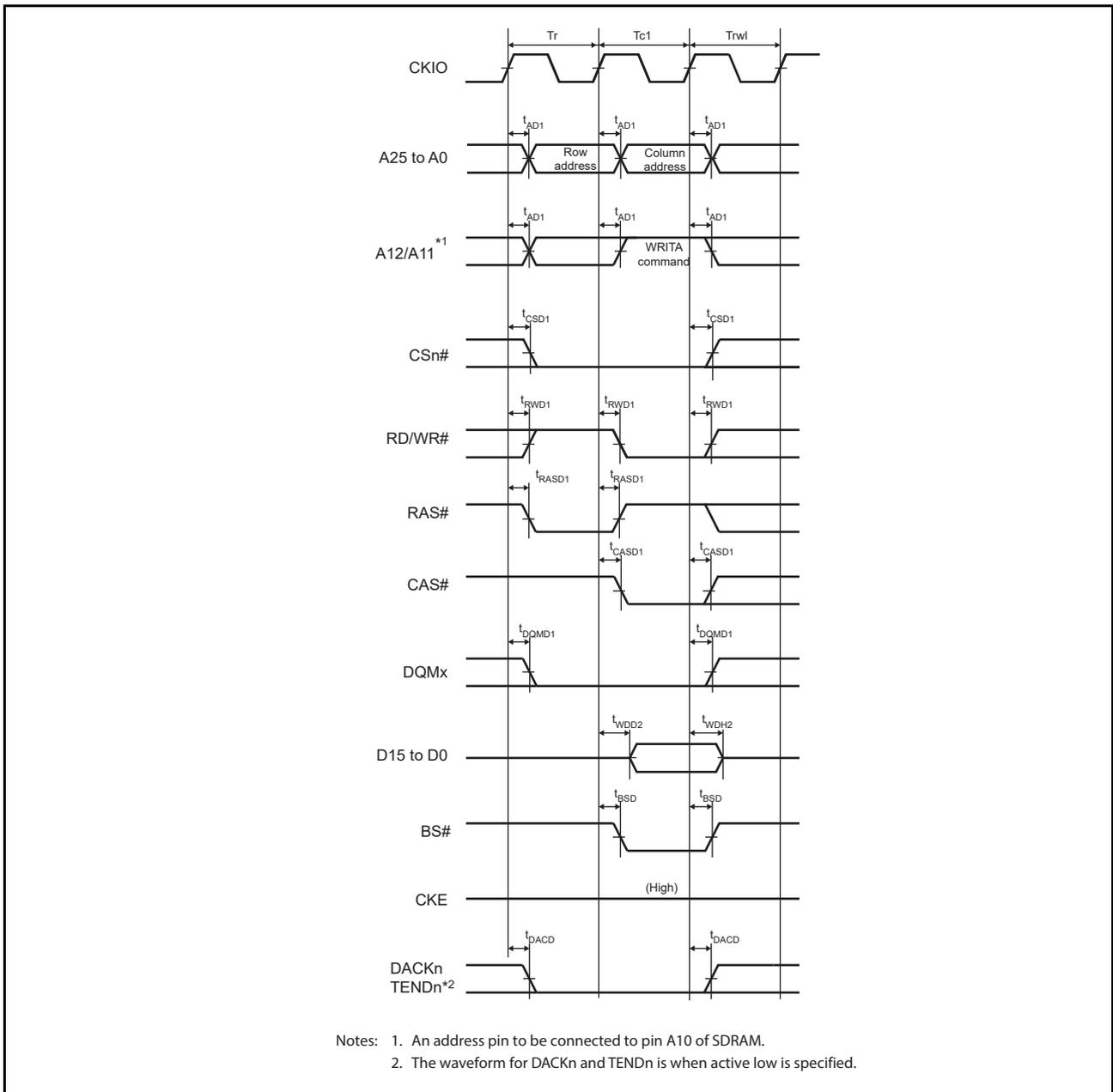


Figure 3.25 Synchronous DRAM Single Write Bus Cycle (Auto Precharge, TRWL = 1 Cycle)

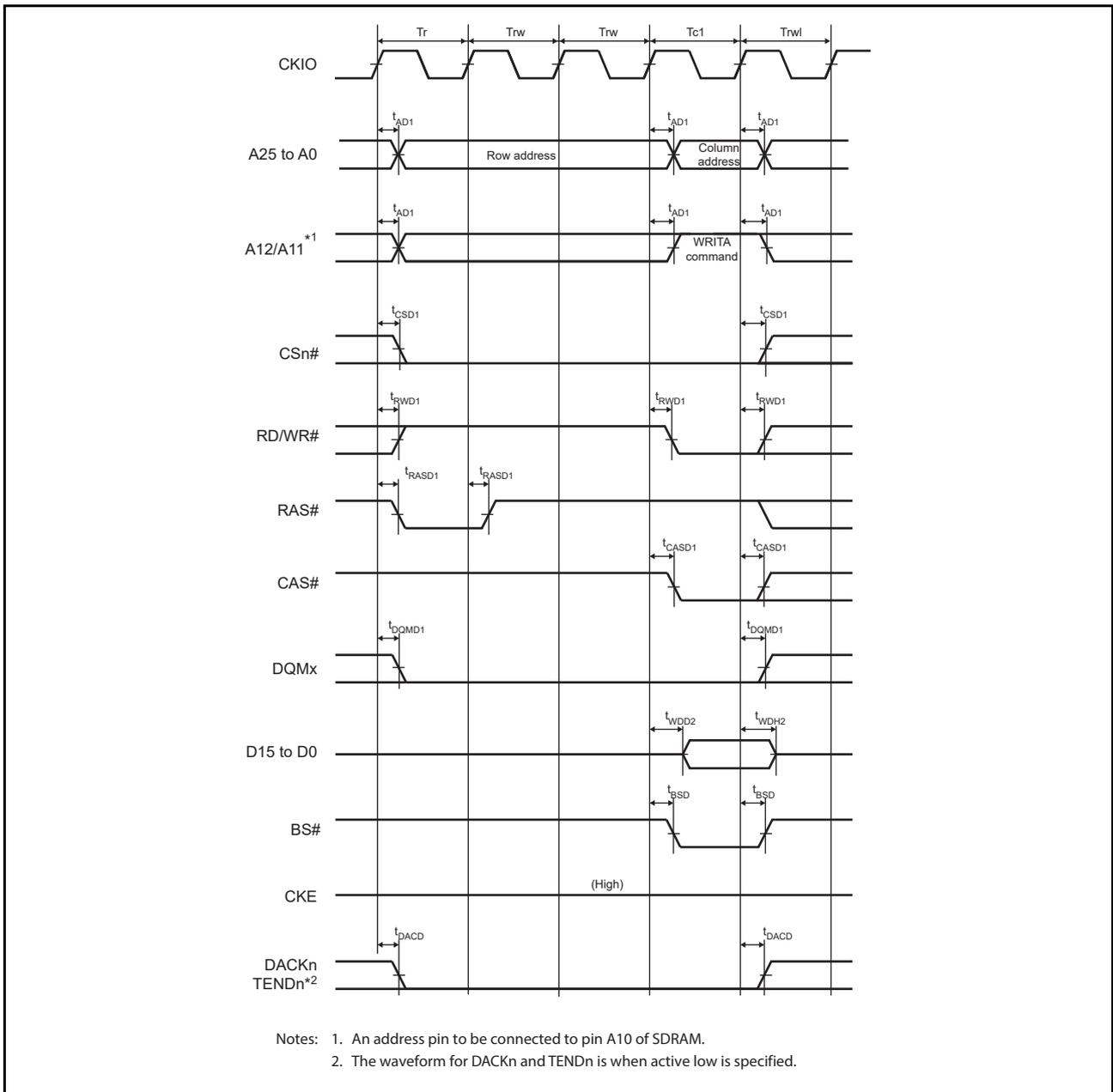


Figure 3.26 Synchronous DRAM Single Write Bus Cycle (Auto Precharge, WTRCD = 2 Cycles, TRWL = 1 Cycle)

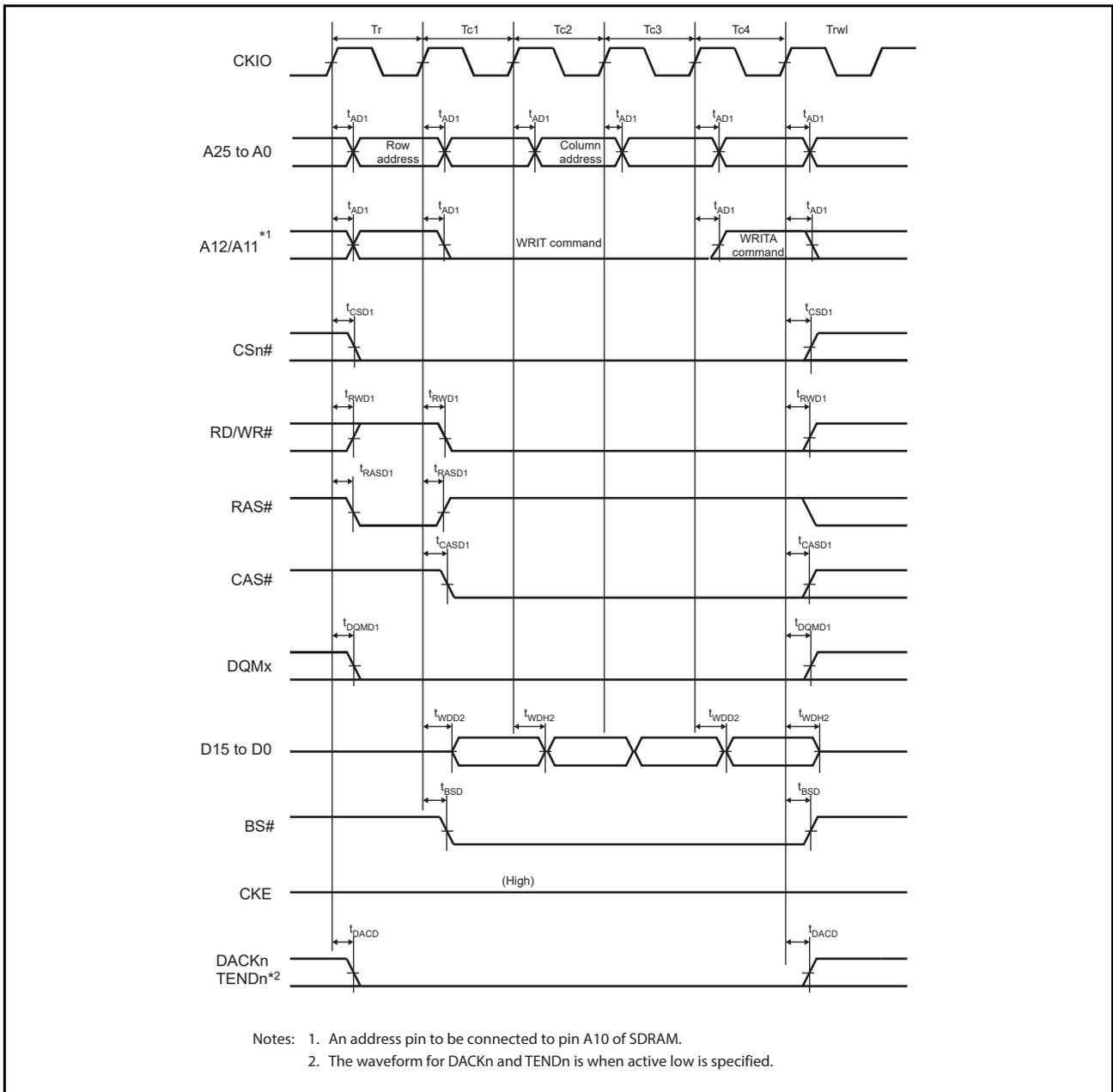


Figure 3.27 Synchronous DRAM Burst Write Bus Cycle (Four Write Cycles) (Auto Precharge, WTRCD = 0 Cycle, TRWL = 1 Cycle)

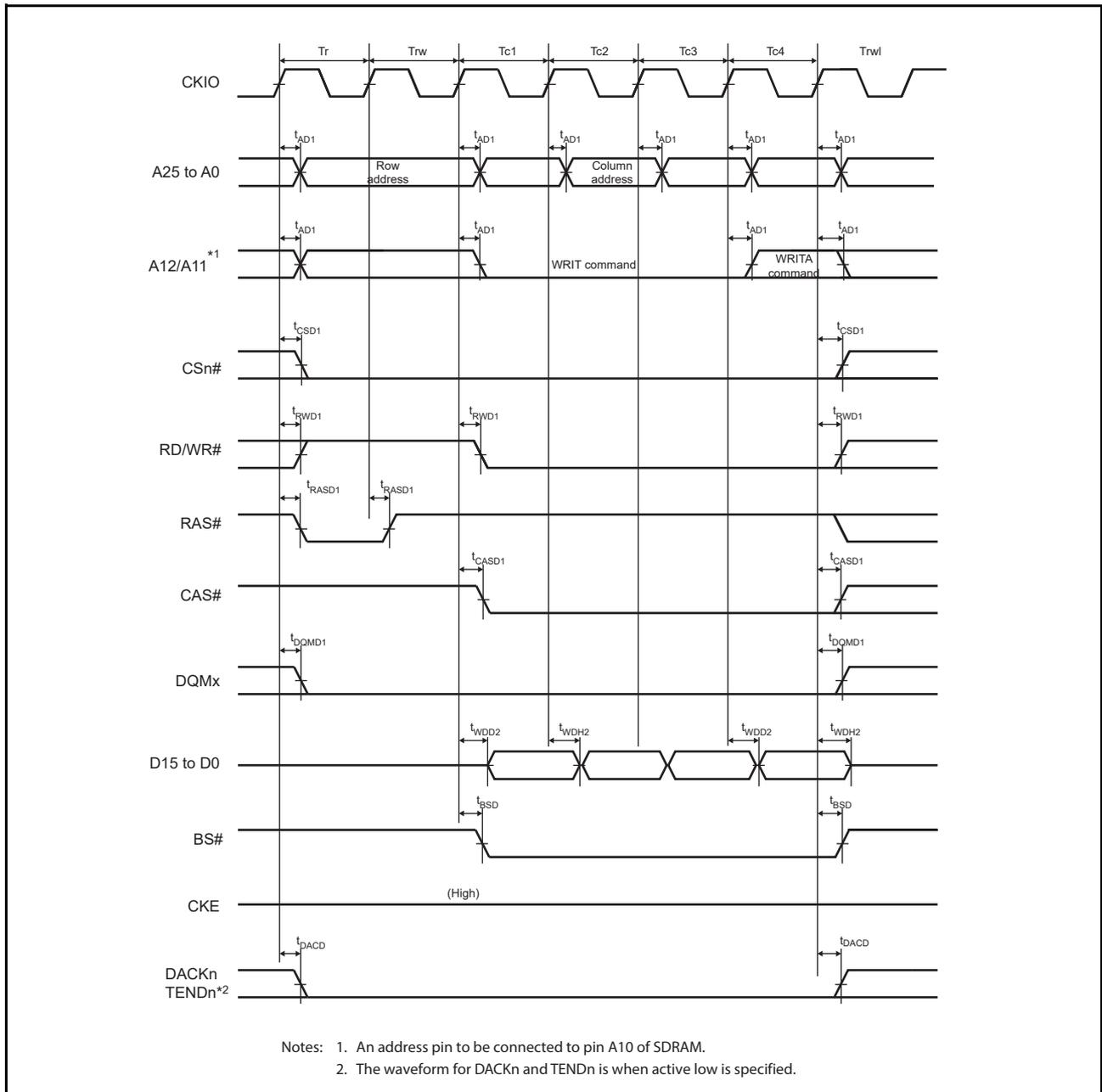


Figure 3.28 Synchronous DRAM Burst Write Bus Cycle (Four Write Cycles) (Auto Precharge, WTRCD = 1 Cycle, TRWL = 1 Cycle)

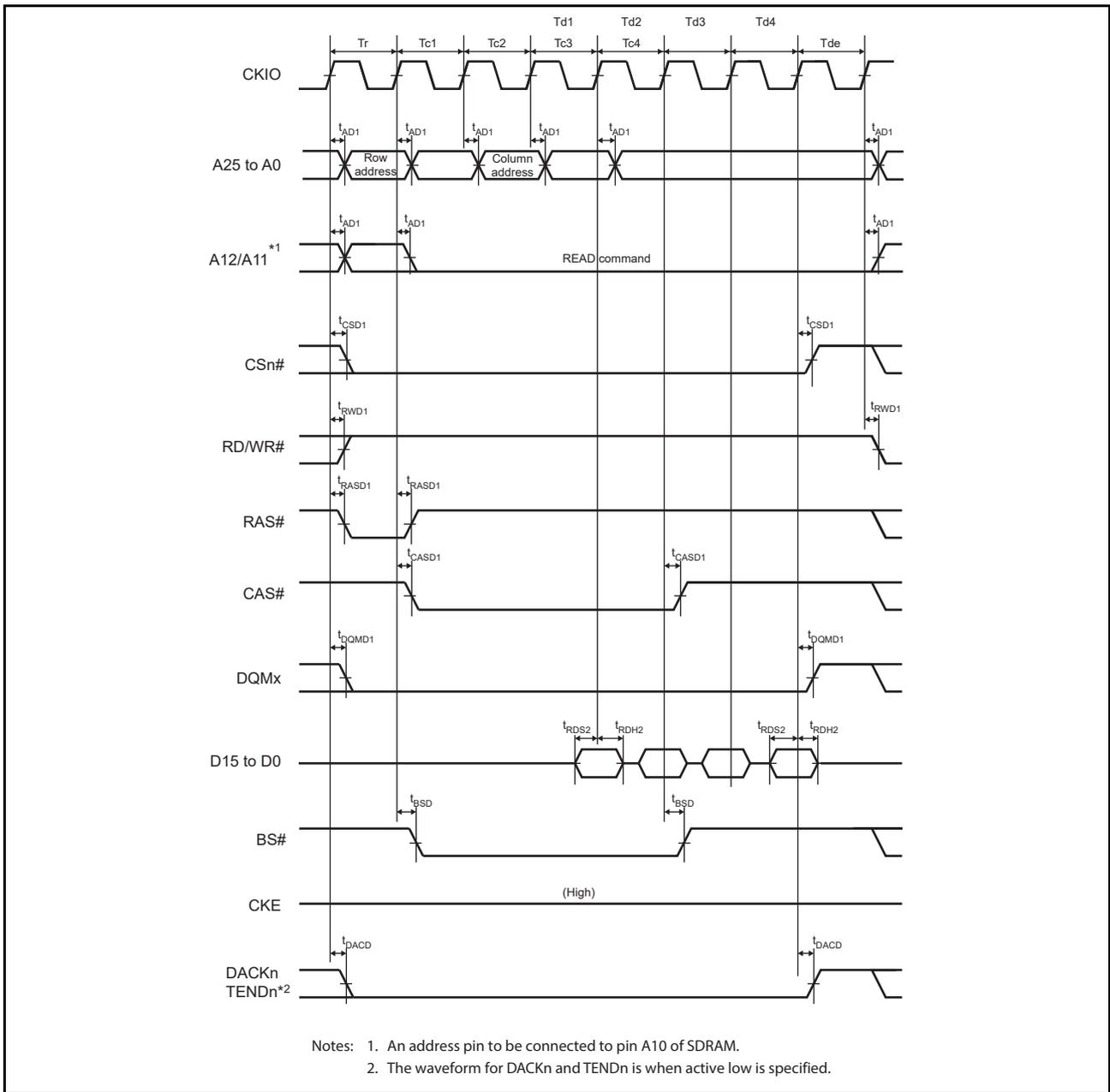


Figure 3.29 Synchronous DRAM Burst Read Bus Cycle (Four Read Cycles) (Bank Active Mode: ACT + READ Commands, CAS Latency 2, WTRCD = 0 Cycle)

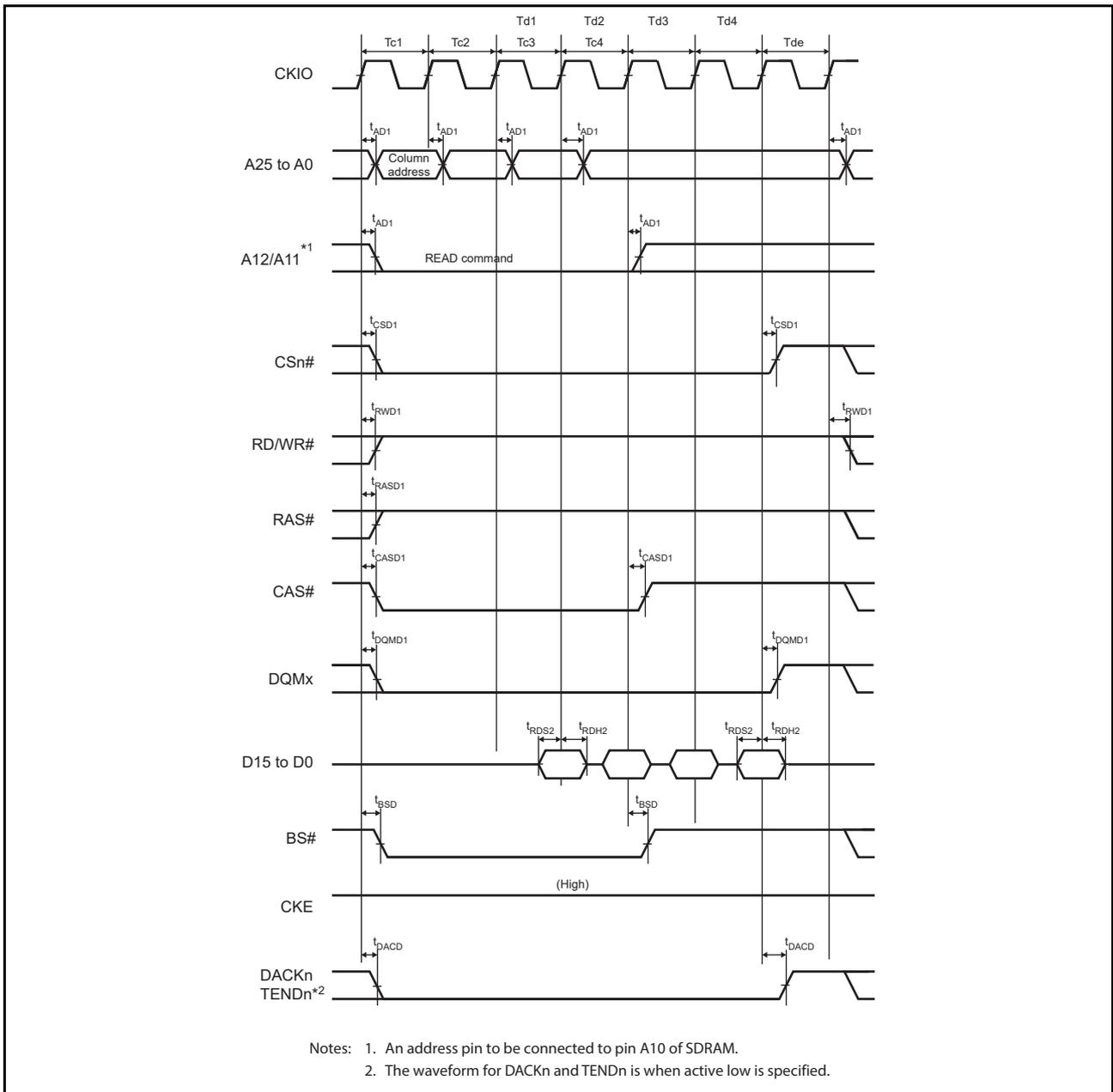


Figure 3.30 Synchronous DRAM Burst Read Bus Cycle (Four Read Cycles) (Bank Active Mode: READ Command, Same Row Address, CAS Latency 2, WTRCD = 0 Cycle)

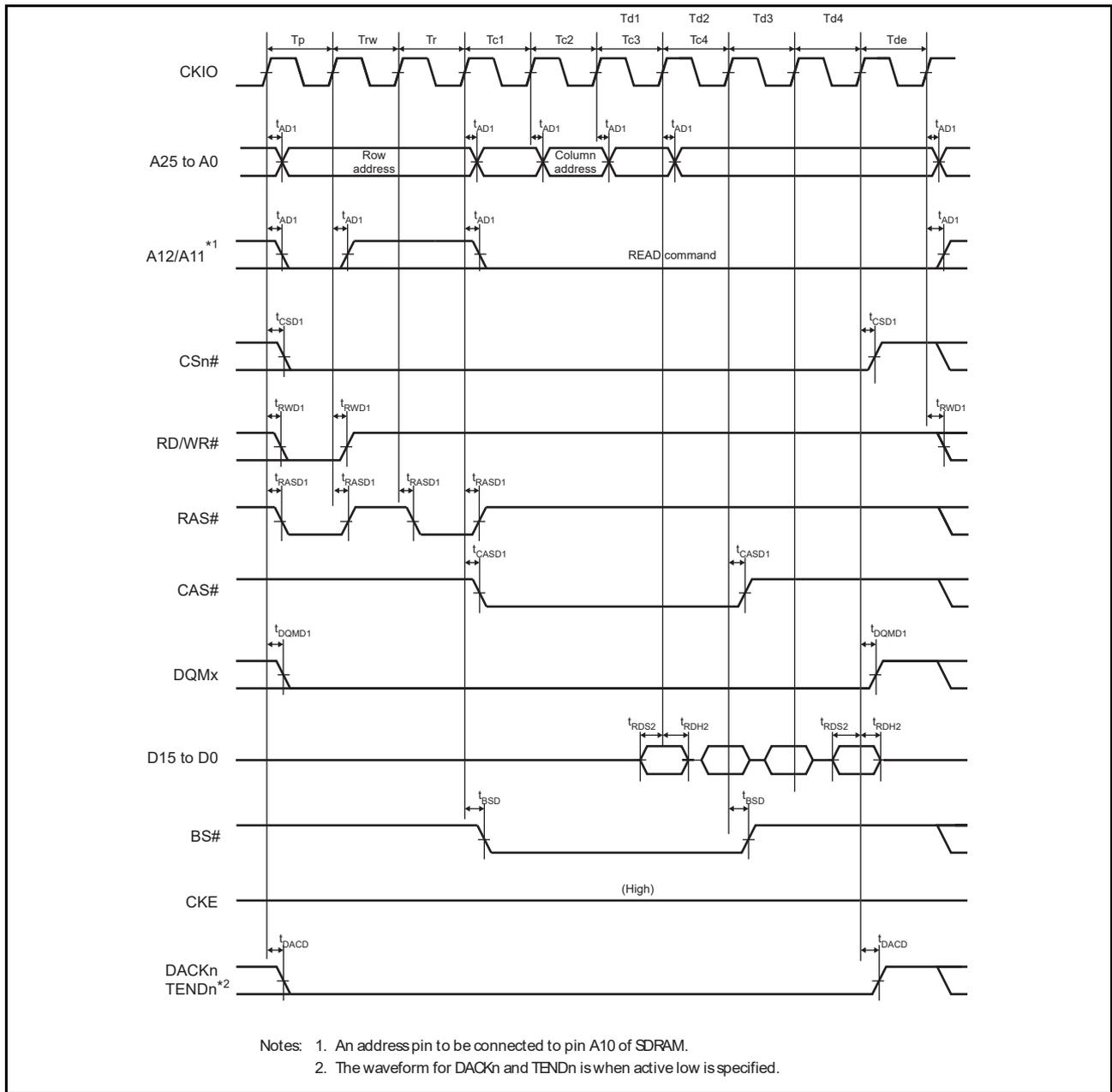


Figure 3.31 Synchronous DRAM Burst Read Bus Cycle (Four Read Cycles) (Bank Active Mode: PRE + ACT + READ Commands, Different Row Addresses, CAS Latency 2, WTRCD = 0 Cycle)

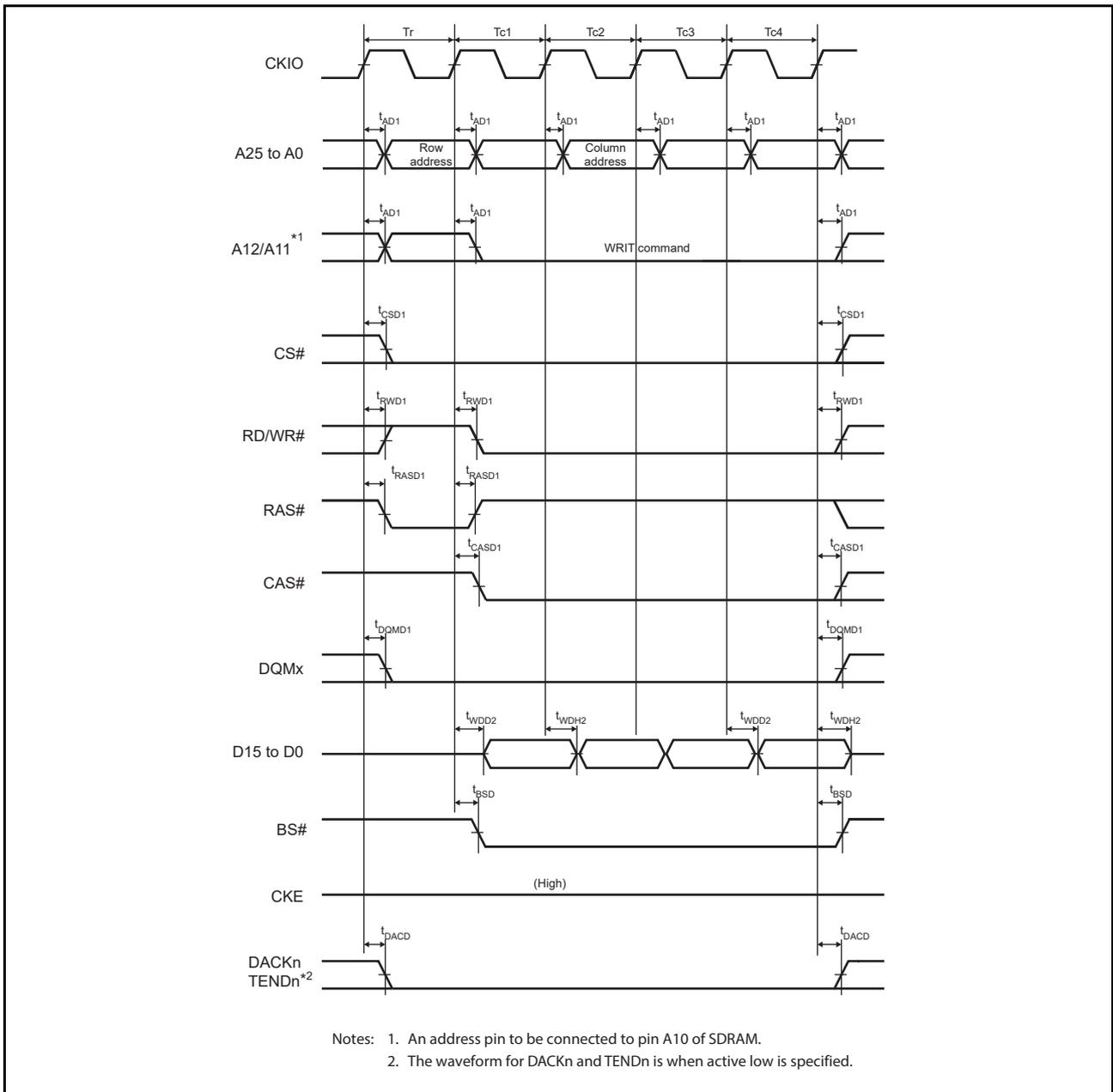


Figure 3.32 Synchronous DRAM Burst Write Bus Cycle (Four Write Cycles) (Bank Active Mode: ACT + WRITE Commands, WTRCD = 0 Cycle, TRWL = 0 Cycle)

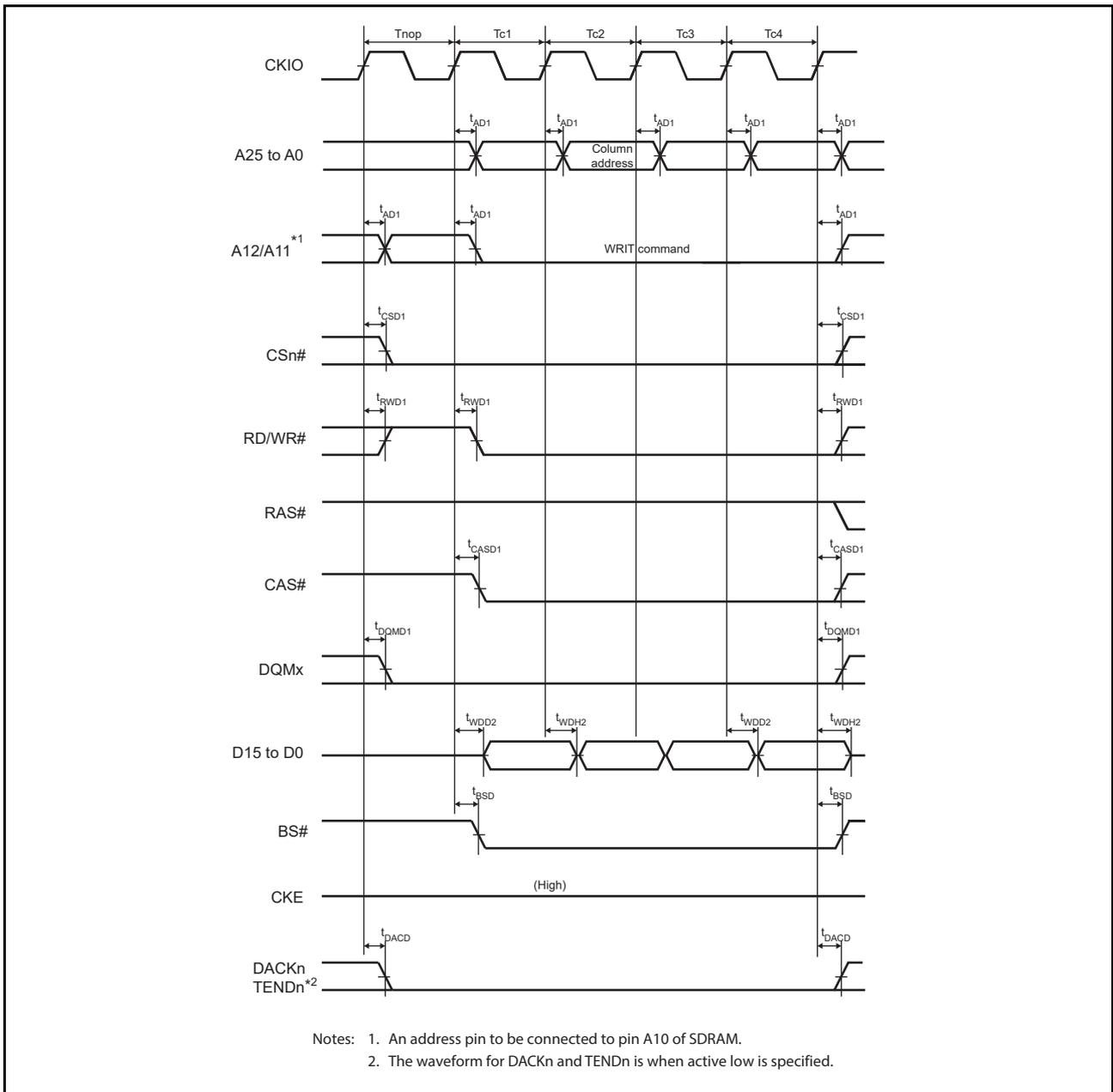


Figure 3.33 Synchronous DRAM Burst Write Bus Cycle (Four Write Cycles) (Bank Active Mode: WRITE Command, Same Row Address, WTRCD = 0 Cycle, TRWL = 0 Cycle)

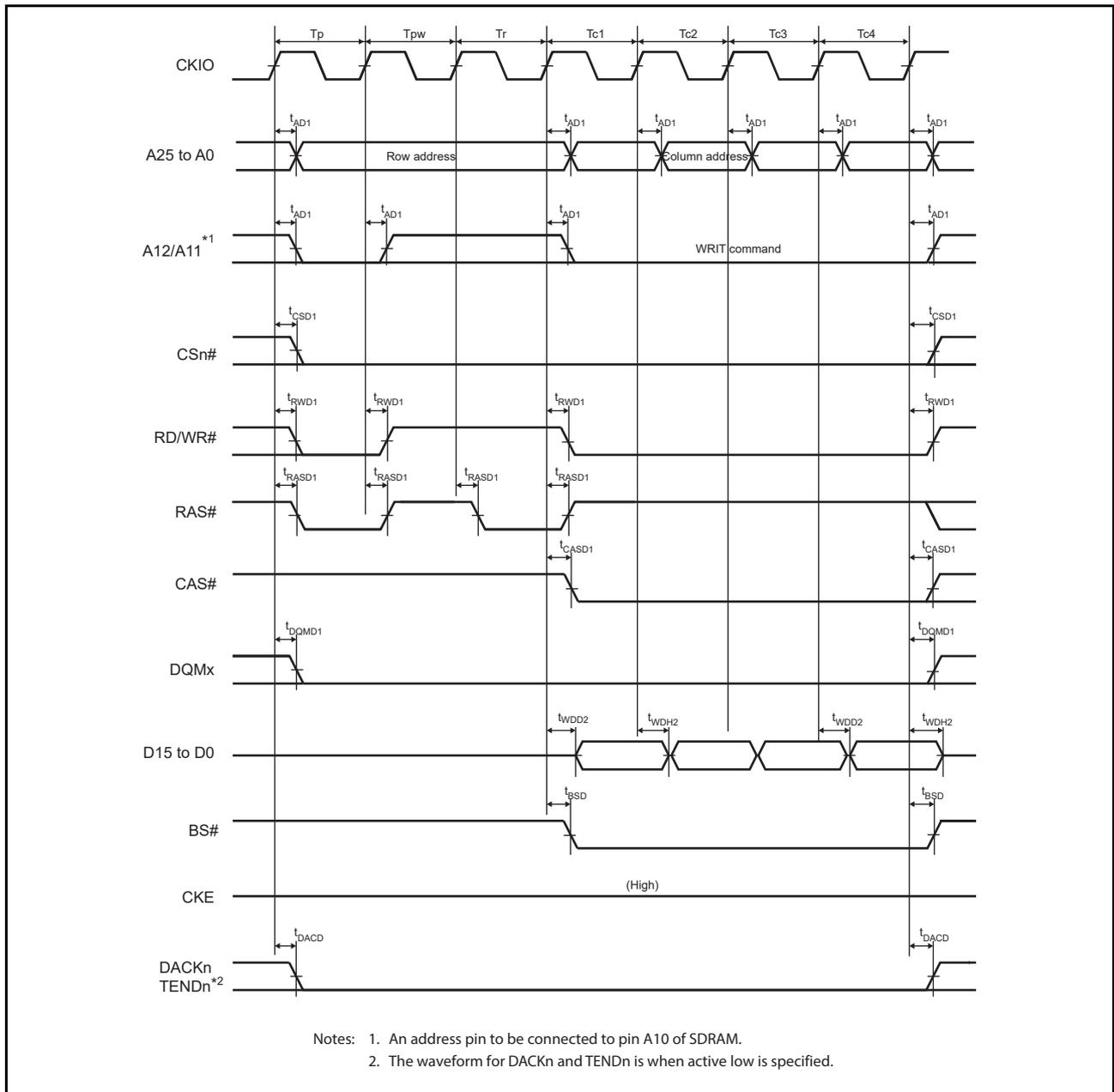


Figure 3.34 Synchronous DRAM Burst Write Bus Cycle (Four Write Cycles) (Bank Active Mode: PRE + ACT + WRITE Commands, Different Row Addresses, WTRCD = 0 Cycle, TRWL = 0 Cycle)

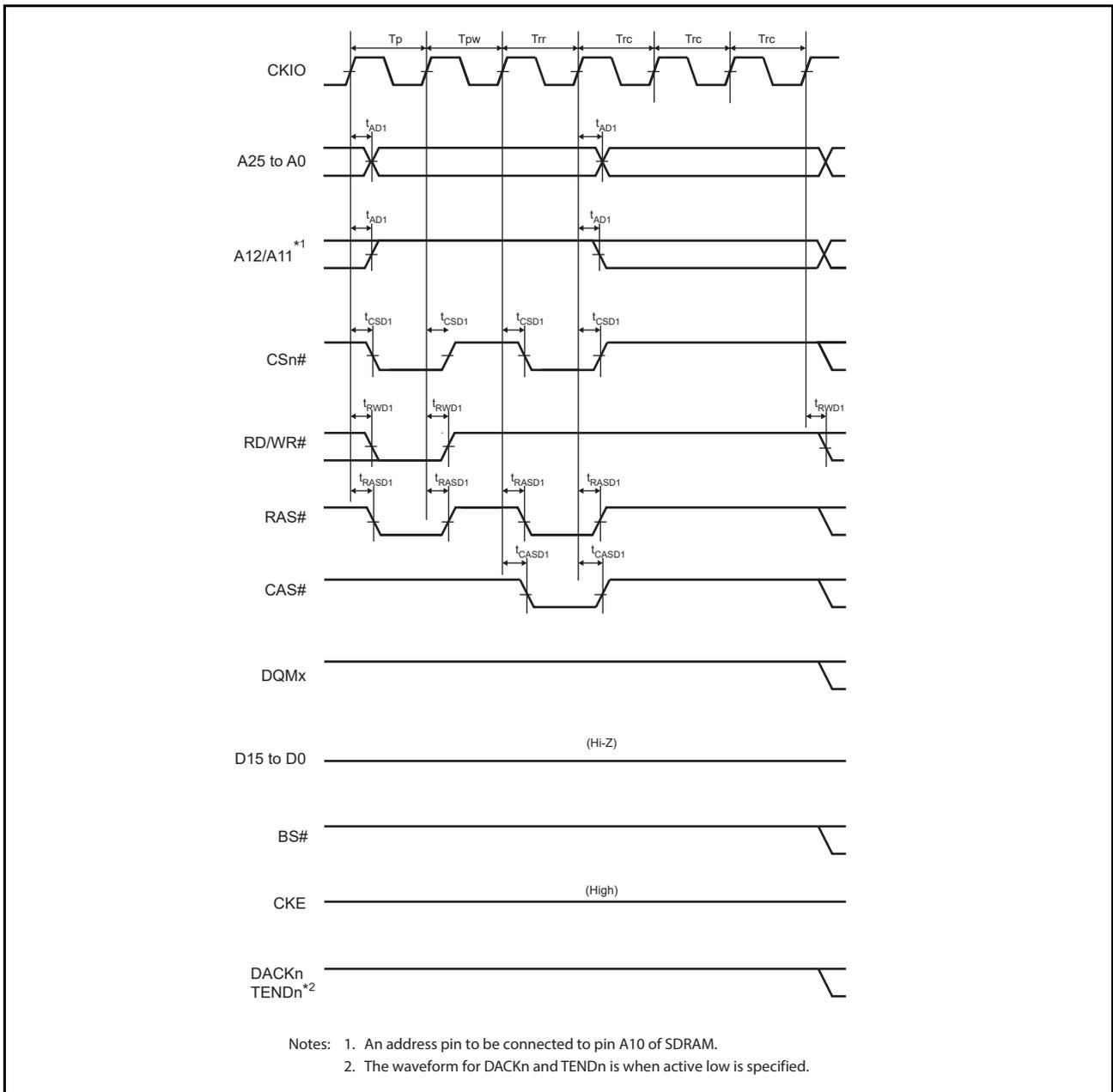


Figure 3.35 Synchronous DRAM Auto-Refreshing Timing (WTRP = 1 Cycle, WTRC = 3 Cycles)

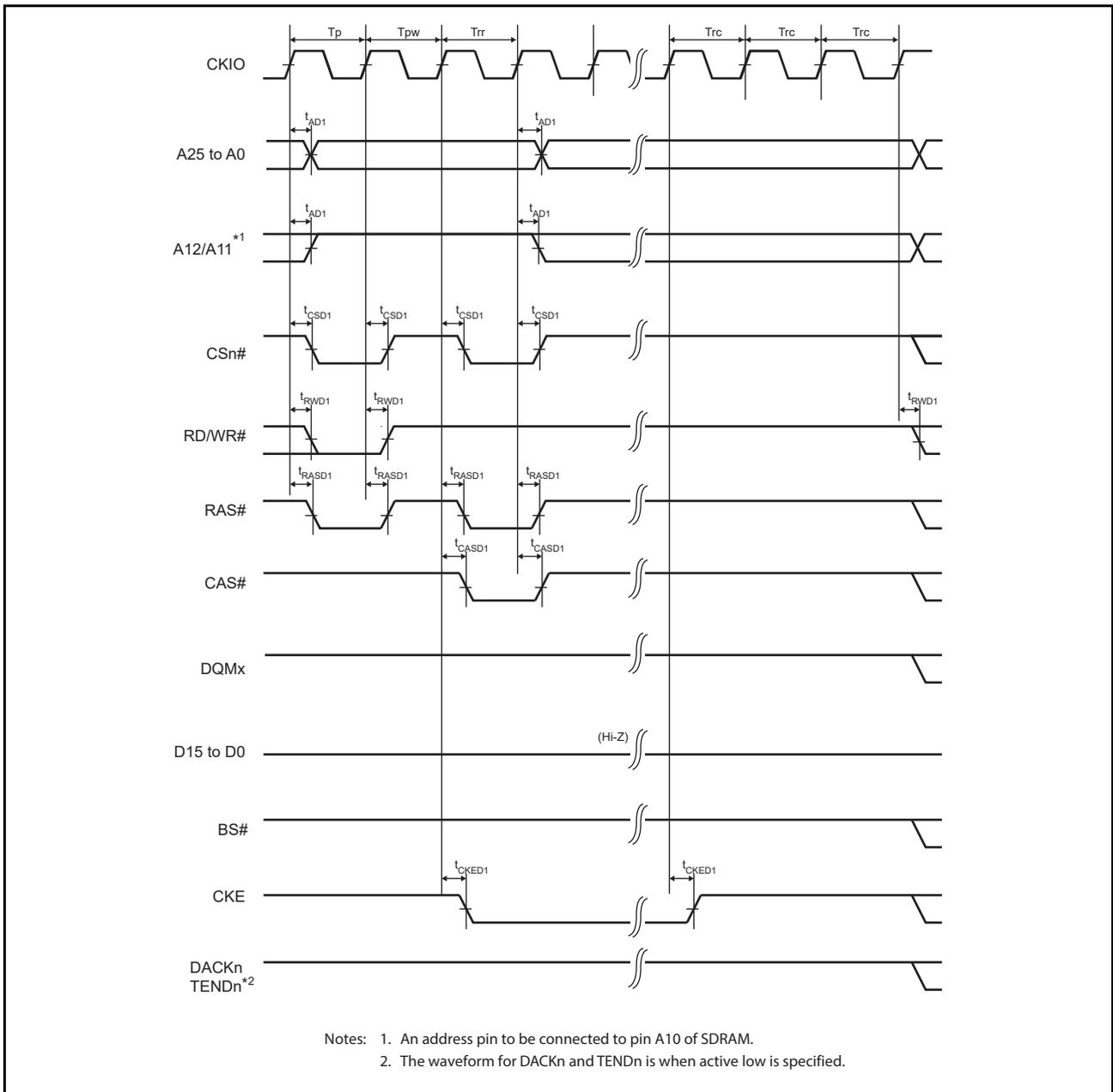


Figure 3.36 Synchronous DRAM Self-Refreshing Timing (WTRP = 1 Cycle)

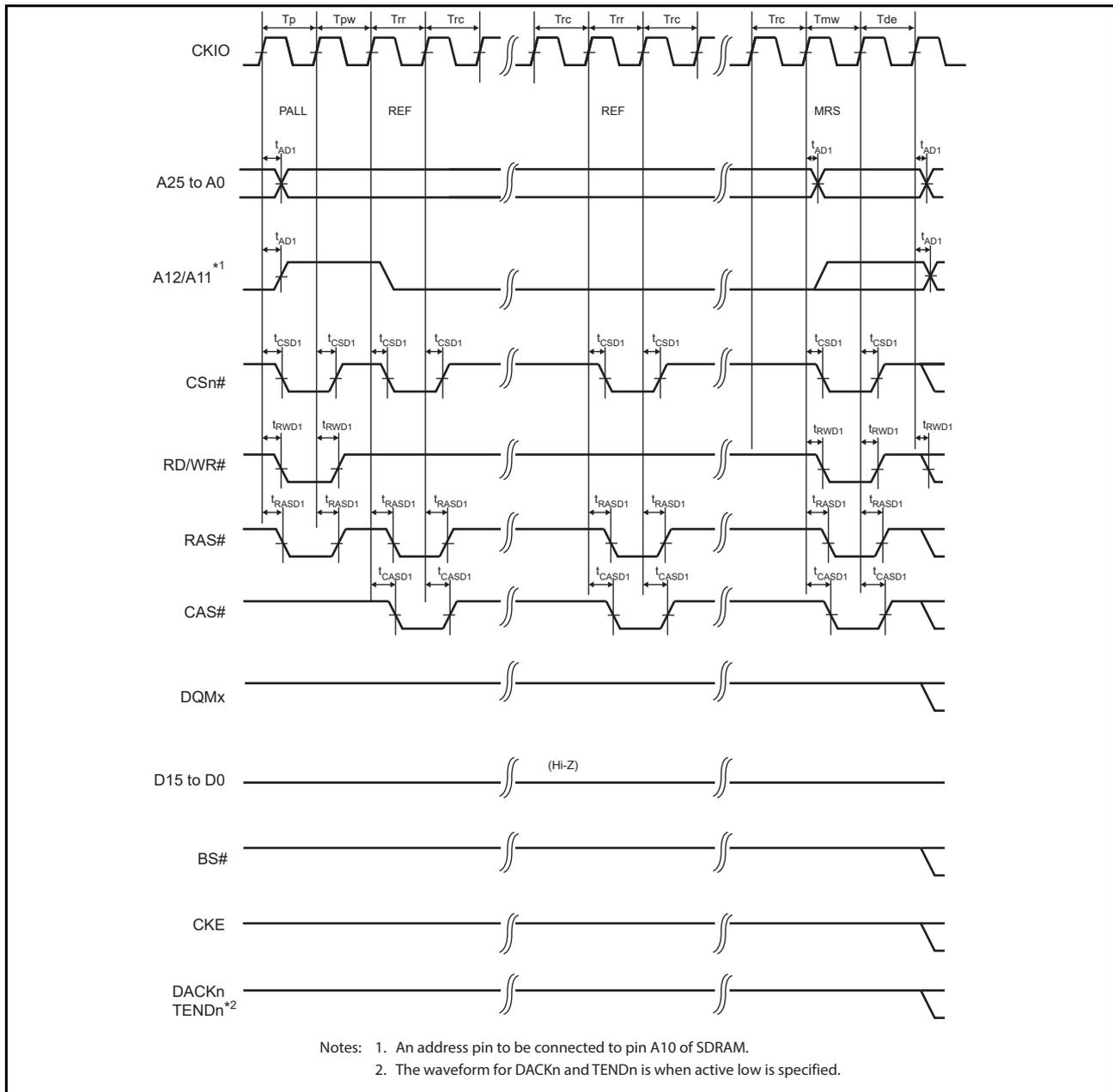


Figure 3.37 Synchronous DRAM Mode Register Write Timing (WTRP = 1 Cycle)

3.4.5 Direct Memory Access Controller Timing

Table 3.9 Direct Memory Access Controller Timing

Item	Symbol	Min.	Max.	Unit	Figure
DREQ setup time	t_{DRQS}	4.0	—	ns	Figure 3.38
DREQ hold time	t_{DRQH}	0.5	—		
DACK, TEND delay time	t_{DACD}	0	12		Figure 3.39

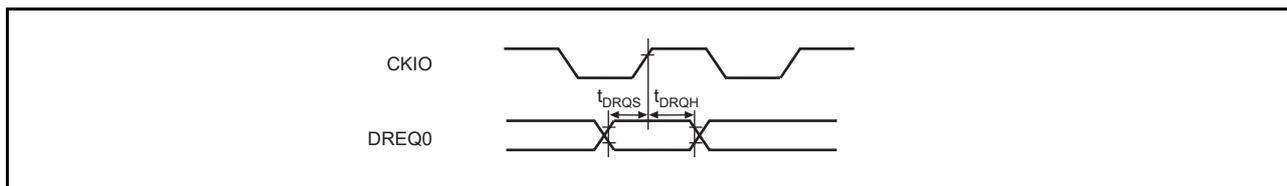


Figure 3.38 DREQ Input Timing

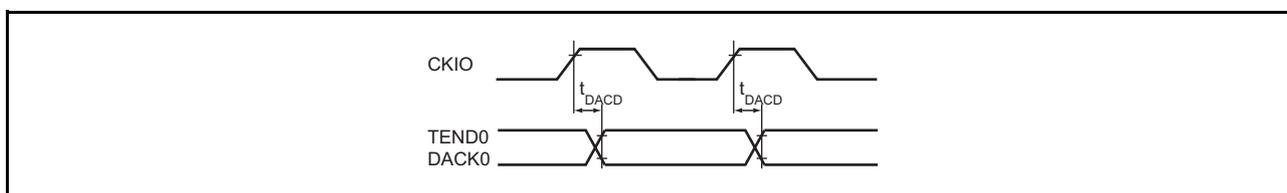


Figure 3.39 DACK, TEND Output Timing

3.4.6 Multi-Function Timer Pulse Unit 3 (MTU3a) Timing

Table 3.10 MTU3a Timing

Item	Symbol	Min.	Max.	Unit*1	Test Conditions
MTU3a Input capture input pulse width	Single-edge setting	t_{MTICW}	1.5	—	t_{p1cyc} Figure 3.40
	Both-edge setting		2.5	—	
Timer clock pulse width	Single-edge setting	t_{MTCKWH} , t_{MTCKWL}	1.5	—	t_{p1cyc} Figure 3.41
	Both-edge setting		2.5	—	
	Phase counting mode		2.5	—	

Note 1. t_{p1cyc} indicates peripheral clock 1C (P1φ) cycle.

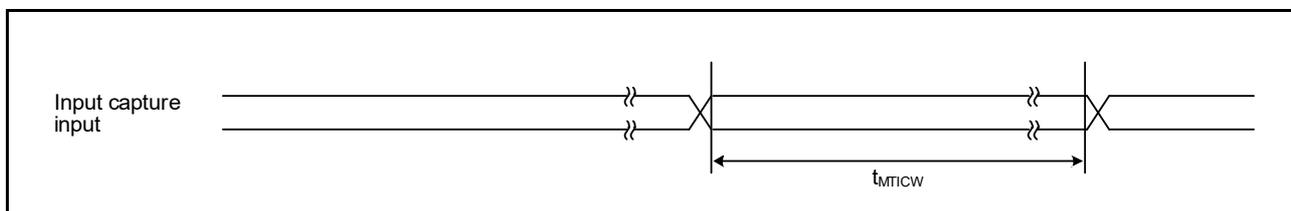


Figure 3.40 MTU3a Input Capture Input Timing

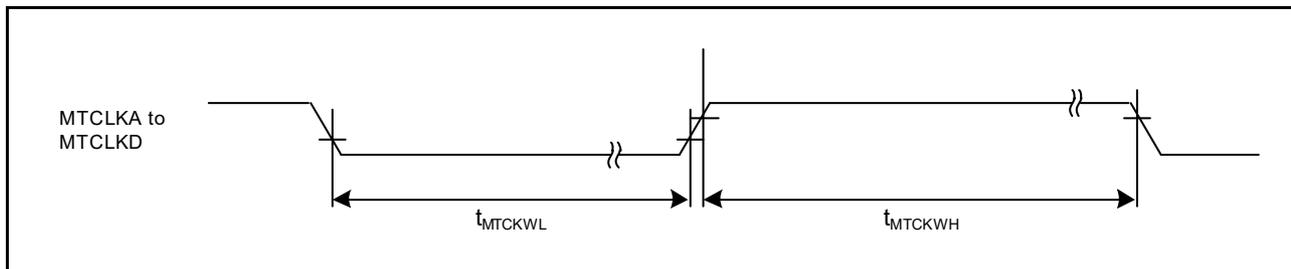


Figure 3.41 MTU3a Clock Input Timing

3.4.7 Port Output Enable 3 (POE3) Timing

Table 3.11 POE3 Timing

Item	Symbol	Min.	Max.	Unit*1	Test Conditions
POE3	POEn# input pulse width	1.5	—	t_{p1cyc}	Figure 3.42

Note 1. t_{p1cyc} indicates peripheral clock 1C (P1φ) cycle.

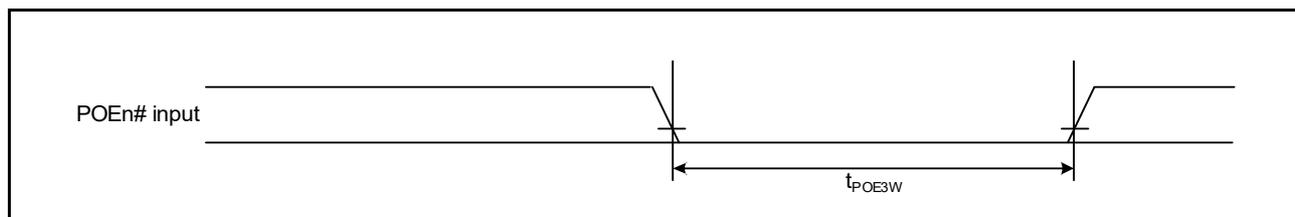


Figure 3.42 POEn# input pulse Timing

3.4.8 General PWM Timer (GPT) Timing

Table 3.12 GPT Timing

Item	Symbol	Min.	Max.	Unit*1	Test Conditions
GPT Input capture input pulse width	Single-edge setting	1.5	—	t_{p1cyc}	Figure 3.43
	Both-edge setting	2.5	—		

Note 1. t_{p1cyc} indicates peripheral clock 1C (P1φ) cycle.

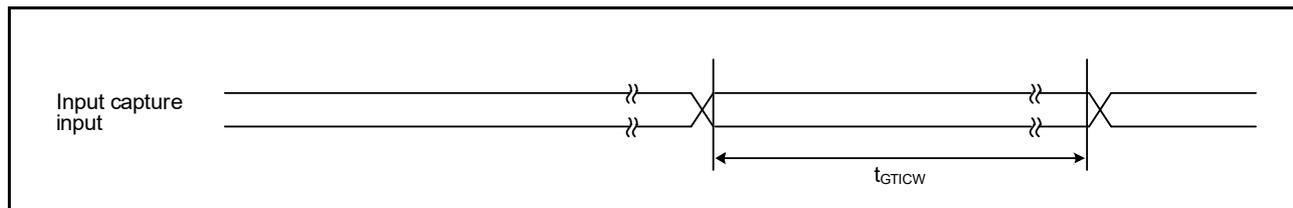


Figure 3.43 GPT Input Capture Input Timing

3.4.9 Port Output Enable for GPT (POEG) Timing

Table 3.13 POEG Timing

Item	Symbol	Min.	Max.	Unit*1	Test Conditions
POEG	POEG input trigger pulse width	t_{POEGW}	3	—	t_{p1cyc} Figure 3.44

Note 1. t_{p1cyc} indicates peripheral clock 1C (P1 ϕ) cycle.

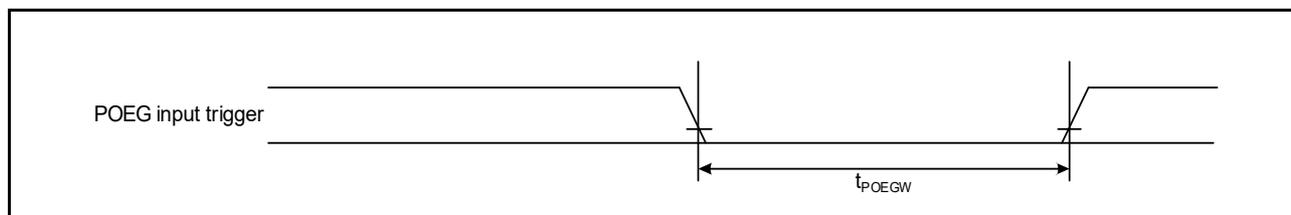


Figure 3.44 POEG Input Trigger Timing

3.4.10 Watchdog Timer Timing

Table 3.14 Watchdog Timer Timing

Item	Symbol	Min.	Max.	Unit	Figure
WDTOVF# delay time	t_{WOVD}	—	100	ns	Figure 3.45
PERROUT# delay time	t_{PEOD}	—	100	ns	

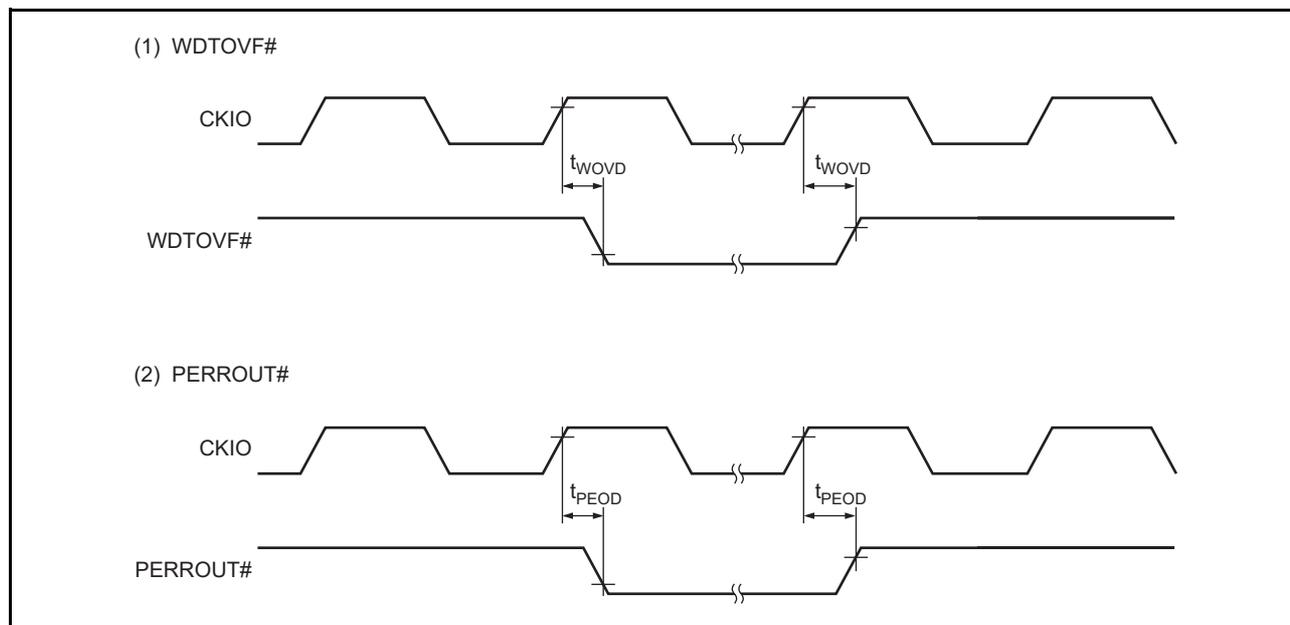


Figure 3.45 Watchdog Timer Output Timing

3.4.11 Serial Communications Interface with FIFO (SCIFA) Timing

Table 3.15 SCIFA Timing

Item		Symbol	Min.*1	Max.*1	Unit*1	Test Conditions
SCIFA Input clock cycle	Asynchronous	$t_{S\text{cyc}}$	4	—	$t_{p1\text{cyc}}$	Figure 3.46
	Clocked synchronous		12	—		
Input clock pulse width		$t_{S\text{CKW}}$	0.4	0.6	$t_{S\text{cyc}}$	
Input clock rise time		$t_{S\text{CKr}}$	—	5	ns	
Input clock fall time		$t_{S\text{CKf}}$	—	5	ns	
Output clock cycle	Asynchronous*2	$t_{S\text{cyc}}$	8	—	$t_{p1\text{cyc}}$	
	Clocked synchronous		4	—		
Output clock pulse width		$t_{S\text{CKW}}$	0.4	0.6	$t_{S\text{cyc}}$	
Output clock rise time		$t_{S\text{CKr}}$	—	9	ns	
Output clock fall time		$t_{S\text{CKf}}$	—	9	ns	
Transmit data delay time	Internal clock	t_{TXD}	-10	10	ns	Figure 3.47
	External clock		$3 \times t_{p1\text{cyc}}$	$4 \times t_{p1\text{cyc}} + 20$		
Receive data setup time	Internal clock	t_{RXS}	$3 \times t_{p1\text{cyc}} + 20$	—	ns	
	External clock		$t_{p1\text{cyc}} + 10$	—		
Receive data hold time	Internal clock	t_{RXH}	$-3 \times t_{p1\text{cyc}}$	—	ns	
	External clock		$2 \times t_{p1\text{cyc}} + 10$	—		

Note 1. $t_{p1\text{cyc}}$ indicates peripheral clock 1C (P1 ϕ) cycle.

Note 2. When the SEMR.ABCS0 and SEMR.BGDM bits are set to 1

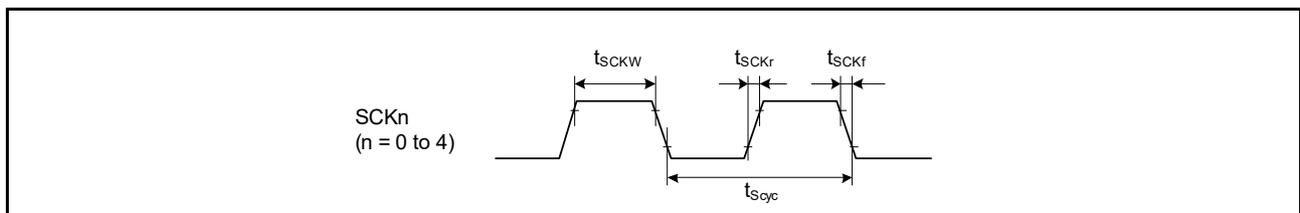


Figure 3.46 SCK Input Clock Timing

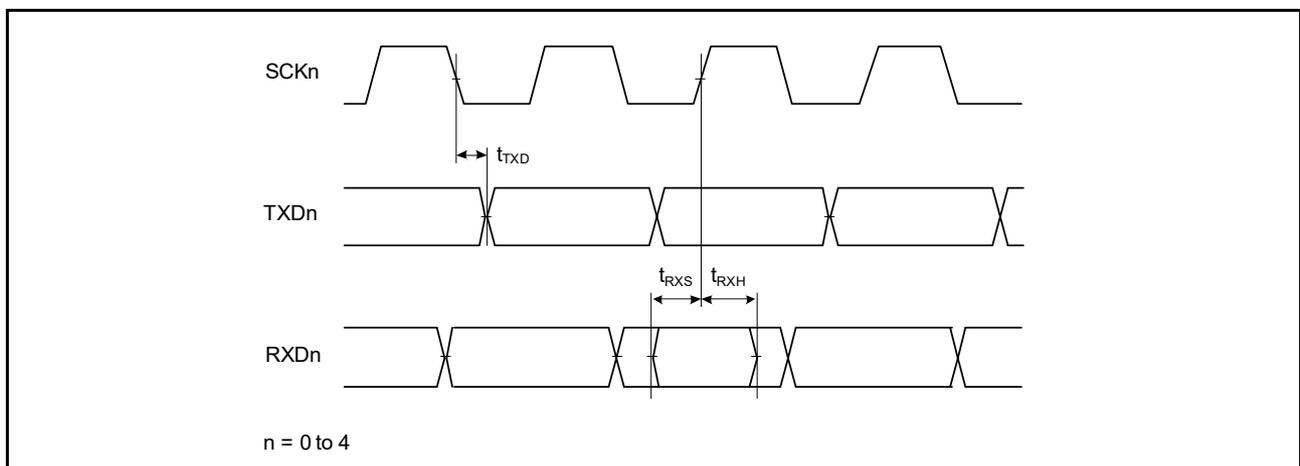


Figure 3.47 SCIFA Input/Output Timing in Clocked Synchronous Mode

3.4.12 Serial Communications Interface (SCI) Timing

Table 3.16 SCI Timing

Item		Symbol	Min.	Max.	Unit	Test Conditions	
SCI	Input clock cycle	asynchronous	$t_{S\text{cyc}}$	4	—	$t_{P\text{cyc}}^{*1}$ Figure 3.48	
		clocked synchronous		6	—		
	Input clock pulse width	$t_{S\text{CKW}}$	0.4	0.6	$t_{S\text{cyc}}$		
	Input clock rise time	$t_{S\text{CKr}}$	—	5	ns		
	Input clock fall time	$t_{S\text{CKf}}$	—	5	ns		
	Output clock cycle	asynchronous*2	$t_{S\text{cyc}}$	8	—	$t_{P\text{cyc}}^{*1}$	
		clocked synchronous		4	—		
	Output clock pulse width	$t_{S\text{CKW}}$	0.4	0.6	$t_{S\text{cyc}}$		
	Output clock rise time	$t_{S\text{CKr}}$	—	5	ns		
	Output clock fall time	$t_{S\text{CKf}}$	—	5	ns		
	Transmit data delay time	clocked synchronous	t_{TXD}	—	28	ns	Figure 3.49
	Receive data setup time	clocked synchronous	t_{RXS}	15	—	ns	
	Receive data hold time	clocked synchronous	t_{RXH}	5	—	ns	

Note 1. $t_{P\text{cyc}}$ indicates the peripheral clock 1 (P1 ϕ) cycle.

Note 2. When the SEMR.ABCS and SEMR.BGDM bits are set to 1

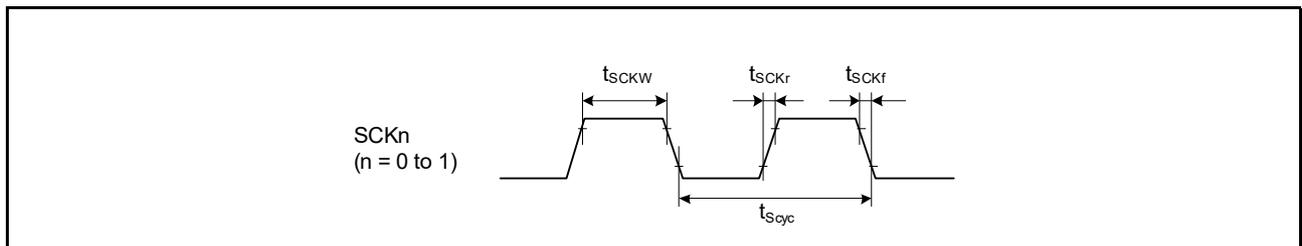


Figure 3.48 SCK Input Clock Timing

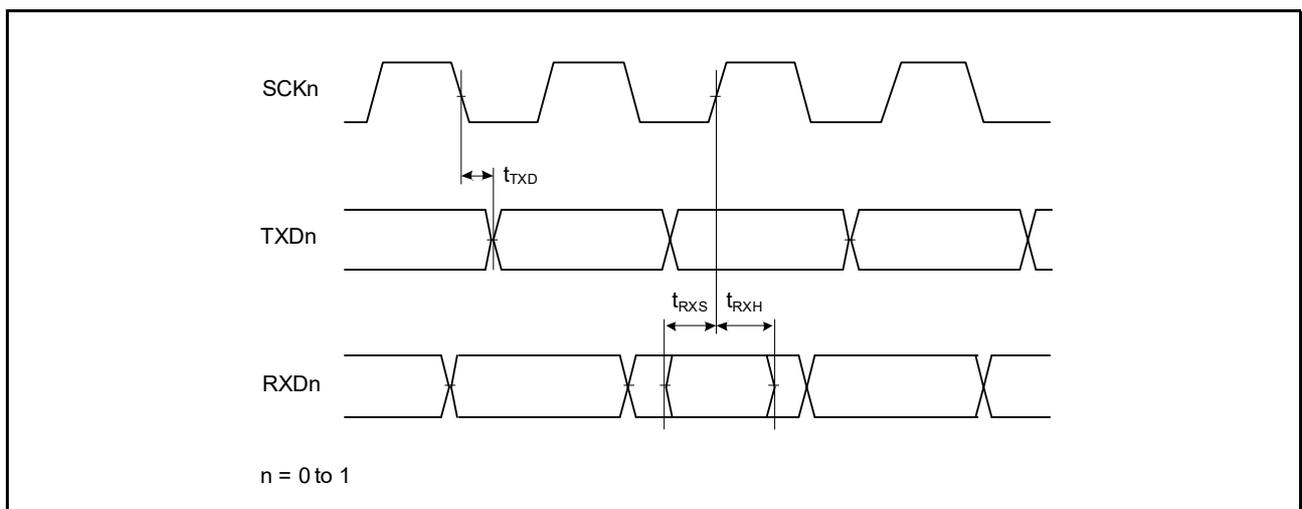


Figure 3.49 SCI Input/Output Timing in Clocked Synchronous Mode

3.4.13 Renesas Serial Peripheral Interface Timing

Table 3.17 Renesas Serial Peripheral Interface Timing

Item		Symbol	Min.	Max.	Unit	Figure
RSPCK clock cycle	Master	t_{SPcyc}	2	4096	t_{p1cyc}	Figure 3.50
	Slave		8	4096		
RSPCK clock high pulse width	Master	t_{SPCKWH}	0.4	—	t_{SPcyc}	
	Slave		0.4	—		
RSPCK clock low pulse width	Master	t_{SPCKWL}	0.4	—	t_{SPcyc}	
	Slave		0.4	—		
Data input setup time	Master	t_{SU}	15	—	ns	Figure 3.51 to Figure 3.54
	Slave		0	—	t_{p1cyc}	
Data input hold time	Master	t_H	0	—	ns	
	Slave		4	—	t_{p1cyc}	
SSL setup time	Master	t_{LEAD}	$1 \times t_{SPcyc} - 20$	$8 \times t_{SPcyc}$	ns	
	Slave		4	—	t_{p1cyc}	
SSL hold time	Master	t_{LAG}	$1 \times t_{SPcyc}$	$8 \times t_{SPcyc} + 20$	ns	
	Slave		4	—	t_{p1cyc}	
Data output delay time	Master	t_{OD}	—	21	ns	
	Slave		—	4	t_{p1cyc}	
Data output hold time	Master	t_{OH}	5	—	ns	
	Slave		3	—	t_{p1cyc}	
Continuous transmission delay time	Master	t_{TD}	$1 \times t_{SPcyc} + 2 \times t_{cyc}$	$8 \times t_{SPcyc} + 2 \times t_{cyc}$	ns	
	Slave		$4 \times t_{cyc}$	—		
Slave access time		t_{SA}	—	4	t_{p1cyc}	Figure 3.53, Figure 3.54
Slave out release time		t_{REL}	—	3	t_{p1cyc}	

Note: t_{p1cyc} indicates the period of a cycle of the peripheral clock 1 (P1 ϕ).

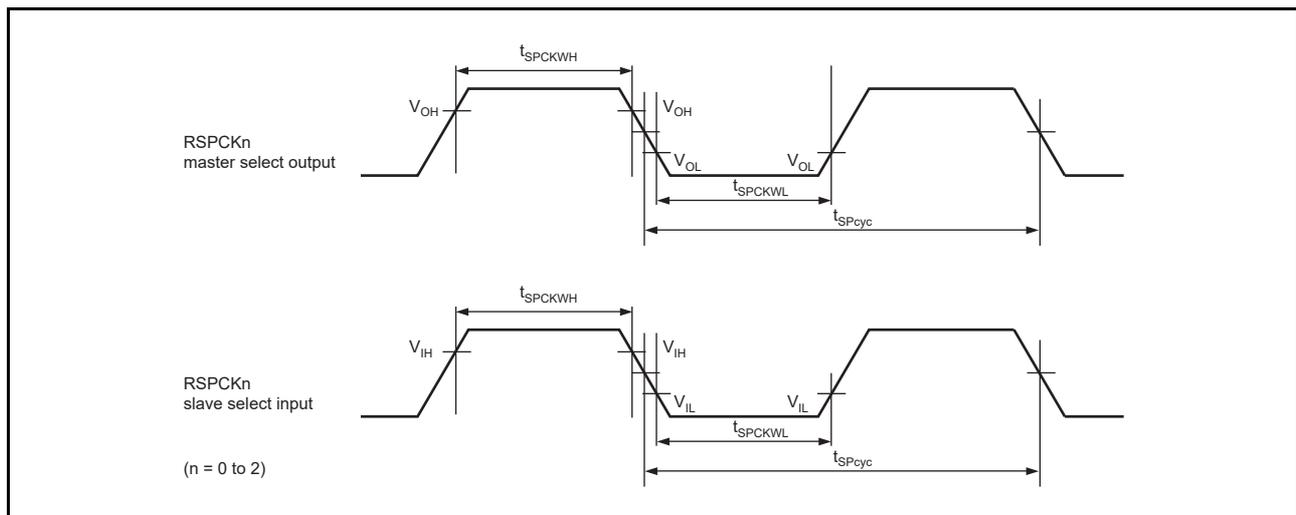


Figure 3.50 Clock Timing

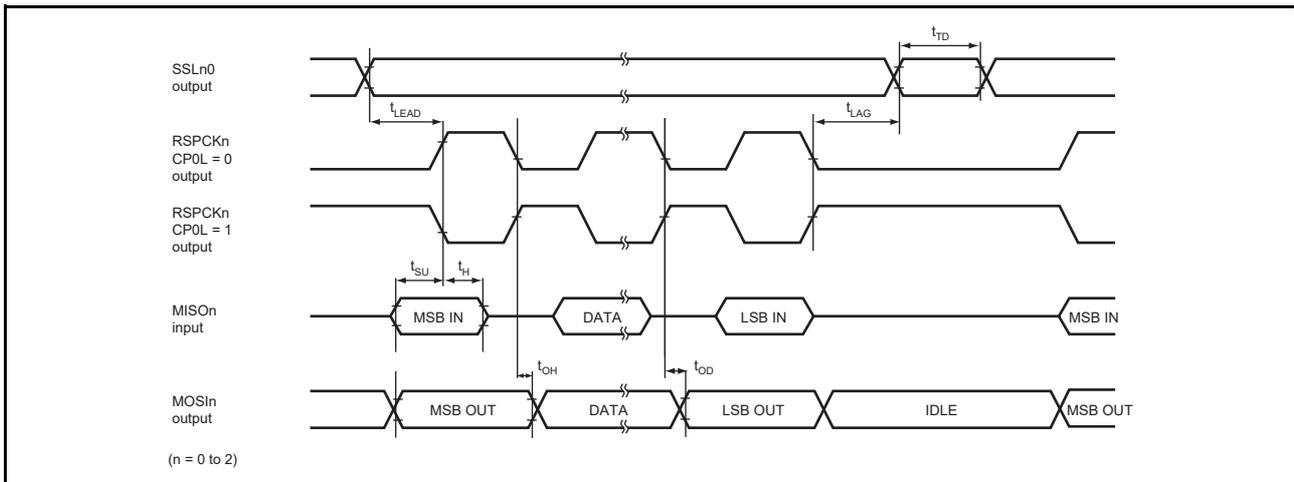


Figure 3.51 Transmission and Reception Timing (Master, CPHA = 0)

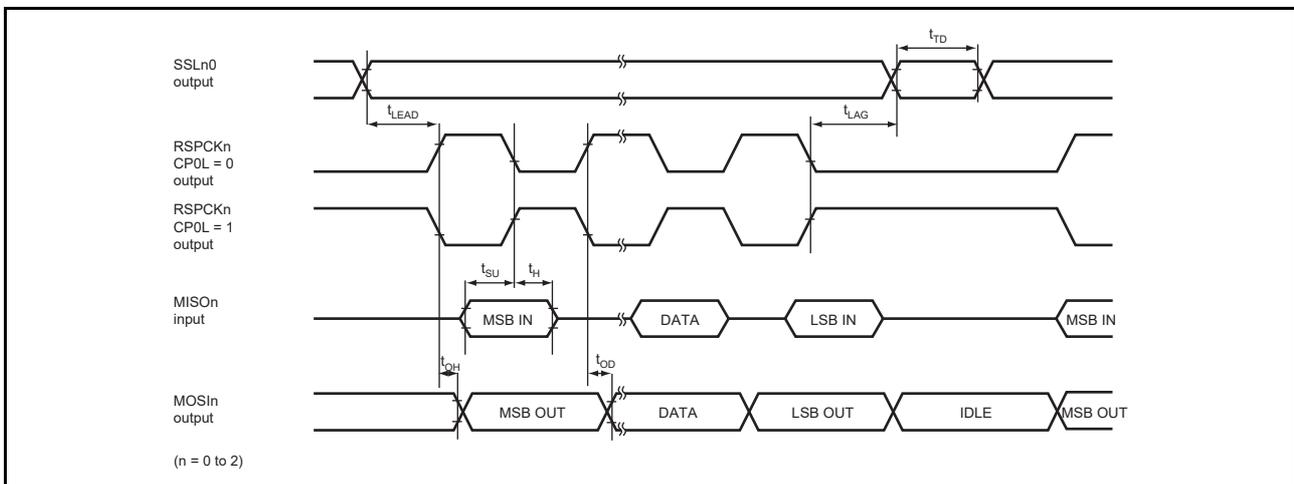


Figure 3.52 Transmission and Reception Timing (Master, CPHA = 1)

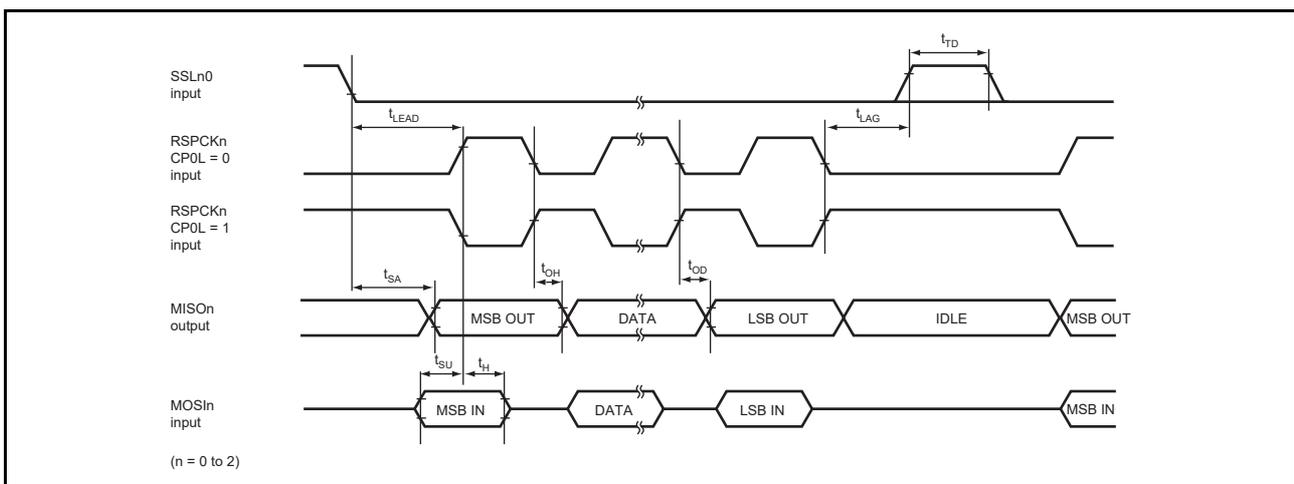


Figure 3.53 Transmission and Reception Timing (Slave, CPHA = 0)

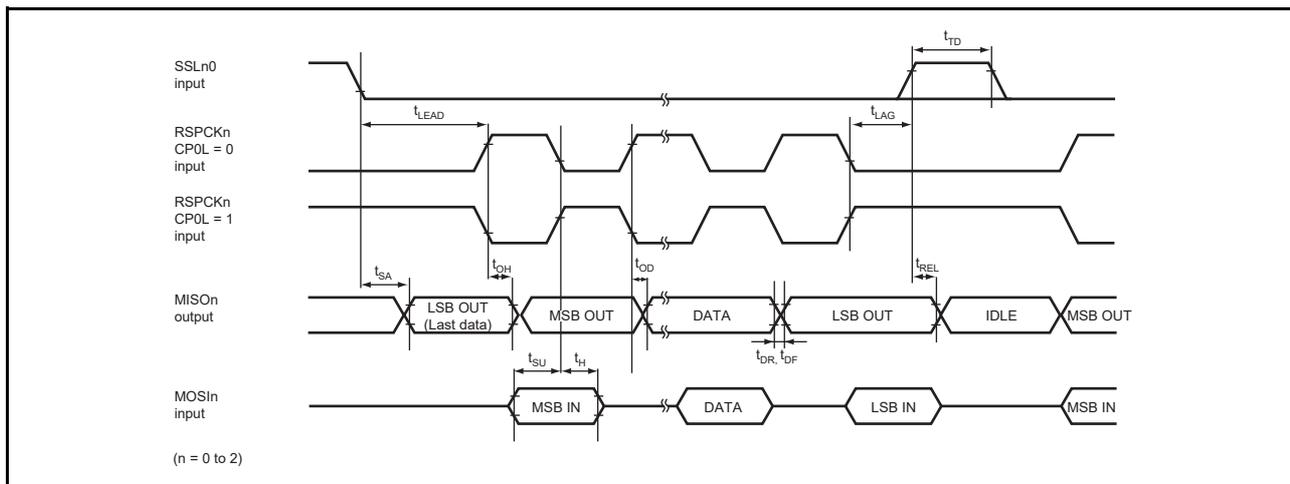


Figure 3.54 Transmission and Reception Timing (Slave, CPHA = 1)

3.4.14 SPI Multi I/O Bus Controller Timing

Table 3.18 SPI Multi I/O Bus Controller Timing *1

Item	Symbol	1.8 V (Octal-SPI flash memory/ HyperFlash connected)		3.3 V (Serial flash connected)		Unit	Figure	
		Min.	Max.	Min.	Max.			
Clock cycle	t_{SPBcyc}	7.58	—	15.15	—	ns	Figure 3.55, Figure 3.59	
CLK high pulse width	t_{SPBWH}	0.475	0.525	0.475	0.525	t_{SPBcyc}	Figure 3.55, Figure 3.59	
CLK low pulse width	t_{SPBWL}	0.475	0.525	0.475	0.525	t_{SPBcyc}	Figure 3.55, Figure 3.59	
CLK rise time	t_{SPBR}	—	1.0	—	2.0	ns	Figure 3.55, Figure 3.59	
CLK fall time	t_{SPBF}	—	1.0	—	2.0	ns	Figure 3.55, Figure 3.59	
Data input setup time	QSPI0_SPCLK base point (SDR mode timing adjusted)	t_{SU}	—	—	5.0	—	ns	Figure 3.56
	QSPI0_SPCLK base point (DDR mode timing adjusted)		—	—	2.0	—	ns	Figure 3.57
	QSPI1_SSL base point		-0.9 *2	—	—	—	ns	Figure 3.60
Data input hold time	QSPI0_SPCLK base point (SDR mode timing adjusted)	t_H	—	—	0.0	—	ns	Figure 3.56
	QSPI0_SPCLK base point (DDR mode timing adjusted)		—	—	1.0	—	ns	Figure 3.57
	QSPI1_SSL base point		2.69 *2	—	—	—	ns	Figure 3.60
SSL setup time	t_{LEAD}	$1.5 \times t_{SPBcyc} - 3$	$8.5 \times t_{SPBcyc} + 3$	$1.5 \times t_{SPBcyc} - 3$	$8.5 \times t_{SPBcyc} + 3$	ns	Figure 3.56, Figure 3.57, Figure 3.60	
SSL hold time	t_{LAG}	$1 \times t_{SPBcyc} - 3$	$8 \times t_{SPBcyc} + 3$	$1 \times t_{SPBcyc} - 3$	$8 \times t_{SPBcyc} + 3$	ns	Figure 3.56, Figure 3.57, Figure 3.60	
Continuous transfer delay time	t_{TD}	$1 \times t_{SPBcyc} - 3$	$8 \times t_{SPBcyc} + 3$	$1 \times t_{SPBcyc} - 3$	$8 \times t_{SPBcyc} + 3$	ns	Figure 3.56, Figure 3.57, Figure 3.60	
Data output delay time	SDR	t_{OD}	—	1.4	—	5.0	ns	Figure 3.56
	DDR		—	2.69 *2	—	5.0 *3	ns	Figure 3.57, Figure 3.60
Data output hold time	SDR	t_{OH}	-1.4	—	-5.0	—	ns	Figure 3.56
	DDR		0.9 *2	—	2.1 *3	—	ns	Figure 3.57, Figure 3.60
Skew of Clock to Data Strobe	t_{CKDS}	—	7	—	—	ns	Figure 3.60	
Data output buffer off time	SDR	t_{BOFF}	-1.7	—	-5.5	2	ns	Figure 3.58
	DDR		$1 \times t_{SPBcyc} - 1.7$	—	$1 \times t_{SPBcyc} - 5.5$	—	ns	

Item	Symbol	1.8 V (Octal-SPI flash memory/ HyperFlash connected)		3.3 V (Serial flash connected)		Unit	Figure
		Min.	Max.	Min.	Max.		
AC differential crossing voltage	V_{OX}	$PV_{cc_SPI} \times 0.4$	$PV_{cc_SPI} \times 0.6$	—	—	V	Figure 3.59

Note 1. Output load: 15 pF
 Note 2. QSPI0_SPCLK frequency: 132 MHz
 Note 3. QSPI0_SPCLK frequency: 66 MHz

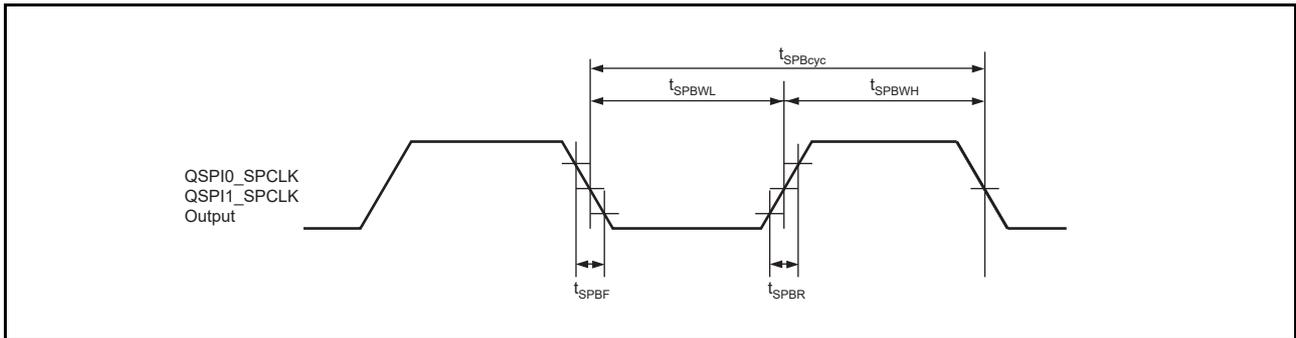


Figure 3.55 Clock Timing

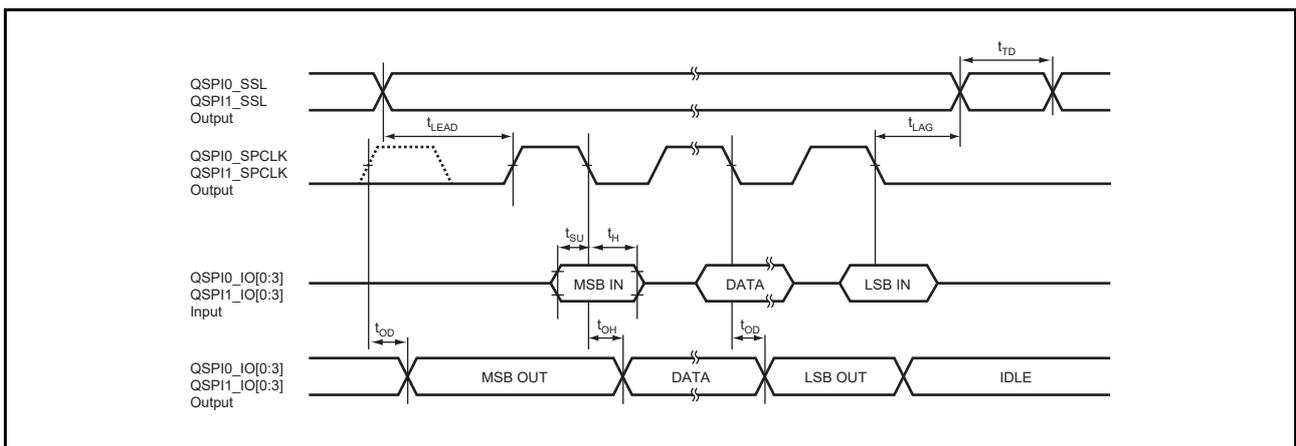


Figure 3.56 SDR Transfer Format Transmission and Reception Timing

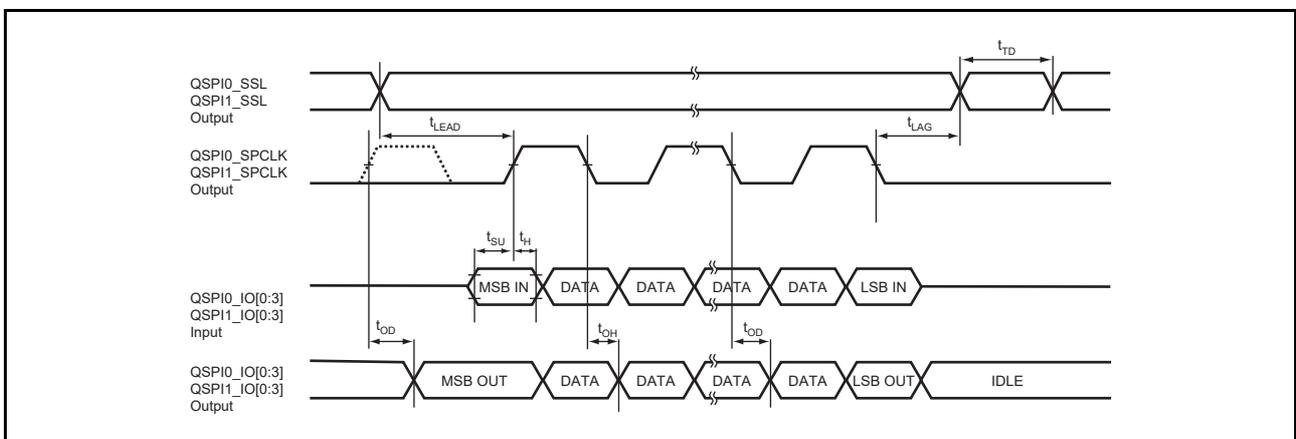


Figure 3.57 DDR Transfer Format Transmission and Reception Timing

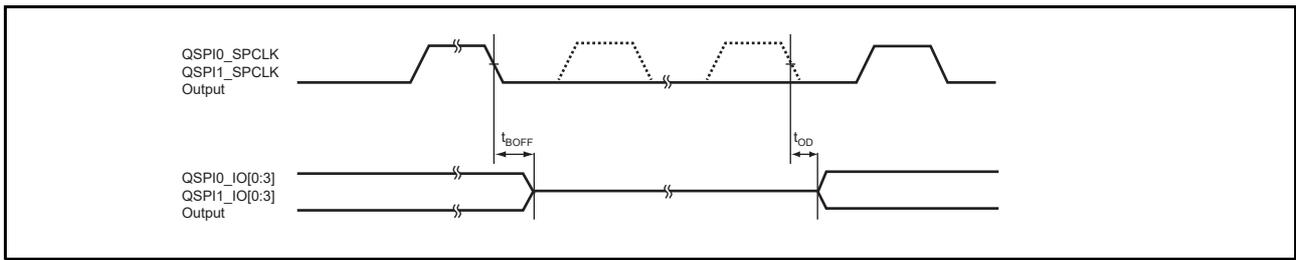


Figure 3.58 Timing for Switching the Buffers on and off

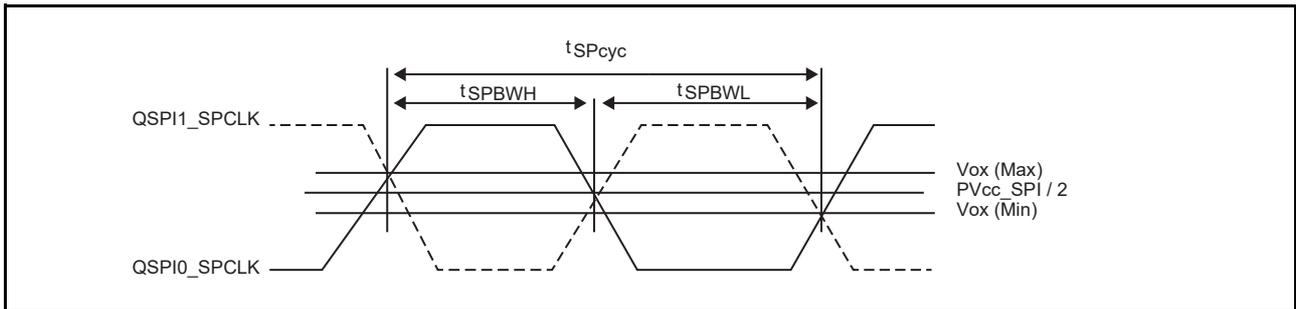


Figure 3.59 AC Differential Crossing Voltage

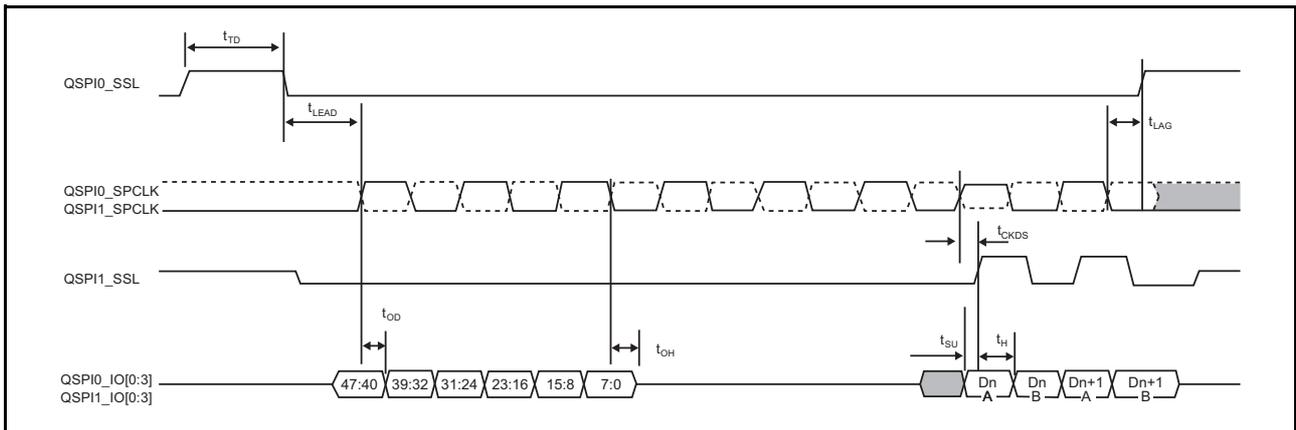


Figure 3.60 Transmit/Receive Timing with Octal-SPI flash memory or HyperFlash™ Connected

3.4.15 HyperBus™ Controller Timing

Table 3.19 HyperBus™ Controller Timing *1*2

Item	Symbol	Min.	Max.	Unit	Figure
HM_CK, HM_CK# clock frequency	f_{HY}	13.75	132	MHz	Figure 3.61, Figure 3.62
HM_CK, HM_CK# clock pulse width	t_{HYW}	0.475	0.525	t_{HYcyc}	
HM_CK, HM_CK# rise time	t_{HYr}	—	1	ns	
HM_CK, HM_CK# fall time	t_{HYf}	—	1	ns	
HM_CK, HM_CK# differential cross point voltage	V_{OX}	$PV_{cc_HO} \times 0.4$	$PV_{cc_HO} \times 0.6$	V	
HM_CS setup time	t_{CSSHY}	$1 \times t_{HYcyc} - 3$ (Minimum register settings*3)	$16 \times t_{HYcyc} + 3$ (Maximum register settings*3)	ns	Figure 3.63, Figure 3.64
HM_CS hold time	t_{CSHHY}	$1 \times t_{HYcyc} - 3$ (Minimum register settings*4)	$16 \times t_{HYcyc} + 3$ (Maximum register settings*4)	ns	
HM_CS High time (Continuous transfer)	t_{CSHIHY}	$1.5 \times t_{HYcyc} - 3$ (Minimum register settings*5)	$16.5 \times t_{HYcyc} + 3$ (Maximum register settings*5)	ns	
Data input setup time	t_{SU}	-0.9 *7	—	ns	
Data input hold time	t_H	2.69 *7	—	ns	
Skew of clock to data strobe	t_{CKDS}	—	$(N + 1) \times t_{HYcyc} - 3$ *6	ns	
Data output delay time	t_{OD}	—	2.69 *7	ns	
Data output hold time	t_{OH}	0.9 *7	—	ns	
RWDS refresh input setup time	t_{RWDS}	12.5	—	ns	Figure 3.65
RWDS refresh input hold time	t_{RWDSH}	$0.5 \times t_{HYcyc}$	—	ns	

Note 1. t_{HYcyc} indicates the HM_CK (HM_CK#) cycle.

Note 2. Output load: 15 pF

Note 3. The value of HM_CS0# is set by the WCSS bits and RCSS bits of the MTR0 register. The value of HM_CS1# is set by the WCSS bits and RCSS bits of the MTR1 register.

Note 4. The value of HM_CS0# is set by the WCSH bits and RCSH bits of the MTR0 register. The value of HM_CS1# is set by the WCSH bits and RCSH bits of the MTR1 register.

Note 5. The value of HM_CS0# is set by the WCSHI bits and RCSHI bits of the MTR0 register. The value of HM_CS1# is set by the WCSHI bits and RCSHI bits of the MTR1 register.

Note 6. N is RCSH bits value of the MTR0 or MTR1 register (N = 0 to 15).

Note 7. HM_CK frequency: 132 MHz

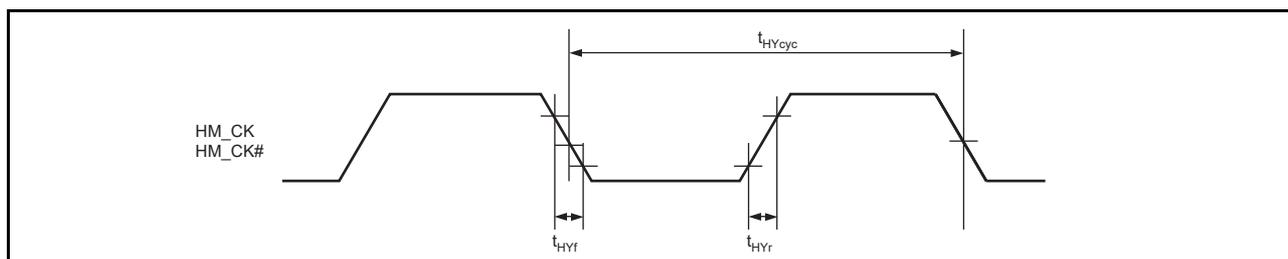


Figure 3.61 Clock Timing

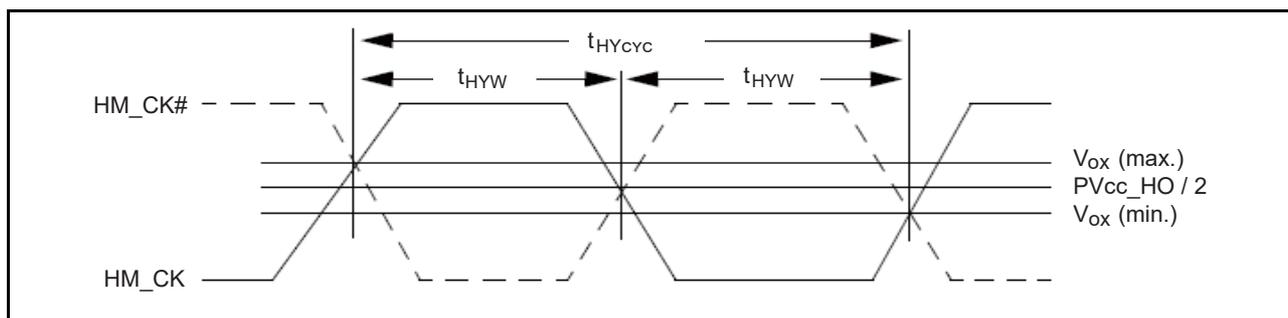


Figure 3.62 AC Differential Crossing Voltage

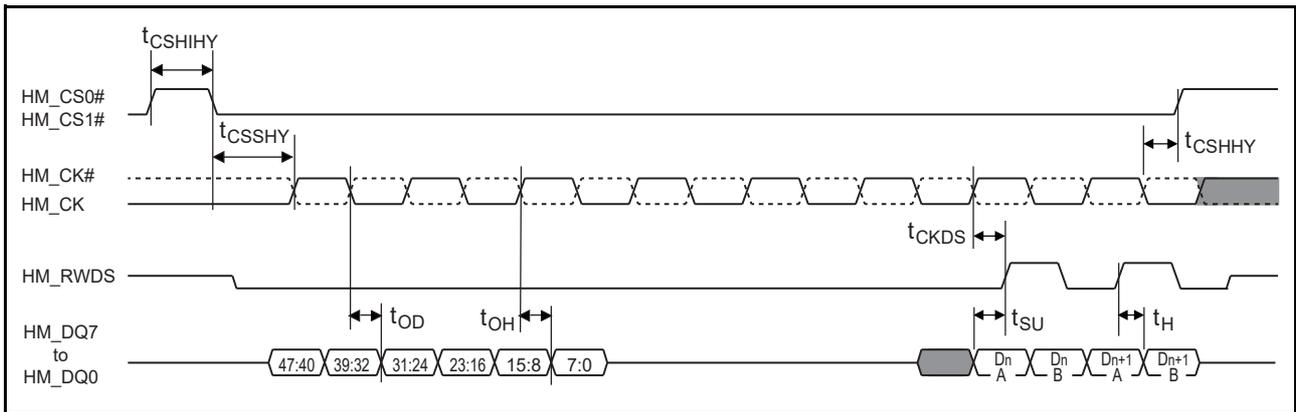


Figure 3.63 HyperBus™ Read Timing

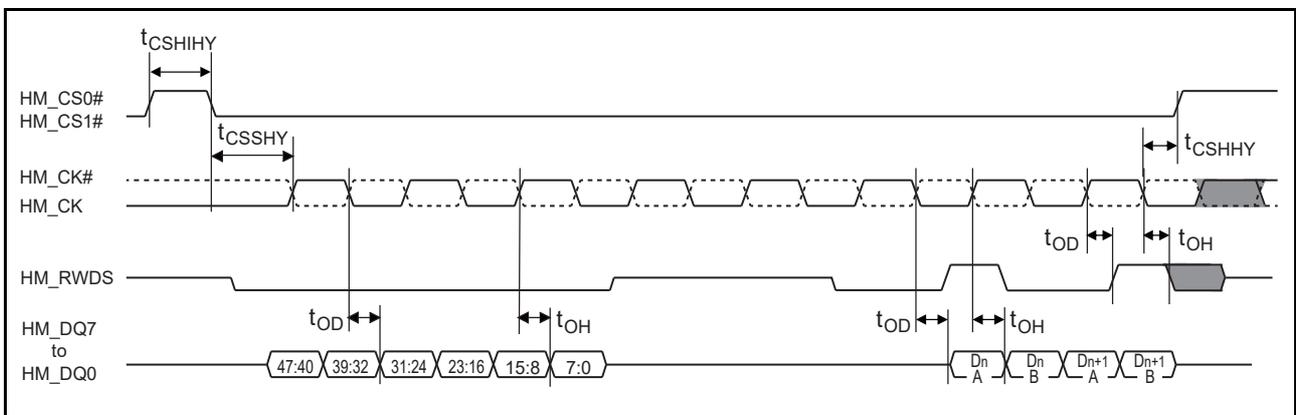


Figure 3.64 HyperBus™ Write Timing

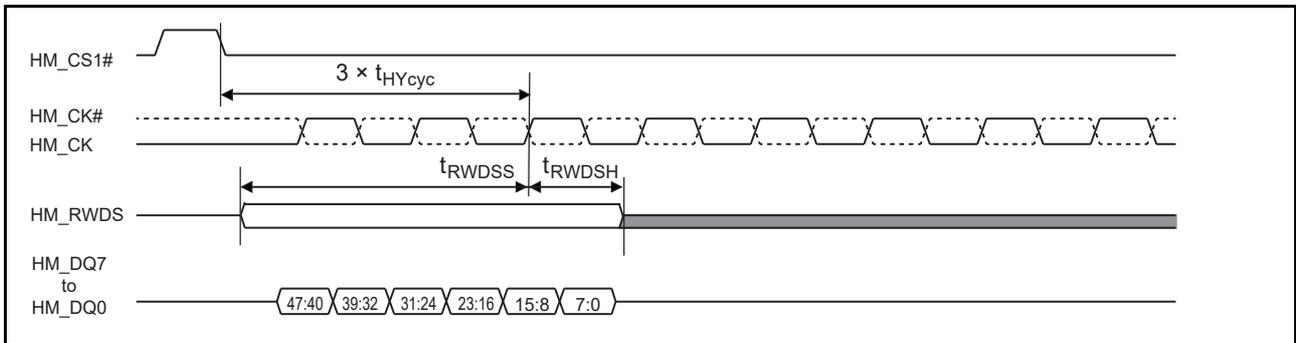


Figure 3.65 RWDS Refresh input Timing (HyperRAM™ Read/Write)

3.4.16 Octa Memory Controller Timing

Table 3.20 Octa Memory Controller Timing *1*2

Item		Symbol	Min.	Max.	Unit	Figure
OM_SCLK clockfrequency		f_{OCcyc}	—	132	MHz	Figure 3.66
OM_SCLK high pulse width		t_{OCwh}	0.475	0.525	t_{OCcyc}	
OM_SCLK low pulse width		t_{OCwl}	0.475	0.525	t_{OCcyc}	
OM_SCLK rise time		t_{OCr}	—	1	ns	
OM_SCLK fall time		t_{OCf}	—	1	ns	
OM_CS setup time	SPI/SOPI	t_{OCLEAD}	$1 \times t_{OCcyc} - 3$ (Minimum register settings)	$2.5 \times t_{OCcyc} + 3$ (Maximum register settings)	ns	Figure 3.67, Figure 3.68
	DOPI	t_{OCLEAD}	$0.75 \times t_{OCcyc} - 3$ (Minimum register settings)	$2.25 \times t_{OCcyc} + 3$ (Maximum register settings)	ns	Figure 3.69
OM_CS hold time	SPI/SOPI	t_{OCLAG}	$1 \times t_{OCcyc} - 3$ (Minimum register settings)	$4.5 \times t_{OCcyc} + 3$ (Maximum register settings)	ns	Figure 3.67, Figure 3.68
	DOPI read	t_{OCLAG}	$3.25 \times t_{OCcyc} - 3$ (Minimum register settings)	$4.25 \times t_{OCcyc} + 3$ (Maximum register settings)	ns	Figure 3.69
	DOPI write	t_{OCLAG}	$0.75 \times t_{OCcyc} - 3$ (Minimum register settings)	$4.25 \times t_{OCcyc} + 3$ (Maximum register settings)	ns	
Continuous transfer delay time		t_{OCTD}	$1 \times t_{OCcyc} - 3$ (Minimum register settings)	$8.5 \times t_{OCcyc} + 3$ (Maximum register settings)	ns	Figure 3.67, Figure 3.68, Figure 3.69
Data input setup time	SPI SCLK base point	t_{SU}	9.6	—	ns	Figure 3.67
Data input hold time		t_H	0.5	—	ns	
Data input setup time	SOPI/DOPI	t_{SU}	-0.7	—	ns	Figure 3.68,
Data input hold time	DQS base point *3	t_H	2.69	—	ns	Figure 3.69
Skew of Clock to Data Strobe		t_{CKDS}	—	20	ns	
Data output delay time	SPI/SOPI	t_{OD}	—	1.4	ns	Figure 3.67, Figure 3.68
Data output hold time		t_{OH}	-1.4	—	ns	
Data output buffer off time	SOPI	t_{BOFF}	2	—	ns	Figure 3.68
Data output delay time	DOPI *3	t_{OD}	—	2.69	ns	Figure 3.69, Figure 3.70
Data output hold time		t_{OH}	0.9	—	ns	
Data output buffer off time	DOPI	t_{BOFF}	0.9	—	ns	Figure 3.69
DQS refresh input setup time		t_{DQSS}	12	—	ns	Figure 3.71
DQS refresh input hold time		t_{DQSH}	$0.5 \times t_{OCcyc}$	—	ns	

Note 1. t_{OCcyc} indicates the OM_SCLK cycle.

Note 2. Maximum load capacitance: 15 pF

Note 3. OM_SCLK frequency: 132 MHz

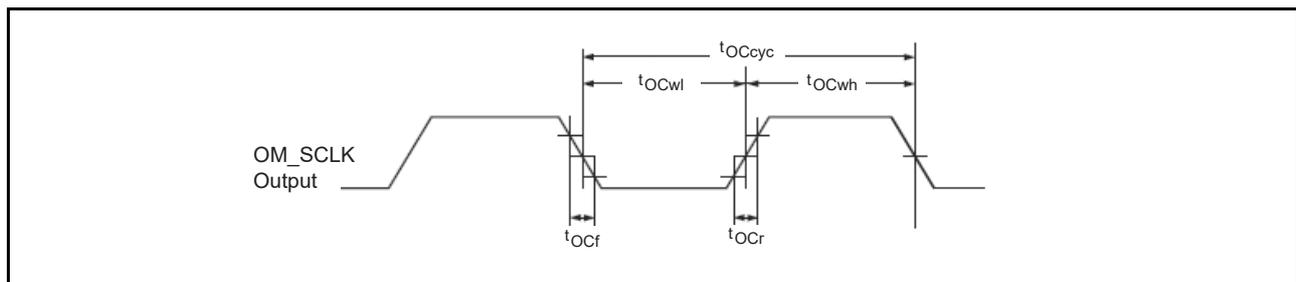


Figure 3.66 Clock Timing

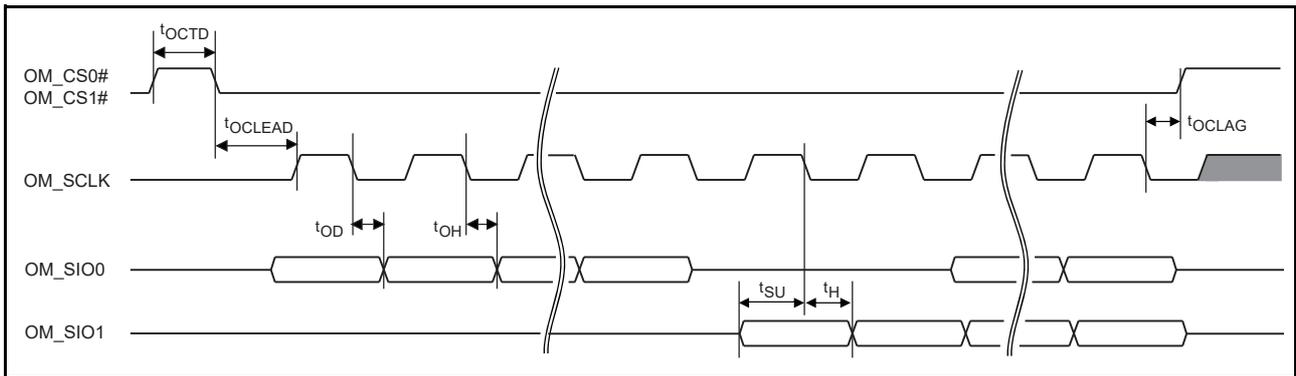


Figure 3.67 SPI Transfer Format Transmission and Reception Timing

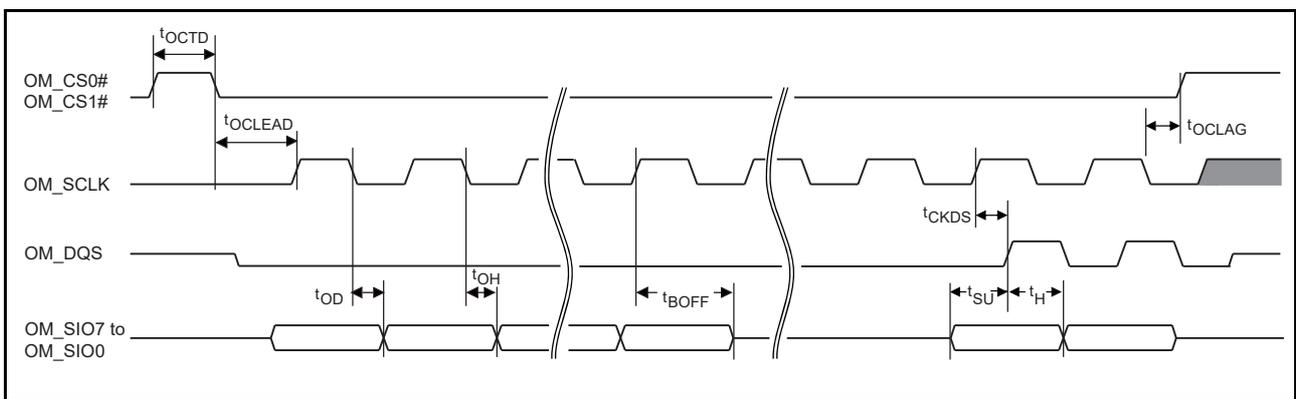


Figure 3.68 SOPI Transfer Format Transmission and Reception Timing

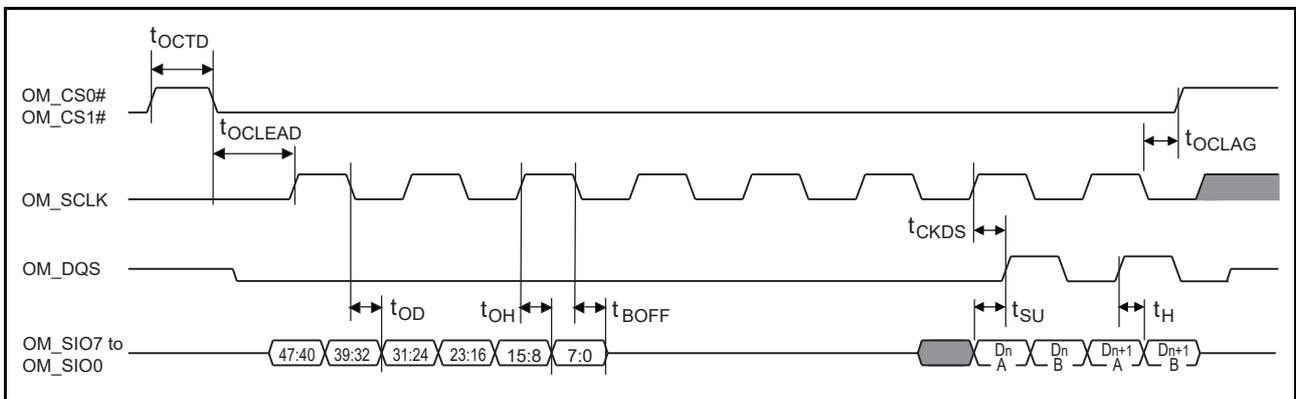


Figure 3.69 DOPI Transfer Format Transmission and Reception Timing

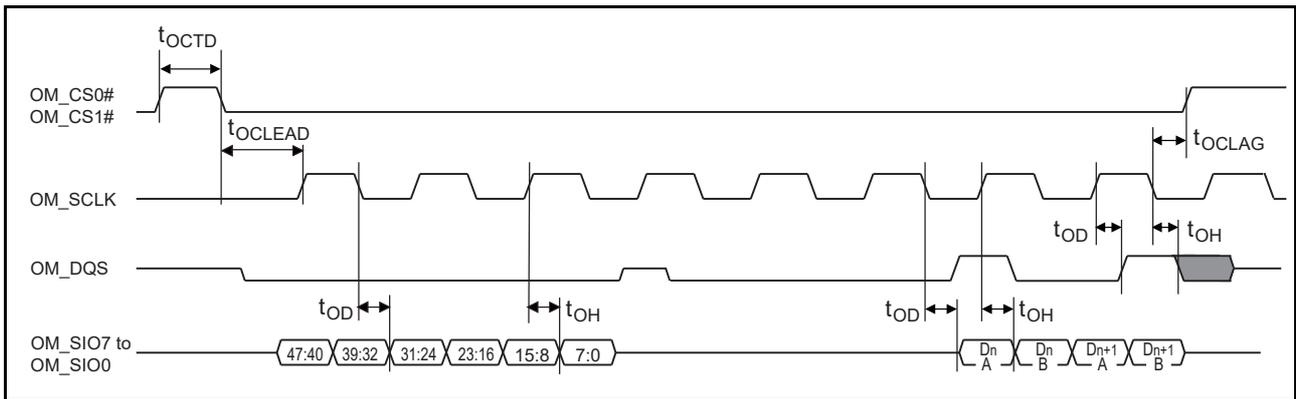


Figure 3.70 DOPI Transfer Format Transmission Timing

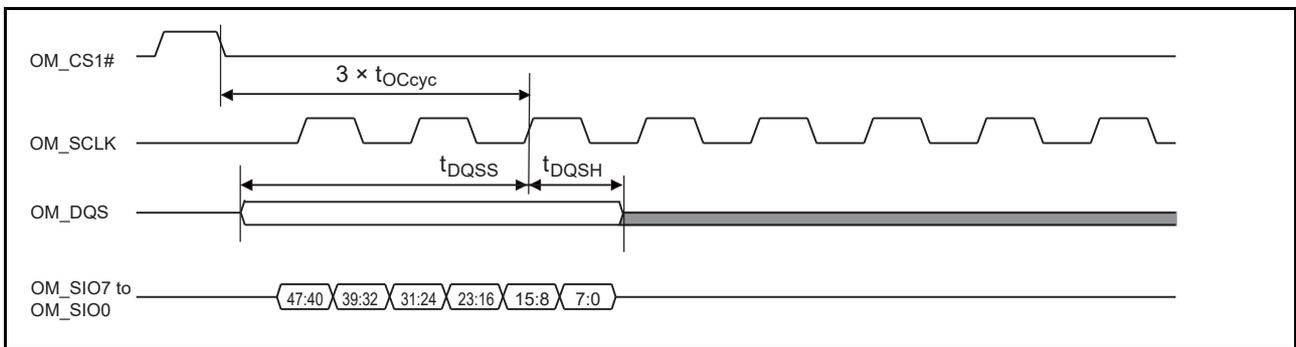


Figure 3.71 DQS Refresh input Timing (OctaRAM™ Read/Write)

3.4.17 I²C Bus Interface TimingTable 3.21 I²C Bus Interface Timing

Item	Symbol	I/O	Standard mode (Sm)		Fast mode (Fm)		Fast mode plus (Fm+)		Unit
			Min.	Max.	Min.	Max.	Min.	Max.	
SCL clock frequency	f _{CLK}	I/O	0	100	0	400	0	1000	kHz
Bus free time (between stop and start condition)	t _{BUF}	I/O	4.7	—	1.3	—	0.5	—	μs
Hold time*1	t _{HD:STA}	I/O	4.0	—	0.6	—	0.26	—	μs
Low period of SCL clock	t _{LOW}	I/O	4.7	—	1.3	—	0.5	—	μs
High period of SCL clock	t _{HIGH}	I/O	4.0	—	0.6	—	0.26	—	μs
Setup time for start/restart condition	t _{SU:STA}	I/O	4.7	—	0.6	—	0.26	—	μs
Data hold time (I ² C bus device)	t _{HD:DAT}	I/O	0*2	—	0*2	—	0	—	μs
Data setup time	t _{SU:DAT}	I/O	250	—	100*3	—	50	—	ns
SDA and SCL signal rise time	t _R	Input	—	1000	20	300	—	120	ns
SDA and SCL signal fall time*3	t _F	Input	—	300	20 × (PV _{CC} / 5.5 V)	300	20 × (PV _{CC} / 5.5 V)	120	ns
		Output	—	250	20 × (PV _{CC} / 5.5 V)	250	20 × (PV _{CC} / 5.5 V)	120	ns
Setup time for STOP condition	t _{SU:STO}	I/O	4.0	—	0.6	—	0.26	—	μs
Capacitive load for each bus line	C _b	—	—	400*4	—	400*4	—	550*4	pF
Pulse width of spikes that must be suppressed by the input filter	t _{SP}	Input	—	—	0	50*5	0	50*5	ns

In the above table and subsequently, SCL and SDA refer to the RIICnSCL and RIICnSDA signals, respectively.

Note 1. The first clock pulse is generated on the SCL line after the start condition has been issued and the hold time has elapsed.

Note 2. This module requires a minimum of 300 ns hold time internally for the SDA signal to handle the period over which the falling edge of SCL has not reached a defined level (time until the CnSCL signal reaches V_{IL} (max.) from V_{IH} (min.)).

Note 3. The fast-mode I²C bus device can be used in the standard mode I²C bus system. In this case, the minimum value of the data setup time (t_{SU:DAT} (min.) 250 [ns]) must be satisfied.

If the system does not extend the low period of SCL clock (t_{LOW}), this condition is automatically satisfied. If the system extends the low period of SCL clock (t_{LOW}), transmit the subsequent data bit to the SDA line before the SCL line is released (t_R (max.) + t_{SU:DAT} (min.) = 1000 + 250 = 1250 [ns]: (standard mode I²C bus specification)).

Note 4. Total capacitance of one bus line. The allowable maximum bus capacitance may differ from this specification, depending on the actual operating voltage and frequency of an application. For techniques to cope with a large bus capacitance, see the I²C bus specification provided by NXP Semiconductors.

Note 5. Noise is removed by the analog and digital input filters. The level of noise reduction of the digital input filter is determined by the period of internal reference clock (IICφ) and the NF[1:0] bits in RIICnMR3. For details, refer to section 23, I²C Bus Interface, in the RZ/A2M Group User's Manual.

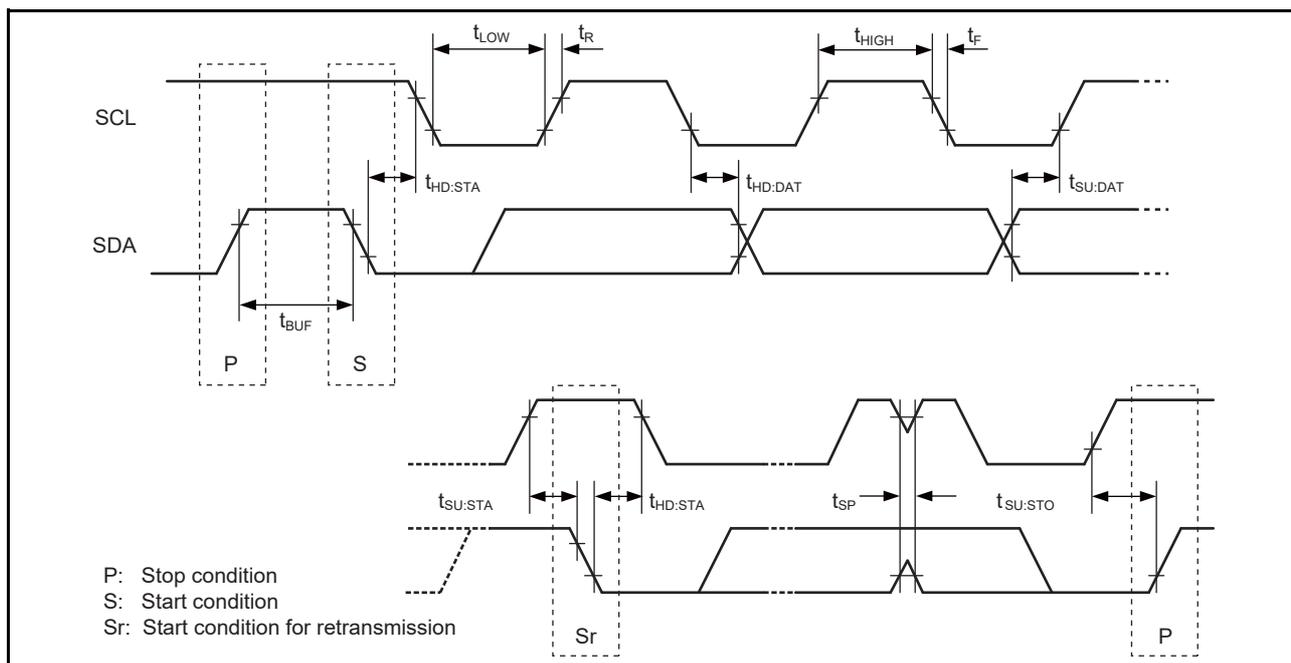


Figure 3.72 Input/Output Timing

3.4.18 Serial Sound Interface (SSIF-2) Timing

Table 3.22 SSIF-2 Timing

Item	Remarks	Symbol	Target Specification		Unit	Figure
			Min.	Max.		
Output clock cycle	Output	t_O	80	64000	ns	Figure 3.73
Input clock cycle	Input	t_I	80	64000	ns	
Clock high	Bidirectional	t_{HC}	32	—	ns	
Clock low		t_{LC}	32	—	ns	
Clock rise time/Clock fall time	Output	t_{RC}/t_{FC}	—	25	ns	
Setup time		t_{SR}	25	—	ns	Figure 3.74, Figure 3.75, Figure 3.76
Hold time		t_{HR}	5	—	ns	
SSILRCK output delay time		t_{DTR}	-5	15	ns	
Data output delay time (Noise canceler not in use)		t_{DTR}	-5	25	ns	
Data output delay time (Noise canceler in use)		t_{DTR}	10	45	ns	

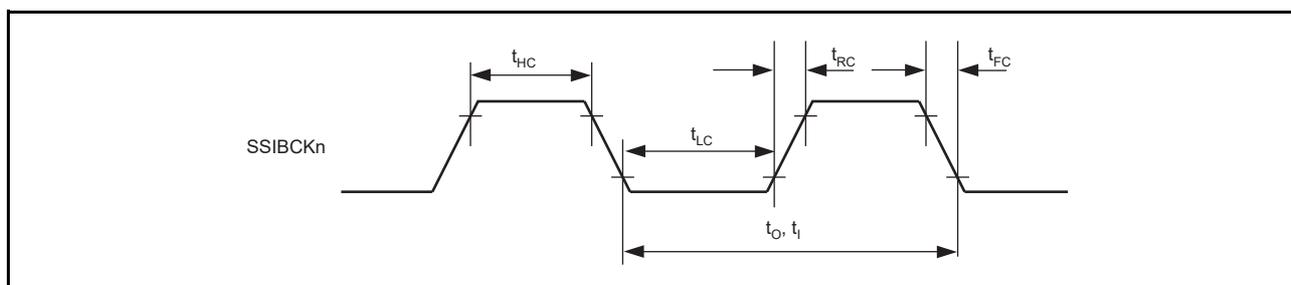


Figure 3.73 Bit Clock Input/Output Timing

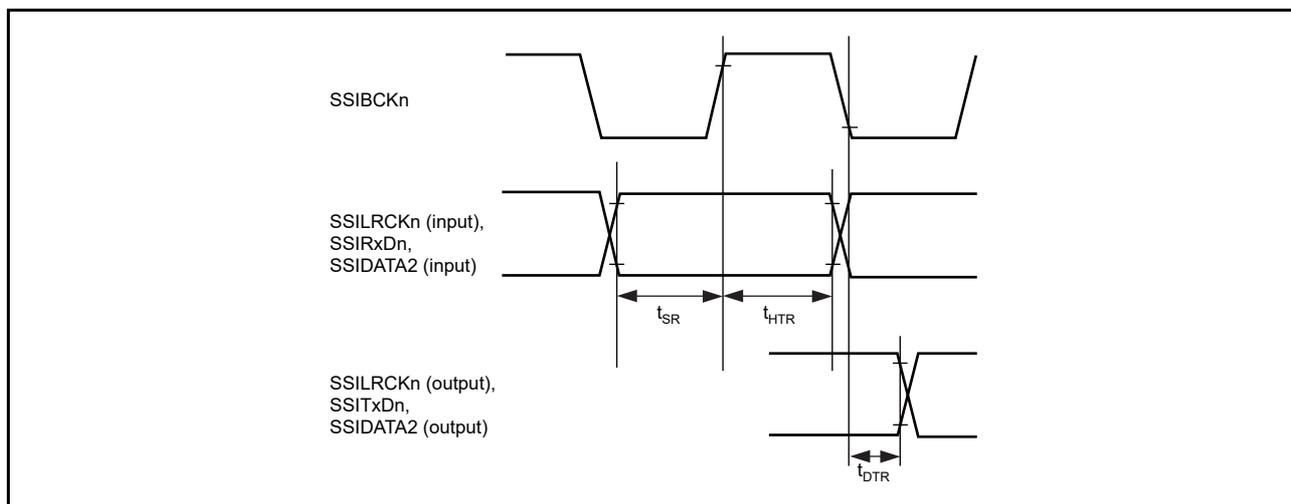


Figure 3.74 Transmission and Reception Timing (SSIBCK Falling Output)

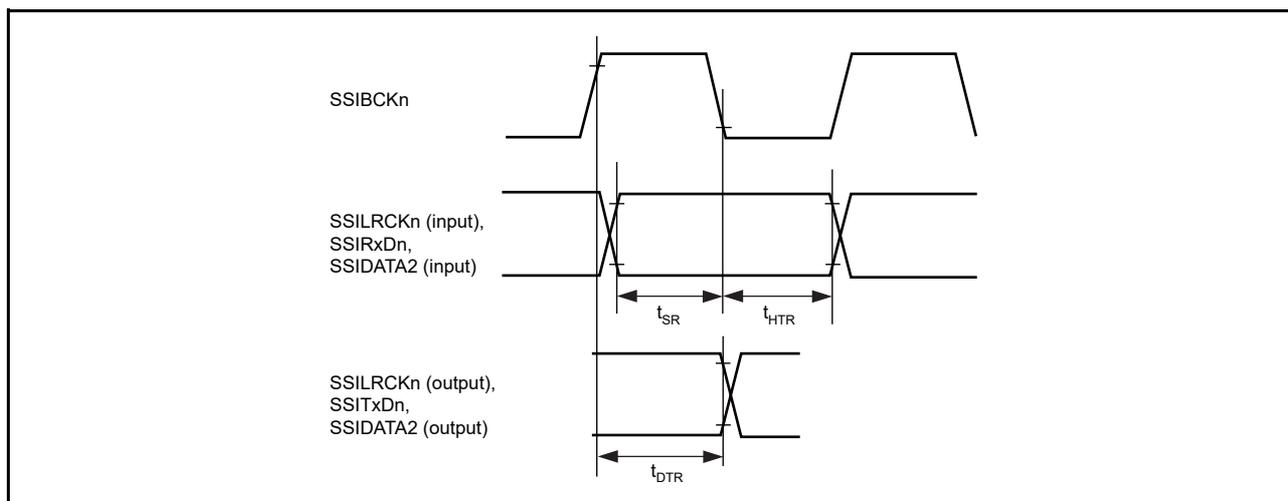


Figure 3.75 Transmission and Reception Timing (SSIBCK Rising Output)

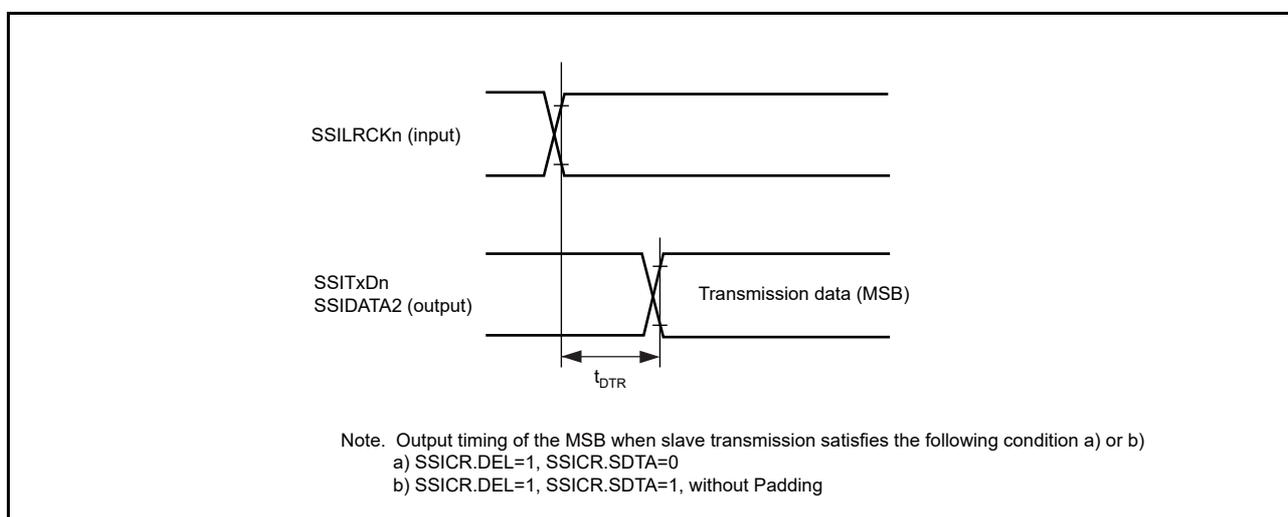


Figure 3.76 Transmission Timing (Slave, in Synchronization with SSILRCK)

3.4.19 CANFD Interface Timing

Table 3.23 CANFD Interface Timing

Item	Symbol	CAN		CANFD		Unit	Conditions
		Min.	Max.	Min.	Max.		
Internal delay time	t_{node}	—	100	—	75	ns	Figure 3.77
Transmission rate		—	1	—	4.125	Mbps	

Internal delay time (t_{node}) = Internal transfer delay time (t_{output}) + Internal receive delay time (t_{input})

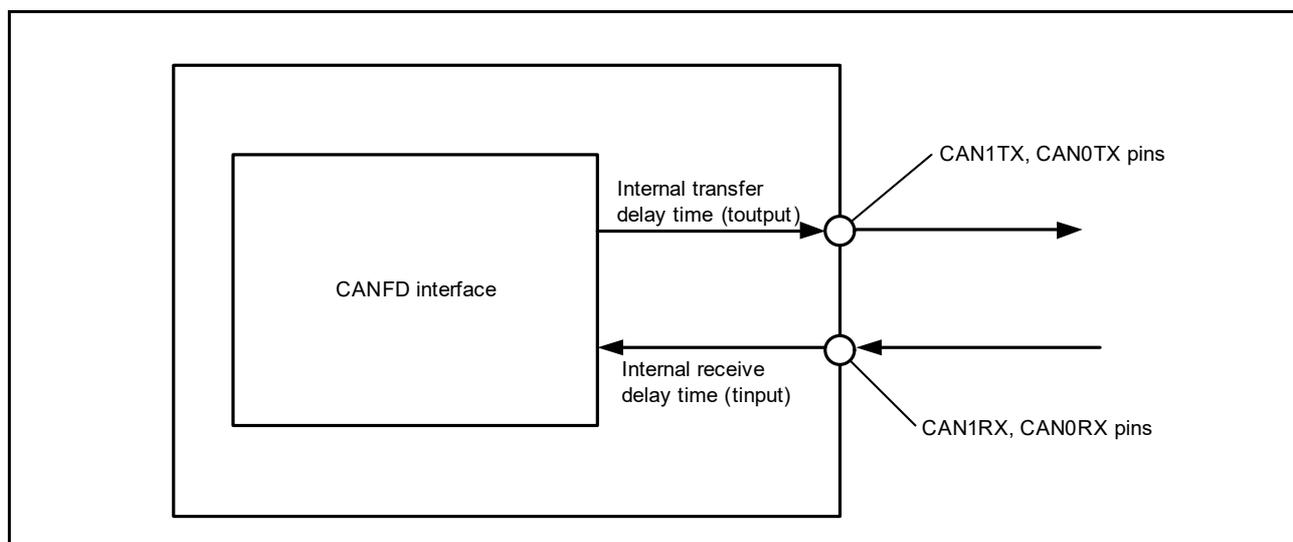


Figure 3.77 CANFD Interface Condition

3.4.20 Ethernet Controller (ETHERC) Timing

Table 3.24 ETHERC Timing

Item	Symbol	Min.	Max.	Unit	Test Conditions	
ETHERC (RMII)	REF50CK cycle time	T_{ck}	20	—	ns	Figure 3.78 to Figure 3.81
	REF50CK frequency Typ. 50 MHz	—	—	50 + 100ppm	MHz	
	REF50CK duty	—	35	65	%	
	REF50CK rise/fall time	$T_{ckr/ckf}$	0.5	3.5	ns	
	RMII_XXXX ^{*1} output delay time	T_{co}	2.5	15.0	ns	
	RMII_XXXX ^{*2} setup time	T_{su}	3	—	ns	
	RMII_XXXX ^{*2} hold time	T_{hd}	1	—	ns	
	RMII_XXXX ^{*1*2} rise/fall time	T_r/T_f	0.5	6	ns	
ETHERC (MII)	ET_TX_CLK cycle time	t_{Tcyc}	40	—	ns	—
	ET_TX_EN output delay time	t_{TENd}	1	20	ns	Figure 3.82
	ET_ETXD0 to ET_ETXD3 output delay time	t_{MTDd}	1	20	ns	
	ET_CRs setup time	t_{CRSs}	10	—	ns	
	ET_CRs hold time	t_{CRSh}	10	—	ns	
	ET_COL setup time	t_{COLs}	10	—	ns	Figure 3.83
	ET_COL hold time	t_{COLh}	10	—	ns	
	ET_RX_CLK cycle time	t_{TRcyc}	40	—	ns	—
	ET_RX_DV setup time	t_{RDVs}	10	—	ns	Figure 3.84
	ET_RX_DV hold time	t_{RDVh}	10	—	ns	
	ET_ERXD0 to ET_ERXD3 setup time	t_{MRDs}	10	—	ns	
	ET_ERXD0 to ET_ERXD3 hold time	t_{MRDh}	10	—	ns	
	ET_RX_ER setup time	t_{RErs}	10	—	ns	Figure 3.85
	ET_RX_ER hold time	t_{RErh}	10	—	ns	

Note 1. RMII_TXD_EN, RMII_TXD1, RMII_TXD0
 Note 2. RMII_CRs_DV, RMII_RXD1, RMII_RXD0, RMII_RX_ER

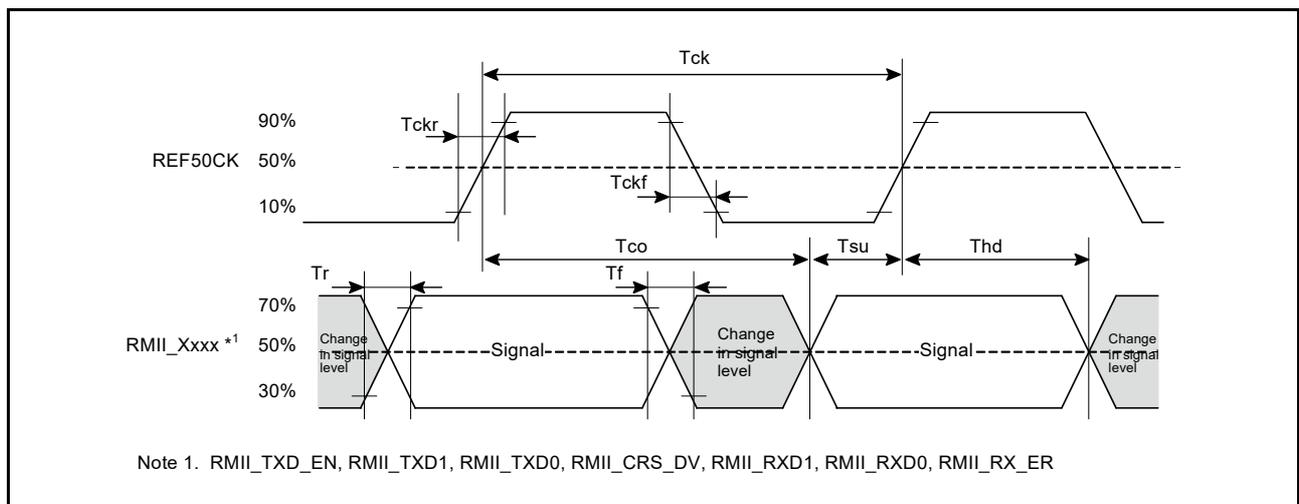


Figure 3.78 Timing with the REF50CK and RMII Signals

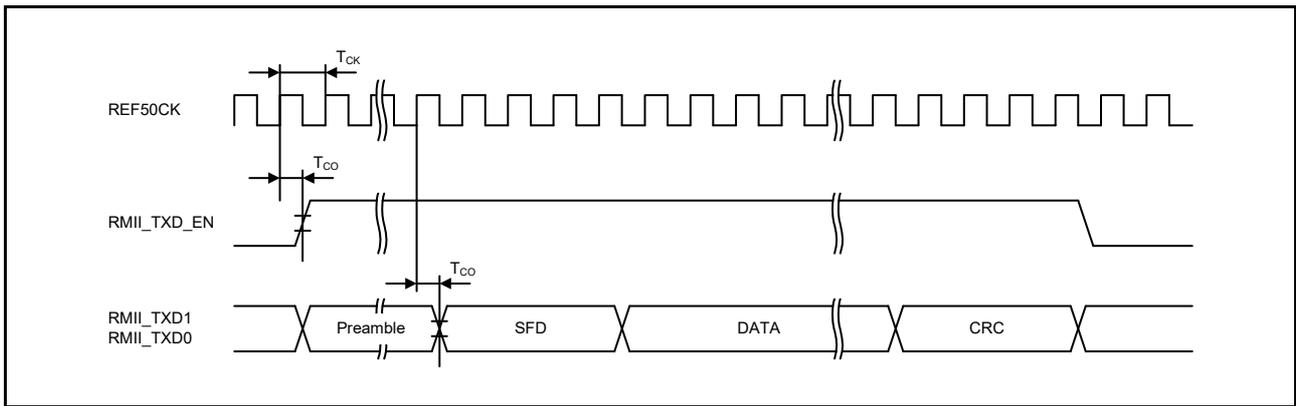


Figure 3.79 RMIITransmission Timing

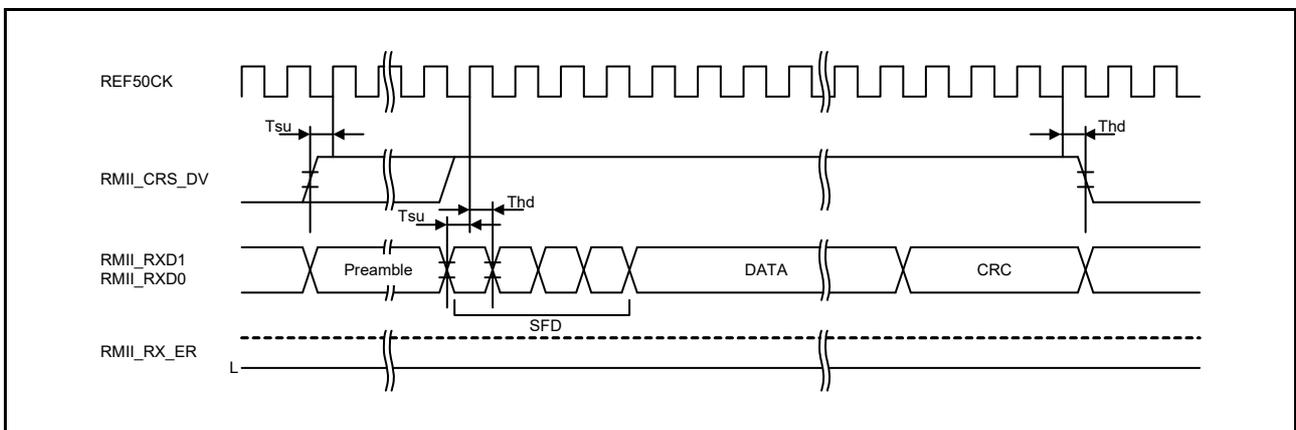


Figure 3.80 RMIIRecption Timing (Normal Operation)

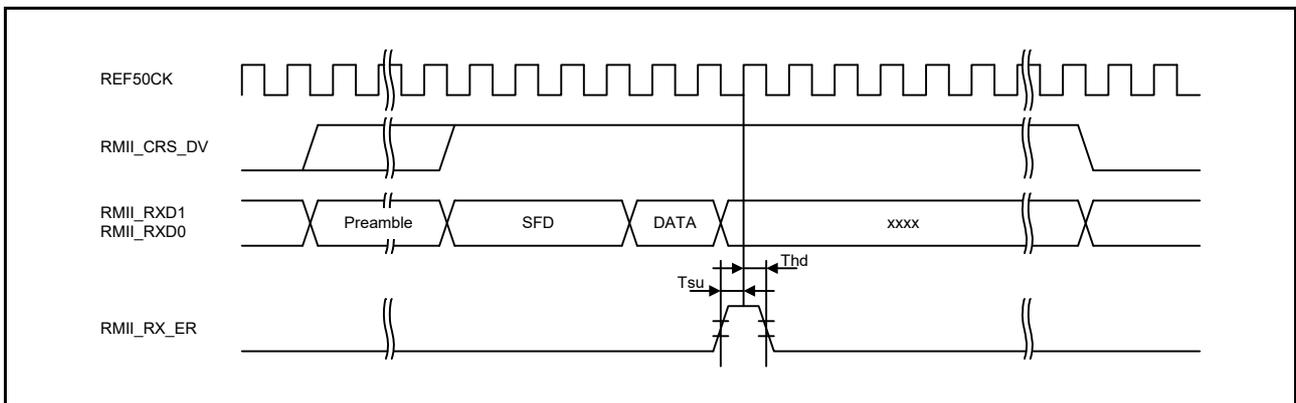


Figure 3.81 RMIIRecption Timing (Error Occurrence)

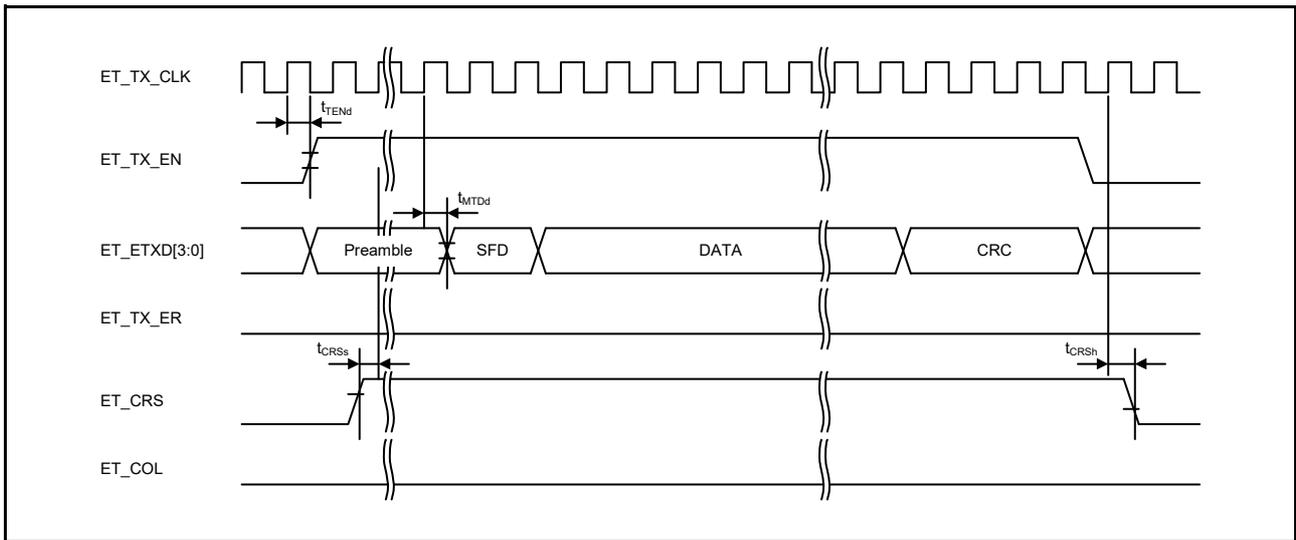


Figure 3.82 MII Transmission Timing (Normal Operation)

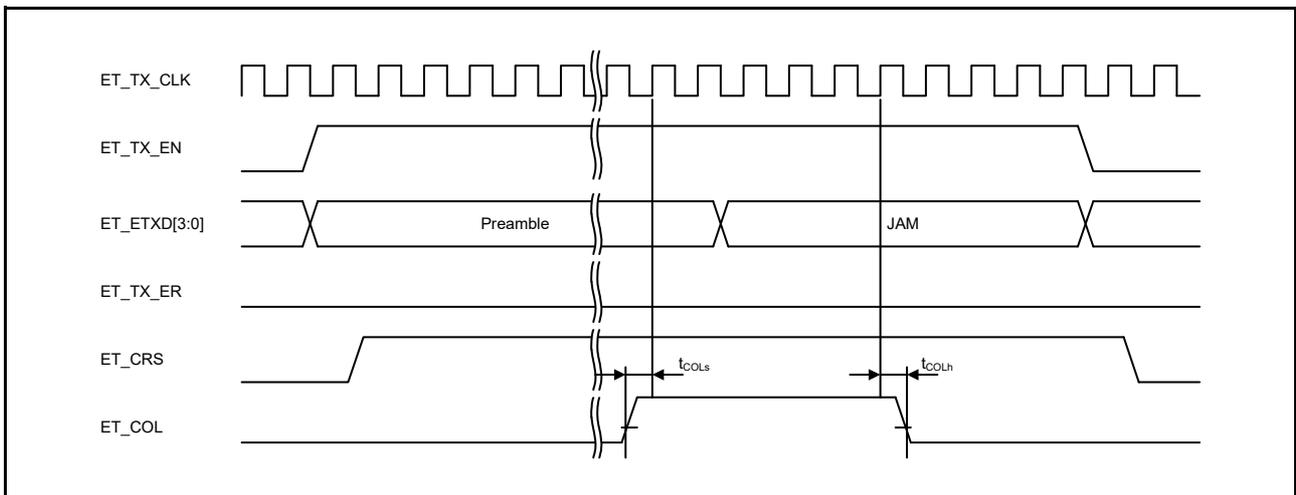


Figure 3.83 MII Transmission Timing (Conflict Occurrence)

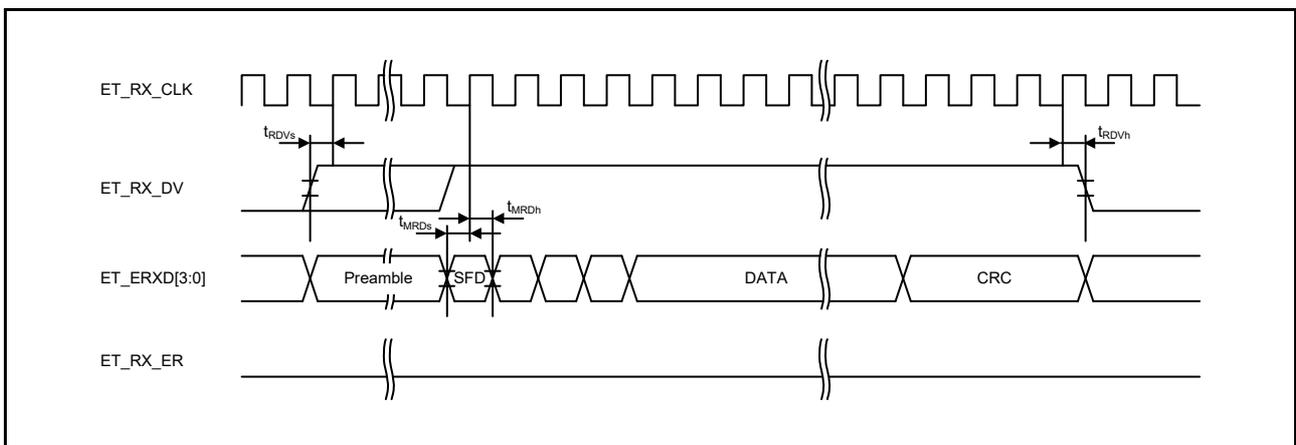


Figure 3.84 MII Reception Timing (Normal Operation)

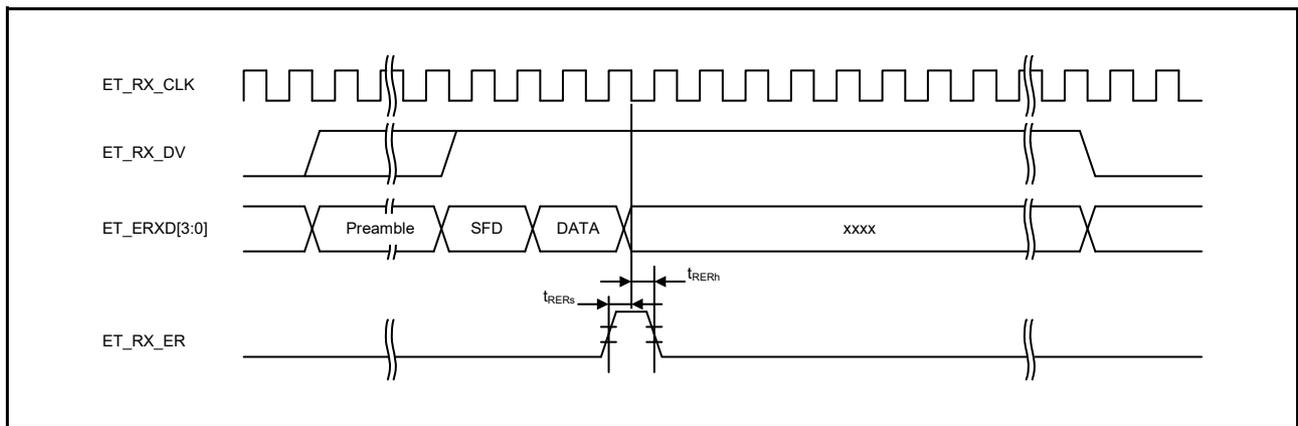


Figure 3.85 MII Reception Timing (Error Occurrence)

3.4.21 A/D Converter Timing

Table 3.25 A/D Converter Timing

Item		Symbol	Min.	Max.	Unit	Test Conditions
ADC12	ADC12 Trigger Input Pulse Width	t_{TRGW}	1.5	—	t_{Pcyc}	Figure 3.86

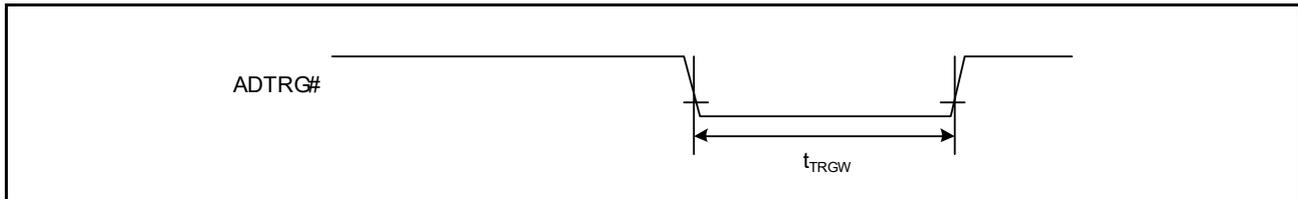


Figure 3.86 ADC12 Trigger Input Timing

3.4.22 NAND Flash Controller Timing

Table 3.26 NAND Flash Controller Timing

Item	Symbol	Min.	Max.	Unit	Test Conditions
Delay time between output signals (t_{OD} delay difference of each output signals)	t_{RFD}	—	5	ns	
Read data setup time (based on the rising edge of NFRE#)	t_{SD}	12	—	ns	Figure 3.87
Read data hold time (based on the rising edge of NFRE#)	t_{HD}	0	—	ns	
Time of NFWE# rising edge to NFRB# falling edge (NFRB# Capture start time)	t_{WB}	$N \times t_{p1cyc}^{*1*2}$	—	ns	
Time of Ready to NFRE# falling edge	t_{RR}	$M \times t_{p1cyc}^{*1*3}$	—	ns	

Note 1. t_{p1cyc} indicates the peripheral clock 1 (P1 ϕ) cycle.

Note 2. N is TWB bits value of the TIME_SEQ_1 register.

Note 3. M is TRR bits value of the TIME_SEQ_1 register.

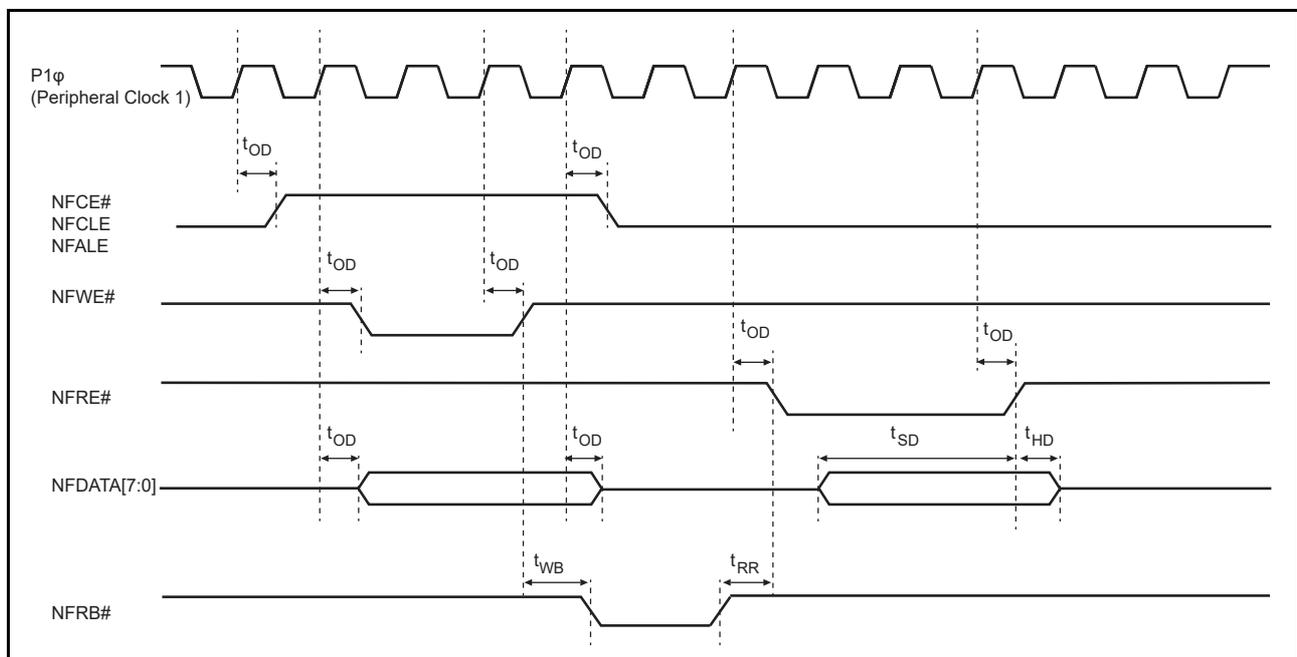


Figure 3.87 NAND Flash Controller Timing

3.4.23 USB 2.0 Host/Function Module Timing

Table 3.27 USB Transceiver Timing (Low-Speed)

Item	Symbol	Min.	Max.	Unit	Figure
Rise time	t_{LR}	75	300	ns	Figure 3.88
Fall time	t_{LF}	75	300	ns	
Rise/fall time lag	t_{LR}/t_{LF}	80	125	%	

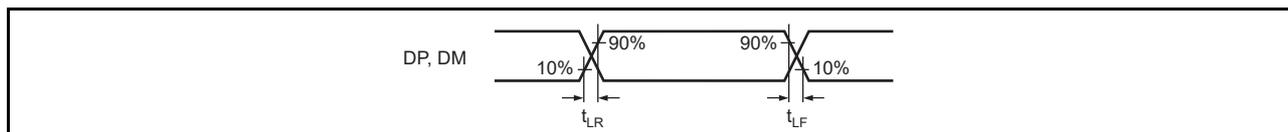


Figure 3.88 DP1, DP0, DM1, and DM0 Output Timing (Low-Speed)

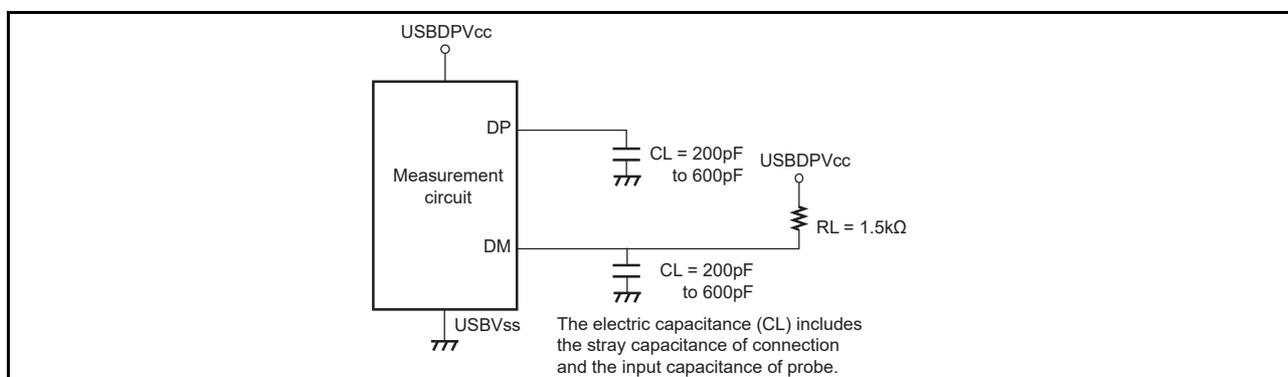


Figure 3.89 Measurement Circuit (Low-Speed)

Table 3.28 USB Transceiver Timing (Full-Speed)

Item	Symbol	Min.	Max.	Unit	Figure
Rise time	t_{FR}	4	20	ns	Figure 3.90
Fall time	t_{FF}	4	20	ns	
Rise/fall time lag	t_{FR}/t_{FF}	90	111.11	%	

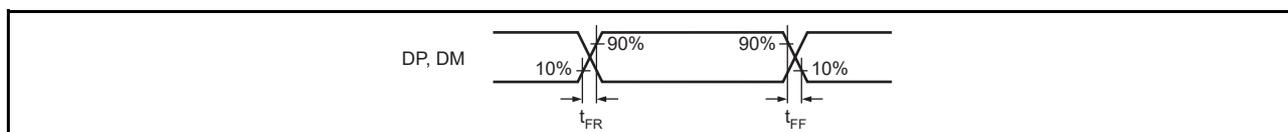


Figure 3.90 DP1, DP0, DM1, and DM0 Output Timing (Full-Speed)

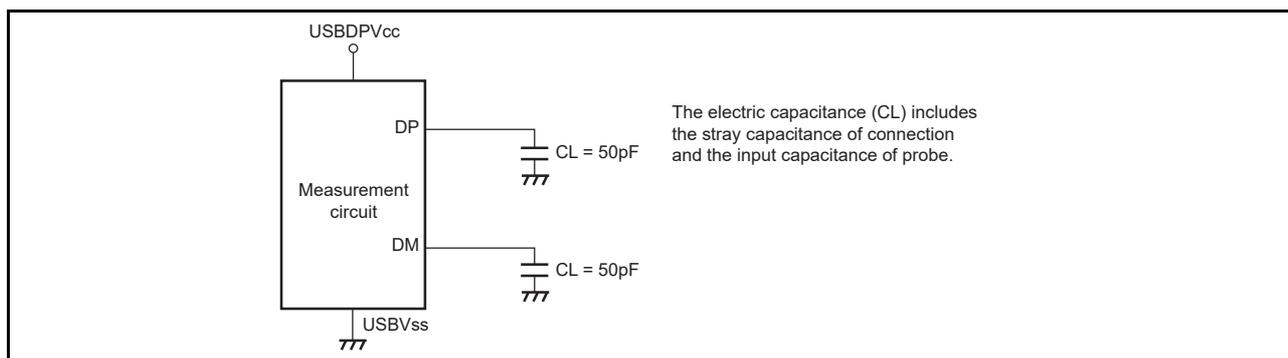


Figure 3.91 Measurement Circuit (Full-Speed)

Table 3.29 USB Transceiver Timing (Hi-Speed)

Item	Symbol	Min.	Max.	Unit	Figure
Rise time	t_{HSR}	500	—	ps	Figure 3.92
Fall time	t_{HSF}	500	—	ps	
Output driver resistance	Z_{HSDRV}	40.5	49.5	Ω	

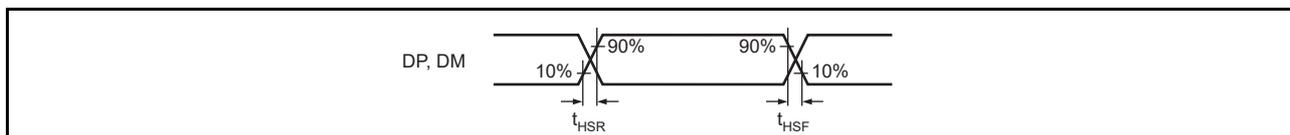


Figure 3.92 DP1, DP0, DM1, and DM0 Output Timing (Hi-Speed)

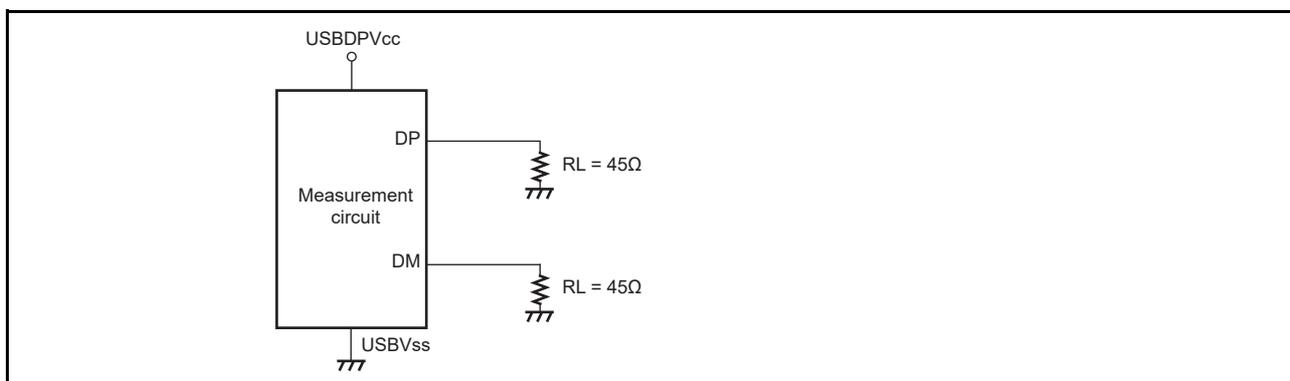


Figure 3.93 Measurement Circuit (Hi-Speed)

3.4.24 Video Display Controller 6 Timing

Table 3.30 Video Display Controller 6 Timing

Item	Symbol	Min.	Max.	Unit	Figure
DV0_CLK input clock cycle	t_{Dcyc}	11.50	—	ns	Figure 3.94
DV0_CLK input clock low pulse width	t_{WIL}	0.4	—	t_{Dcyc}	
DV0_CLK input clock high pulse width	t_{WH}	0.4	—		
LCD0_EXTCLK input clock cycle	t_{Ecyc}	11.50	—	ns	
LCD0_EXTCLK input clock low pulse width	t_{WIL}	0.4	—	t_{Ecyc}	
LCD0_EXTCLK input clock high pulse width	t_{WH}	0.4	—		
LCD0_CLK output clock cycle	t_{Lcyc}	11.50	—	ns	Figure 3.95
LCD0_CLK clock output low pulse width ^{*1}	t_{LOL}	$t_{WIL} - 0.95$	$t_{WIL} + 0.95$	ns	
LCD0_CLK clock output high pulse width ^{*1}	t_{LOH}	$t_{WH} - 0.95$	$t_{WH} + 0.95$	ns	
LCD0_CLK clock output low pulse width ^{*2}	t_{LOL}	$t_{Lcyc} / 2 - 1.06$	$t_{Lcyc} / 2 + 1.06$	ns	
LCD0_CLK clock output high pulse width ^{*2}	t_{LOH}	$t_{Lcyc} / 2 - 1.06$	$t_{Lcyc} / 2 + 1.06$	ns	
LCD0_CLK clock output rise time	t_{LOR}	—	3	ns	
LCD0_CLK clock output fall time	t_{LOF}	—	3	ns	
Input data setup time	t_{VS}	2	—	ns	Figure 3.96
Input data hold time	t_{VH}	4	—	ns	
Output data delay time	t_{DD}	-3	$\frac{3^*3}{4^*4}$	ns	Figure 3.97

- Note 1. This is the case when the video image clock or an external clock is selected as the clock for frequency division and the division ratio is set to 1/1.
- Note 2. This is for cases other than when the video image clock or an external clock is selected as the clock for frequency division and the division ratio is set to 1/1.
- Note 3. This is the case when normal driving ability is set with LCD0_CLK pin.
- Note 4. This is the case when high driving ability is set with LCD0_CLK pin.

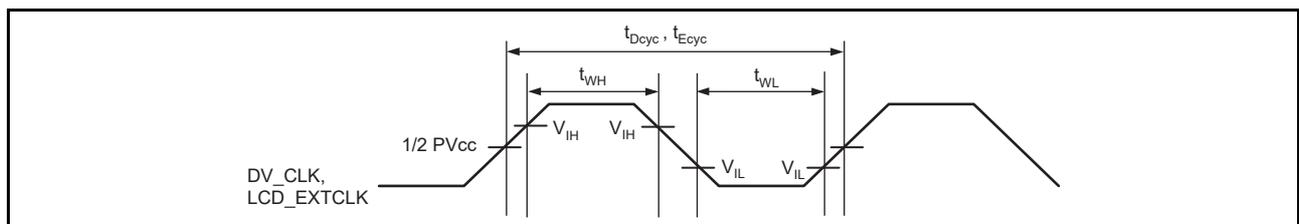


Figure 3.94 DV0_CLK and LCD0_EXTCLK Clock Input Timing

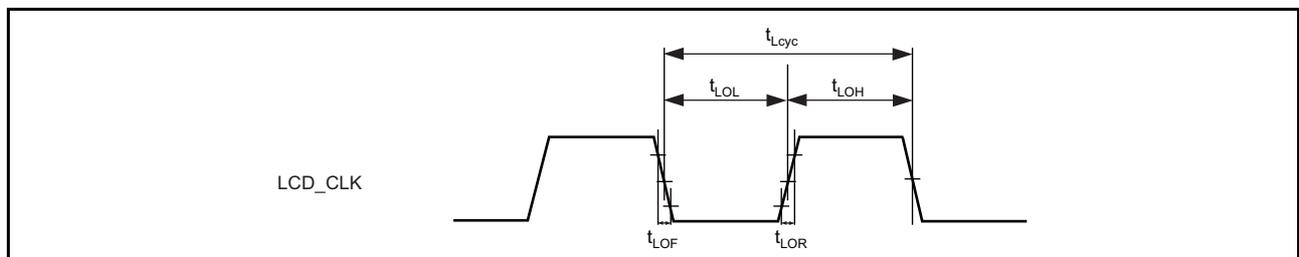


Figure 3.95 LCD0_CLK Clock Output Timing

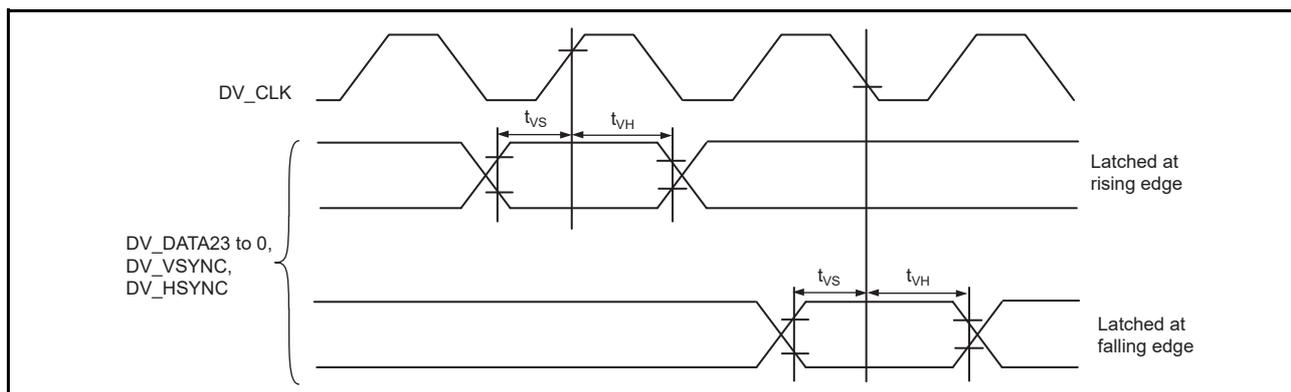


Figure 3.96 Video Input Timing

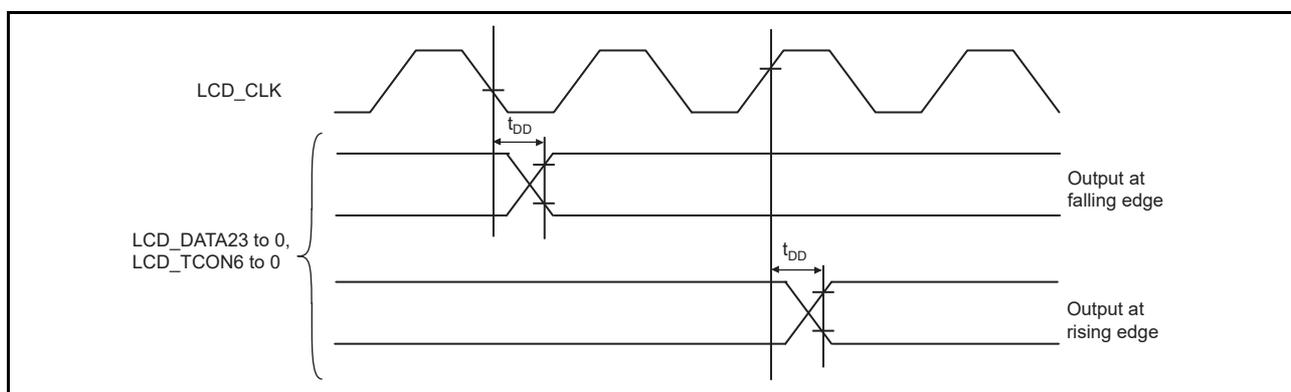


Figure 3.97 Display Output Timing

3.4.25 LVDS Output Interface Timing

Table 3.31 LVDS Timing

Item	Symbol	Min.	Typ.	Max.	Unit	Figure
Panel clock for LVDS output (LSI internal signal)	T	11.49 (87 MHz)	—	24.1 (41.43 MHz)	ns	Figure 3.98
Transmitter Output Pulse Position for Bit1	TPPos1	-0.20	0	0.20	ns	
Transmitter Output Pulse Position for Bit0	TPPos0	$T / 7 - 0.20$	$T / 7$	$T / 7 + 0.20$	ns	
Transmitter Output Pulse Position for Bit6	TPPos6	$T \times 2 / 7 - 0.20$	$T \times 2 / 7$	$T \times 2 / 7 + 0.20$	ns	
Transmitter Output Pulse Position for Bit5	TPPos5	$T \times 3 / 7 - 0.20$	$T \times 3 / 7$	$T \times 3 / 7 + 0.20$	ns	
Transmitter Output Pulse Position for Bit4	TPPos4	$T \times 4 / 7 - 0.20$	$T \times 4 / 7$	$T \times 4 / 7 + 0.20$	ns	
Transmitter Output Pulse Position for Bit3	TPPos3	$T \times 5 / 7 - 0.20$	$T \times 5 / 7$	$T \times 5 / 7 + 0.20$	ns	
Transmitter Output Pulse Position for Bit2	TPPos2	$T \times 6 / 7 - 0.20$	$T \times 6 / 7$	$T \times 6 / 7 + 0.20$	ns	

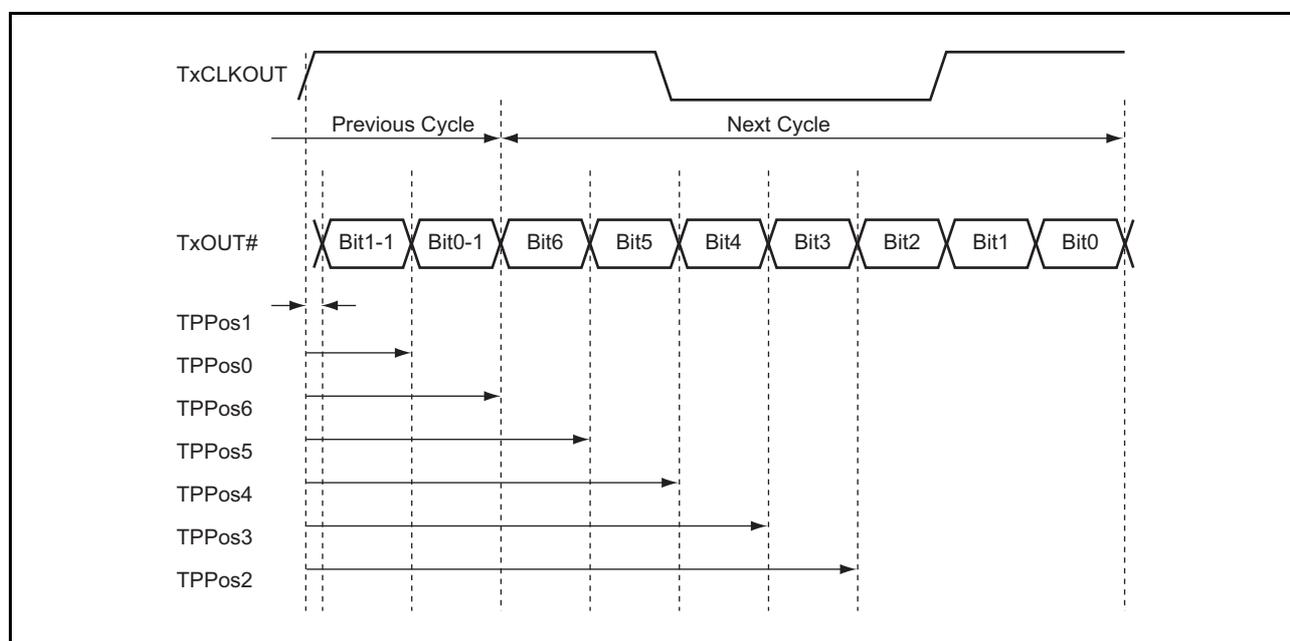


Figure 3.98 Transmitter LVDS Output Pulse Position Measurement

3.4.26 Capture Engine Unit Timing

Table 3.32 Capture Engine Unit Signal Timing

Item	Symbol	Min.	Max.	Unit	Figure
Vertical sync (VIO_VD) setup time (Camera clock rising)	t_{VDS}	2	—	ns	Figure 3.99 (1) , Figure 3.99 (2)
Vertical sync (VIO_VD) setup time (Camera clock falling)	t_{VDS}	2.5	—	ns	
Vertical sync (VIO_VD) hold time	t_{VDH}	3.5	—	ns	
Horizontal sync (VIO_HD) setup time (Camera clock rising)	t_{VHDS}	2	—	ns	
Horizontal sync (VIO_HD) setup time (Camera clock falling)	t_{VHDS}	2.5	—	ns	
Horizontal sync (VIO_HD) hold time	t_{VHDH}	3.5	—	ns	
Capture image data (VIO_D) setup time (Camera clock rising)	t_{VDTS}	2	—	ns	
Capture image data (VIO_D) setup time (Camera clock falling)	t_{VDTS}	2.5	—	ns	
Capture image data (VIO_D) hold time	t_{VDTH}	3.5	—	ns	
Camera clock cycle	t_{VCYC}	11.50	—	ns	
Camera clock high level width	t_{VHW}	$0.4 \times t_{VCYC}$	—	ns	
Camera clock low level width	t_{VLW}	$0.4 \times t_{VCYC}$	—	ns	
Field identification signal (VIO_FLD) setup time (Camera clock rising)	t_{VFDS}	2	—	ns	
Field identification signal (VIO_FLD) setup time (Camera clock falling)	t_{VFDS}	2.5	—	ns	
Field identification signal (VIO_FLD) hold time	t_{VFDH}	3.5	—	ns	

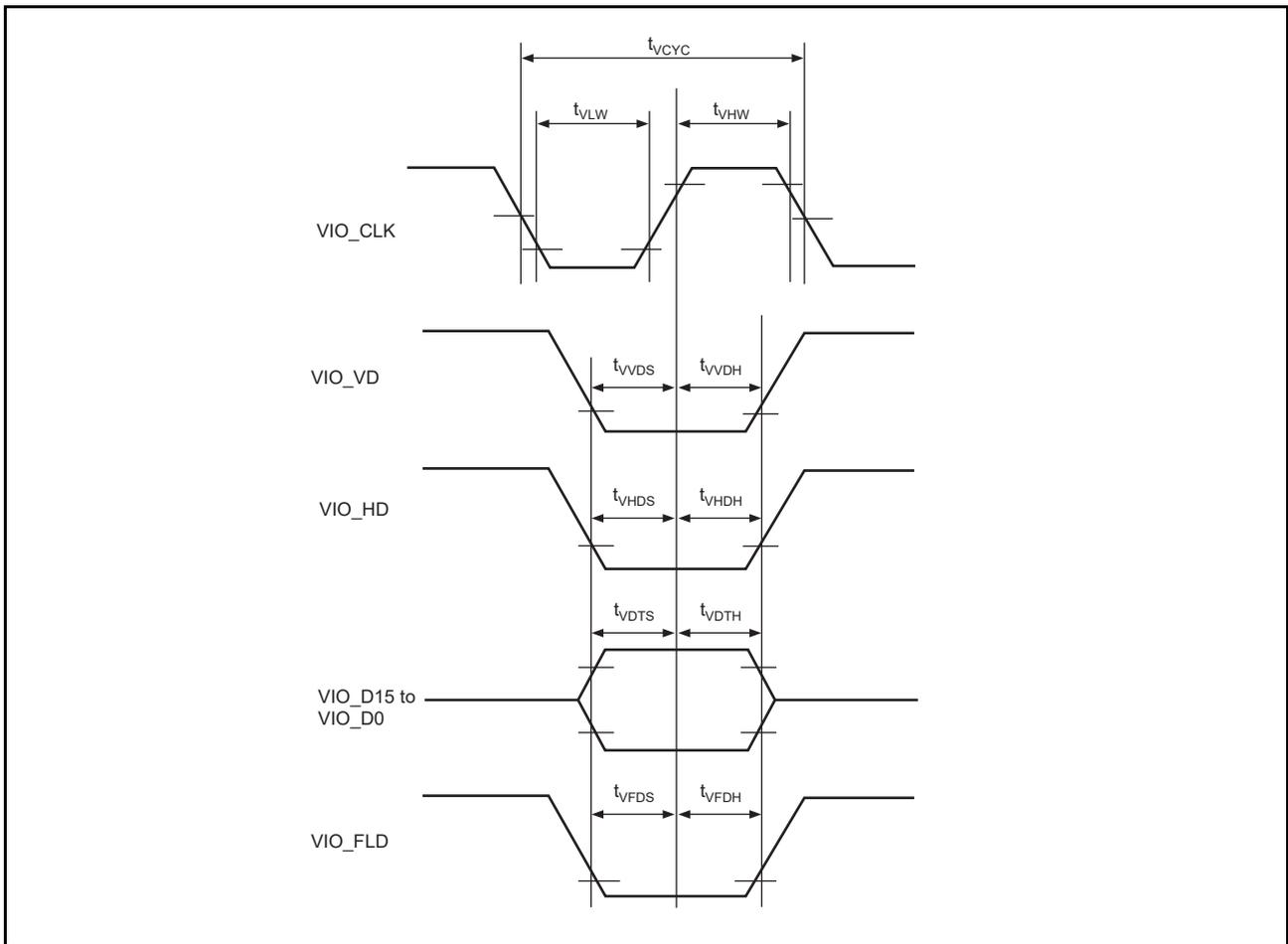


Figure 3.99 (1) Capture Engine Unit Module Signal Timing of data capturing on the rising edge of VIO_CLK

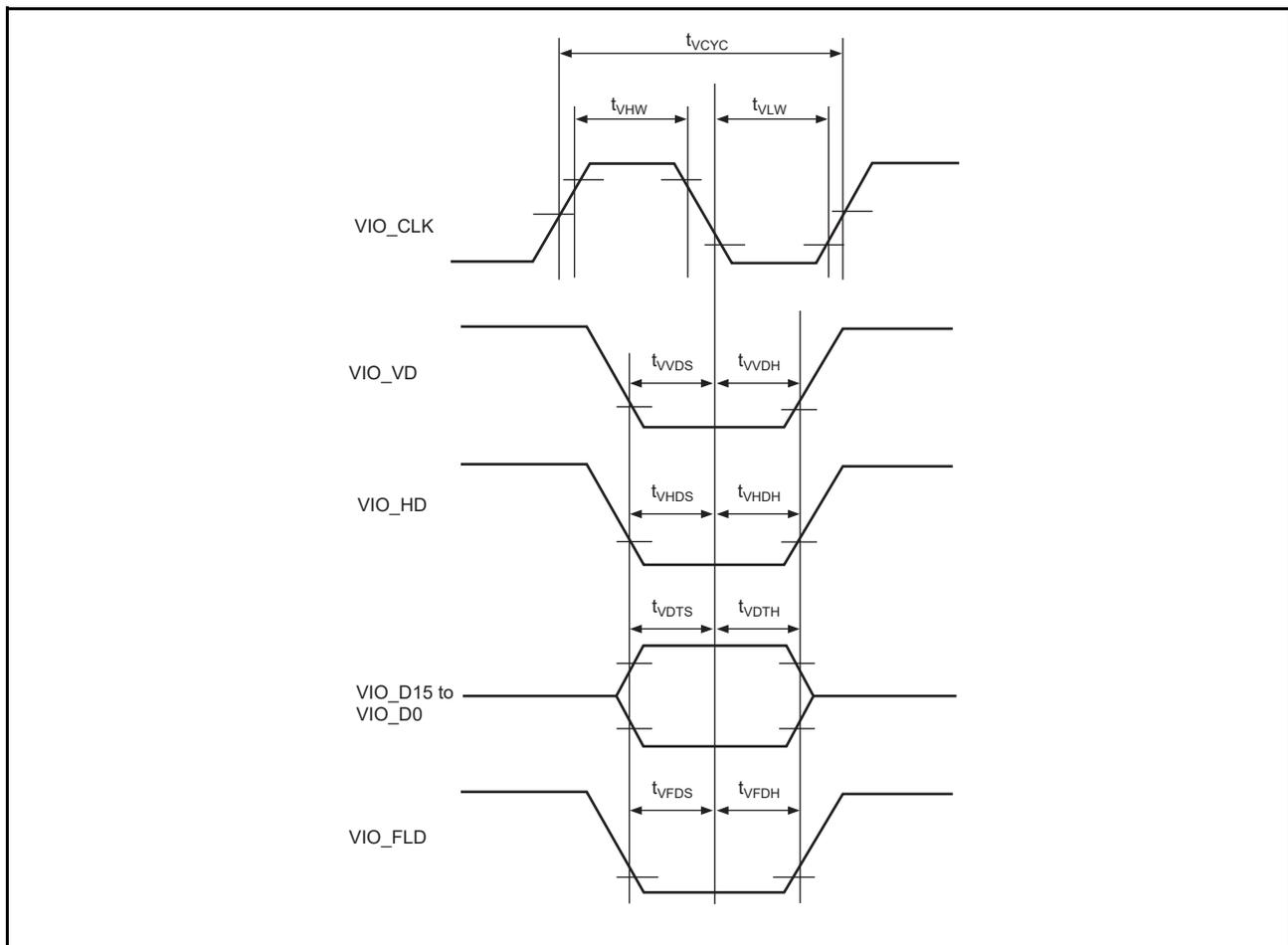


Figure 3.99 (2) Capture Engine Unit Module Signal Timing of data capturing on the falling edge of VIO_CLK

3.4.27 MIPI CSI-2 Interface Timing

Table 3.33 MIPI CSI-2 Interface Timing

Item	Symbol	Min.	Max.	Unit	Remarks	Figure
UI instantaneous	UI_{INST}	1	12.5	ns		Figure 3.100
Common-mode interference beyond 450 MHz	$\Delta V_{CMRX(HF)}$	—	100	mV	HS Receiver	
Common-mode interference 50MHz – 450MHz	$\Delta V_{CMRX(LF)}$	-50	50	mV	HS Receiver	
Setup time	T_{CDS}	0.15	—	UI	HS Receiver	Figure 3.100
Hold time	T_{CDH}	0.15	—	UI	HS Receiver	Figure 3.100

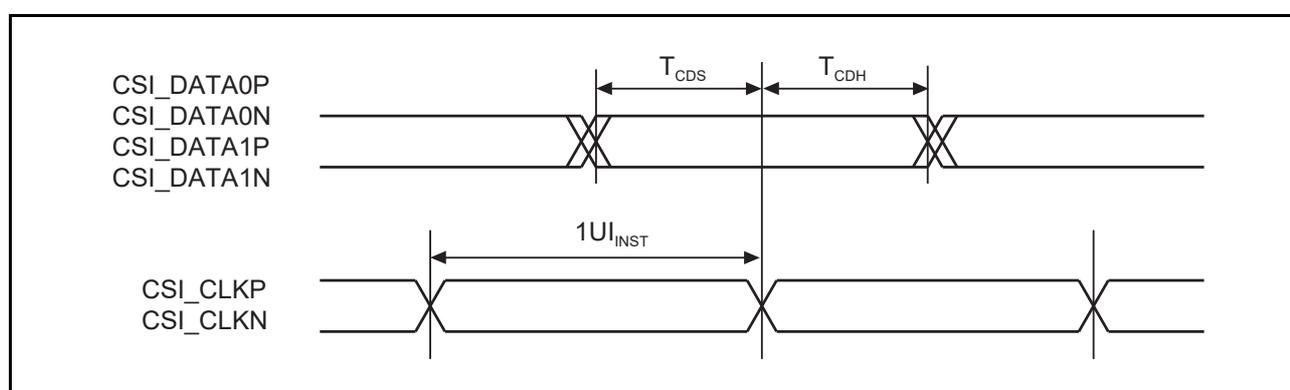


Figure 3.100 MIPI CSI-2 Interface Timing

3.4.28 SD/MMC Host Interface Timing

3.4.28.1 SD Interface

Table 3.34 SD/MMC Host Interface Timing (SD Default/High Speed mode 3.3-V power supply selection)

Item	Symbol	Min.	Max.	Unit	Figure
SD_CLK clock cycle	t_{SDPP}	$4 \times t_{bcyc}$	—	ns	Figure 3.101
SD_CLK clock high level width	t_{SDWH}	$0.4 \times t_{SDPP}$	—	ns	
SD_CLK clock low level width	t_{SDWL}	$0.4 \times t_{SDPP}$	—	ns	
SD_CLK clock rise time	t_{SDLH}	—	3	ns	
SD_CLK clock fall time	t_{SDHL}	—	3	ns	
SD_CMD, SD_D7 to SD_D0 output data delay time	t_{SDODLY}	-8	4	ns	
SD_CMD, SD_D7 to SD_D0 input data setup time	t_{SDISU}	4.5	—	ns	
SD_CMD, SD_D7 to SD_D0 input data hold time	t_{SDIH}	2	—	ns	

Note: t_{bcyc} indicates internal bus clock (B ϕ) cycle.

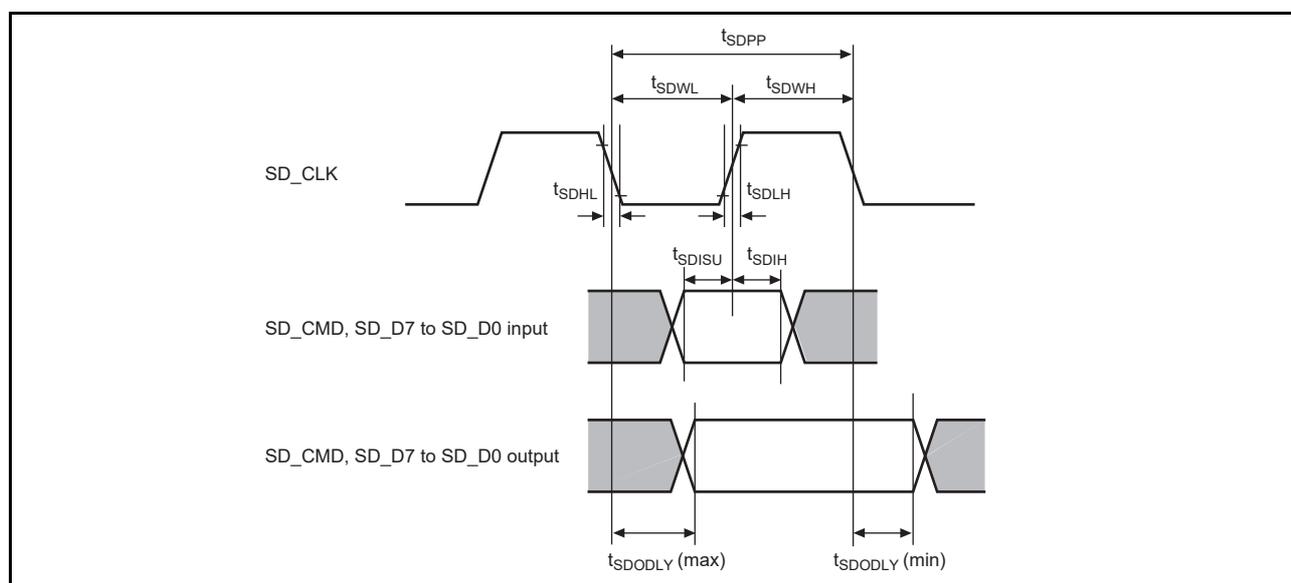


Figure 3.101 SD/MMC Host Interface (SD Interface)

Other characteristics of the SD interface are available upon non-disclosure agreement.

For details, contact your local sales representatives.

3.4.28.2 MMC Interface Timing

Table 3.35 SD/MMC Host Interface Timing (MMC Default/High Speed mode 3.3-V power supply selection)

Item	Symbol	Min.	Max.	Unit	Figure
SD_CLK clock cycle	t_{MMCPP}	$4 \times t_{bcyc}$	—	ns	Figure 3.102
SD_CLK clock high level width	t_{MMCWH}	$0.4 \times t_{MMCPP}$	—	ns	
SD_CLK clock low level width	t_{MMCWL}	$0.4 \times t_{MMCPP}$	—	ns	
SD_CLK clock rise time	t_{MMCLH}	—	3	ns	
SD_CLK clock fall time	t_{MMCHL}	—	3	ns	
SD_CMD, SD_D7 to SD_D0 output data delay time	$t_{MMCODLY}$	-7	4	ns	
SD_CMD, SD_D7 to SD_D0 input data setup time	t_{MMCISU}	4.5	—	ns	
SD_CMD, SD_D7 to SD_D0 input data hold time	t_{MMCIH}	2	—	ns	

Note: t_{bcyc} indicates internal bus clock (B ϕ) cycle.

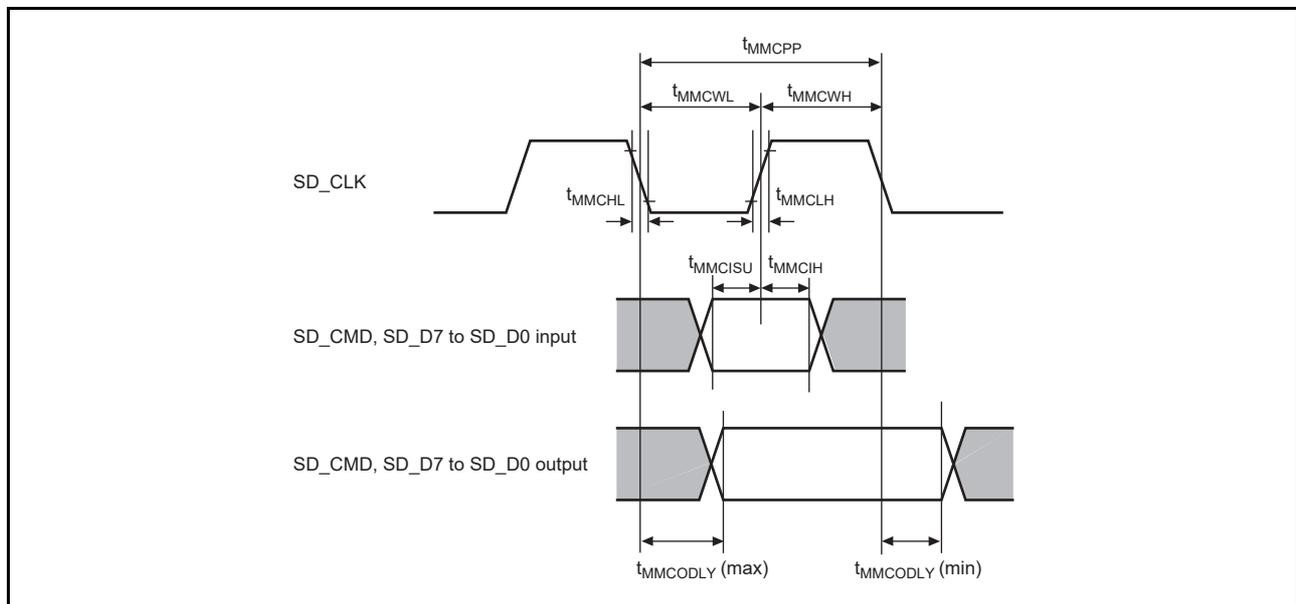


Figure 3.102 SD/MMC Host Interface (MMC Interface Default/High Speed mode 3.3-V power supply selection)

Table 3.36 SD/MMC Host Interface Timing (MMC HS-DDR mode 3.3-/1.8-V power supply selection)

Item	Symbol	Min.	Max.	Unit	Figure
SD_CLK clock cycle	t_{MMCPP}	$4 \times t_{bcyc}$	—	ns	Figure 3.103, Figure 3.104
SD_CLK clock high level width	t_{MMCWH}	$0.45 \times t_{MMCPP}$	—	ns	
SD_CLK clock low level width	t_{MMCWL}	$0.45 \times t_{MMCPP}$	—	ns	
SD_CLK clock rise time	t_{MMCLH}	—	3	ns	
SD_CLK clock fall time	t_{MMCHL}	—	3	ns	
SD_CMD output data delay time	t_{MMCODY}	-6.6	6.6	ns	Figure 3.103
SD_CMD input data setup time	t_{MMCISU}	5.5	—	ns	
SD_CMD input data hold time	t_{MMCIH}	2.5	—	ns	
SD_D7 to SD_D0 output data delay time	$t_{MMCODYddr}$	2.5	$0.5 \times t_{bcyc} + 3$	ns	Figure 3.104
SD_D7 to SD_D0 input data setup time	$t_{MMCISUddr}$	2.6	—	ns	
SD_D7 to SD_D0 input data hold time	$t_{MMCIHddr}$	1.5	—	ns	

Note: t_{bcyc} indicates internal bus clock (Bφ) cycle.

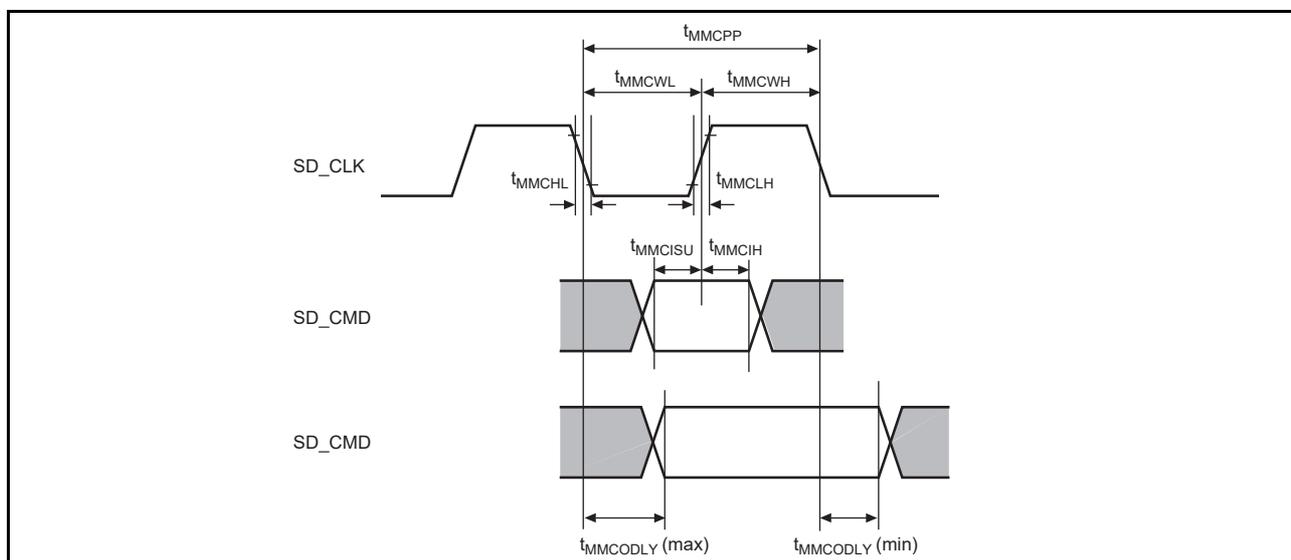


Figure 3.103 SD_CMD, SD/MMC Host Interface (MMC Interface HS-DDR mode 3.3-/1.8-V power supply selection)

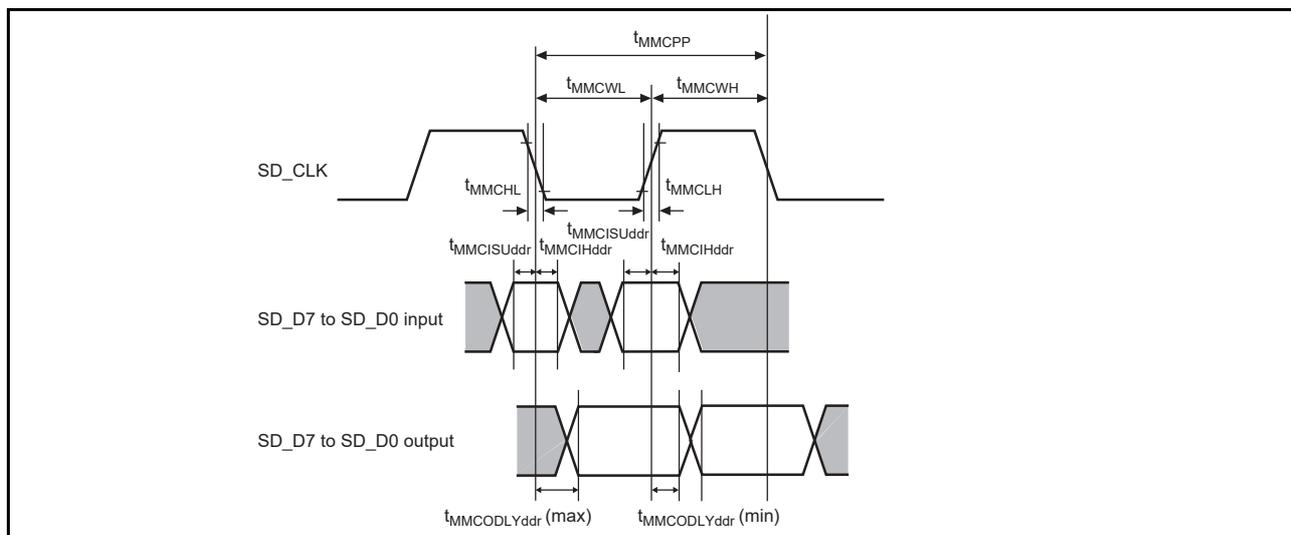


Figure 3.104 SD_D7 to SD_D0, SD/MMC Host Interface (MMC Interface HS-DDR mode 3.3-/1.8-V power supply selection)

Table 3.37 SD/MMC Host Interface Timing (MMC HS200 mode 1.8-V power supply selection, Output load: 15pF)

Item	Symbol	Min.	Max.	Unit	Figure
SD_CLK clock cycle	t_{MMCPP}	$1 \times t_{bcyc}^{*1}$	—	ns	Figure 3.105
SD_CLK clock high level width	t_{MMCWH}	$0.35 \times t_{MMCPP}$	—	ns	
SD_CLK clock low level width	t_{MMCWL}	$0.35 \times t_{MMCPP}$	—	ns	
SD_CLK clock rise time	t_{MMCLH}	—	1.5	ns	
SD_CLK clock fall time	t_{MMCHL}	—	1.5	ns	
SD_CMD, SD_D7 to SD_D0 output data delay time	$t_{MMCODLY}$	-1.7	1.1	ns	
SD_CMD, SD_D7 to SD_D0 input data setup time*2	t_{MMCISU}	—	—	ns	
SD_CMD, SD_D7 to SD_D0 input data hold time*2	t_{MMCIH}	—	—	ns	
SD_CMD, SD_D7 to SD_D0 input data width*2	t_{MMCIDW}	3.6	—	ns	

Note 1. t_{bcyc} indicates internal bus (Bφ) cycle.

Note 2. In HS200 mode, tuning by SCC is required. For details, see section 49.6, Sampling Clock Controller (SCC), in the RZ/A2M Group User's Manual.

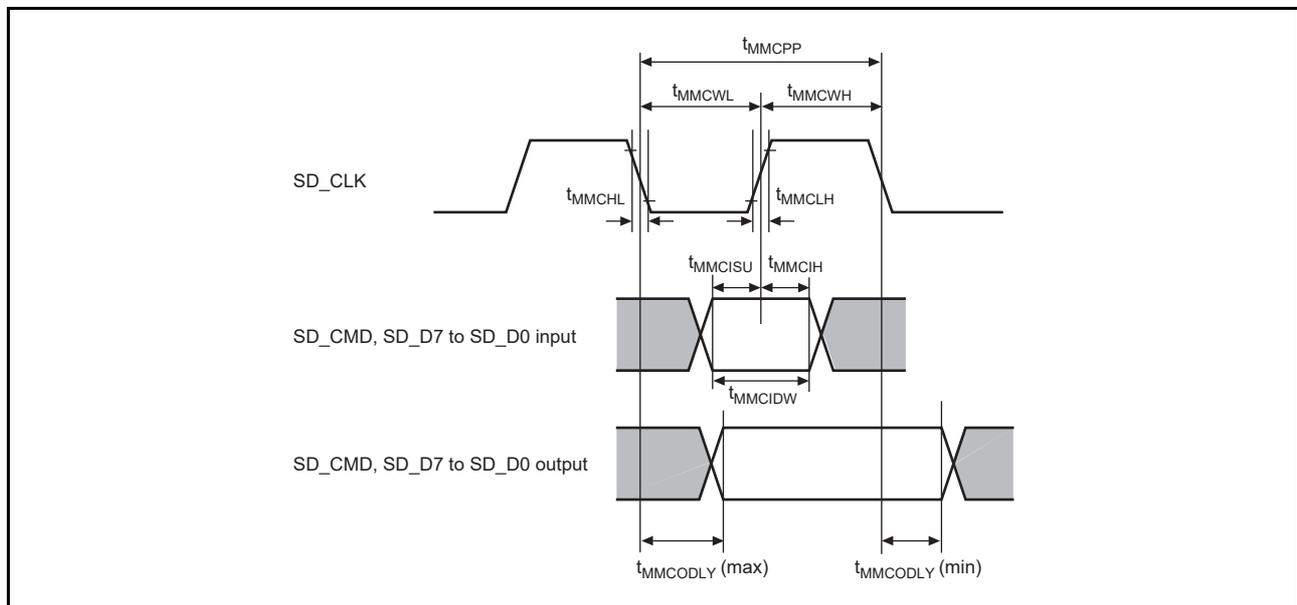


Figure 3.105 SD/MMC Host Interface (MMC Interface HS200 mode 1.8-V power supply selection)

3.4.29 General Purpose I/O Ports Timing

Table 3.38 General Purpose I/O Ports Timing

Item	Symbol	Min.	Max.	Unit	Figure
Output data delay time	t_{PORTD}	—	100	ns	Figure 3.106
Input data setup time	t_{PORTS}	100	—		
Input data hold time	t_{PORTH}	100	—		

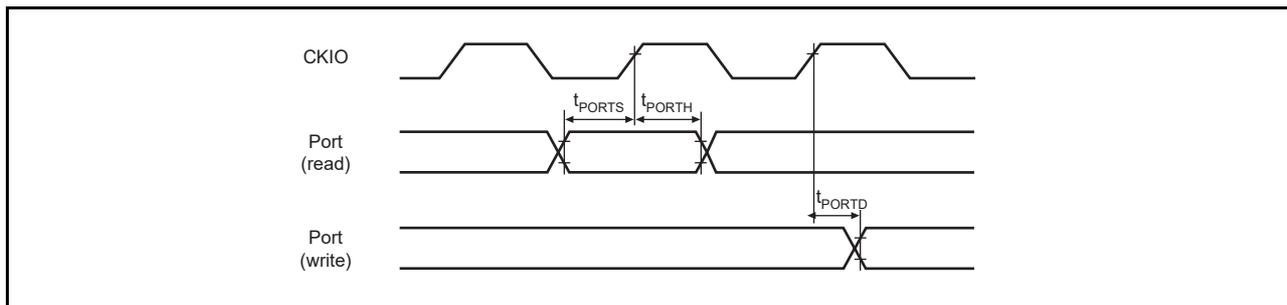


Figure 3.106 General I/O Ports Timing

3.4.30 Debugger Interface Timing

Table 3.39 Debugger Interface Timing

Item	Symbol	Min.	Max.	Unit	Figure
TCK cycle time	t_{TCKcyc}	50^{*1}	—	ns	Figure 3.107
TCK high pulse width	t_{TCKH}	0.4	0.6	t_{TCKcyc}	
TCK low pulse width	t_{TCKL}	0.4	0.6	t_{TCKcyc}	
TDI setup time	t_{TDIS}	10	—	ns	Figure 3.108
TDI hold time	t_{TDIH}	10	—	ns	
TMS/SWDIO setup time	t_{TMSS}	10	—	ns	
TMS/SWDIO hold time	t_{TMSH}	10	—	ns	
SWDIO delay time	t_{SWDO}	—	16	ns	
TDO delay time	t_{TDOD}	—	16	ns	
Capture register setup time	t_{CAPTS}	10	—	ns	Figure 3.109
Capture register hold time	t_{CAPTH}	10	—	ns	
Update register delay time	$t_{UPDATED}$	—	20	ns	
Trace clock cycle	t_{TCYC}	7.57	—	ns	Figure 3.110
Trace clock high level	t_{THC}	2.5	—	ns	Output load: 15 pF
Trace clock low level	t_{TLC}	2.5	—	ns	
Trace data delay time	t_{TDT}	$0.1 \times t_{TCYC} - 0.1$	$0.4 \times t_{TCYC} - 0.2$	ns	

Note 1. Should be greater than the peripheral clock 0 (P0φ) cycle time.

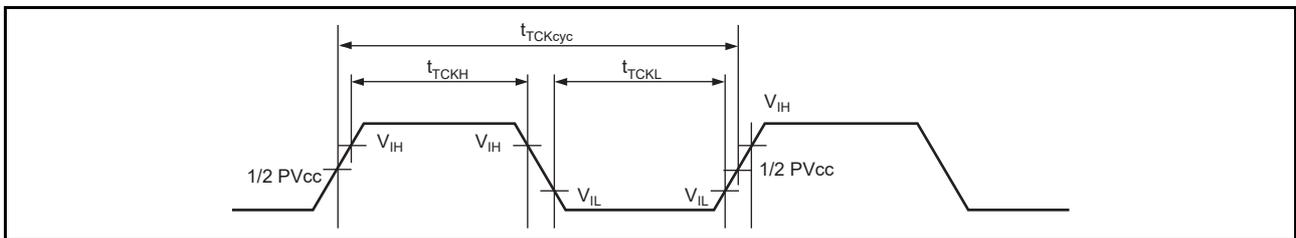


Figure 3.107 TCK Input Timing

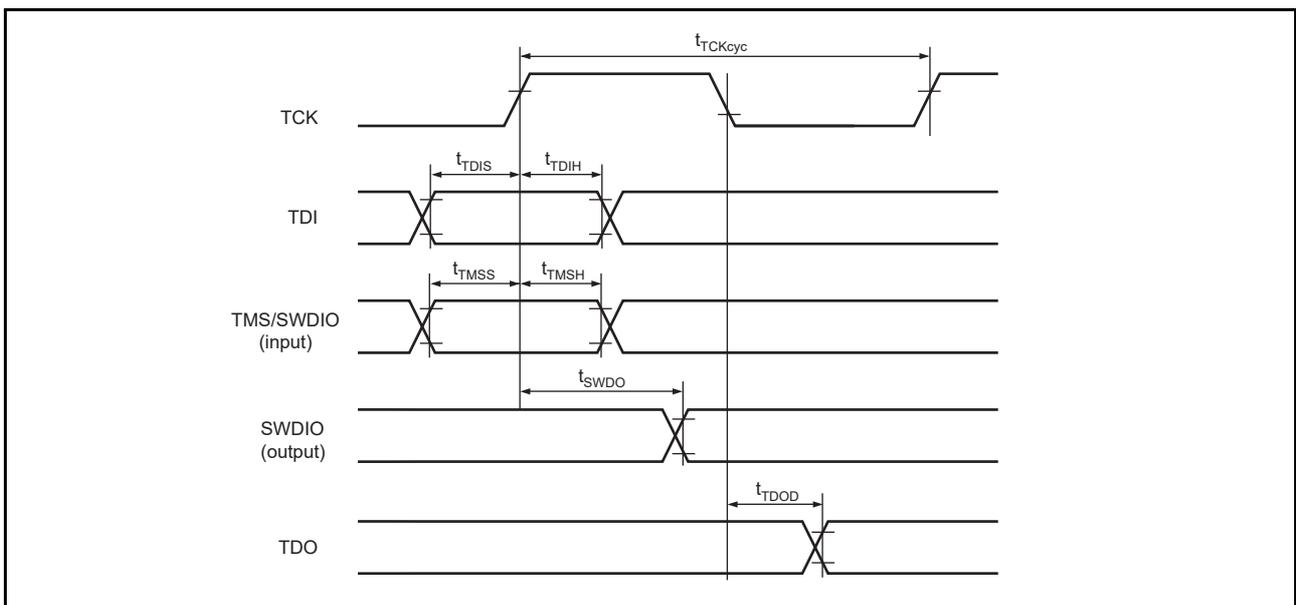


Figure 3.108 Data Transfer Timing

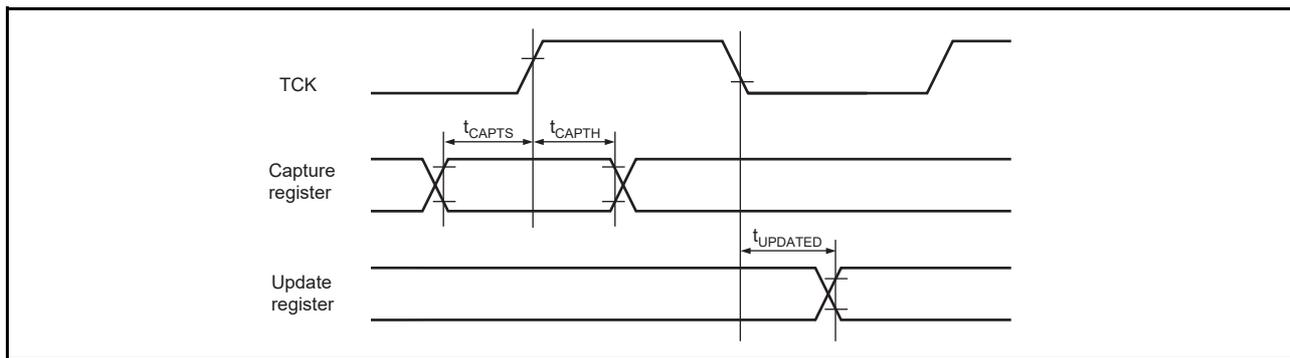


Figure 3.109 Boundary Scan Input/Output I/O Timing

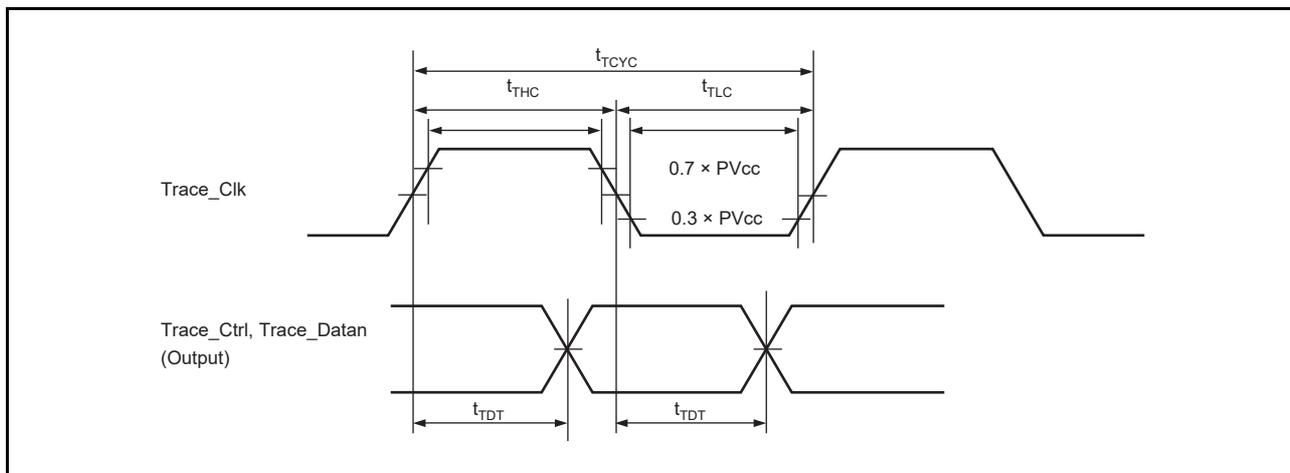


Figure 3.110 Trace Interface Timing

3.4.31 AC Characteristics Measurement Conditions

- I/O signal reference level: $PV_{cc}/2$, $PV_{cc_SPI}/2$, $PV_{cc_HO}/2$, $PV_{cc_SD0}/2$, $PV_{cc_SD1}/2$, the minimum values of V_{IH} , V_{T+} , and V_{OH} , and the maximum values of V_{IL} , V_{T-} , and V_{OL} (refer to the individual timing chart)
- Input pulse level: PV_{cc} , PV_{cc_SPI} , PV_{cc_HO} , PV_{cc_SD0} , and PV_{cc_SD1}
- Input rise and fall times: 1 ns

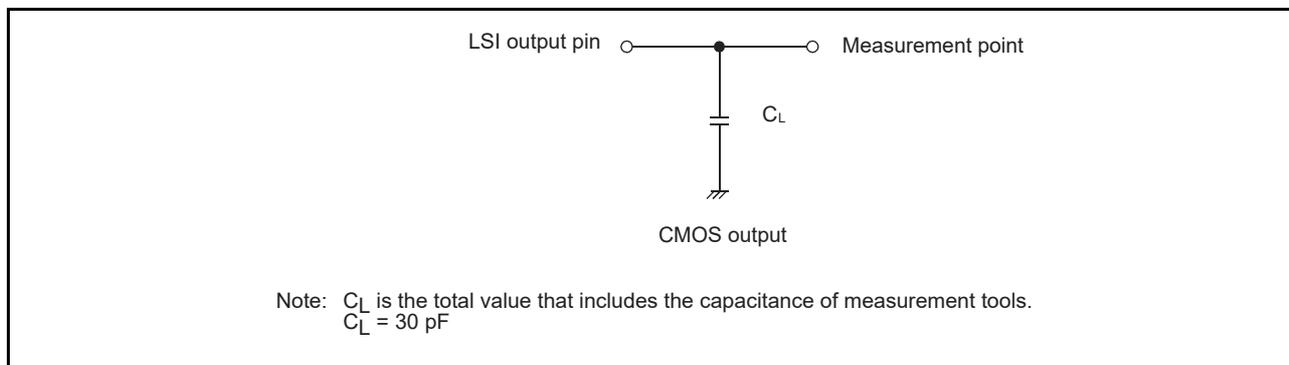


Figure 3.111 Output Load Circuit

3.5 A/D Converter Characteristics

Conditions: $V_{cc} = 1.14$ to 1.26 V, $PV_{cc} = USBDPV_{cc0} = USBDPV_{cc1} = AV_{cc} = 3.0$ to 3.6 V,
 $PV_{cc_SPI} = 3.0$ to 3.6 V/ 1.7 to 1.9 V, $PV_{cc_SD0} = 3.0$ to 3.6 V/ 1.7 to 1.9 V, $PV_{cc_SD1} = 3.0$ to 3.6 V/ 1.7 to
 1.9 V, $PLL_{V_{cc}} = 1.14$ to 1.26 V, $USBAPV_{cc0} = USBAPV_{cc1} = 3.0$ to 3.6 V, $LVDSAPV_{cc} = 3.0$ to 3.6 V,
 $LVDSPLL_{V_{cc}} = 1.14$ to 1.26 V, $PV_{cc_HO} = MIPIAV_{cc18} = 1.7$ to 1.9 V,
 $V_{ss} = AV_{ss} = USBV_{ss} = 0$ V
 $T_a = -40$ to $+85^{\circ}\text{C}$, $T_j = -40$ to $+125^{\circ}\text{C}$

Table 3.40 A/D Converter Characteristics

Item	Min.	Typ.	Max.	Unit	Test Conditions
Resolution	8	—	12	bits	
Analog input capacitance	—	—	30	pF	
Conversion time*1 (P1 ϕ = 66 MHz, P0 ϕ = 33 MHz)	1	—	—	us	Sampling in 20 states
Permissible signal-source impedance	—	—	1	k Ω	
DNL	—	—	± 3	LSB	
INL	—	—	± 4	LSB	
Offset error	—	—	± 5.5	LSB	
Full-scale error	—	—	± 5.5	LSB	
Absolute accuracy	—	—	± 7	LSB	

Note: The above specification values apply when there is no access to the external bus during A/D conversion. If access proceeds during A/D conversion, values may not fall within the above ranges.

Note 1. The conversion time includes the sampling time and the comparison time ($t_{SPL} + t_{SAM}$).

4. Package Dimensions

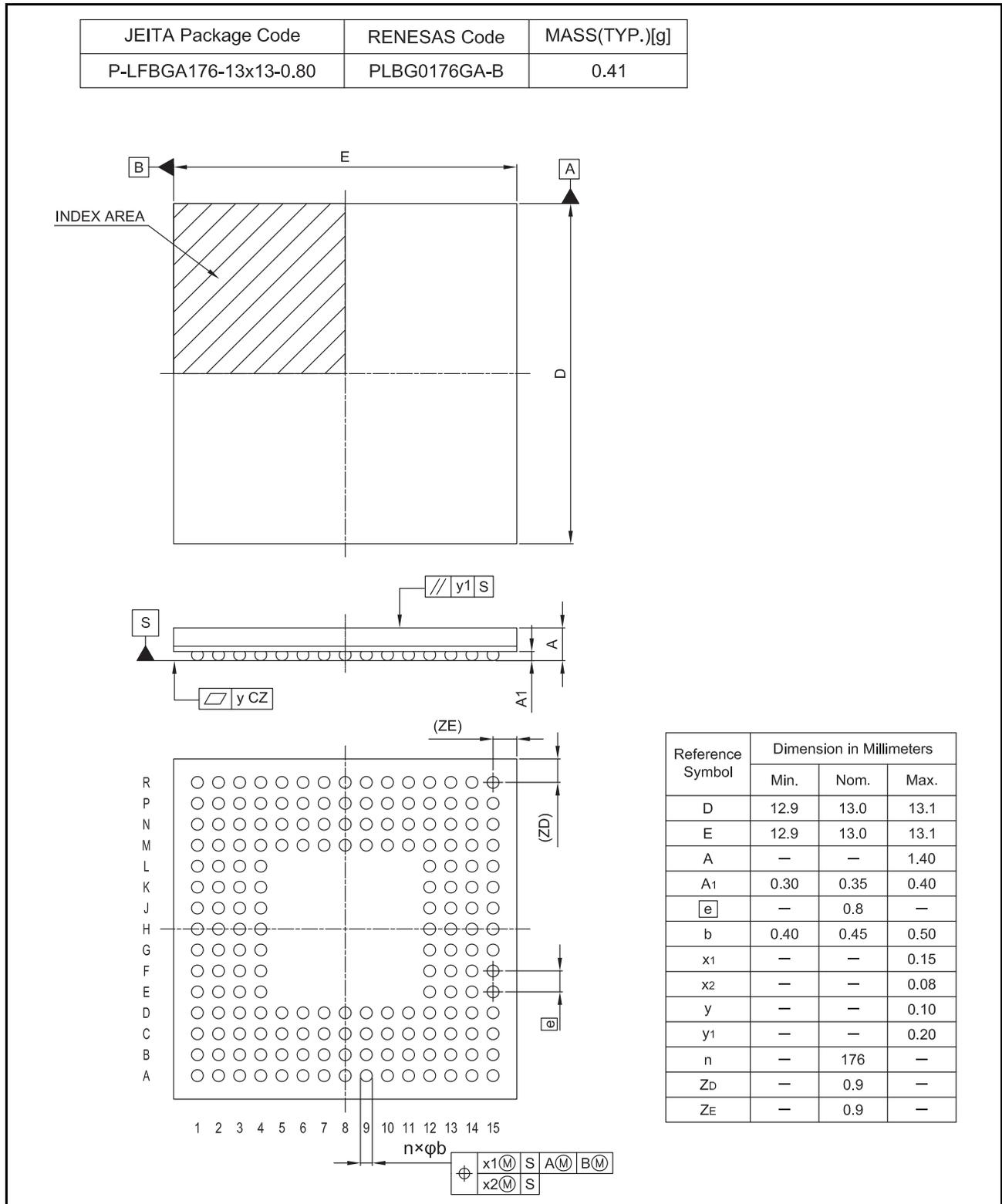


Figure 4.1 Dimensions of 176-Pin BGA Package

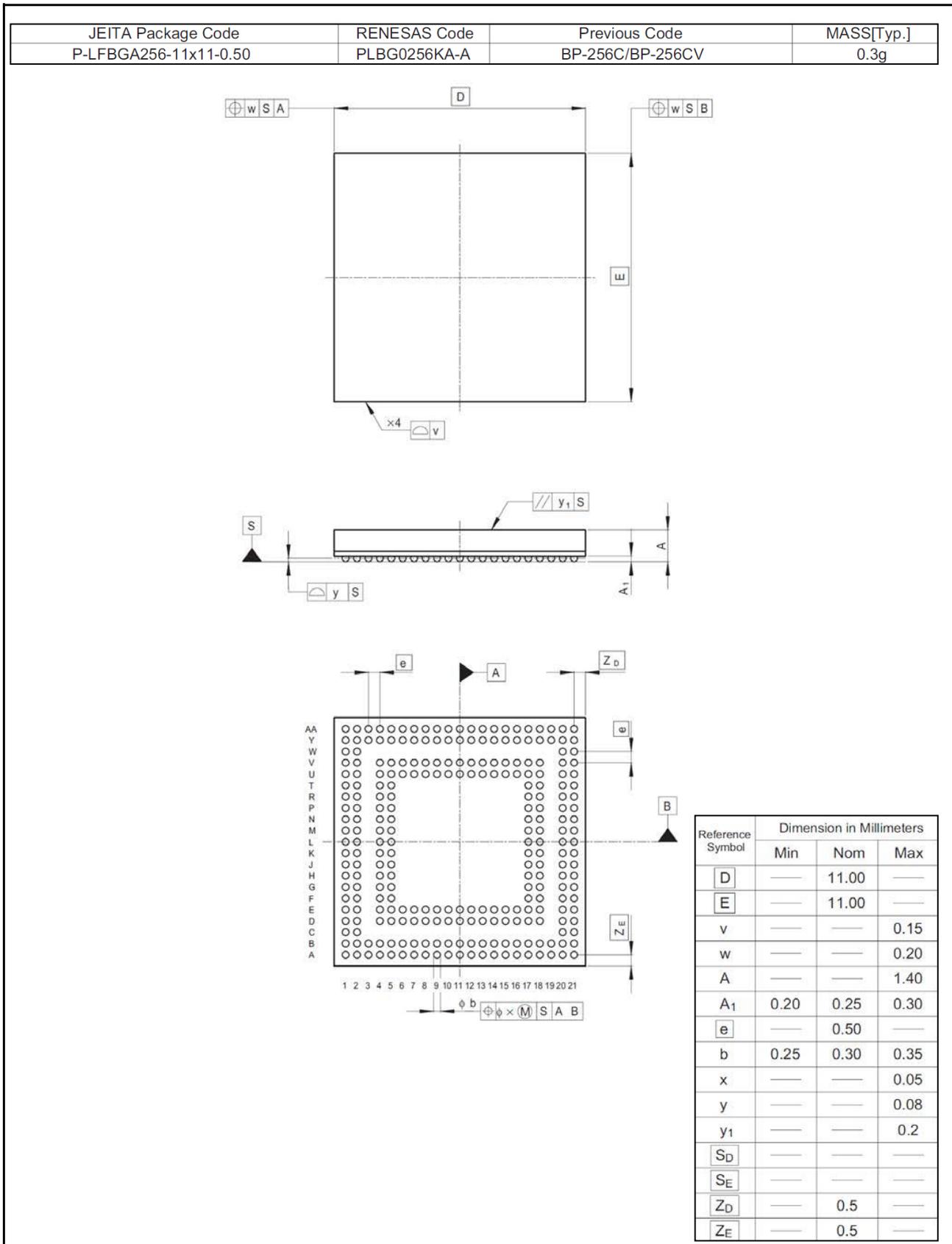


Figure 4.2 Dimensions of 256-Pin BGA Package

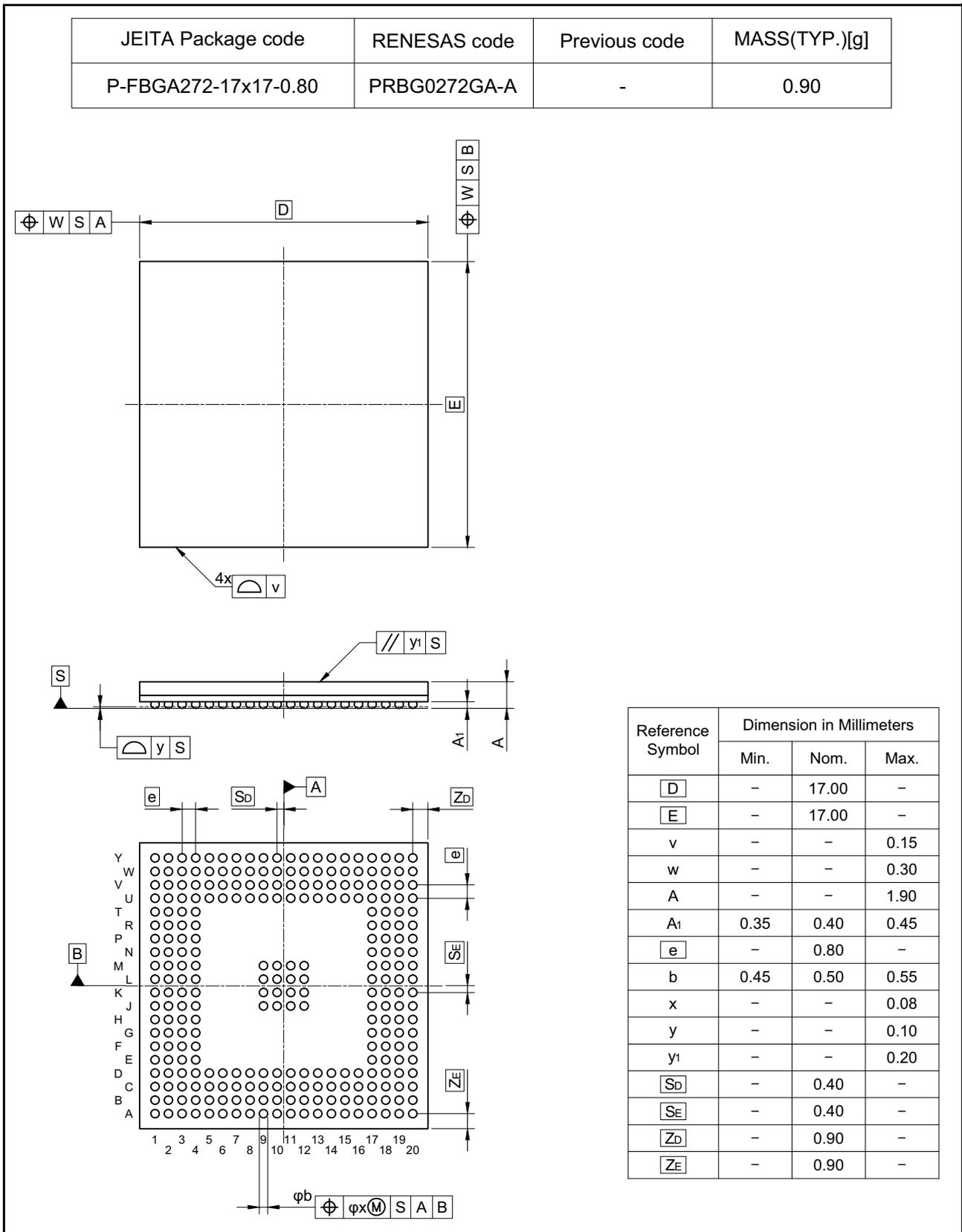
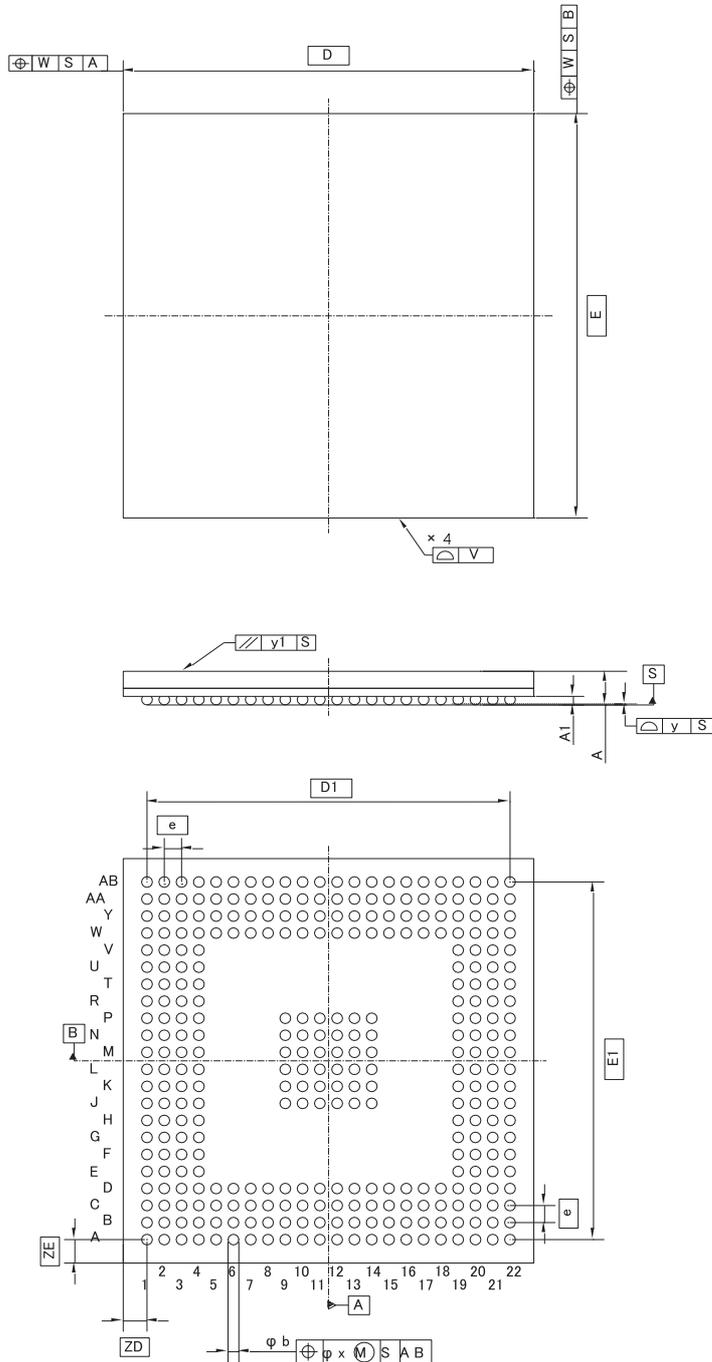


Figure 4.3 Dimensions of 272-Pin BGA Package

JEITA Package code	RENESAS code	Previous code	MASS(TYP.)[g]
P-FBGA324-19x19-0.80	PRBG0324GA-A	-	1.2

Unit:mm



Reference Symbol	Dimension in Millimeters		
	Min	Mon	Max
D	—	19.00	—
D1	—	16.80	—
E	—	19.00	—
E1	—	16.80	—
v	—	—	0.15
w	—	—	0.20
e	—	0.80	—
A	—	1.76	2.10
A1	0.35	0.40	0.45
b	0.45	0.50	0.55
x	—	—	0.08
y	—	—	0.10
y1	—	—	0.20
ZD	—	1.10	—
ZE	—	1.10	—

Figure 4.4 Dimensions of 324-Pin BGA Package

REVISION HISTORY		RZ/A2M Group Datasheet	
Rev.	Date	Description	
		Page	Summary
1.00	Dec. 25, 2024	—	First edition, issued

General Precautions in the Handling of Microprocessing Unit and Microcontroller Unit Products

The following usage notes are applicable to all Microprocessing unit and Microcontroller unit products from Renesas. For detailed usage notes on the products covered by this document, refer to the relevant sections of the document as well as any technical updates that have been issued for the products.

1. Precaution against Electrostatic Discharge (ESD)

A strong electrical field, when exposed to a CMOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop the generation of static electricity as much as possible, and quickly dissipate it when it occurs. Environmental control must be adequate. When it is dry, a humidifier should be used. This is recommended to avoid using insulators that can easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors must be grounded. The operator must also be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions must be taken for printed circuit boards with mounted semiconductor devices.

2. Processing at power-on

The state of the product is undefined at the time when power is supplied. The states of internal circuits in the LSI are indeterminate and the states of register settings and pins are undefined at the time when power is supplied. In a finished product where the reset signal is applied to the external reset pin, the states of pins are not guaranteed from the time when power is supplied until the reset process is completed. In a similar way, the states of pins in a product that is reset by an on-chip power-on reset function are not guaranteed from the time when power is supplied until the power reaches the level at which resetting is specified.

3. Input of signal during power-off state

Do not input signals or an I/O pull-up power supply while the device is powered off. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Follow the guideline for input signal during power-off state as described in your product documentation.

4. Handling of unused pins

Handle unused pins in accordance with the directions given under handling of unused pins in the manual. The input pins of CMOS products are generally in the high-impedance state. In operation with an unused pin in the open-circuit state, extra electromagnetic noise is induced in the vicinity of the LSI, an associated shoot-through current flows internally, and malfunctions occur due to the false recognition of the pin state as an input signal become possible.

5. Clock signals

After applying a reset, only release the reset line after the operating clock signal becomes stable. When switching the clock signal during program execution, wait until the target clock signal is stabilized. When the clock signal is generated with an external resonator or from an external oscillator during a reset, ensure that the reset line is only released after full stabilization of the clock signal. Additionally, when switching to a clock signal produced with an external resonator or by an external oscillator while program execution is in progress, wait until the target clock signal is stable.

6. Voltage application waveform at input pin

Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (Max.) and V_{IH} (Min.) due to noise, for example, the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (Max.) and V_{IH} (Min.).

7. Prohibition of access to reserved addresses

Access to reserved addresses is prohibited. The reserved addresses are provided for possible future expansion of functions. Do not access these addresses as the correct operation of the LSI is not guaranteed.

8. Differences between products

Before changing from one product to another, for example to a product with a different part number, confirm that the change will not lead to problems. The characteristics of a microprocessing unit or microcontroller unit products in the same group but having a different part number might differ in terms of internal memory capacity, layout pattern, and other factors, which can affect the ranges of electrical characteristics, such as characteristic values, operating margins, immunity to noise, and amount of radiated noise. When changing to a product with a different part number, implement a system-evaluation test for the given product.

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